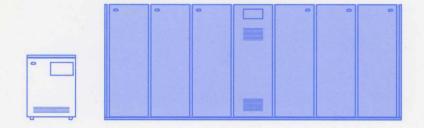
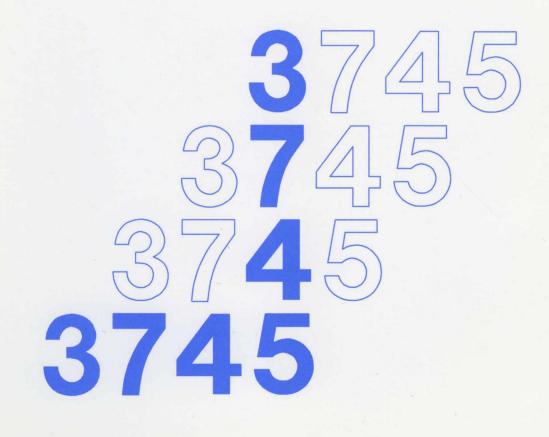
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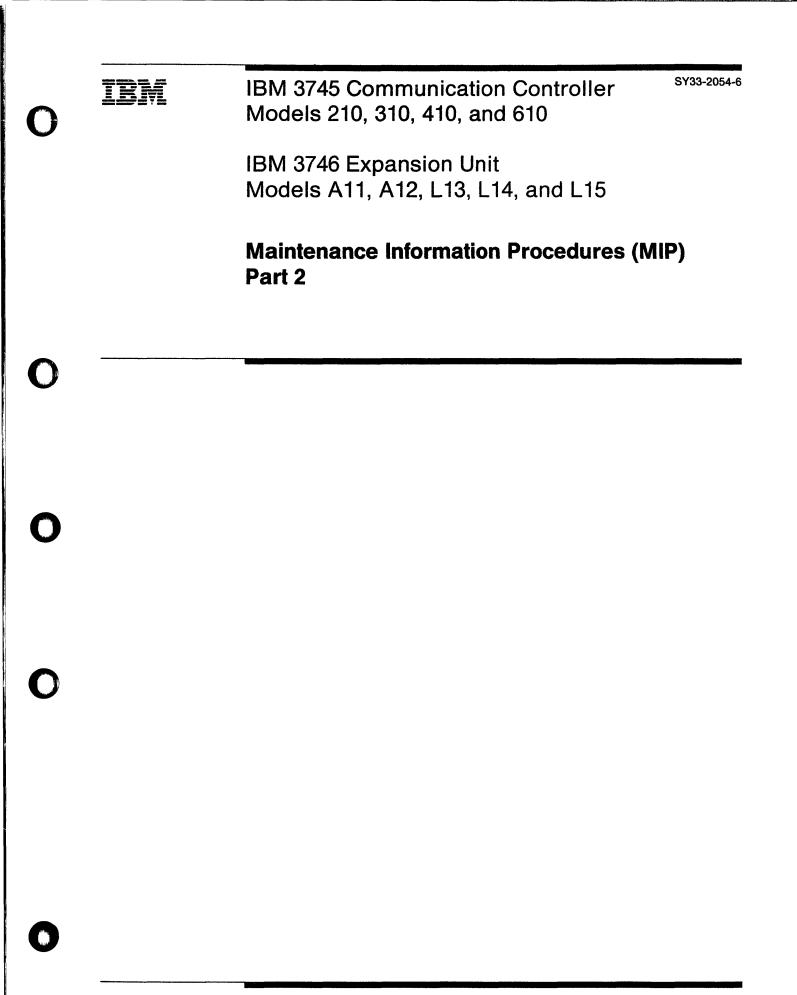
3745 Communication Controller

SY33-2054-6

Maintenance Information Procedures (MIP) Part 2







– Note! —

Before using this information and the product it supports, be sure to read the general information under "Notices" on page xiii.

Seventh Edition (August 1991)

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Changes have been made throughout this edition, and this manual should be read in its entirety.

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Contents

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Maintenance Information Procedures, Part 1 of 2

Chapter 1. Introducing the IBM 3745 Communication Controller	1-1
Table of Contents for Chapter 1	1-1
Using this Manual	1-3
Special Tools	1-6
Maintenance Philosophy	1-8
Using the 3745 Library for Service	1-9
General Description	1-11
Internal Organization	1-15
Model Configurations	1-20
Specifications and Features	1-23
Configuration Identification	1-24
Control Panel Use	1-33
How to Perform Control Panel Operations	1-38
Chapter 2. START - How to Begin Troubleshooting	2-1
START - Console Use for Maintenance	2-2
Problems During Machine, EC or MES Installation	2-5
Symptom Index	2-6
Using Reference Codes	2-12
Panel Codes	2-14
Using the MIP FRU Group Table	2-29
FRU Machine Requirements	2-34
Diagnostic Requirements	2-81
Chapter 3. MAPs for FRU Isolation of 3745 Failures	3-1
MOSS MAPs	3-1
Line Adapter MAPs	3-12
Channel Adapter MAPs	3-17
Power MAPs	3-20
IOC bus MAP	3-41

Maintenance Information Procedures, Part 2 of 2

Chapter 4. How to Run the 3745 Diagnostics	4-1
Table of Contents for Chapter 4	4-1
Diagnostic Description	4-2
How to Run MOSS Diagnostics 4	-19
How to Loop MOSS Diagnostics 4	-20
How to Run the Panel Test 4	-21
How to Run the Console Link Test 4	-22
How to Run the Power Control Bus Test 4	-24
How to Run Internal Function Tests 4	-29
Messages for Manual Intervention During IOC Bus Diagnostics 4	-33
How to Run the Wrap Test (WTT) for LIC 1, 3, 4, 5, 6 or HPTSS Port	-35
How to Run the Wrap Test with IFTs for LIC 1, 3, 4, 5, 6 or HPTSS Port 4	-37

How to Run the Channel Wrap Test 4-42 Action to Take After a Diagnostic Run 4-43
Chapter 5. 3745 FRU Exchange5-1Exchange Precautions5-1FRU Physical Locations5-5FRU Exchange Procedures5-51Repair Verification Procedure5-170CE Leaving Procedure5-172
Appendix A. Control Panel Code Definitions A-1
Appendix B. Maintenance AidsB-1PKD Maintenance AidsB-1Contacting SupportB-2Control Program Maintenance AidsB-4MOSS Microcode Maintenance AidsB-6Scanner Microcode Maintenance AidsB-8Channel Microcode Maintenance AidsB-1
List of Abbreviations X-1
Glossary X-9

4-1-1-1

-						
F	ł	a	11	r	ρ	S
		<u> </u>	w.		-	U

 \square

 \mathbf{O}

 \cap

 \bigcap

0-1.	3745 (Basic Frame 01) Label and Power Rating Plate Locations	
0-1. 0-2.	3745 (Basic Frame 01) Label and Power Rating Plate Locations .	
0-2. 0-3.		
0-3. 0-4.	3746-A11 (Frame 02) or 3746-A12 (Frame 03) Label Locations	. XXI
0-4.	3746-L13 (Frame 04) 3746-L14 (Frame 05) 3746-L15 (Frame 06)	
0 5	Label Locations	
0-5.	Safety Labels	
1-1.	Representation of Flow Through this Manual	
1-2.	3745 Subsystems	
1-3.	Control Subsystem (CSS)	
1-4.	Transmission Subsystem if LIC Type 1 to 4.	
1-5.	Transmission Subsystem if LIC Type 5-6 Low/medium Speed	
1-6.	Transmission Subsystem if LIC Type 6 High Speed	
1-7.	High Performance Transmission Subsystem (HPTSS)	
1-8.	Token-Ring Subsystem (TRSS)	
1-9.	Maintenance and Operator Subsystem (MOSS)	
1-10.	Power Control Subsystem (PCSS)	1-14
1-11.	CCU Single Configuration	1-15
1-12.	CCU Twin Standby Configuration	1-16
1-13.	CCU Twin Backup or Dual Configuration	1-17
1-14.	Full Configuration of Adapter Buses	1-18
1-15.	DMA Bus Configuration	1-18
1-16.	3745 Data Flow	1-19
1-17.	3745 Frame Locations	
1-18.	CDF Channel Adapter Screen	1-25
1-19.	Channel Board Crossover Locations	1-26
1-20.	CDF Line Adapter Screen	
1-21.	FESH Identification	
1-22.	FESL Identification	
1-23.	TSSB Board Layout	
1-24.	TSST Board Layout	
1-25.	Panel Layout	
2-1.	Maintenance Functions Menu	
2-2.	Reference Code Screen	
2-3.	TSS/HPTSS Diagnostic Selection Screen	
2-4.	TRSS Diagnostic Selection Screen	
2-5.	TSS/HPTSS Diagnostic Selection Screen	
2-6.	TSS Service Screen	
2-7.	Select/Release Screen	
2-8.	Mode Control Screen	
2-9.	LIC Type 1 and 4 Wrap Plug P/N65X8927	
2-10.	LIC Type 3 Wrap Cable P/N65X8928	
2-11.	LIC Type 5 and 6 Wrap Plug P/N11F4815	
2-12.	LIC Types 1, 3 and 4	
2-13.	LIC Types 5 and 6	
2-13. 2-14.	TSS/HPTSS Diagnostic Selection Screen	
2-14.	TSS/HPTSS Diagnostic Selection Screen	
2-1 <u>5</u> . 2-16.	CDF Function Menu	
2-10. 2-17.	CDF Display/Update Function Menu	
2-17. 2-18.	CCU Operating Menu	
2-10. 2-19.	TSS Service Screen	
2-19.		2-90

2-20.	Select/Release Screen	
2-21.	Mode Control Screen	
2-22.	TSS/HPTSS Diagnostic Selection Screen	
2-23.	TRSS Services Screen	
2-24.	Select Screen	
2-25.	Connect/Disconnect Screen	
2-26.	TRSS Diagnostic Selection Screen	
2-27.	TSS Service Screen	
2-28.	Select/Release Screen	
2-29.	Mode Control Screen	
2-30.	TSS Service Screen	
2-31.	Select/Release Screen	
2-32.	Mode Control Screen	
2-33.	TSS/HPTSS Diagnostic Selection Screen	
2-34.	CDF Function Menu	
2-35.	CDF Menu	2-103
2-36.	CCU Operating Menu	2-103
3-1.	MOSS Voltage Test Points	
3-2.	PS Type 6 SW1 Actuator	
3-3.	Console Outputs	3-9
3-4.	PSTY6 Test Points.	3-21
3-5.	UEPO Switch	3-22
3-6.	Primary Power Box	3-24
4-1.	MOSS Overview	4-4
4-2.	Power Control Bus Layout	4-6
4-3.	CCU Diagnostic Coverage	4-8
4-4.	IOC Diagnostic Coverage	4-9
4-5.	CA Diagnostic Coverage	4-11
4-6.	TSS Diagnostic Coverage	4-13
4-7.	TRSS Diagnostic Coverage	
4-8.	HPTSS Diagnostic Coverage	
4-9.	Console Outputs	
4-10.	Cable Configurations	
4-11.	Power Terminator (Frame 01 Represented).	4-24
4-12.	Power Control Bus Wrap Card	4-26
4-13.	Wrap Circuit of the Wrap Card	4-26
4-14.	Power Control Bus Layout	4-27
4-15.	Maintenance Functions Menu	4-29
4-16.	How to Select Diagnostics	4-30
4-17.	How to Enter an Option	4-31
4-18.	Error Menu	4-32
4-19.	Diagnostic Messages Screen	4-33
4-20.	LIC Type 1 and 4 Wrap Plug P/N65X8927	4-39
4-21.	LIC Type 3 Wrap Cable P N65X8928	
4-22.	LIC Type 5 and 6 Wrap Plug P/N11F4815	
4-23.	LIC Types 1, 3 and 4	
4-24.	LIC Types 5 and 6	
5-1.	3745 Full Machine Configuration	5-5
5-2.	3745-210, 310, 410 or 610	
5-3.	3746-011	5-8
5-4.	3746-012	5-9
5-5.	3746-013	
5-6.	3746-014	
5-7.	3746-015	
- • •	· · · · · · · · · · · · · · · · · · ·	

.

vi IBM 3745 Communication Controller

5-8 .	3745 MOSS Board. Cards and Connectors	
5-9.	3745 Storage, Control Boards and Cards for Models 210 and 410	
5-10.	3745 Storage, Control Boards and Cards for Models 310 and 610	
5-11.	3745 SACU Board and Connectors for Models 210 and 410	
5-12.	3745 SACU2 Board and Connectors for Models 310 and 610	
5-13.	3745 SACL Board and Connectors for Models 210 and 410	
5-14.	3745 SACL2 Board and Connectors for Models 310 and 610	5-19
5-15.	3745 TCM Board and Connectors (Front)	5-20
5-16.	3745 TCM Board and Connectors (Rear)	5-21
5-17.	3745 TSSB Board and Cards	5-22
5-18.	3745 TSSB Board and Connectors	5-23
5-19.	3745 TSST Board Cards and Connectors	5-24
5-20.	3745 LIC Unit Type 1 Board and Connectors	5-25
5-21.	3745 LIC Unit type 2 Board and Connectors	5-26
5-22.	3745 DMUX Packaging	5-27
5-23.	3745 SMUXA/B Packaging	
5-24.	LIC Unit Type 1 Packaging (for LIC Type 1-4)	5-28
5-25.	Line Numbers and Boards (for LIC Type 1-6)	5-28
5-26.	LIC Unit Type 2 Packaging (for LIC Type 5)	5-29
5-27.	LIC Unit Type 2 Packaging for LIC Type 6 Low-speed	
5-28.	LIC Unit Type 2 Packaging for LIC Type 6 High-speed	
5-29.	LIC Unit Type 1 Layout Board B2 (for LIC Type 1-4)	
5-30.	LIC Unit Type 1 Layout Board B1 (for LIC Type 1-4)	
5-31.	LIC Unit Type 2 Layout Board B2 (for LIC Type 5)	
5-32.	LIC Unit Type 2 Layout Board B1 (for LIC Type 5)	5-34
5-33.	LIC Unit Type 2 Layout Board B2 (for LIC Type 6 Low-speed)	
5-34.	LIC Unit Type 2 Layout Board B1 (for LIC Type 6 Low-speed)	
5-35.	LIC Unit Type 2 Layout Board B2 (for LIC Type 6 High-speed)	5-36
5-36.	LIC Unit Type 2 Layout Board B1 (for LIC Type 6 High-speed)	5-36
5-37.	LIC Number / Line Address Tables for Frame 01	
5-38.	LIC Number / Line Address for Frame 04B/D	
5-39.	LIC Number / Line Address for Frame 04E/G	
5-40.	LIC Number / Line Address for Frame 05B/D	
5-41.	LIC Number / Line Address for Frame 05E/G	
5-42.	LIC Number / Line Address for Frame 06B/D	
5-43.	LIC Number / Line Address for Frame 06E/G	
5-44.	3745 Channel Board Cards and Connectors	
5-45.	3745 Channel Tail Gate and Standard Interface Test Points	5-45
5-46.	3745 Channel Tail Gate	5-46
5-47.	3745 Control Panel	5-47
5-48.	3745 Primary Power Box Components	5-48
5-49.	Control Panel Removal	5-52
5-50.	PS Type 6 SW1 Actuator	5-53
5-51.	FDD Removal	5-55
5-52.	FDD Jumpering	5-56
5-53.	PS Type 2	5-56
5-54.	HDD Removal	
5-55.	HDD Jumpering (Old Model and New Models)	
5-56.	Shipping Springs	
5-57.	Shipping Springs	
5-58.	CSP and FESL Cards	
5-59.	FESH Card	
5-60.	DMUX Card	
5-61.	SMUX A/B Switches	5-69

 \bigcirc

5-62.	SMUX A and SMUX B cards	
5-63.	LIC Cassette Type 1-4	. 5-71
5-64.	LIC Cassette Type 5 and 6	. 5-72
5-65.	Fan Assembly	
5-66.	TIC and TRM	. 5-75
5-67.	Location of Jumper A and Switch Block B on the TIC Card	
5-68.	PTER Locations	
5-69.	Power Terminator (Frame 01 Represented)	
5-70.	Card Clamp Mechanism	
5-71.	Frame 01 Internal Access	. 5-80
5-72.	AMD Filter Location	. 5-80
5-73.	Filter Removal	. 5-81
5-74.	Air Filter locations	
5-75.	Back Air Filter location	. 5-82
5-76.	Power Services Screen	. 5-83
5-77.	Acknowledge Screen	. 5-83
5-78.	Frame 01 Internal Access	. 5-84
5-79.	Air Moving Devices Location	. 5-84
5-80.	Air Moving Devices Removal	. 5-85
5-81.	Air Moving Devices Location	. 5-86
5-82.	Air Moving Devices Removal	. 5-87
5-83.	Battery Location	. 5-88
5-84.	Battery Removal	. 5-88
5-85.	Power Services Screen	. 5-89
5-86.	Acknowledge Screen	. [`] 5-89
5-87.	Frame 01 Internal Access	. 5-90
5-88.	Blower Assembly Removal	. 5-90
5-89.	Frame 01 Internal Access	. 5-96
5-90.	AMD Location	. 5-96
5-91.	Air Moving Device Removal	. 5-97
5-92.	Heat Sink Removal	. 5-97
5-93.	TCM Handle Attachment	. 5-97
5-94.	TCM Retaining Screws	. 5-98
5-95.	Actuation Tool, TCM Removal	. 5-98
5-96.	Actuation Tool Usage	. 5-98
5-97.	TCM Uncammed Position	. 5-99
5-98.	TCM Removal	. 5-99
5-99.	TCM Protection	. 5-99
5-100.	TCM Container	. 5-99
5-101.	TCM Board	5-100
5-102.	TCM Assembly	5-100
5-103.	TCM Inspection	5-100
5-104.	TCM Installation	5-100
5-105.	Actuation Tool Installation	5-101
5-106.	TCM Cammed Position	5-101
5-107.	Actuation Tool Usage	5-101
5-108.	TCM Handle Removal	5-102
5-109.	Heat Sink Installation	5-102
5-110.	AMD Installation	5-102
5-111.	PS Type 1	5-103
5-112.	PS Type 1B	5-105
5-113.	PS Type 2	5-107
5-114.	PS Type 3	5-108
5-115.	PS Type 4	5-109

5-116.	PS Type 5	5-111
5-117.	PS Type 6	5-113
5-118.	PS Type 7	5-114
5-119.	Phases	5-116
5-120.	Frame 01 Internal Access	5-116
5-121.	PS Type 8	5-116
5-122.	Fan Assembly	5-118
5-123.	Tail Gate Connector	5-119
5-123. 5-124.	Primary Power Box in Frame 01	5-120
5-124. 5-125.	Channel Board, Tail Gate and Channel Power in Basic Frame 01	5-121
5-125. 5-126.	Channel Board, Tail Gate and Channel Power in Frame 02	5-121
5-120. 5-127.		5-121
5-127.	Tail Gate Channel Board Power Supply	5-122
		5-122
5-129.	Channel Board and Power Enclosure	
5-130.	Board Assembly	5-125
5-131.	Primary Power Box in Frame 01	5-129
5-132.	LAB1 and the Associated Power Supplies	5-130
5-133.	LAB2, LAB3 and the Associated Power Supplies	5-130
5-134.	LAB4 and Associated Power Supplies	5-131
5-135.	Line Adapter Power Supply	5-131
5-136.	Line Adapter Board, Cards and Crossovers (TSSB)	5-132
5-137.	Line Adapter Board, Cards and Crossovers (TSST)	5-133
5-138.	Enclosure for the Line Adapter Board	5-135
5-139.	Back Plate Assembly	5-136
5-140.	Primary Power Box	5-139
5-141.	LIC Board Type 1 Assembly	5-140
5-142.	LIC Board Type 1 Enclosure Assembly	5-141
5-143.	LIC Board Type 1 Assemblies	5-141
5-144.	Primary Power Box	5-143
5-145.	LIC Board Type 2 Assembly	5-144
5-146.	LIC Board Type 2 Enclosure Assembly	5-146
5-147.	LIC Board Type 2 Assemblies	5-146
5-148.	Base Frame - Rear View	5-148
5-149.	Primary Power Box in Frame 01	5-148
5-150.	Cables and Cards of the MOSS	5-149
5-151.	MOSS Board and Card Rail Assemblies	5-150
5-152.	Primary Power BOX in Frame 01	5-153
5-153.	Frame 01 Front and Rear View	5-154
5-154.	Rear View of the SAC Gate Assembly	5-155
5-155.	Front View of the SAC Gate Assembly	5-156
5-156.	Card Clamp Mechanism	5-156
5-157.	SAC Air Moving Device Unit Location	5-157
5-158.	SAC Air Moving Device	5-157
5-159.	Primary Power BOX in Frame 01	5-160
5-160.	Frame 01 Front and Rear View	5-161
5-161.	SAC Gate Assembly - Brackets	5-162
5-162.	Card Clamp Mechanism	5-163
5-163.	Lower view of the SAC Gate Assembly	5-163
5-164.	Air Duct	5-164
5-165.	Upper View of the SAC Gate Assembly	5-164
5-166.	SAC Air Moving Devices Unit Location	5-165
5-167.	Air Moving Device Unit Removal	5-165
5-168.		5-168
5-169.	Board Screws	5-169
0-103.	Dourd Oolomg	5 105

0

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0-1.	Part Numbers	
0-1. 0-2.		
0-2. 0-3.	3745 Power Supply CP/CB Reference	
0-3. 1-1.	Safety Label Numbers by Country	
	Panel Display Values	2-6
2-1.	General Symptoms	2-0 2-7
2 - 2.	3745 Console Symptoms	
2-3.	Control Panel Symptoms	2-8
2-4.	Power Symptoms	2-10
2 - 5.	Control Panel Code Table	
2-6.	3745 FRU Table	
2-7.	Requirements for CCU, Adapter or DMA buses.	
2-8.	Requirements for ITER/DTER.	
2-9.	Requirements for MOSS.	
2-10.	Requirements for CADR.	2-44
2-11.	Requirements for CAL.	
2-12.	Requirements for CSP When Board Type Is TSST.	
2-13.	Requirements for CSP When Board Type Is TSSB	2-48
2-14.	Requirements for CSP When Board Type Is TSSB (continued)	2-49
2-15.	Requirements for FESH When Board Type Is TSST	2-50
2-16.	Requirements for FESH When Board Type Is TSSB	2-50
2-17.	Requirements for FESL When Board Type Is TSST	2-50
2-18.	Requirements for FESL When Board Type Is TSSB	2-51
2-19.	Requirements for TIC.	2-53
2-20.	Requirements for TRM.	2-53
2-21.	Requirements for PS Type 4.	2-55
2-22.	Requirements for PS Type 1 and 1B.	2-57
2-23.	Requirements for PS Type 2.	2-57
2-24.	Requirements for PS Type 3.	2-57
2-25.	Requirements for PS Type 5.	2-57
2-26.	Requirements for PS Type 7.	
4-1.	Channel Adapters	4-34
4-2.	Line Adapters	
5-1.	3745 Power Supply Cross Reference	5-49
5-2.	Voltage Test Points	5-56
5-3.	Voltage Test Points	5-58
5-4.	Relation Between the CSP Card Location and the Power Services	-
-	Screen	5-65
A-1.	MOSS Control Panel Codes	
	· · · · · · · · · · · · · · · · · · ·	

xii IBM 3745 Communication Controller

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Properly shielded and grounded cables and connectors must be used in order to meet FCC emission limits. IBM is not responsible for any radio or television interference caused by using other than recommended cables and connectors or by unauthorized changes or modifications to this equipment. Unauthorized changes or modifications could void the user's authority to operate the equipment.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

For Canada, Canadian Department of Communication Statement, GX27-3883, applies.

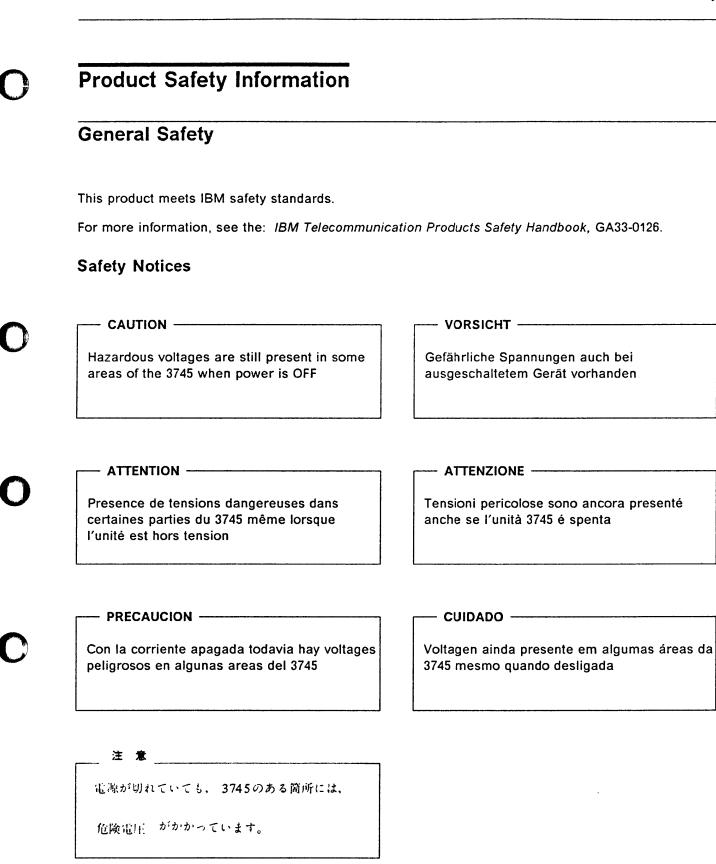
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Service Inspection Procedures

Introduction

The following procedures help the service personnel check whether the 3745 conforms to IBM safety criteria. They are to be used each time the 3745 safety is suspected.

The 3745 areas and functions checked through these procedures are:

- 1. External covers
- 2. Safety labels
- 3. Safety covers and shields
- 4. Grounding
- 5. Circuit breaker and protector rating
- 6. Input power voltage
- 7. Power On indicator On
- 8. Emergency power OFF.

Important Notes:

 The 3746(s) are powered On and Off through the basic frame 3745.

Hazardous voltages are still present in some areas of the 3745 when power is Off.

- Steps 1 through 6 must be performed with the power OFF; that is, on the 3745 and 3746(s):
 - CB1 tripped (switched off) on the 3745, and

 Customer's power supply switch OFF. do not remove the power cord in order to maintain the ground protection.

1. External covers

Check that:

- They are all present on the 3745 and 3746(s).
- They are locked with two kind of locks: flat blade screw for IBM access area and hex head for customer access area (refer to the 3745 Parts Catalog).
- They can be fully opened.
- Appropriate service clearances and accesses are provided around the frames with external covers opened.

Leave all external covers opened to allow further safety inspection steps.

2. Safety labels

Check that:

- All the safety labels are at the places indicated by letters in "Safety Label Locations" on page xx.
- Each label is of the model corresponding to the letter as shown on "Safety Label Identifications" on page xxii.

3. Safety covers and shields

Referring to FRU location (Chapter 5) check that:

- All the safety covers are present and secured with screws.
- All the voltage terminal boards (TBs) are protected by a plastic shield screwed on top of the TB.

4. Grounding

Refer to "Volume 4, page YZ110 to YZ114" for grounding jumper locations

Check that:

- Electrical continuity is assured, within each frame, between the frame ground and the terminals indicated on the ground distribution diagrams.
- Electrical continuity is assured between the 3745 and 3746(s), frame grounds and to the premises grounding system, through the 3745 power cord.

5. Circuit breaker and protector rating

Refer to Table 0-2 on page xix for CB and CP locations.

Check that:

• All CBs and CPs in the 3745 are rated at the indicated value in Table 0-2 on page xix. If the rating is not indicated, check the part number against the 3745 *Parts Catalog, S135-2010.*

6. Input power voltage

The power rating plate indicates the voltage ranges available (200/220/240 or 346/380/415).

The voltage label (label E) indicates the input voltage for which the 3745 is wired.

Performing a Power Conversion Inspection.

- A power conversion inspection must be performed on any 3745 Communication Controller that has been converted from 50 Hz to 60 Hz, from 60 Hz to 50 Hz, from 220 V to 380 V, or from 380 V to 220 V.
- The following procedure is only used for frame 01 (base frame) which contains the Primary Power Box (PPB). Each component must be inspected as described.
 Refer to Figure 5-2 on page 5-6 to locate the frame 01 and the PPB.

Inspection

 Check against the Table 0-1 on page xviii for the correct primary power part numbers for the specified 50 Hz or 60 Hz use. Check for the correct PS type 8 : P/N6495884 for 50 Hz or P/N6495898 for 60 Hz In case of discrepancy, contact your support structure.

Refer to Figure 0-1 on page xx for power rating plate location and voltage label and:

- "Volume 4. page YZ561 to YZ564" for the primary power box voltage adjustment,
- "Volume 4, page YZ576" for the power box PS Type 6 voltage adjustment and
- "Volume 4, page YZ578" for the power supply PS Type 8 voltage adjustment.

Check that:

• The power rating plate is consistent with the voltage level measured at the customer's power supply. If not, inform your branch office.

Important Note:

Since the 3745 can be remotely powered On, all the following procedures must be performed with the Power Control function on the 3745 control panel set to **Local mode**.

7. Emergency power OFF

Ask the customer to connect the power cord to the customer's mains supply, put CB1 On, and power ON the 3745 (Power Control function to Local on the control panel).

Then operate the EMERGENCY switch to POWER OFF ('0') and check that:

- The 3745 is powered Off.
- · The diskette and disk drives are stopped.
- All the fans are stopped, except MOSS.
- The convenience outlets on the 3745 are not supplied with ac power.

Relatch the EMERGENCY switch, then power ON the controller.

8. Power ON Indicator

Once the controller is powered On, check that the Power On indicator On on the 3745 control panel is lit. The indicator is located to the right of the Power ON/Reset key, refer to Figure 1-25 on page 1-35.

Primary Power Assembly	Power Cord	Convenience outlet Voltage
P/N 6495105 US and Canada 208.220,240V 60 Hz	P/N 6495844	117V P/N 357995
P/N 6495106 JAPAN 200.220 50 Hz	P/N 6495845	100V P/N 357995
P/N 65X8688 JAPAN 200.208,240 60 Hz	P.'N 6495845	100V P/N 357995
P/N 6495107 All countries 200,220 50 Hz	P/N 6495845	200V P/N 418835
P/N 65X8689 All countries 200,208,220,240 60 Hz	P/N 6495845	220V P/N 418835
P/N 6495688 All countries 380,400,415 50 Hz	P/N 6495846	220V P/N 418835
P/N 65X8690 All countries 380 60 Hz	P/N 6495846	220V P/N 418835

3745 Power Supply CP/CB Reference

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Frame	CB/CP	Location	Rating	PS
Frame 1	CB1	01E	40A/220V	
	CB1	01E	25A/380V	
	CP1	01E	3A	PSTY8
	CP1	01F	1.5A	PSTY6
	CP2	01F	1.5A	PSTY6
	CP3	01F	1.5A	PSTY6
	CP3	01E	6A	PSTY1-A
	CP4	01E	3A	PSTY5/7
	CP5	01E	3A	PSTY3
	CP6	01E	3A	PSTY2
	CP7	01E	6A	PSTY4
	CP8	01E	6A	PSTY1-B
	CP9	01E	3A	Outlet
Frame 2	CP1	02J-A0	6A	PSTY4
	CP2	02J-A0	3A	PSTY3
	CP3	02J-A0	6A	PSTY4
Frame 3	СР	03J-A0	6A	PSTY4
Frame 4	CP1	04A-A0	6A	PSTY5/7
	CP2	04A-A0	6A	PSTY5/7
Frame 5	CP1	05A-A0	6A	PSTY5/7
	CP2	05A-A0	6A	PSTY5/7
Frame 6	CP1	06A-A0	6A	PSTY7
	CP2	06A-A0	6A	PSTY7

Safety Label Locations

On the following figures, labe s are designated by letters. A particular wording corresponds to each letter (see "Safety Label Identifications" on page xxii).

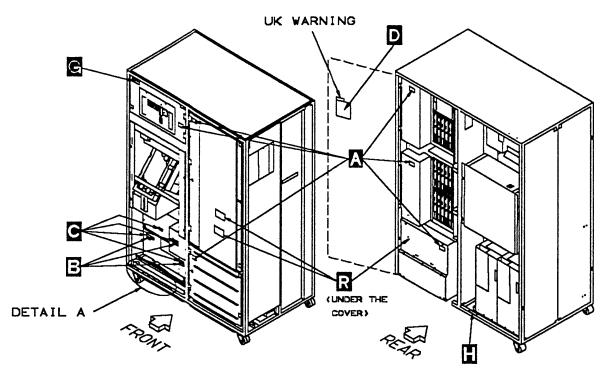


Figure 0-1. 3745 (Basic Frame 01) Label and Power Rating Plate Locations

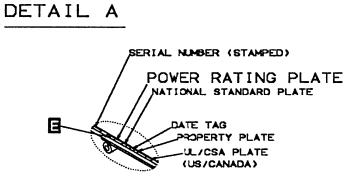


Figure 0-2. 3745 (Basic Frame 01) Label and Power Rating Plate Locations. (Detail).

Safety

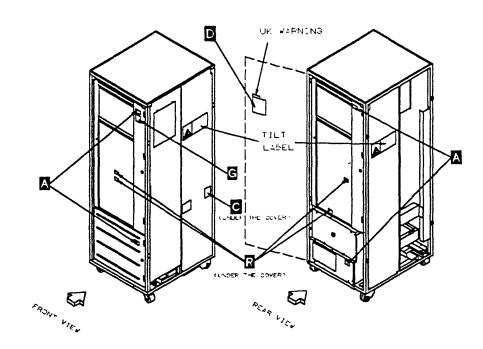


Figure 0-3. 3746-A11 (Frame 02) or 3746-A12 (Frame 03) Label Locations

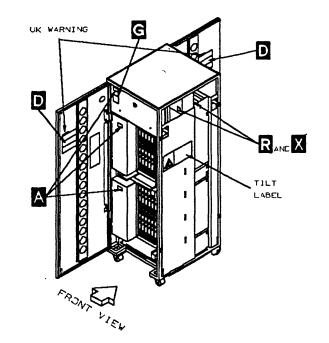


Figure 0-4 (Part 1 of 2). 3746-L13 (Frame 04) 3746-L14 (Frame 05) 3746-L15 (Frame 06) Label Locations

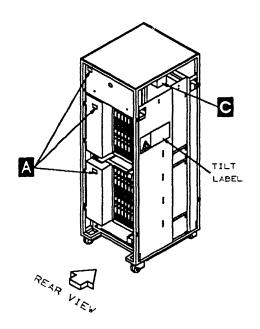


Figure 0-4 (Part 2 of 2). 3746-L13 (Frame 04) 3746-L14 (Frame 05) 3746-L15 (Frame 06) Label Locations

Safety Label Identifications

The safety labels shown in Figure 0-5 are in English. They are also available in other languages. See "Safety Label Part Numbers by Country" on page xxiii for ordering.

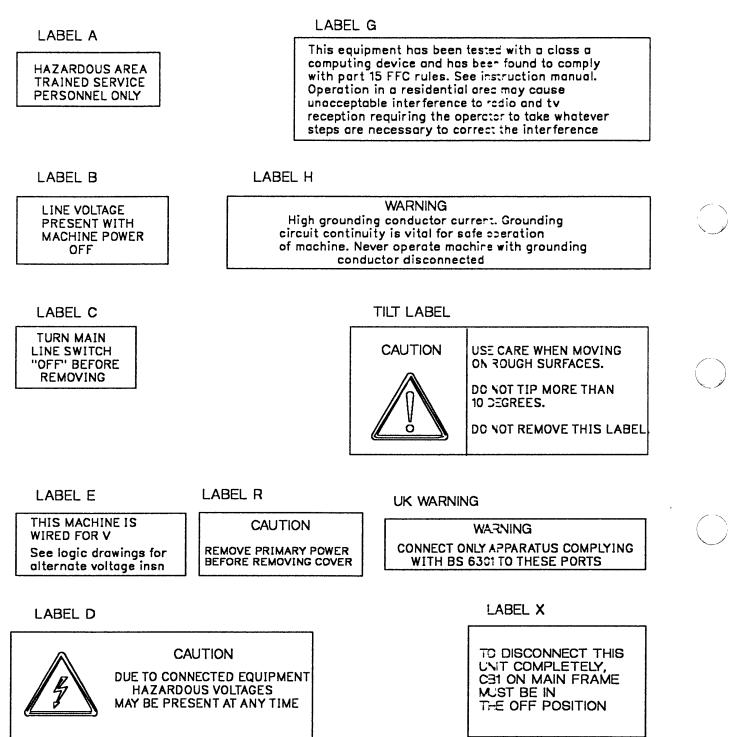


Figure 0-5. Safety Labels

Safety Label Part Numbers by Country

The following table gives the label group part number for each frame according to the language(s) of the country in which the 3745 is installed.

Table 0-3. Safety Label	Numbers by C	ountry		
LANGUAGE	FRAME 01 PART NUMBER	FRAME 02 or 03 PART NUMBER	FRAME 04 or 05 PART NUMBER	TILT LABEL PART NUMBER
Danish	- 03F4314	03F4334	03F4349	03F4462
Dutch	03F4316	03F4336	03F4351	· 03F4464
English	03F4302	03F4322	03F4337	03F4417
*	03F7770	03F7770	03F7770	
Finnish	03F4305	03F4325	03F4340	03F4453
French	03F4304	03F4324	03F4339	03F4452
French/Dutch	03F4306	03F4326	03F4341	03F4454
French/German/Italian	03F4315	03F4335	03F4350	03F4463
Canadian French	03F4303	03F4323	03F4338	03F4451
German	03F4307	03F4327	03F4342	03F4455
Italian	03F4308	03F4328	03F4343	03F4456
Japanese	03F4313	03F4333	03F4348	03F4461
Norwegian	03F4309	03F4329	03F4344	03F4457
Portuguese	03F4310	03F4330	03F4345	03F4458
Spanish	03F4311	03F4331	03F4346	03F4459
Swedish	03F4312	03F4332	03F4347	03F4460

* UK ONLY

About This Book

Aim of this book

The MIP is a guide for fault isolation and repair of the 3745 Communication Controller. It is expected that the customer has used the *Problem Determination Guide*, SA33-0096 prior to calling IBM for service and the MIP open not duplicate the tasks specified by the *Problem Determination Guide*.

The MIP gives the service representative the information needed to:

- Analyze problems or symptoms reported by the system user.
- Restore normal 3[−].5 operation.

Who should read this book

The person using this -anual should be:

- Trained to service the 3745 and 3745 Expansion frames.
- Familiar with the configuration of the system to which the 3745 is connected.
- Familiar with the czeration of the 3745, as described in IBM 3745 Communication Controller Maintenance Information Reference, SY33-2056 and IBM 3745 Communication Controller Service Functions, SY33-2055, which are part of this Maintenance Library.

The intended audience for this manual are Product-Trained Customer Engineers (PT CE). The Product Support-Trained Customer Engineer (PST CE) is also expected to refer to the manual when he is required to perform the same tasks as the PT CE.

How this book is organized

This manual is organized as follows:

- Safety information is at the start of the manual followed by information about the maintenance library and related cocuments.
- Chapter 1 gives a general description of the product and its features and also a description of the maintenance philosophy.
- From Chapter 2 trough Chapter 5, this manual is designed so that the information is presented to the user in the same order as he will require it for most service calls. The user is told where to go next for each path prough this part of the manual.
- At the back of the -anual are Appendix A and B, abbreviation list and glossary. This information is for reference purposes.

XXVI IBM 3745 Communication Controller

Summary of Changes

This revised edition takes into account the new 3745 models: 310 and 610. Also corrections and improvements relating to the previous edition have been inserted.

3745 BIBLIOGRAPHY

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Service Personnel Definitions

Definition	Uses
Product trained CE (PT CE): hardware CE also able to fix problems in the microcode Also called: CE1 1st Level CE CE Phase 1	RETAIN console 3745 control panel 3745 console MIP Service Functions Installation Guide Parts Catalog Basic Operations Guide Problem Determination Guide Connection and Integration Advanced Operations Guide Wiring Diagrams (YZ Pages)
Product support trained CE (PST CE): hardware CE also able to determine and fix problems in the microcode Also called: CE2 2nd Level CE CE Phase 2 Specialist Support	Same as PT CE, plus: MIR Diagnostic Descriptions Principles of Operation
Hardware Central Service (HCS) May include: Dispatchers PT CEs PST CEs	All 3745 tools and books
Program service representative (PSR) Also called: Program support CE Software CE	Operating systems, access methods and NCP/EP library

Customer Information

Supplied with the 3745 (Without binder)

Manual		Order Number
Title	Telecommunication Products Safety Handbook	GA33-0126
Purpose:	Recalls elementary safety principles that must be observed when installing and connecting telecommunication products on a customer site.	
Audience:	(1) Customers (2) IBM CE.	

Volume A

(With pader SX11-8300)

Manuzi		Order Number
Title	3745 Master Index	SA33-0172
Purpœe:	Helps the user find information in the 3745 customer documentation.	
Audience:	(1) Telecommunication network specialist. (2) Network operator, System operator.	
Title [.]	3745 Connection and Integration Guide	SA33-0129
Purpœe:	Explains how to install, replace, and remove the LICs, and how to plug and unplug cables for all attachments. Also explains how to integrate the 3745 into a telecommunication network.	
Audie*ce:	(1) Telecommunication network specialist. (2) Network operator, IBM product trained CE.	
Title:	3745 Console Setup Guide	SA33-0158
Purpcse:	Explains how to install 3745 consoles.	
Audience:	(1) Telecommunication network specialist. (2) Network operator, IBM product trained CE.	

Volume B (With birder SX11-8301)

Manual		Order Number
Title:	3745 Advanced Operations Guide	SA33-0097
Purpose:	Describes all maintenance and operator subsystem functions.	
Audie*ce:	(1) Telecommunication network specialist, system programmer. (2) IBM product trained CE.	

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Volume C (With binder SX11-8301)

Manual		Order Number
Title:	3745 Basic Operations Guide	SA33-0098
Purpose:	Provides the basic procedures needed for the da ; operation of the 3745.	
Audience:	(1) Operator. (2) Network operator, installation coordinator, IBM product trained CE.	
Title:	3745 Problem Determination Guide	SA33-0096
Purpose:	Provides problem determination procedures.	
Audience:	(1) Network operator, system operator. (2) IBM product trained CE.	

Other Customer Information

Manual		Order Number
Title:	3745 Introduction	GA33-0092
Purpose:	Provides introductory information. Describes highlights of the 3745.	
Audience:	(1) DP management, IBM marketing. (2) Operator IBM system engineer and service personnel.	
Title:	3745 Configuration Program	GA33-0093
Purpose:	Can be run from an IBM PC, PC convertible, or ary equipment of the IBM Personal System/2 to configurate the 3745.	
Audience:	(1) Network DP Manager, IBM marketing representative and system engineer. (2) Other customer users.	
Title:	3745 Preparing for Connection	GA33-0127
Purpose:	Provides plugging sheets and information to prepare the 3745 cable installation. Explains how to fill in the LIC5 5 configuration sheets.	
Audience:	(1) DP manager, facilities technician, IBM Marketing. (2) IBM system engineer and service personnel.	
Title:	System/360, System 370, 4300 Processors Input/O_tput Equipment IM-PP	GC22-7064
Purpose:	Gives reference information to plan the physical installation of the 3745.	
Audience:	(1) DP manager, facilities technician, IBM Marketing. (2) IBM system engineer and service personnel.	
Title:	3745 Principles of Operation	SA33-0102
Purpose:	Gives an understanding of the 3745 instruction and command set.	
Audience:	(1) System programmer, IBM system engineer and program service representative. (2) System analyst, IBM marketing representative and service personnel.	

Service Information

Supplied with the 3745

Volumes 1-1 and 1-2 (With two binders SX11-8300)

Manual		Order Number
Title.	3745 Service Master Index (SMI)	SY33-2080
Purpose:	Help the user find information in the 3745 models 210 and 410 shipping group documentation.	
Audience:	(1) IBM product trained CE. (2) IBM product support trained CE.	
Title:	3745 Maintenance Information Procedures (MIP)	SY33-2054
Purpose:	From exits from the Problem Determination Guide, or from error information given by the machine, provides procedures for isolating and fixing the 3745 failures.	
Aud ence:	(1) IBM product trained CE. (2) IBM product support trained CE.	

Volume 2

(Without binder)

Manual		Order Number
Title:	3745 Service Functions	SY33-2055
Purpose:	Describes how the MOSS service functions are used from the 3745 console.	
Audience:	(1) IBM product trained CE. (2) IBM product support trained CE.	

Volume 3 (With blader SX11-8301)

Manual		Order Number
Title:	3745 Installation Guide	SY33-2057
Purpose:	Provides instructions to install or relocate the 3745.	
Audience:	IBM product trained CE.	
Title:	3745 Parts Catalog	S135-2010
Purpose:	Provides reference information for ordering 3745 parts, assemblies, and subassemblies.	
Audience:	(1) IBM product trained CE. (2) IBM part distribution centers.	
Title:	3745 Wiring Diagram (YZ Pages)	Part Numbers (See Note)
Purpose:	Provides detailed schematic information on power wiring, board to board interconnections, locations, card population, jumpering, and interfaces.	
Audience:	(1) IBM product trained CE. (2) IBM product support trained CE and Product Engineering.	

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Manual		Order Number
Title:	3745 External Cable Reference	SY33-2075
Purpose:	Describes interface cables and wrap plugs used for conrecting the 3745 to the console(s) and lines.	
Audience:	(1) IBM product support trained CE. (2) IBM Product Engineering.	

Note: Manufacturing documents, cannot be ordered from the IBM distribution centers.

Volume 4

(Without binder)

Manual		Order Number
Title:	3745 Diagnostic Descriptions	SY33-2059
Purpose:	Describes the diagnostic programs and the purpose of each routine.	
Audience:	(1) IBM product support trained CE. (2) IBM Product Engreering.	

Volumes 5-1 and 5-2

(Without binder)

Manual		Order Number
Title:	3745 Maintenance Information Reference (MIR)	SY33-2056
Purpose:	Provides reference information to locate failures in the 3745 in complement to the Maintenance Information Procedures.	
Audience:	(1) IBM product support trained CE. (2) IBM Product Engineering.	

Other Service Information

Manuai		Order Number
Title:	3745 Channel Adapter On-Line Tests	D99-3745A (See
Purpose:	Describes the 3745 channel adapter OLTs and how to run them.	Note 1)
Audience:	(1) IBM product trained CE. (2) IBM product support trained CE.	

Notes:

1. Shipped from Poughkeepsie with the S/370 channel adapter OLT tape. Cannot be ordered from the IBM distribution centers.

Related Signal Converter Products Information

The following publications relate to IBM signal converter products and are currently available:

- 7861 Description and Planning Guide, GA33-0122.
- 7861 Setup, User's Guide, and Problem Analysis, SA33-0123.
- 7861 Maintenance Information and Parts Catalog, SY33-2062.
- 7868 Guide to Operation, GA33-0134.
- 5822-10 Guide to Operation, GA33-0118.
- 5822-18 Guide to Operation, GA33-0136.
- 5858 Guide to Operation, GH11-3027.
- 5858 Maintenance Information and Parts Catalog, SY12-8246.
- Link Problem Determination Aid, SY33-2064.
- Power Supply and Telecommunication Connections, GA33-0054.

Related NCP Service Information

NCP and EP Reference Summary and Data Areas (LY30-3*96 for V4R3.1 only)

NCP and EP Reference Summary and Data Areas (LY30-5503 for V5 only)

These manuals are for system programmers and IBM program service representatives. They provide quick access to often-used diagnostic and debugging information about NCP and EP in PEP environment.

NCP, SSP, and EP Diagnosis Guide (LY30-5591)

This manual is designed to help customers and IBM program service representative isolate and define problem in NCP Version 3, NCP Version 4, NCP V4 Subset. NCP Version 5, and EP in the PEP environment using SSP Version 3. The primary purpose of the manual is to help the user interact with the IBM Support Center to resolve a problem. Procedures in these manuals describe how to:

- · Determine whether the problem is in NCP
- Use relevant information to describe the problem
- · Gather appropriate documentation about the problem
- · Report the problem to the IBM Support Center

In addition, it includes detailed descriptions of how to use the programming tools available with NCP and SSP.

NCP and EP Reference (LY30-5569 for V4R3.1 only)

NCP and EP Reference (LY30-5605 for V5 only)

These manuals contain reference material describing the internal organization and function of the NCP and the EP in PEP environment. These manuals provide information for customization and diagnosis.



Chapter 4. How to Run the 3745 Diagnostics

Table of Contents for Chapter 4

	4-2
	4-2
J J J J J J J J J J J J J J J J J J J	4-2
	4-2
	4-3
	4-4
Power Subsystem Tests	4-6
	4-7
	4-7
CCU Diagnostics	
	4-9
\mathbf{J}	1-10
	1-12
	1-14
	I-15
	-16
	1-17
	-18
	1-19
	-20
	-21
	-22
	-22
	-24
	-24
	-26
	-28
	-29
	-33
	-35
	-37
	-42
	-43
Diagnostic Result Analysis	-43

Diagnostic Description

3745 Diagnostics

A full and detailed description of diagnostics is given in "3745 Service Functions" and "Diagnostic Description".

Two groups of diagnostics run on the 3745:

1. Automatic:

IML/IPL checkout diagnostics including MOSS diagnostics.

- 2. Controlled:
 - a. Power subsystem tests
 - b. Functional area diagnostics
 - Internal Function Tests (IFTs)
 - Wrap tests
 - OLTs.

Diagnostics are run during the installation procedure and when a fault is detected to isolate a field-replaceable unit that caused the failure. They are also executed after a repair is performed, to check that the hardware area is working correctly. They have to be run before and after an EC or MES has been installed in the area concerned.

Diagnostics may be run in offline mode when the 3745 is fully available or in concurrent mode. In

concurrent mode, the diagnostic must be selected in the specific area and will run only in configured units. These units must be available at that time.

Errors During Diagnostics

When the MOSS diagnostic program detects a failure, a three-digit code is displayed on the control panel.

When the internal function tests detect an error, a reference code is posted on the 3745 console.

Diagnostics Monitoring

The functional diagnostics are monitored by the Diagnostic Control Monitor (DCM) and the Command Processor (CP).

The diagnostic control monitor is loaded when the diagnostic utility program is selected from the 3745 function menu.

It automatically restricts diagnostic testing to the elements defined in the Configuration Data File (CDF), powered ON and disconnected from the NCP.

Checkout Diagnostics

The checkout diagnostics are designed to test the hardware of the CCU, switch, IOC, channel adapter, CSP part of the line adapter, TIC and the PLC card.

For the CA, LA, and TRA, they are part of the microcode and located in the ROS of the adapter itself. They run automatically every time the power is applied to the respective adapter, that is, at power ON time before IML, or when respective power is started, (power ON reset line).

The PLC checkouts only run when power is applied to the power subsystem and are successful when the power control and service mode indicators are displayed. For the CCU, switch and IOC, the diagnostics are located on the disk and run during IPL.

For the CA, TSS, and HPTSS they are also automatically run when the internal function tests are started.

For the TIC, the Token-Ring wrap test is automatically run at each TIC Open command from the NCP. This TIC Internal Lobe Media tests the ring up to the local wiring concentrator (IBM 8228), or up to the point where it is unplugged before the 8228.

If an error is detected, the MOSS analyzes the problem and presents a control panel code or a reference code.

MOSS Diagnostics

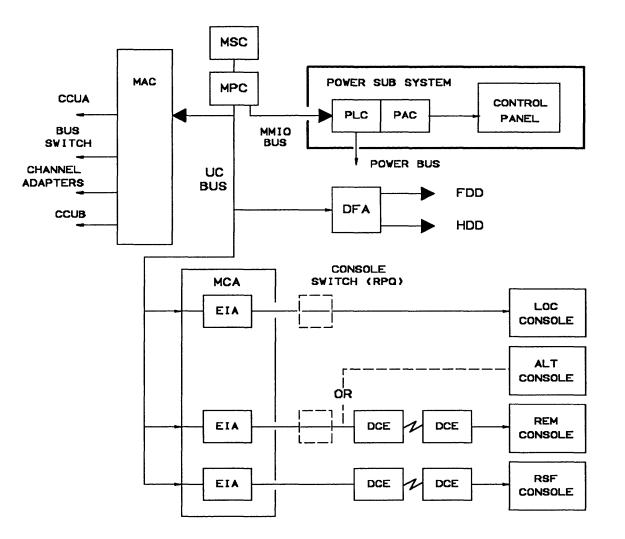


Figure 4-1. MOSS Overview

The MOSS diagnostics can be run in concurrent mode.

1. Basic MOSS tests

They are designed to test the following units:

- MPC (Moss Processor Card)
- MSC (Moss Storage Card)
- MAC/MAC2 (Moss Adapter Card)
- MCA (Moss Console Adapter Card)
- DFA (Disk File Adapter Card)
- HDD (Hard Disk Drive)
- FDD (Flexible Disk Drive).

The basic MOSS tests are run whenever the following functions occur:

- Power ON reset
- Moss IML
- General IPL.

Partial MOSS diagnostics also run for re-IML and for certain other MOSS functions. For example: MOSS dump.

IF A CRITICAL FAILURE IS DETECTED DURING ANY OF THE MOSS DIAGNOSTICS, A CODE WILL BE DISPLAYED ON THE CONTROL PANEL.

Refer to "How to Run MOSS Diagnostics" on page 4-19 for execution.

2. Loop on MOSS diagnostics

Refer to "How to Loop MOSS Diagnostics" on page 4-20 for execution.

Basic tests will loop until an error is detected or an exit from this option is performed.

3. Local/Remote/RSF console link tests

Refer to "How to Run the Console Link Test" on page 4-22 for execution.

They are individually selected tests which will test the hardware connecting the respective consoles.

Power Subsystem Tests

1. Control panel test

This test is designed to ensure that all the keys and displays are working correctly. The control panel bus and the PLC (Power Logic Card) are also partially tested.

This diagnostic can be run in concurrent mode; refer to "How to Run the Panel Test" on page 4-21 for execution.

2. Power control bus test

The power control bus test function allows the CE to check the interface between the PLC card and the different power supplies of the 3745.

This function is dedicated to CE use only.

When the power control subsystem loses the control of a power supply due to an interface problem, a BER is logged by the MOSS. Based on this information, the CE may have to check the power control bus.

This diagnostic can be run in concurrent mode; refer to "How to Run the Power Control Bus Test" on page 4-24 for execution.

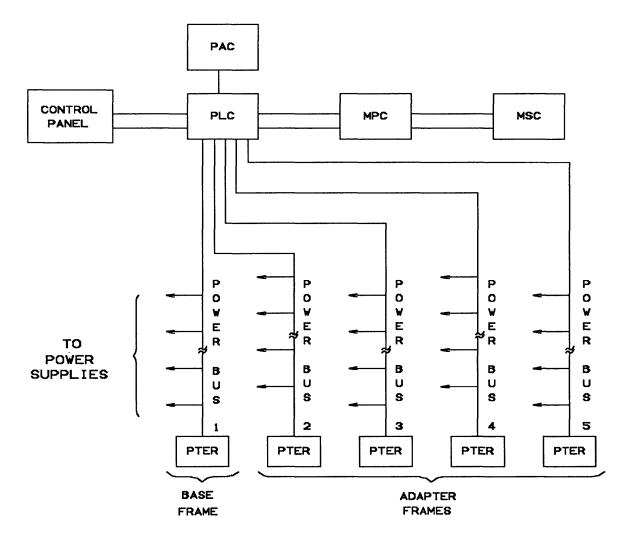


Figure 4-2. Power Control Bus Layout



Functional Area Diagnostics

- 1. CCU (Central Control Unit)
- 2. IOC BUS (Input/Output Control)
- 3. CA (Channel Adapter)
- 4. TSS (Transmission Subsystem)
- 5. TRSS (Token-Ring Subsystem)
- 6. HPTSS (High-Performance Transmission Subsystem).

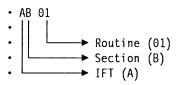
These tests are stored on the hard disk and are run to detect failures caused by the hardware in the 3745, and to isolate the FRU that caused the failure. They are also used to verify that the machine is working correctly after a repair has been made.

The diagnostics are arranged in groups, internal function tests (IFTs), sections and routines.

- Group: Set of IFTs that test a 3745 subsystem (the CA group for example).
- IFT: Internal function test often divided into Sections that can be loaded and executed one at a time.
- Section: Set of routines that test a particular adapter, or a component of a subsystem.
- **Routine:** The shortest executable test.

Diagnostic Identification

The identification contains the IFT number, the section number, and the routine number as follows:



Selecting these diagnostics is accomplished by using the 3745 console.

If a failure is detected by the diagnostics, a reference code is posted at the 3745 console, and the corresponding FRUs can be displayed by the Reference Code Interpretation function. See "Using Reference Codes" on page 2-12.

Refer to "How to Run Internal Function Tests" on page 4-29 for execution.

CCU Diagnostics

The CCU and the switch hardware are tested by automatic checkout during IPL. The IFTs for CCU and Switch mainly check if the different internal functions are working properly.

For components tested, see Figure 4-3.

CCU diagnostics include following IFTs:

- **IFT A** -CCU Operations
- IFT B -CACHE
- IFT D -SCTL/CCU link
- IFT E -SCTL/STORAGE/CACHE link

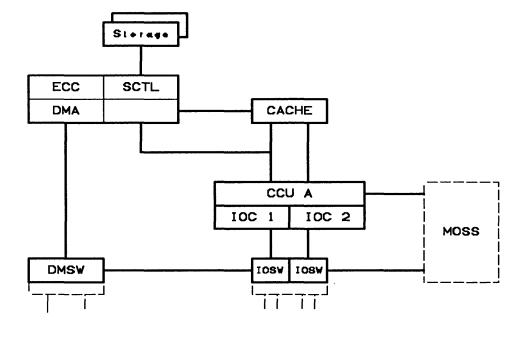
IFT F -SCTL/DMA link

- IFT G -SWITCH diagnostics (IOC driver/receiver are not tested by that diagnostic but by the IOC diagnostics).
- IFT H -Functional processor diagnostic

These diagnostics can be run in concurrent mode on one CCU for a model 410 or 610.

AT05 is a manual intervention routine and cannot be run in concurrent mode.

Running time for the whole group is a minimum of 40 minutes per CCU.



—— Parts tested

--- Parts tested by other diagnostics

Figure 4-3. CCU Diagnostic Coverage

IOC Diagnostics

The IOC hardware is tested by automatic checkout during IPL. The IFTs for IOC mainly check if the different internal functions are working properly.

Only the adapter bus drivers/receivers are tested in the IOSW/IOSW2 card.

For components tested, see Figure 4-4.

IOC diagnostics include the following IFTs:

- **IFT I** Primary pass for transmission and channel adapters.
- **IFT J** Secondary pass for transmission and channel adapters.
- **IFT K** Transmission adapter attachment to adapter buses.

IFTs I and J have a special isolation process routine to isolate the failing

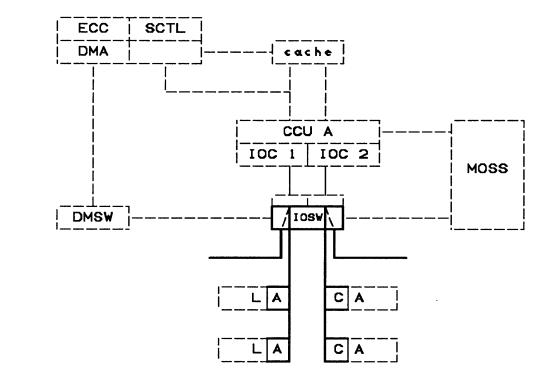
adapter on one adapter bus in case of bus pollution.

This process consists of powering off one adapter by microcode and asking the CE by means of a message to replace or reinstall the CSP, CAL or TRM card of this adapter. Then the diagnostics restart and this process is repeated for each adapter present on this bus. Refer to "Messages for Manual Intervention During IOC Bus Diagnostics" on page 4-33 for message interpretation.

Each power OFF will generate an alarm 9F, ignore these alarms during this test.

These diagnostics can be run in concurrent mode on one CCU for a model 410 or 610.

Running time for the whole group depends on the configuration.



----- Parts tested

---- Parts tested by other diagnostics

Figure 4-4. IOC Diagnostic Coverage

CA Diagnostics

As the channel adapter hardware is tested during IML checkout by the diagnostics contained in the CA ROS itself, CA diagnostics are mainly designed to check if the different functions with MOSS, CCU, memory, host sequences are working properly.

Autoselect and cycle steal chains, internal wrap and external wrap are also tested.

The channel adapter diagnostics are all included in IFT L.

The following routines are not linked and need a manual intervention:

LG02, LI03, LI04, LJ03, LK02 (channel cables must be removed and terminators installed in the 'OUT' connectors).

LO01 (wrap plugs and terminators installed).

Note: Routine LA must be run before starting the manual routines.

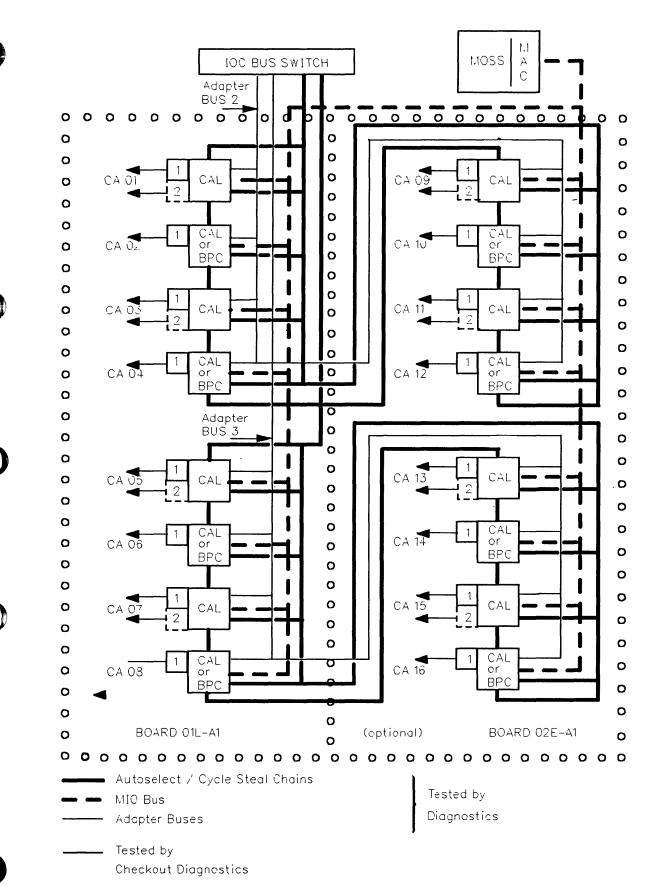
Due to possible interferences with other 3745 components, some routines are not run in concurrent mode but automatically selected and run in offline mode.

Running time for the whole group is about 1 minute per CA.

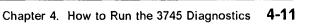
CA Wrap Test

This test is part of the CA diagnostics. It is a specific manual intervention routine (LO01) which is run on the CA from the 3745 console, with two wrap plugs installed at the tail gate to check if input or output lines of the CA are working properly.

For the running procedure refer to "How to Run the Channel Wrap Test" on page 4-42.







Diagnostics

TSS Diagnostics

Two sets of diagnostics are used to test the TSS in the 3745:

- · Tests residing in the ROS of the CSP card
- IFTs residing on the disk and run from the MOSS console.

Refer to Figure 4-6 on page 4-13 for the coverage of TSS diagnostics.

CSP ROS diagnostics are run every time the scanner is IMLed. They test the CSP hardware. If an error is detected, a RAC code is sent to MOSS which will build the appropriate reference code. After a successful run, an OK is posted to MOSS.

IFTs are run from the 3745 console. They are used to test the remaining part of the TSS after ROS diagnostics are run.

In concurrent mode, CSP checkout is included in TSS diagnostics.

The following table shows the relation between IFTs and the areas tested.

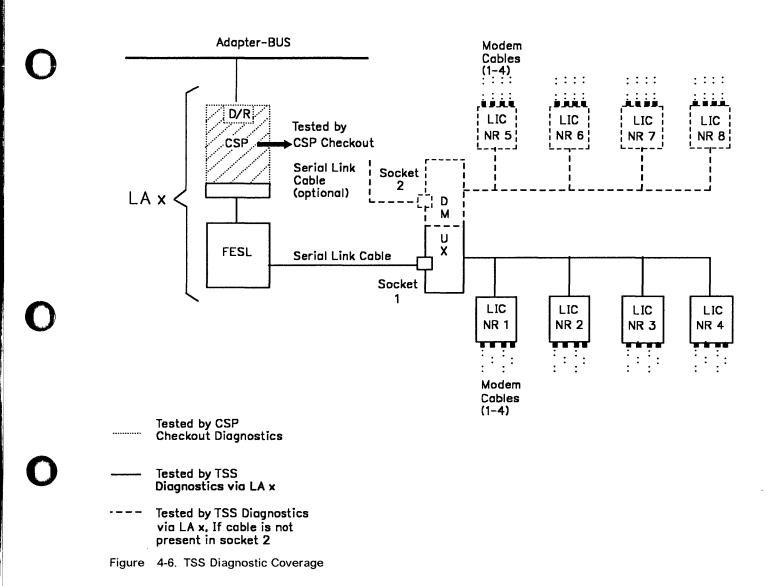
IFT/RTN	AREA TESTED			
PA to PE	FESL/CSP card level			
	FESL interconnections			
QA	DMUX card level			
RA	LIC1-4/ICF card level			
RB to RC	LIC1-4/ICF line level			
RD	LIC1-4/ICF Japan NTT			
RG	LIC5-6 card level			
RH	LIC5-6 line level			

RC01, RD01 to RD03 and RH59 are manual intervention routines.

IFTs can be run concurrently with the customer's operations. Only one scanner needs to be disabled from NCP/VTAM.

Running time can be up to 15 minutes per adapter, depending of the number of lines connected to that adapter.

Diagnostics



TRSS diagnostics

IFTs are used to test the TRSS. They are loaded and run using the 3745 console only.

Refer to Figure 4-7 for the coverage of TRSS diagnostics.

The following table shows the relation between IFTs and the areas tested.

IFT/RTN AREA TESTED

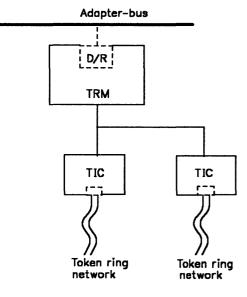
TA to TE TRM card level



IFTs can be run concurrently with the customer's operations. Only one TRA needs to be disabled from NCP/VTAM.

Running time can be up to 5 minutes per adapter.

Note: The TRA must be disconnected prior to run the diagnostics each time the power supply is turned ON.



——— Tested by TRSS diagnostics

Figure 4-7. TRSS Diagnostic Coverage

HPTSS Diagnostics

Two sets of diagnostics are used to test the HPTSS in the 3745:

- · Tests residing in the ROS of the CSP card
- IFTs residing on the disk and run from the 3745 console.

The CSP ROS diagnostics are run every time a scanner is IMLed. They test the CSP hardware. If an error is detected, a RAC code is sent to MOSS which will build the appropriate reference code. After a successful run, an OK is posted to MOSS.

IFTs are run from the 3745 console. They are used to test the FESH card, DMA bus connection from switch to HPTSS, and the line interface from the FESH card up to the tail gate. However, in concurrent mode, the DMA bus is not tested until specifically selected. This is to avoid overloading other adapters residing on the same DMA bus.

Refer to Figure 4-8 for the coverage of HPTSS diagnostics.

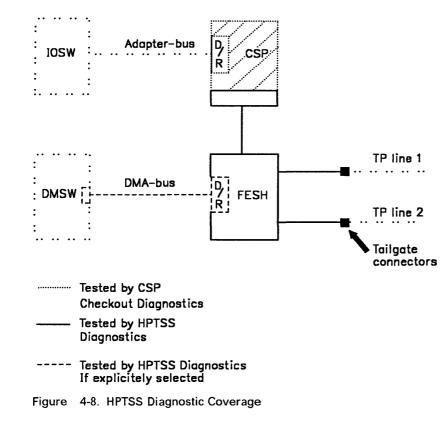
The following table shows the relation between IFTs and the areas tested.

IFT/RTN	AREA TESTED
VA	FESH card level and FESH to CSP interconnection.
VB to VD	FESH card state machines.
VE	FESH to CSP cycle steal function.
VF	FESH card SDLC functions.
VG to VH	Complete DMA operation on FESH, DMSW, and SCTL/SCTL2 cards.
VI to VK	FESH to TP lines interface. WRAP PLUG needed.

In concurrent mode, routines VG and VH are run only if explicitly selected.

IFTs can be run concurrently with the customer's operations. Only one scanner needs to be disabled from NCP/VTAM.

Running time can be up to 10 minutes per scanner.



CA Online Test (OLT)

This test causes the OLT responder stored on the disk, to be loaded into the 3745.

It requires that the OLTs be loaded at the host. It is used to respond to requests from the host via the channel interface.

If a failure is detected while running the OLTs, a system message is displayed at the system operator's display.

This test is run only in offline mode.

Information for running the OLTs is covered by the "3745 Channel Adapter Online Tests" D99-3745A.

Note: OLTs are not invoked by any of the MIP's procedures.

Network Power OFF Test

The CCU IFT routine AT05 is a manual routine which tests the correct execution of the network power OFF command.

If the 3745 has only one CCU, running the AT05 routine on this CCU will power OFF the 3745. If

the machine has two CCUs, the AT05 routine must be run on both CCUs to cause the power OFF condition.

The 3745 must be fully available before running this routine.

LIC Wrap Test

Two different wrap tests are available for the customer and the CE.

- The Wrap Test function (WTT) is a problem determination aid available for the customer. It needs the control program (NCP) running and ports on a LIC being 'Sysgenned'. It also needs lines on a LIC being deactivated by the network operator.
 - a. The automatic wrap test (option 1) runs at LIC level only and does not need a wrap plug.

This wrap test, without any manual intervention on the machine aims to confirm if the tested LIC is failing, or checks if the new installed LIC is good.

The only input is the number of a line on the LIC.

The result is of the type GO - NOGO with three possibilities:

- Wrap test completed: Link is OK.
- · Wrap test completed: Link is failing.
- Unable to perform wrap test on this LIC for, please retry. (The reason is given).

Run time is about 30 seconds.

b. The Wrap Test At Any Level (option 2) is intended for the customer's use. For more explanations, refer to the "Advanced Operation Guide, Chapter 24".

Reference for running is given in "How to Run the Wrap Test (WTT) for LIC 1, 3, 4, 5, 6 or HPTSS Port" on page 4-35.

2. The IFT wrap test is run when:

The RC section (or all TSS or HPTSS IFTs) is called on the selected LA and line when there is a wrap plug or wrap cable installed on the HPTSS port or LIC 1, 3, 4.

The RH59 routine (or all TSS IFTs) is called on the selected LA and line with a wrap plug installed on LIC 5, 6.

The RD01 through RD03 routines are reserved for the Nippon Telegraph Telephone (NTT) administration. They check the data wrap. They also check the modem control leads depending on the LIC type (modem-in-wrap).

Reference for running is given in "How to Run the Wrap Test with IFTs for LIC 1, 3, 4, 5, 6 or HPTSS Port" on page 4-37.

How to Run MOSS Diagnostics

These tests can be run without stopping the customer's application.

Error conditions will result in a control panel code being displayed. Actions for these codes are defined in "Panel Codes" on page 2-14.

or,

Some errors will result in a reference code at IML completion. These types can also be recognized by the panel code displaying '**FOD**'. Refer to "Using Reference Codes" on page 2-12 for action.

Ensure that MOSS is offline or alone.

From the 3745 console

- 1. Perform a MOSS IML action from the console by entering 'IML' in menu 1.
- 2. After approximately 2 minutes the console will be re-initialized with the 'Channel Enable/Disable' screen which indicates that a successful run of MOSS diagnostics and the MOSS IML have been completed.

3. If the console has not been re-initialized, then an error was detected.

From the control panel

- 1. Set the function to MOSS IML:
 - a. Press the 'Service' key until '**0**' or '**1**' is displayed in the service window. (No bypass of MOSS diagnostics.)
 - b. Press the 'Validate' key.
 - c. Press the 'Function' key until '1' is displayed in the function window.
 - d. Press the 'Validate' key.
- If after approximately 2 minutes the control panel displays code 'FOF', then MOSS diagnostics and a MOSS IML have been successfully completed. The code 'FOE' can be displayed if the MOSS was previously 'alone', that is, not in 'offline mode'.
- 3. If any other code is displayed, then an error was detected.

How to Loop MOSS Diagnostics

If an intermittent Moss problem is suspected, the 'loop MOSS diagnostics' facility can be used as follows:

Ensure that MOSS is offline or alone.

- 1. Set service mode to MAINT1:
 - a. Press the 'Service' key until '1' is displayed in the service window.
 - b. Press the 'Validate' key.
- 2. Set function to loop on MOSS diagnostics:
 - a. Press the 'Function' key until 'A' is displayed in the function window.
 - b. Press the 'Validate' key.
- 3. The MOSS diagnostics will run continuously unless an error is detected. Usually 5 to 10 minutes of error free operation are sufficient to determine whether the MOSS is working satisfactorily. If an error is detected, a panel code will be permanently displayed. Therefore, go to "Panel Codes" on page 2-14. Gentle vibration of the MOSS

cables and cards while the test is running, will locate most loose connection problems.

If no error is detected:

- 4. Set service mode to NORMAL:
 - a. Press the 'Service' key until '**0**' is displayed in the function window.
 - b. Press the 'Validate' key.
- 5. Set function to MOSS IML:
 - a. Press the 'Function' key until '1' is displayed in the function window.
 - b. Press the 'Validate' key.
- When the control panel displays 'FOF' (or 'FOE' if the MOSS was previously 'alone'), perform a MOSS online. Refer to "How to Put MOSS Online" on page 5-175

How to Run the Panel Test

This test can be run without stopping the customer's application.

It is not a sequential test and can be cancelled at any time, by pressing the 'Exit' key.

Notes:

- 1. Any inactivity lasting about 60 seconds during the panel test, will result in the test being automatically cancelled and the panel will return to operational mode.
- 2. During this test the control panel's audible alarm will sound for each action.

'special character': Can be described as when every possible segment of the window is lit.



- 1. Set power to local:
 - a. Press the 'Power Control' key until '3' is displayed in the power control window.
 - b. Press the 'Validate' key.

If the above action cannot be performed, go to step 11.

- 2. Set Service mode to MAINT1:
 - a. Press the 'Service' key until the number '1' is displayed in th service window.
 - b. Press the 'Validate' key.

If the above action cannot be performed go to step 11.

- 3. Set 'Function' to panel test:
 - a. Press the 'Function' key until '5' is displayed in the function window.
 - b. Press the 'Validate' key.

If the above action cannot be performed go to step 11.

Observe the display: All 10 'special character' will be displayed.

If the pattern is not identical for each of the 10 special characters go to step 11.

Note: If during the following steps the function window displays '5', the control panel has detected its own failure. Go to step 11.

4. Press the 'Function' key.

Observe the display: The 'Function' window 'special character' will be displayed. Repetitive action will scroll through the 'Code' window sequentially, and wrap around.

If this does not occur, go to step 12.

5. Press the 'Service' key.

Observe the display: The 'Service' window 'special character' will be displayed. Repetitive action will scroll through the 'Power Control' window, and wrap around.

If this does not occur, go to step 12.

6. Press the 'Power Control' key.

Observe the display: The 'Console in Use' window 'special character' will be displayed. Repetitive action will scroll through the 'All CA Disabled' 'MOSS Inop' and the 'MOSS Msg' windows sequentially, and wrap around.

If this does not occur, go to step 12.

7. Press the 'Power ON Reset' key.

Observe the display: '8' will be displayed in the 'Function' window.

If this does not occur, go to step 12.

8. Press the 'Power OFF' key.

Observe the display: The display will be completely blank.

If this does not occur, go to step 12.

9. Press the 'Exit' key.

Observe the display: The display will present the 'Power Control' and 'Service Mode' indicating that the test is complete, and the panel has returned to operational mode.

If this does not occur, go to step 12.

- 10. The control panel test has completed with no error detected, discard steps 11 and 12
- 11. Record that FRU group 4077 on page 2-31 is involved.
- 12. Record that FRU group 1116 on page 2-30 is involved.

How to Run the Console Link Test

This function tests the customer's console ports with wrap plugs which may be installed at the end of the cable attached to either the local console, the remote console modem, or the RSF link modem. The wrap plugs can also be installed at the connectors for these cables in the 3745. (Not possible with the 3727 console cable)

This test can be run without stopping the customer's application.

Local/Remote or Alternate/RSF Link Tests

- 1. Ensure that the customer is not using any of the 3745 consoles and also confirm the availability of MOSS.
- 2. Set the power control to local:
 - a. Press the 'Power Control' key until '3' is displayed in the power control window.
 - b. Press the 'Validate' key.
- 3. Set Service mode to MAINT1:
 - a. Press the 'Service' key until the number '1' is displayed in the service window.
 - b. Press the 'Validate' key.

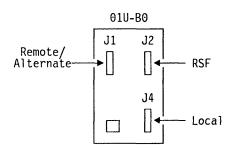


Figure 4-9. Console Outputs

- 4. We advise you to start the "wrap plugging" from the far end of the DCE interface cable. Refer to Figure 4-10 on page 4-23 for the different cable configurations.
- 5. Remove the DCE interface cable from the console or modem or console switch. (The DCE interface cable may be connected directly to the DCE, or to an intermediate "adapter". In this second case remove the the DCE interface cable from the "adapter"). Connect the appropriate wrap plug at the end of the cable.

Wrap plug to be used according to the DCE interface cable and to the console:

a. DCE interface cable between the 3745 and the console/modem without intermediate "adapter" - (A in Figure 4-10)

- Use wrap plug P/N 6398697.

b. DCE interface cable between the 3745 and the console/modem with an intermediate "adapter". - (B in Figure 4-10)

- Use the wrap plug P/N 2667737.

c. DCE interface cable between the 3745 and the console switch (7427) - (C in Figure 4-10)

- Use the wrap plug P/N 2667737.

d. DCE interface cable between the console swith (7427) and the console/modem (D in Figure 4-10)

- Use the wrap plug P/N 6398697 for a console 31XX or the wrap plug P/N 2667737 for a console 3727.

Important: The cable going to the alternate console must be tested on the 'Local' output with the test option '8'.

OR

Open the rear cover of the 3745 base frame, remove the appropriate cable (if installed) from the output and connect the wrap plug P/N 6398697. See Figure 4-9.

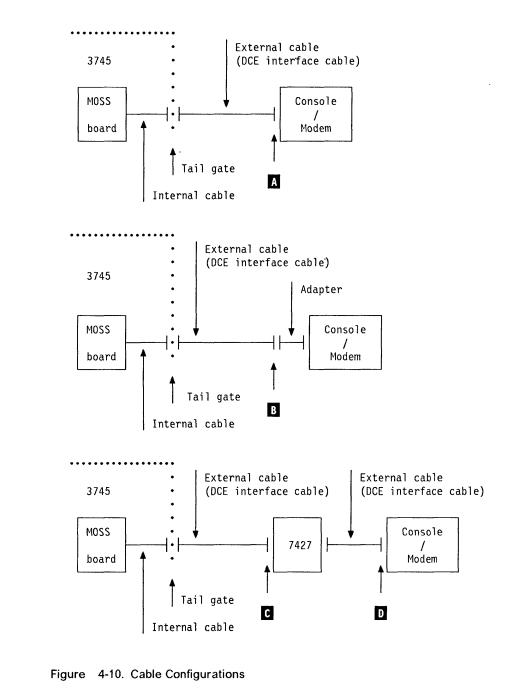
- 6. Set function to the link test required: either remote/alternate, RSF or local:
 - a. Press the 'Function' key until '6','7' or '8' is displayed in the function window.
 - 6 (remote/alternate)
 - 7 (RSF)
 - 8 (Local).
 - b. Press the 'Validate' key.
- 7. After a partial MOSS IML the following panel codes will be displayed:
 - a. LOCAL.1B1: Start of test1B2: Successful completion of test
 - b. REMOTE/ALTERNATE 1B3: Start of test 1B4: Successful completion of test
 - c. RSF 1B5: Start of test

1B6: Successful completion of test

If any other panel code is displayed, disconnect the wrap plug, go to "Panel Codes" on page 2-14 and follow the instructions.

- 8. Disconnect the wrap plug and reconnect the cable.
- 9. Set service mode to NORMAL:
 - a. Press the 'Service' key until '0' is displayed in the function window.
 - b. Press the 'Validate' key.

- 10. Set function to MOSS IML:
 - a. Press the 'Function' key until '1' is displayed in the function window.
 - b. Press the 'Validate' key.
- When the control panel displays 'F0F' or 'F0E' if the MOS was previously 'alone'), perform a MOSS online. Refer to "How to Put MOSS Online" on page 5-175.
- 12. The console link test has completed with no error detected.



How to Run the Power Control Bus Test

The Power Control Bus (PCB) test can be run, with the machine being either power OFF or power ON and online.

- Power supplies statuses will not be impacted.
- Power supplies are not polled during the test.
- No cooling detection available.
- Scoping is possible on the wrap card.
- Test result has a code displayed on the control panel.
- Step-by-step action will allow the CE to isolate the faulty FRU.

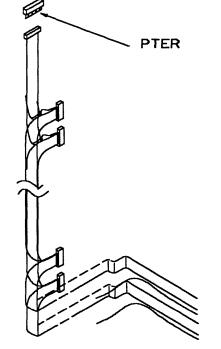
Power Control Bus Test Procedures

Use the Power Control Wrap Card P/N 65X9848 to run this test.

The power bus test function is available from the control panel.

Start:

- 1. Set the power control to local.
 - a. Press the 'Power Control' key until '3' is displayed in the power control window.
 - b. Press the 'Validate' key.
- 2. Set service mode to 'MAINT1'.
 - a. Select service '1'.
 - b. Press the 'Validate' key.
- 3. Select the power bus test.
 - a. Press the 'Function' key until 'C' is displayed in the function window.
 - b. Press the 'Validate' key.
- 4. For the power terminator's (PTER) location see Figure 5-2 on page 5-6 to Figure 5-7 on page 5-12.
- 5. Disconnect the power bus cable from the terminator on the bus to be tested. See Figure 4-11.



- Figure 4-11. Power Terminator (Frame 01 Represented).
- 6. Fit the wrap card side A to this bus. See Figure 4-12 on page 4-26.
- 7. Press the 'Function' key until the required character 'D' through 'H' (according to the following table) is displayed in the 'Function' window.

Function Bus Number

D	Bus 1	Frame 01
E	Bus 2	Frame 02
F	Bus 3	Frame 03

- G Bus 4 Frame 04/05/06 Front
- H Bus 5 Frame 04/05/06 Rear
- 8. Press the 'Validate' key.
- 9. On the control panel select service 'A'.
- 10. Press the 'Validate' key.

Now the predetermined patterns are sent on the power control bus.

The test will loop on these patterns as long as the function or service keys are not pressed, or an error detected.

11. IF code **005** displayed on the control panel, go to "Power MAP 3920: Power Bus Test Failure" on page 3-31.

- 12. Code 004 displayed on the control panel indicates a successful cycling of the test.
- 13. Select service '1'.
- 14. Press the 'Validate' key.
- 15. Reverse the wrap card to side B.
- 16. Select service 'B'.
- 17. Press the 'Validate' key.
- 18. Code 004 displayed on the control panel indicates a successful cycling of the test.

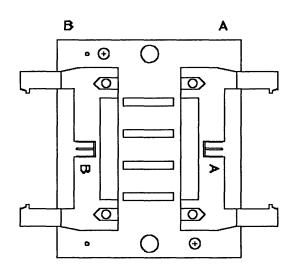
- 19. Any other code displayed on the control panel, go to "Power MAP 3920: Power Bus Test Failure" on page 3-31.
- 20. Remove the power control wrap card and reinstall the removed cable on the terminator.

Note: Code **005** displayed at this time is a normal consequence of the test without a wrap card installed.

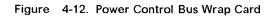
21. Press the 'Exit' key to finish the test.

PCB Wrap Card Description

The wrap card consists of 2 independent wrap circuits (A or B) on the same tool, each circuit having its own connector.



FRONT VIEW



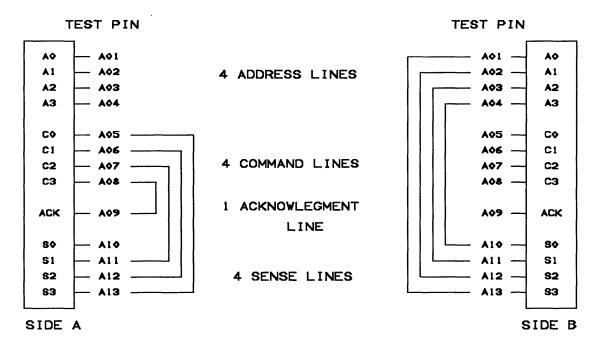
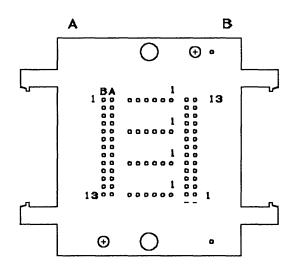


Figure 4-13. Wrap Circuit of the Wrap Card

There are 8 output wires for only 5 input wires. The test will be performed in two runs.



REAR VIEW

ģ

Diagnostics

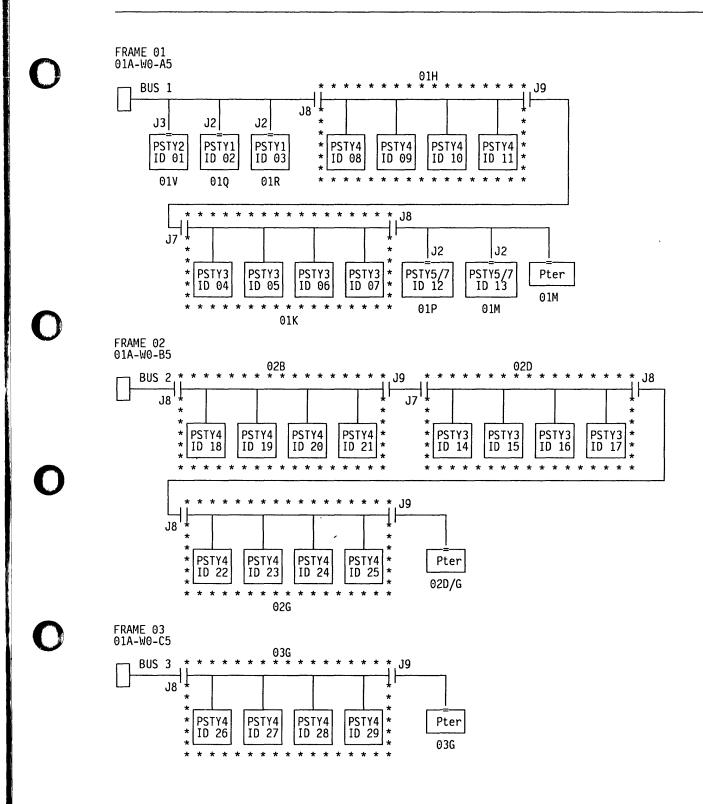


Figure 4-14 (Part 1 of 2). Power Control Bus Layout

Diagnostics

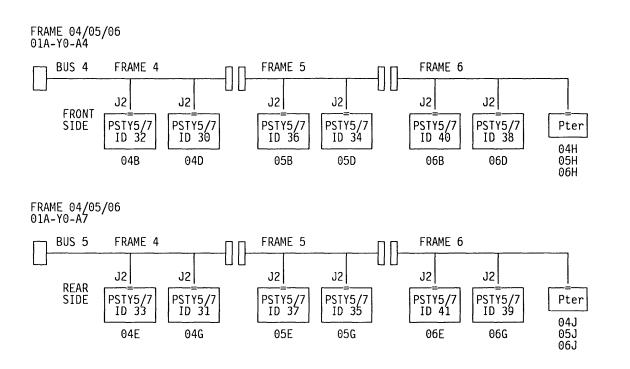


Figure 4-14 (Part 2 of 2). Power Control Bus Layout

Types of Failure Detected

The power bus is made of 13 signal wires, each separated from the other by a ground wire.

- · Short circuit on a signal wire.
- · Open circuit on a signal wire.
- Driver or receiver forcing a low or high level.
- Board (CA, scanner, MOSS) problems.
- Power supply problems.
- PLC-card problems.

The test sends alternating patterns on the bus and verifies if it receives alternating patterns.

How to Run Internal Function Tests

How to Call Diagnostics

On the 3745 console, from menu 1 hit F5 to get the maintenance function menu (Menu 3). See Figure 4-15.

CUSTOMER ID: CCU-A SELECTED PROCESS MOSS-OFFLINE	3745-xxx SERIAL NUMBER: X71:020415 X72:000085
CCU-B RUN-REQ	01/12/87 04:29
4	IENU 3
MISUSE OF MAINTENANCE FUNCTION	IS MAY LEAD TO UNPREDICTABLE RESULTS
CADS SERVICES: CAS MOSS STOR	SPLAY: MDD TSS SERVICES: TSS E DSPLY.: HSD DIAGS: ODG VICES: TRS
===>	F TO LOG OFF
F1:END F2:MENU2 F3:ALARM F4:	MENU1 F6:RULES

Figure 4-15. Maintenance Functions Menu

On this menu two options are available to run diagnostics:

• CDG to run diagnostics in concurrent maintenance mode. Selected diagnostics will run if the adapter is disconnected from the NCP, and only the sections or routines allowed to run in concurrent mode will be called without interfering with the operation of the 3745.

CDG must be used if at least one CCU $\,+\,$ NCP are running.

Note: If you are in TWIN-DUAL mode with one CCU running and the other CCU just powered ON (not IPLed), you can not run the diagnostics on any adapter or IOC connected to the idle CCU. In this case, you must IPL this CCU to the end of phase 1 (step-by-step IPL will allow a ready stop at the end of

will allow a ready stop at the end of phase 1) then start the concurrent diagnostics. • **ODG** to run diagnostics in **offline mode** when the 3745 is fully available for maintenance.

Selected diagnostics will run whatever the status of the adapter.

All channel interfaces must be disabled.

ODG must be used if conditions for concurrent maintenance mode are not met (no NCP or CCU running).

Type ODG or CDG after = = = > and press SEND.

Diagnostics

How to Select Diagnostics

CUSTOMER ID: CCU-A SELECTED PR	OCESS MOSS-OFFLINE	3745-xxx X71:020415 X72:000085	SERIAL NUHBER:
CCU-B RUN-REQ			02/07/07 00.21
FUNCTION ON SCREE GROUP :ADP# :LINE 1 ALL 2 CCU : A- B: 3 IOCB: 1- 4: 4 CA : 1-16: 5 TSS : 1-32: 0-3 6 TRSS: 1- 6: 1- 7 HTSS: 1- 8: 8 OLT : 1-16:	N: CONCURRENT DIAGS : : : : : : : : : : : : :		OSTICS INITIALIZATION
OPT= Y IF MODIFY	:		
OPTION REQUIRED	: ENTER REQUEST ACC : DIAG==> ADP		
F1:END F2:NENU2	F3:ALARM		

Figure 4-16. How to Select Diagnostics

After entering ODG or CDG on menu 3, the diagnostic menu is displayed. See Figure 4-16.

Four input fields are available in this menu:

• **DIAG** = => Diagnostic group (1-8), IFT, section, or the routine you want to run.

Example:

2 (full set of CCU IFTs.) K (section K of IOC diags.) AC01 (specific routine of CCU diags.)

- ADP#==> adapter number
- LINE = = > Line number for TSS, HPTSS or TRSS (00-31)

You may obtain the line number from the 'LID' function entering the line address.

OPT == > Y to display the option menu

Diagnostics will be run on the selected adapter if its power is ON.

In concurrent mode, if the 'ALL' option is entered, diagnostics will be run on all adapters, IOC buses and CCUs in CDF which are disconnected from the NCP.

Type your request in the input fields and press SEND.

If OPT = = = > Y is entered, the option menu is displayed. See Figure 4-17 on page 4-31. If not, the diagnostic is started and the diagnostic result is displayed on this frame.

If an error is detected, an error message is displayed. See Figure 4-18 on page 4-32.

Options Menu

CUSTOMER ID: CCU-A SELECTED PRO	DCESS MOSS-OFFLINE	3745-xxx X71:020415 X72:000085	SERIAL NUMBER:	
CCU-B RUN-REQ			03/06/87	00.15
FUNCTION ON SCREEM	I: CONCURRENT DIAGS		03/00/8/	00:15
	:			
C CANCEL REQUEST	:			
G GO	•			
M NODIFY OPTIONS:				
S/LS/AL/ALS/B/DM NW/W	: : START 09:58:15			
C1/CNNN/C		DIAG	NOSTICS INITIALIZA	TION
	: OPTIONS: S NW C1			
BR/NBR	:			
	: ENTER REQUEST ACCO : ==>M R2	RDING TO THE DIA	G MENU	
===>	:ri nz			
F1:END F2:MENU2	F3:ALARM			

Figure 4-17. How to Enter an Option

When the OPT field is set to Y in the diagnostic menu, the options menu is displayed. See Figure 4-17.

The default options are automatically displayed.

OPTIONS:	Meaning	only the last one is accepted.
S	Stop on first error	Press SEND
LS	Loop on first error with stop	Restart the same procedure to enter the other
AL	Automatic loop on error	options if needed.
ALS	Automatic loop on error with new error stop	Enter 'G'.
В	Bypass error stop	Press SEND.
DM	Display multiple errors	The diagnostic is started and the diagnostic
NW	No wait before execution of each routine	result is displayed on this frame.
W	Wait before execution of each routine	If an error is detected, an error message is displayed. See Figure 4-18 on page 4-32.
C1/CNNN/C	Cycle request option	
R1/RNNN	Repeat routine option	
BR/NBR	BER recording option	

Enter or modify the option using the 'M' function followed by the option or options needed.

Only one option per line of the menu can be selected. If more than one option is entered, only the last one is accepted.

Diagnostics

Error Menu

CUSTOMER ID: CCU-A SELECTED PR	OCESS MOSS-OFFLINE	3745-xxx X71:020415 X72:000085	SERIAL NUMBER:
CCU-B RUN-REQ			02/01/02 10 12
FUNCTION ON SCREE	N: CONCURRENT DIAGS		03/01/87 10:17 FRU REMOVAL ==> POWER 0FF
	* *RH R3036694 * * *RAC 906030001 * * ERC RB23E01C *	ERR BIT C108	ERROR COUNT 00001
	: START 10:13:46 S	O TS 1 RÌ BR	ROUTINE RB23 TSS 03 L 00
F1:END F2:MENU2	F3:ALARM		

Figure 4-18. Error Menu

The reference code is in the 8-digit field following 'RH'.

This menu is used by "Diagnostic Result Analysis" on page 4-43, and "Using Reference Codes" on page 2-12 to determine which ERU is involved with the error.

Note: An "unexpected Error" must be considered as a normal error and the reference code is the usable information.

Messages for Manual Intervention During IOC Bus Diagnostics

CUSTOMER ID: CCU-A SELECTED PROCE	SS MOSS-OFFLINE	3745-xxx X71:020415 X72:000085	SERIAL	NUMBER:
CCU-B RUN-REQ				03/01/97 01.22
FUNCTION ON SCREEN:				05/01/8/ 01.22
:	REQUEST: DD	REPLACE ADPT CA	TINE DD0 :0500	NING D2 CCU A
F1:END F2:MENU2 F3	:ALARM	F6:QUIT		

Figure 4-19. Diagnostic Messages Screen

- 1. When you receive a message asking you to **replace** adapter xx:
 - a. Locate the CSP, CAL or TRM card corresponding to the adapter number in the following⁻tables.
 - b. Replace it with a new one. (Adapter's PS has automatically been turned OFF)
 - c. Reply to the message by typing 'R'.
 - d. Press SEND. The power will be turned ON and the routine automatically restarted.

- 2. When you receive a message asking you to **reinstall** adapter xx:
 - a. Reinstall the card previously replaced.
 - b. Reply to the message by typing 'R'.
 - c. Press SEND. The power will be turned ON and the routine automatically restarted.

This process will be repeated until the test stops with a '*** ERROR FOUND ***' message.

If the reference code is pointing to the last replaced card, the problem is solved. Go to "CE Leaving Procedure" on page 5-172. If not, replace the FRU(s) given by the reference code using the "FRU Machine Requirements" on page 2-34.

Note: Alarm 9F will be generated at each power OFF, ignore them during this test.

Diagnostics

Table 4-1. Channel Adapters				
CA Num	Location	CA Num	Location	
01	01L-A1-B2	09	02E-A1-B2	
02	01L-A1-E2	10	02E-A1-E2	
03	01L-A1-G2	11	02E-A1-G2	
04	01E-A1-K2	12	02E-A1-K2	
05	01L-A1-N2	13	02E-A1-N2	
06	01L-A1-R2	14	02E-A1-R2	
07	01E-A1-T2	15	02E-A1-T2	
08	01L-A1-W2	16	02E-A1-W2	

Table	Table 4-2. Line Adapters						
LA Num	Location	LA Num	Location	LA Num	Location	LA Num	Location
01	01G-A1-E2 01G-A1-A2 *	09	02A-A1-E2	17	02F-A1-E2	25	03F-A1-E2
02	01G-A1-G2 01G-A1-D2 *	10	02A-A1-G2	18	02F-A1-G2	26	03F-A1-G2
03	01G-A1-J2 01G-A1-G2 *	·11	02A-A1-J2	19	02F-A1-J2	27	03F-A1-J2
04	01G-A1-L2 01G-A1-J2 *	12	02A-A1-L2	20	02F-A1-L2	28	03F-A1-L2
05	01G-A1-N2 01G-A1-L2 *	13	02A-A1-N2	21	02F-A1-N2	29	03F-A1-N2
06	01G-A1-Q2 01G-A1-P2 *	14	02A-A1-Q2	22	02F-A1-Q2	30	03F-A1-Q2
07	01G-A1-S2	15	02A-A1-S2	23	02F-A1-S2	31	03F-A1-S2
08	01G-A1-U2	16	02A-A1-U2	24	02F-A1-U2	32	03F-A1-U2

ii

Note: * Used for the TSST board only.

How to Run the Wrap Test (WTT) for LIC 1, 3, 4, 5, 6 or HPTSS Port

WARNING: MOSS must be online to start this procedure.

- Call Menu 1, type WTT and press SEND.
- Follow the instructions given by the following screen.

CUSTOHER CCA-A RESET	ID: PROCESS MOSS-ALONE BYP-IOC-CHK STOP-CCU-CHK	3745-xxx	SERIAL	NUMBER:				
CCU-B RUN	PROCESS MOSS-ALONE BYP-IOC-CHK STOP-CCU-CHK	X72:0BC800		03/01/87 01:22				
FUNCTION ON SCREEN: WRAP TEST WRAP TEST INITIAL SELECTION								
- SELECT ONE OPTION (1,2) ==> (A)								
1 = AUTOMATIC WRAP TEST ON LIC UNIT								
2 = 1	VRAP TEST AT ANY LEVEL							
THEN PF ===>	RESS SEND							
F1:END	F2:MENU2 F3:ALARM	F6:QUIT						

(A) Enter 1 or 2 here to select the wrap test option

Option 1: Follow the instructions given by the following screen.

CUSTONER CCA-A RESET		ALONE	-xxx	SERIAL	NUMBER:			
CCU-B RUN	PROCESS MOSS- BYP-IOC-CHK STOP-C	ALONE X CU-CHK X	72:0BC800		03/01/87 01:22			
FUNCTION ON SCREEN: WRAP TEST AUTOMATIC WRAP TEST ON LIC UNIT								
- ENTER A LINE ADDRESS OF THE LIC (0-1023) ≈=> (B)								
WARNING: ALL LINES OF THE LIC HUST BE DISABLED/DEACTIVATED								
===>								
F1:END F	2:MENU2 F3:ALARM	F4:WRAP TES	T INITIAL SE	LECTION				

(B) Enter the line address here

Option 2: Follow the instructions given by the following screen and select the wrap level '4' (tailgate).

```
CUSTOMER ID:
                                      3745-xxx
                                                       SERIAL NUMBER:
              PROCESS MOSS-ALONE
CCA-A
RESET
         BYP-IOC-CHK STOP-CCU-CHK
CCU-B
              PROCESS MOSS-ALONE
                                         X71:0A0800
RUN
         BYP-IOC-CHK STOP-CCU-CHK
                                         X72:0BC800
                                               ----- 03/01/87 01:22
FUNCTION ON SCREEN: WRAP TEST
             WRAP TEST INITIAL SELECTION
- ENTER LINE ADDRESS (TSS: 0-895 HPTSS: 1024-1039) ==> (B)
- ENTER WRAP TYPE (1 to 3) ==>
    1 = DATA
                                   3 = DISPLAY LIC 5-6 DATA
    2 = CONTROL LEADS
- ENTER WRAP LEVEL (1 to 6) ==> (C)
   1 = LOCAL MODEM
                                   4 = TAILGATE
   2 = NTT CABLE (TSS ONLY)
                                   5 = REMOTE MODEM (HPTSS & DATA WRAP ONLY)
    3 = LIC (TSS & DATA WRAP ONLY) 6 = INTERNAL (HPTSS ONLY)
      LINE(S) TO BE TESTED MUST BE DISABLED/DEACTIVATED
===>
F1:END F2:MENU2 F3:ALARM
                                        F6:QUIT
```

(B) Enter the line address here

(C) Enter '4' here to select the tailgate level

• For LIC type 1, 4

Install wrap plug P/N 65X8927 on the LIC connector. See Figure 4-20 on page 4-39 and Figure 4-23 on page 4-40.

• For LIC type 3

Install wrap cable P/N 65X8928 between the 2 sockets. See Figure 4-21 on page 4-39 and Figure 4-23 on page 4-40.

Notes:

- 1. The test must be run a second time with the wrap cable reversed end to end.
- 2. If you are working on a Line Adapter with 1 line at 256 kbps speed connected to and at least 1 other line, and if these lines are initialized at the NCP activation, you are not allowed to run the WTT on these lines.
- For HPTSS

Install wrap plug P/N 58X9349 for V35 or P/N 58X9354 for X21 on the tail gate connector.

• For LICs type 5, 6

Unplug the line cable at the customer wall frame and install the appropriate wrap plug (see list hereafter) at the end of the cable or unplug the line cable from both ends and install the wrap plug P/N 11F4815 at the LIC connector. (The line cable must be unplugged from the wall frame when necessary for telephone line loading reason.) See Figure 4-22 on page 4-39 and Figure 4-24 on page 4-41.

LIC5/6 wrap plug P/N according to the Country.

U.S / Canada	66X0807
Japan	6124644
Austria	6162946
France	6162955
Germany	6162950
Belgium	6162950
Luxemburg	6162950
Israel	66X1954
Hong Kong	65X8070
Italy	6162957
Switzerland	66X0748
U.K.	65X8069
Netherlands	6162948
Netherlands	6162948

How to Run the Wrap Test with IFTs for LIC 1, 3, 4, 5, 6 or HPTSS Port

- 1. Install the wrap plug as follows:
 - For HPTSS

Install wrap plug P/N 58X9349 for V35 or P/N 58X9354 for X21 on the tail gate connector.

• For LICs type 1, 4

Install wrap plug P/N 65X8927 on the LIC connector. See Figure 4-20 on page 4-39

• For LIC type 3

Install wrap cable P/N 65X8928 between the 2 sockets. See Figure 4-21 on page 4-39 and Figure 4-23 on page 4-40.

• For LICs type 5, 6

Unplug the line cable at the customer wall frame and install the appropriate wrap plug (see list hereafter) at the end of the cable or unplug the line cable from both ends and install the wrap plug P/N 11F4815 at the tail gate connector. (The line cable must be unplugged from the wall frame when necessary for telephone line loading reason.) See Figure 4-22 on page 4-39 and Figure 4-24 on page 4-41.

LIC-5/6 wrap plug P/N according to the Country.

Country	P/N
U.S / Canada	66X0807
Japan	6124644
Austria	6162946
France	6162955
Germany	6162950
Belgium	6162950
Luxemburg	6162950
Israel	66X1954
Hong Kong	65X8070
Italy	6162957
Switzerland	66X0748
U.K.	65X8069
Netherlands	6162948

2. Start the diagnostic as follows:

For HPTSS

- Update the CDF to show that the lines to be tested have wrap plugs installed. Refer to "3745 Service Functions, Chapter 9".
- Using "How to Run Internal Function Tests" on page 4-29 call the HPTSS diagnostics, and enter '7' (HPTSS group) in the DIAG == > area, the adapter number in the ADP# == > area.
- Press SEND.
- For LICs type 1, 3, 4

Using "How to Run Internal Function Tests" on page 4-29 call the IFTs and enter the routine number **RC01** in the DIAG = = > area, the adapter number in the ADP# = > area and the line number in the LINE = = > area. (You may obtain the LA number and the line number from the 'LID' function entering the line address. Refer to "Advanced Operation Guide"). See note. Press SEND.

For LIC type 3 reverse the wrap cable end to end and rerun the test.

• For LICs type 5, 6

Ensure that no PKD action is in progress, this would lead to an unexpected diagnostic error.

Using "How to Run Internal Function Tests" on page 4-29 call the IFTs and enter routine number **RH59** in the DIAG = = > area, the adapter number in the ADP#= = > area and the line number in the LINE = = > area. (You may obtain the LA number and the line number from the 'LID' function entering the line address. Refer to "Advanced Operation Guide"). See note. Press SEND.

Note: MOSS can be alone, online or offline but the scanners must be IMLed and the CCU must be running.

In the case of MOSS alone, IPL until phase 4, then cancel the IPL in order for the LID function to work as required.

Diagnostics

Routines RD01 through RD03 for Japan only (LIC 1,3,4 only)

RD01: NTT ON/OFF Driver

This routine sets permanently ON or OFF all the active line drivers of a LIC card to allow measurements by the NTT service personnel.

When the message LINE DRIVER STATE: ON=F1, OFF=F2, EXIT=F9 is displayed, enter:

- RF1 to set drivers at high voltage level
- · RF2 to set drivers at low voltage level
- RF9 to exit from the routine

When you enter RF1 or RF2, the following message is displayed:

MODEM INCL X21 MODEM EXC X21 CHECK DRIVERS ARE ON PRESS SEND TO CONTINUE X21 OFF AUTOCALL

At this step, the NTT personnel may check the driver voltage. To change the option, press SEND.

RD02: NTT Data Wrap Test

This routine checks the data wrap path (transmit to receive).

The Test/Operate switch on the cable connector or on the DCE must be set as follows:

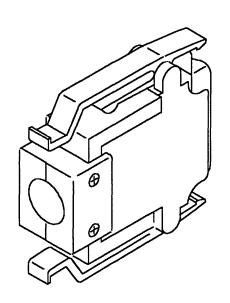
- LIC type 1: Set the connector TEST/OPERATE switch to TEST
- LIC type 3: Set the DCE Test/Operate switch to T1
- LIC type 4: Set the DCE Test/Operate switch to T1

RD03: Modem-In Wrap Test

This routine check the modem control leads according to the LIC type.

Use the TEST/OPERATE switch or the wrap block as follows:

- LIC type 1 (V24): Set the connector TEST/OPERATE switch to TEST
- LIC type 1 (V25): Plug the wrap block at the cable end
- LIC type 3: Set the DCE Test/Operate switch to T1
- LIC type 4: Set the DCE Test/Operate switch to T1



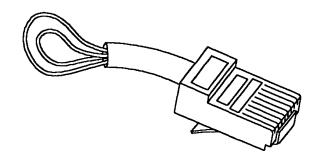
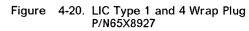


Figure 4-22. LIC Type 5 and 6 Wrap Plug P/N11F4815



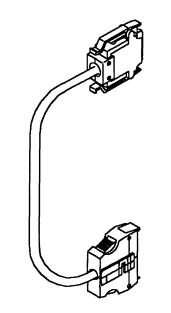
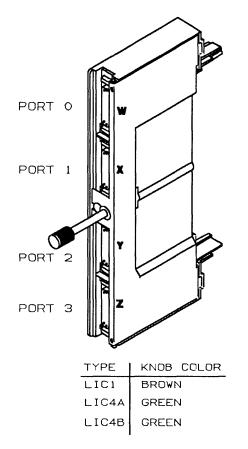


Figure 4-21. LIC Type 3 Wrap Cable P/N65X8928

Diagnostics



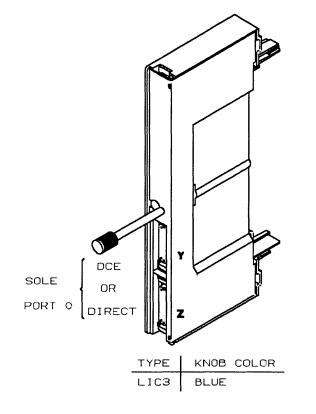
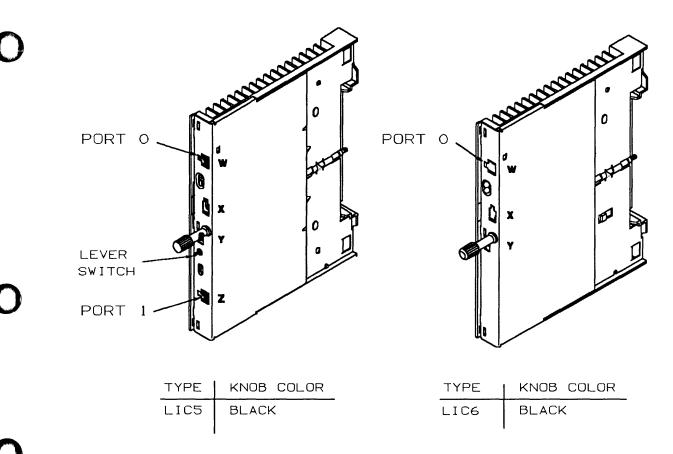


Figure 4-23. LIC Types 1, 3 and 4

Diagnostics





How to Run the Channel Wrap Test

- 1. Ensure that the 'Select Out Bypass' switch is in the 'NORMAL' position.
- 2. Call the option ODG or CDG from the maintenance function menu.
- 3. Enter **LO01** in the DIAG = = > area and the channel number in the ADP# = = > area.
- 4. Press SEND.
- 5. When you are required by the diagnostic, remove the interface cables then install the wrap plugs and terminators, refer to Figure 5-46 on page 5-46 In order to allow the customer to use the channel during test time, you have to connect the cables together or to the terminators.
- 6. You will be asked for the wrap tools P/N you are using.

Two models of wrap plugs can be used for this test:

BUS P/N 03F4301 and TAG P/N 03F4300 or BUS P/N 26F1755 and TAG P/N 26F1754

7. Messages on the screen will prompt you for the required actions.

According to the wrap plugs you are using, follow one of the two actions here after :

• If you have the channel wrap plugs:

P/N 03F4300 (for Tag) and P/N 03F4301 (for Bus)

install them for interface A in the IN ROW (dark gray) and the CA terminators:

P/N 2282676 (for Tag) and P/N 2282675 (for Bus)

in the OUT ROW (light gray).

• If you have the channel wrap plugs :

P/N 26F1754 (for Tag) and P/N 26F1755 (for Bus)

you have to make two installations, one after the other (when requested by messages on the screen) :

1st step - Install the wrap plugs for interface A in the IN ROW (dark gray), and the CA terminators:

P/N 2282676 (for Tag) and P/N 2282675 (for Bus)

in the OUT ROW (light gray).

- 2st step Install the wrap plugs in the OUT ROW (light gray) and leave the IN ROW (dark gray) free. (CA terminators have not to be used).
- 8. You will be asked to install the wrap plugs on interface connectors B if the TPS feature is installed on this channel. In this case repeat the action as before for interface A.

Action to Take After a Diagnostic Run

Diagnostic Result Analysis

001

This procedure analyzes the results of the diagnostics prior to exchange any FRU and tells you what to do next.

When MOSS diagnostics detect an error, a hex code is set on the control panel. The code can be decoded by using "Panel Codes" on page 2-14.

When ODG/CDG diagnostics detect an error, a reference code is given on the diagnostic screen, see (Figure 4-18 on page 4-32).

This reference code can be decoded to find the action to take using the BRC function in menu 3. If required, see "Using Reference Codes" on page 2-12

Did diagnostics run without a message for manual intervention ?

Yes No



Follow the instructions given by the diagnostics. Then, go back to this procedure according to the result.



005

Did the diagnostics detect a failure ? Yes No

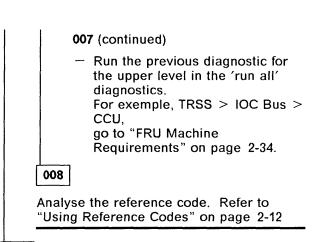


Was the failure other than 'unexpected error' ? Yes No



Was a reference code generated by the diagnostics ? Yes No





009

You may have started this service call to exchange FRUs called by a reference code or panel code.

Is the first FRU called by diagnostics different from the FRU you were going to exchange ? Yes No



Perform FRU exchange using Chapter 5, "3745 FRU Exchange" on page 5-1.



Is there a FRU given by both lists ? Yes No



 If you do not have the first FRU called by the diagnostics, obtain it.

If you have the FRU or when you obtain the FRU, go to "FRU Machine Requirements" on page 2-34.

013

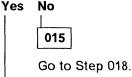
Consider it is the first FRU of the list and exchange it.



(Step 014 continues)

014 (continued)

Were HPTSS diagnostics being run for a suspected FESH card ?



016

- In the 3745 frame 01 at tail gate location 01U, remove cables from the HPTSS lines to be tested. Refer to Figure 5-2 on page 5-6.
- Install wrap plugs in the sockets of 01U for the lines to be tested.
- Update the CDF to show that the lines to be tested have wrap plugs installed. Refer to "3745 Service Functions, Chapter 9".
- Run HPTSS diagnostic routines VI and VK if V.35 wrap plug is installed, or VJ and VK if X.21 wrap plug is installed, or VI, VJ, and VK if both types of wrap plugs are installed. Refer to "How to Run Internal Function Tests" on page 4-29.

Did the diagnostic run free of error ?



Go to Step 009 on page 4-43.

018

Is the FRU you were processing, the last FRU called for the error ? Yes No

019

You have an intermittent error or an error not detected by this diagnostic.

Continue using this manual for the next FRU called, go to "FRU Machine Requirements" on page 2-34.

020

Go to "CE Leaving Procedure" on page 5-172.

Chapter 5. 3745 FRU Exchange

Use this chapter once you know what FRU to exchange. You should use all its sections, from front to back, to learn:

- Where the FRU is physically located
- · How to exchange FRUs properly
- How to test the machine afterward
- What else to do before returning the machine to the customer.

Exchange Precautions

- 1. Most of the FRUs can be exchanged in concurrent maintenance. Thus, it is **VERY IMPORTANT** that these procedures be followed when replacing any FRU in the machine.
- 2. The control panel has voltage present even with the machine 'Power OFF'.
- 3. Be sure that the involved area of the 3745 is 'power OFF', when requested by the procedure, before replacing any FRUs.
- 4. Before starting FRU exchange, make sure the involved area has been disabled by the customer.
- 5. The 3745 communication controller contains cards that are sensitive to electrostatic discharge (ESD). Store all cards in their protective packaging when you are not actually exchanging them.
- 6. Procedures for exchanging FRUs are listed on the next pages, use the list in alphabetical order leading to the correct page.

important. Do not disassemble or attempt to remove FRUs from the 3745 until you have read "Telecommunication Products Safety Handbook" GA33-0126.

---- VERY IMPORTANT -

BEFORE ANY FRU EXCHANGE

BE SURE THAT THE REQUIRED AREA HAS BEEN DISABLED

IF NOT, GO TO START PAGE AND FOLLOW THE APPROPRIATE PROCEDURE

FRU Exchange

List of FRUs

CA TAILGATE	Use "Channel Tail Gate and Internal Cables Exchange Procedure" on page 5-119.
CA BOARD	Use "Channel Board Exchange Procedure" on page 5-120.
LA BOARD	Use "Line Adapter Board Exchange Procedure" on page 5-129.
LIC BOARD type 1	Use "LIC Board Type 1 Exchange Procedure" on page 5-139.
LIC BOARD type 2	Use "LIC Board Type 2 Exchange Procedure" on page 5-143.
MOSS BOARD	Use "MOSS Board Exchange Procedure" on page 5-148.
SAC GATE	Use "SAC Gate Assembly Exchange Procedure for Models 210 and 410" on page 5-153.
SAC2 GATE	Use "SAC2 Gate Assembly Exchange Procedure for Models 310 and 610" on page 5-160.
TCM BOARD	Use "TCM Board Exchange Procedure" on page 5-167.
Air Filters	Use "Air Filters Exchange Procedure" on page 5-80.
AMD	Use "Air Moving Device Exchange Procedure for Models 210 and 410" on page 5-84.
AMD2	Use "Air Moving Device Exchange Procedure for Models 310 and 610" on page 5-86.
Battery	Use "Battery Exchange Procedure" on page 5-88.
CADR	Use "CADR/CAL Exchange Procedure" on page 5-51.
CAL	Use "CADR/CAL Exchange Procedure" on page 5-51.
Control Panel	Use "Control Panel Exchange Procedure" on page 5-52.
CSP	Use "CSP Exchange Procedure" on page 5-65.
DFA	Use "DFA Exchange Procedure" on page 5-54.
DMSW	Use "Storage and Controls Exchange Procedure" on page 5-79.
DMUX	Use "DMUX Exchange Procedure" on page 5-68.
DTER	Use "DTER/ITER Exchange Procedure" on page 5-76.
FDD	Use "FDD Exchange Procedure" on page 5-55.
FESH	Use "FESH Exchange Procedure" on page 5-67.
FESL	Use "FESL Exchange Procedure" on page 5-66.
HDD	Use "HDD Exchange Procedure" on page 5-57.
IOSW/IOSW2	Use "Storage and Controls Exchange Procedure" on page 5-79.

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FRU Exchange

ITER	Use "DTER/ITER Exchange Procedure" on page 5-76.
LIC FAN	Use "LIC FAN Exchange Procedure" on page 5-73.
LIC type 1-4	Use "LIC Type 1-4 Exchange Procedure" on page 5-71.
LIC type 5,6	Use "LIC Type 5 and 6 Exchange Procedure" on page 5-72.
MAC/MAC2	Use "MAC/MAC2 Exchange Procedure" on page 5-59.
MCA	Use "MCA/MSC Exchange Procedure" on page 5-61.
MOSS Blower	Use "MOSS Blower Exchange Procedure" on page 5-90.
MPC	Use "MPC Exchange Procedure" on page 5-60.
MSC	Use "MCA/MSC Exchange Procedure" on page 5-61.
PAC	Use "PAC Exchange Procedure" on page 5-62.
PLC	Use "PLC Exchange Procedure" on page 5-63.
PROM	Use "PROM Exchange Procedure" on page 5-64.
PSTY1	Use "PS Type 1 Exchange Procedure for Models 210 and 410" on page 5-103.
PSTY1B	Use "PS Type 1B Exchange Procedure for Models 310 and 610" on page 5-105.
PSTY2	Use "PS Type 2 Exchange Procedure" on page 5-107.
PSTY3	Use "PS Type 3 Exchange Procedure" on page 5-108.
PSTY4	Use "PS Type 4 Exchange Procedure" on page 5-109.
PSTY5	Use "PS Type 5 Exchange Procedure" on page 5-111.
PSTY6	Use "PS Type 6 Exchange Procedure" on page 5-113.
PSTY7	Use "PS Type 7 Exchange Procedure" on page 5-114.
PSTY8	Use "PS Type 8 Exchange Procedure" on page 5-116.
PS FAN	Use "PS Fan Exchange Procedure" on page 5-118.
PTER	Use "PTER Exchange Procedure" on page 5-77.
PUC	Use "Storage and Controls Exchange Procedure" on page 5-79.
SCTL/SCTL2	Use "Storage and Controls Exchange Procedure" on page 5-79.
SMUXA/B	Use "SMUXA/B Exchange Procedure" on page 5-69.
STER	Use "STER Exchange Procedure" on page 5-78.
STO	Use "Storage and Controls Exchange Procedure" on page 5-79.
ТСМ	Use "TCM Exchange Procedure" on page 5-92.
TIC	Use "TRM/TIC Exchange Procedure" on page 5-74.

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FRU Exchange	<u>*</u> **

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Use "TRM/TIC Exchange Procedure" on page 5-74.

TRM

FRU Physical Locations

3745 Frames

				/			
FRAME 06	FRAME 05	FRAME 04	FRAME 01 (BASE FRA	ME)	FRAME 02	FRAME 03	
(EXPANSION UNIT)		(EXPANSION UNIT)			(EXPANSION UNIT)	(EXPANSION UNIT)	
3746-L15	3746-L14	3746-L13	3745-2 or 310	10 , 410 , 610	3746-A11	3746-A12	
		LINES 128 TO 383	CCUs	LINES 0 TO 127 CAs 1 TO 8 LAs 1 TO 8		LAs 25 TO 32	



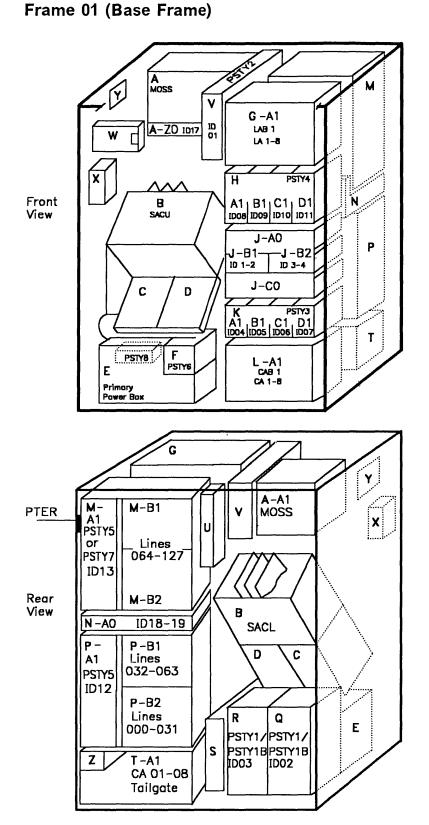
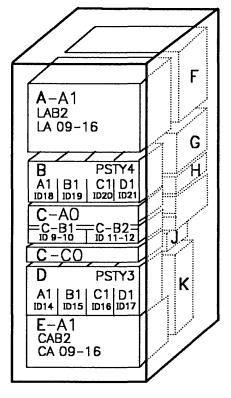


Figure 5-2. 3745-210, 310, 410 or 610

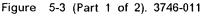
- 0
- A MOSS
- B SAC gate
- C AMD/AMD2 for CCU A
- D AMD/AMD2 for CCU B
- E Primary power box
- F Power supply control (type 6)
- G Line adapters from 01 to 08
- H PS type 4 for line adapters 01 to 08
- J Fan, ac and dc distribution
- **K** PS type 3 for channel adapters 01 to 08
- L Channel adapters from 01 to 08
- M LIC unit (lines from 64 to 127)

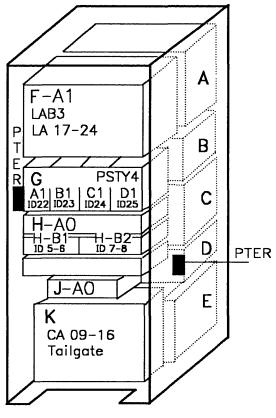
- N FAN for LICs
- P LIC unit (lines from 00 to 63)
- Q PS type 1B for CCU A
- R PS type 1B for CCU B
- S EPO tail gate
- T Channels adapters 01 to 08 tail gate
- U TRSS or HPTSS tail gate
- V PS type 2 for MOSS
- W Control panel and FDD
- X HDD
- Y Remote control
- Z Auxiliary power box

Frame 02 (Expansion Unit A11)



Front View





Rear View

Figure 5-3 (Part 2 of 2). 3746-011

- A Line adapters (from 09 to 16)
- **B** PS type 4 for line adapters 09 to 16
- C Fan, ac and dc distribution
- **D** PS type 3 for channel adapters 09 to 16
- E Channel adapter (from 09 to 16)

- **F** Line adapters (from 17 to 24)
- **G** PS type 4 for line adapters 17 to 24
- **H** Fan, ac and dc distribution
- J Auxiliary power box
- K Channels adapters 09 to 16 tail gate

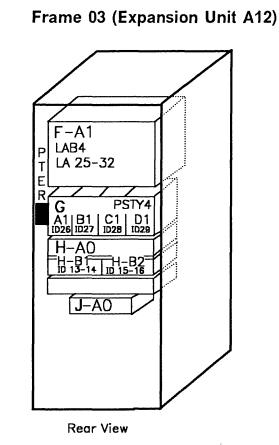
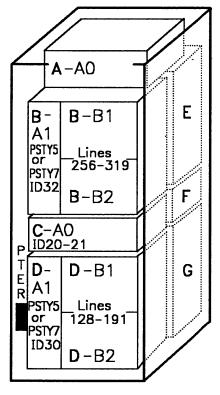


Figure 5-4. 3746-012

- **F** Line adapters (from 25 to 32)
- **G** PS type 4 for line adapters 25 to 32
- **H** Fan, ac and dc distribution
- J Auxiliary power box

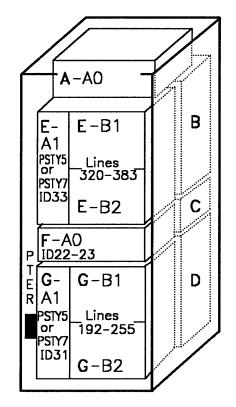
Frame 04 (Expansion Unit L13)



Front View

Figure 5-5 (Part 1 of 2). 3746-013

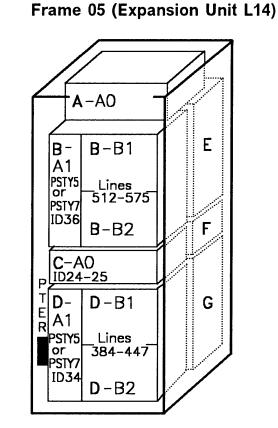
- A ac distribution
- B LIC unit (from 256 to 319 lines)
- C FAN for LICs
- D LIC unit (from 128 to 191 lines)



Rear View

Figure 5-5 (Part 2 of 2). 3746-013

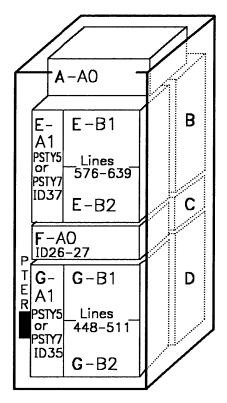
- E LIC unit (from 320 to 383 lines)
- F FAN for LICs
- G LIC unit (from 192 to 255 lines)



Front View

Figure 5-6 (Part 1 of 2). 3746-014

- A AC distribution
- B LIC unit (from 512 to 575 lines)
- C FAN for LICs
- D LIC unit (from 384 to 447 lines)

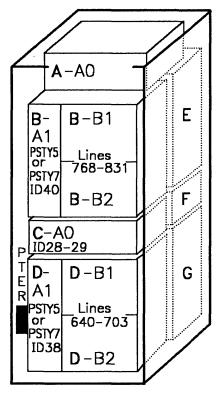


Rear View

Figure 5-6 (Part 2 of 2). 3746-014

- E LIC unit (from 576 to 639 lines)
- F FAN for LICs
- G LIC unit (from 448 to 511 lines)

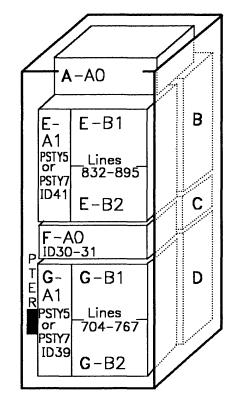
Frame 06 (Expansion Unit L15)



Front View

Figure 5-7 (Part 1 of 2). 3746-015

- A AC distribution
- B LIC unit (from 768 to 831 lines)
- C FAN for LICs
- D LIC unit (from 640 to 703 lines)



Rear View

Figure 5-7 (Part 2 of 2). 3746-015

- E LIC unit (from 832 to 895 lines)
- F FAN for LICs
- G LIC unit (from 704 to 767 lines)

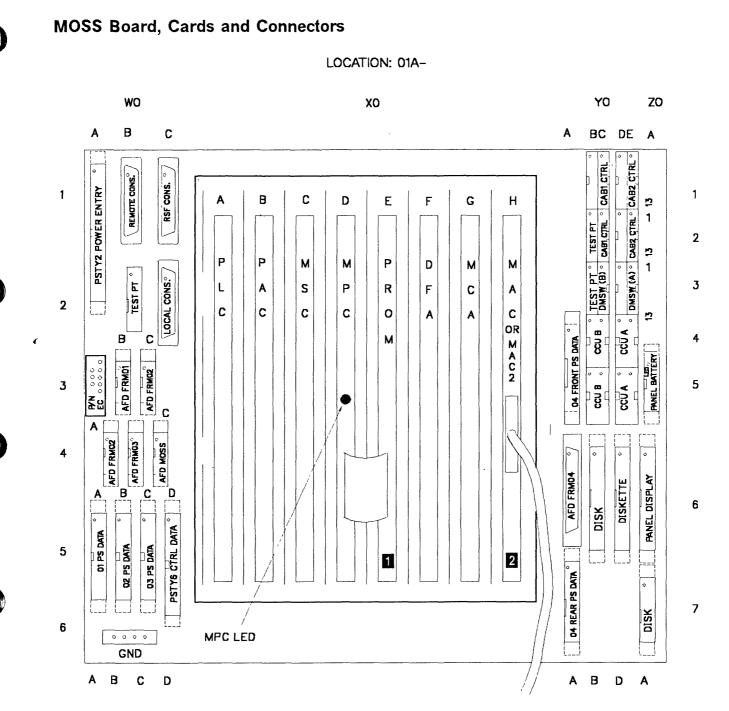


Figure 5-8. 3745 MOSS Board, Cards and Connectors

1 The **PROM** card may not be present on the machine, in this case the interconnecting cable is not present too.

2 MAC card for models 210 and 410 or MAC2 card for models 310 and 610







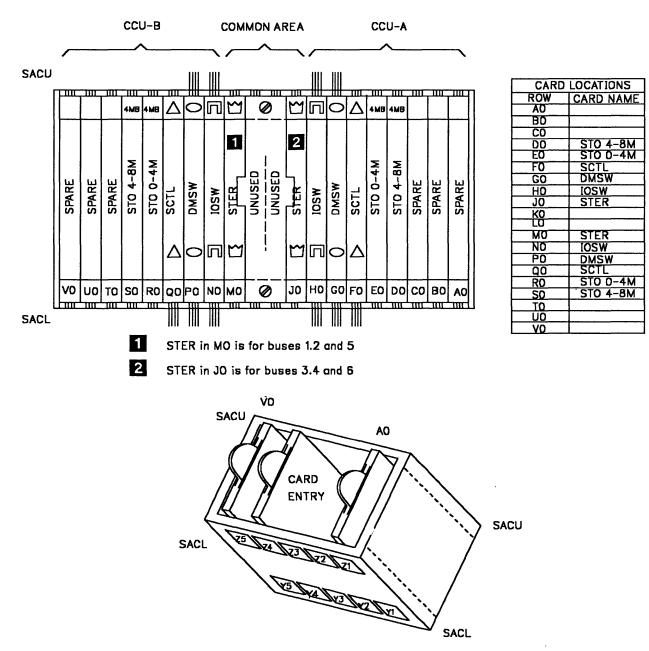
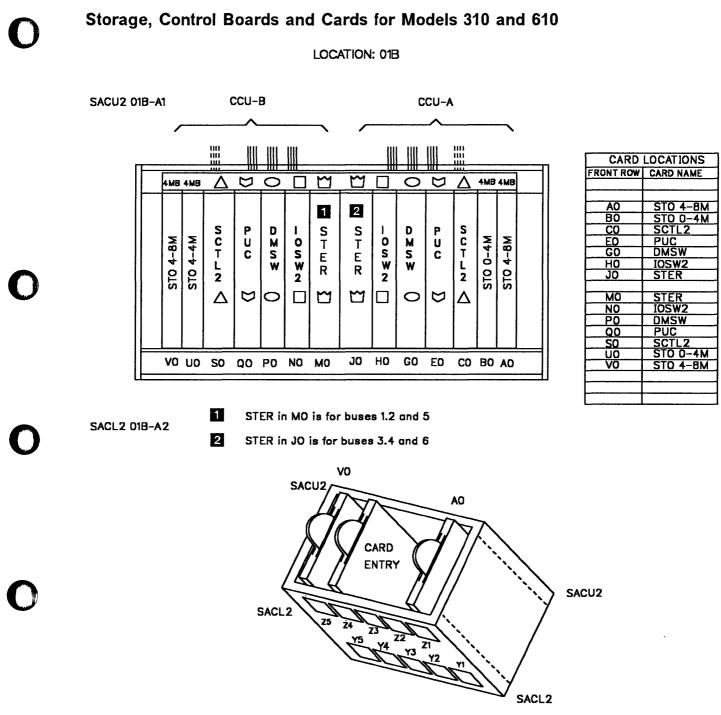


Figure 5-9. 3745 Storage, Control Boards and Cards for Models 210 and 410









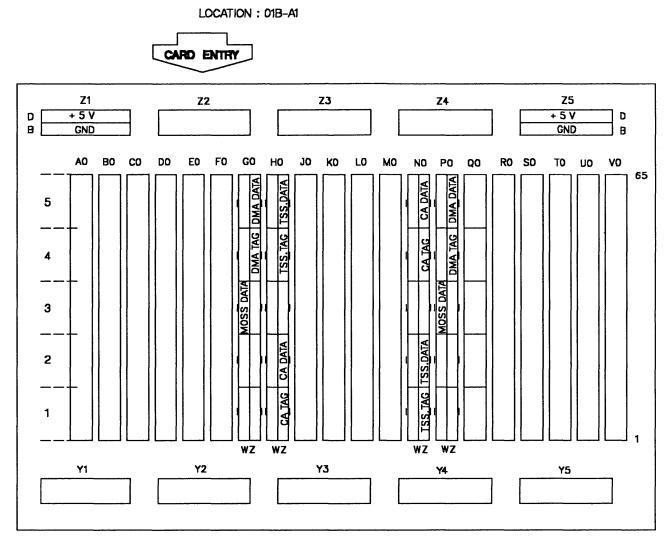
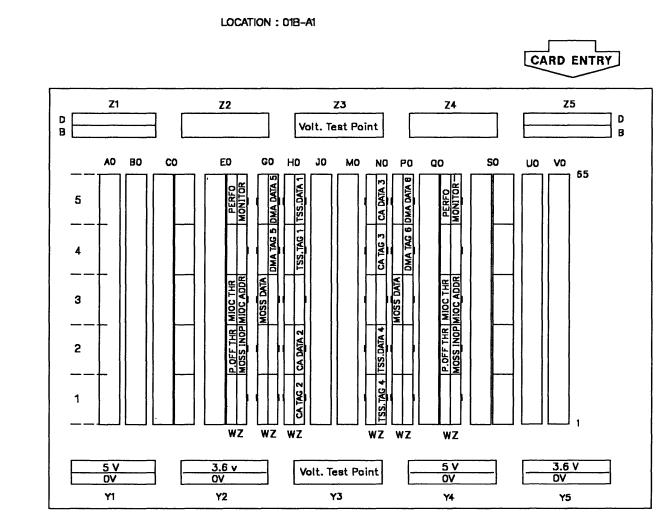


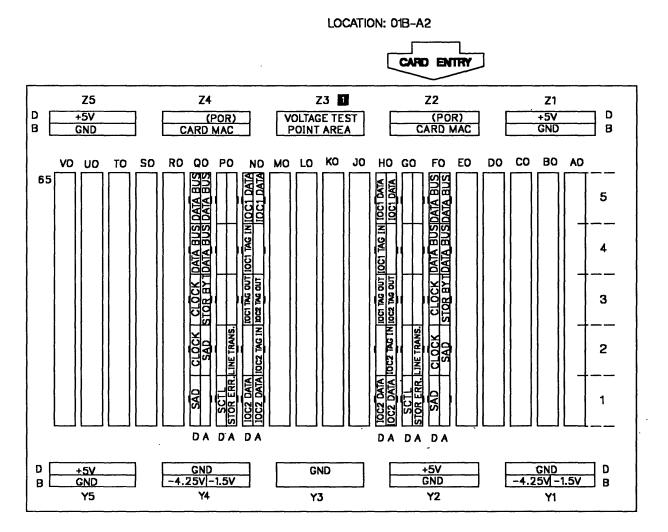
Figure 5-11. 3745 SACU Board and Connectors for Models 210 and 410



SACU2 Board and Connectors for Models 310 and 610

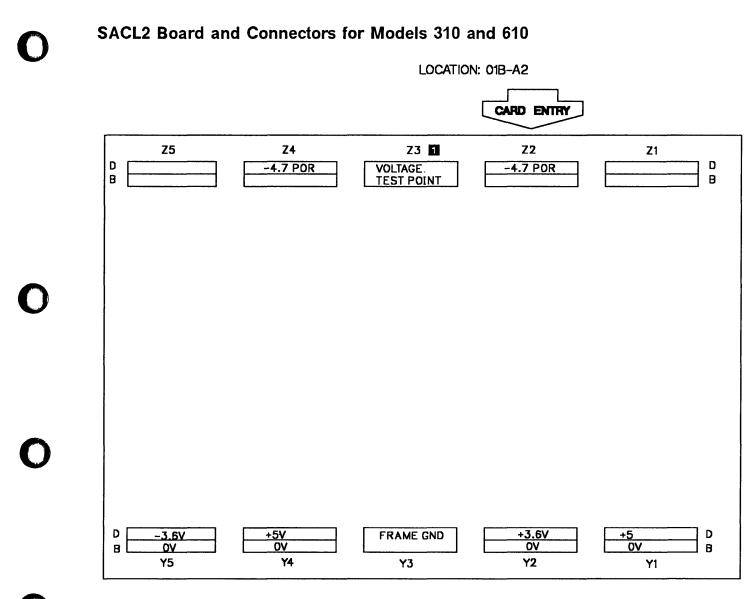
Figure 5-12. 3745 SACU2 Board and Connectors for Models 310 and 610





See Power Supply chapter in the MIR for details.

Figure 5-13. 3745 SACL Board and Connectors for Models 210 and 410



See Power Supply chapter in the MIR for details.

Figure 5-14. 3745 SACL2 Board and Connectors for Models 310 and 610

TCM Board Front

LOCATION: 01C-A1 / 01D-A1



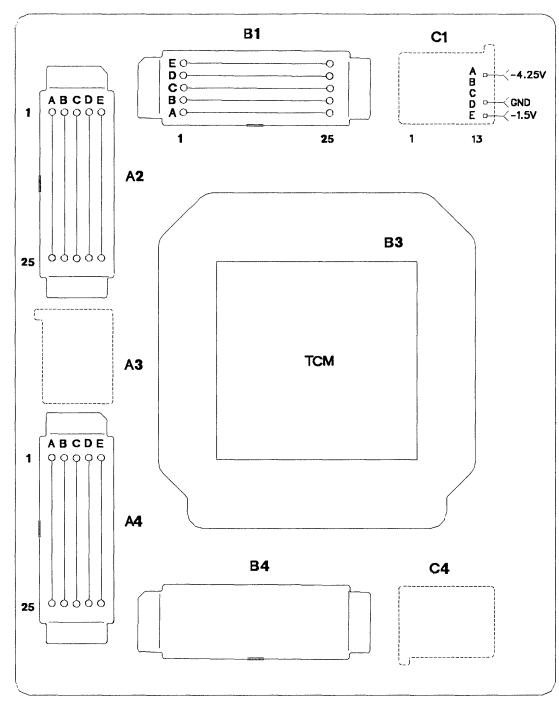


Figure 5-15. 3745 TCM Board and Connectors (Front)

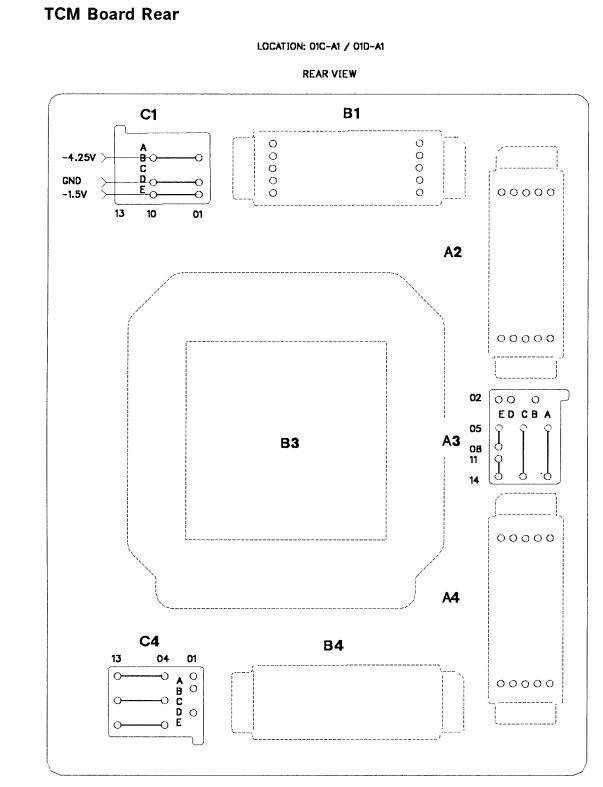
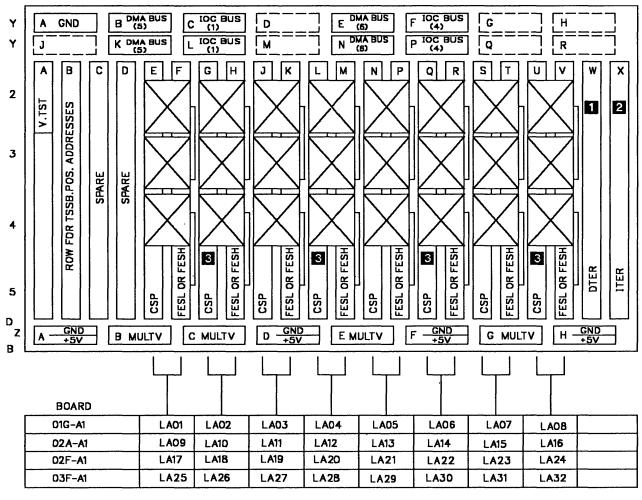


Figure 5-16. 3745 TCM Board and Connectors (Rear)

TSSB Board and Cards

BOARD CARD SIDE

LOCATION : 01G-A1.02A-A1.02F-A1.03F-A1



1 Card present when HPTSS installed

2 Either Card or flat cables

Install bypass CARD BPC1 in missing CSP positions to insure the bus continuity between scanners, except for the case when the first adapter of the group is the last adapter of the bus.

Figure 5-17. 3745 TSSB Board and Cards

1

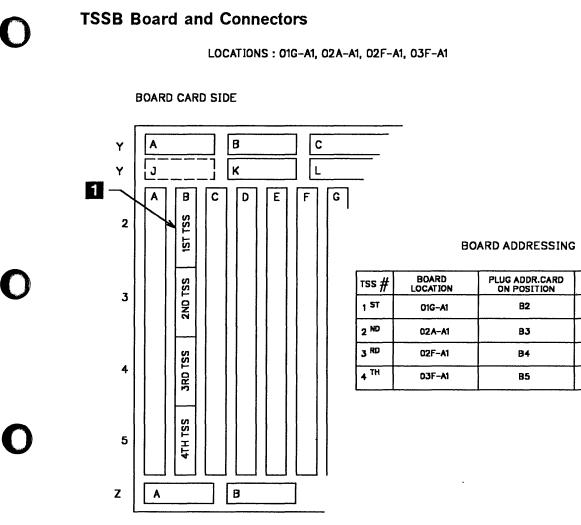
PWR SUPP. PLUG JUMPER

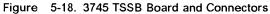
NO

NO

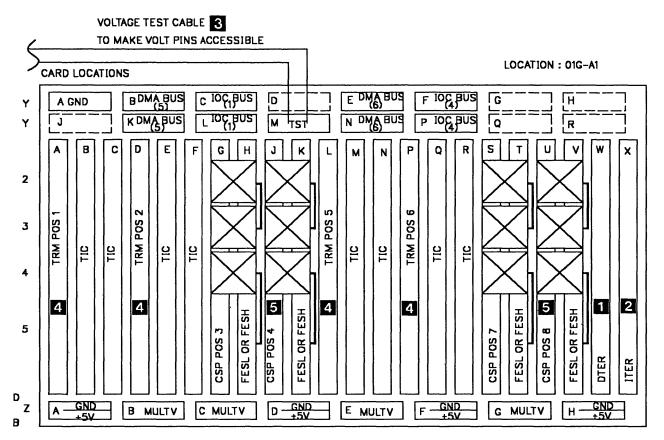
YES

NO





TSST Board and Cards





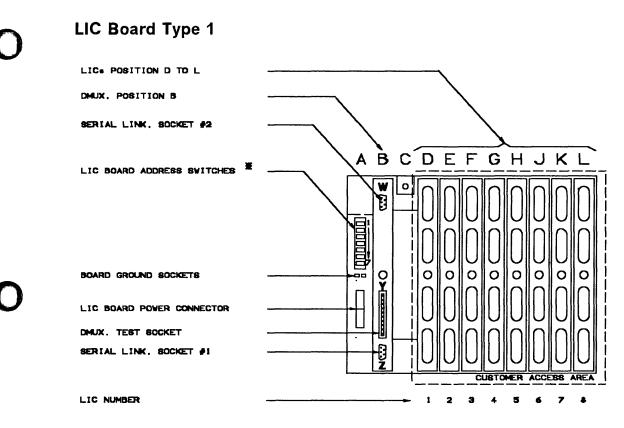
1 CARD present when HPTSS installed

2 either a CARD or flat cable

3 going to voltage test connector located on the left side on board 01G-A1

4 install bypass CARD BPC2 in missing TRM positions to insure the bus continuity between scanners

5 install bypass CARD BPC1 in missing CSP positions to insure the bus continuity between scanners, except if the first adapter of the group is the last adapter of the bus.



* See details page 5-140.

Figure 5-20. 3745 LIC Unit Type 1 Board and Connectors

LIC Board type 2

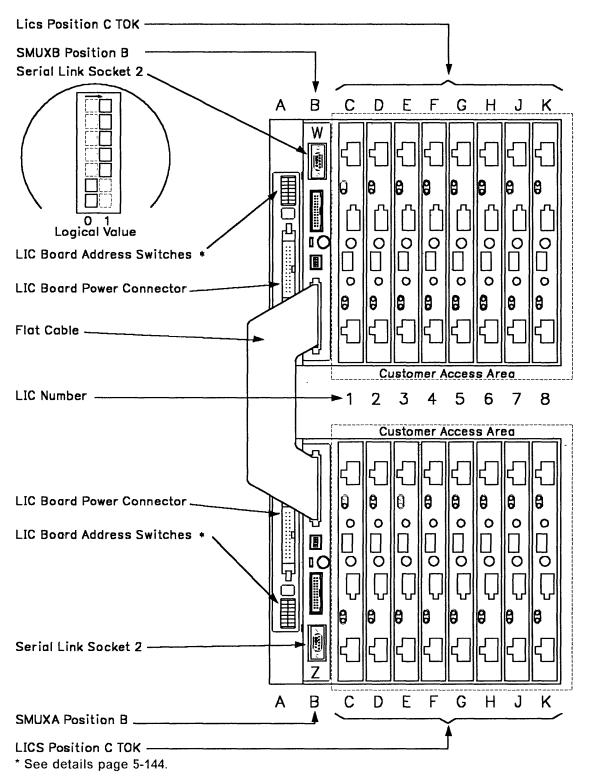


Figure 5-21. 3745 LIC Unit type 2 Board and Connectors

DMUX Packaging

	Number ector W	DMUX Location
1	2	01P-B2-B1
3	4	01P-B1-B1
5	6	01M-B2-B1
7	8	01M-B1-B1
9	10	04D-B2-B1
11	12	04D-B1-B1
13	14	04G-B2-B1
15	16	04G-B1-B1
17	18	04B-B2-B1
19	20	04B-B1-B1
21	22	04E-B2-B1
23	24	04E-B1-B1
25	26	05D-B2-B1
27	28	05D-B1-B1

	Number ector W	DMUX Location
29	30	05G-B2-B1
31	32	05G-B1-B1
33	34	05B-B2-B1
35	36	05B-B1-B1
37	38	05E-B2-B1
39	40	05E-B1-B1
41	42	06D-B2-B1
43	44	06D-B1-B1
45	46	06G-B2-B1
47	48	06G-B1-B1
49	50	06B-B2-B1
51	52	06B-B1-B1
53	54	06E-B2-B1
55	56	06E-B1-B1

Figure 5-22. 3745 DMUX Packaging

SMUXA/B Packaging

	Number ector W	SMUX Location
NA	NA	01P-B2-B1
NA	NA	01P-B1-B1
5	NA	01M-B2-B1
NA	7	01M-B1-B1
9	NA	04D-B2-B1
NA	11	04D-B1-B1
13	NA	04G-B2-B1
NA	15	04G-B1-B1
17	NA	04B-B2-B1
NA	19	04B-B1-B1
21	NA	04E-B2-B1
NA	23	04E-B1-B1
25	NA	05D-B2-B1
NA	27	05D-B1-B1

MUX Number Connector Z 1 W		SMUX Location
29	NA	05G-B2-B1
NA	31	05G-B1-B1
33	NA	05B-B2-B1
NA	35	05B-B1-B1
37	NA	05E-B2-B1
NA	39	05E-B1-B1
41	NA	06D-B2-B1
NA	43	06D-B1-B1
45	NA	06G-B2-B1
NA	47	06G-B1-B1
49	NA	06B-B2-B1
NA	51	06B-B1-B1
53	NA	06E-B2-B1
NA	55	06E-B1-B1

Figure 5-23, 3745 SMUXA/B Packaging

LIC Unit Type 1 Packaging for LIC Type 1-4

	A	В	С	D	E	F	G	н	J	К	L
		ß		32	36	40	44	48	52	56	60
		D		33	37	41	45	49	53	57	61
		D M U X		34	38	42	46	50	54	58	62
ΡS		2		35	39	43	47	51	55	59	63
type 5		ß		00	04	08	12	16	20	24	28
(see Note)		D		01	05	09	13	17	21	25	29
		D M U X		02	06	10	14	18	22	26	30
		3		03	07	11	15	19	23	27	31

BOARD

BOARD 01P-B1

01P-B2

Note: Refer to Vol 4, page YZ075 for PS type 5 addressing switches.

Figure 5-24. LIC Unit Type 1 Packaging (for LIC Type 1-4)

Boards	Lines (LIC 1-4)	Lines (LIC 5-6)
01P-B1/B2	000-063	NA
01M-B1/B2	064-127	064-095
04D-B1/B2	128-191	128-159
04G-B1/B2	192-255	192-223
04B-B1/B2	256-319	256-287
04E-B1/B2	320-383	320-351
05D-B1/B2	384-447	384-415
05G-B1/B2	448-511	448-479
05B-B1/B2	512-575	512-543
05E-B1/B2	576-639	576-607
06D-B1/B2	640-703	640-671
06G-B1/B2	704-767	704-735
06B-B1/B2	768-831	768-799
06E-B1/B2	832-895	832-863

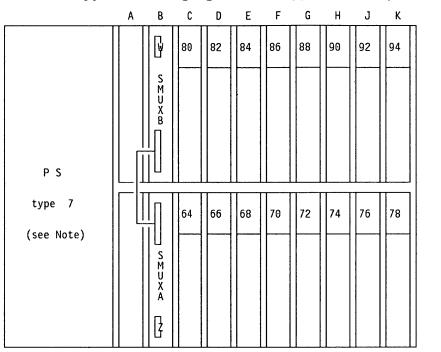
Figure 5-25. Line Numbers and Boards (for LIC Type 1-6)

LIC Unit Type			_	-								
	A	B	C	D	E	F	G	Н	J	к П Т	7	
		S M U X B	80	82	84	86	88	90	92	94		E
PS			81	83	85	87	89	91	93	95		G
type 7 (see Note)			64	66	68	70	72	74	76	78		
		U S M U X A										6
]]]]]	65	67	69	71	73	75	77	79		

Note: Refer to Vol 4, page YZ077 for PS type 7 addressing switches. Note: LICs type 5 and 6 can be mixed in this board.

Figure 5-26. LIC Unit Type 2 Packaging (for LIC Type 5)

Chapter 5. 3745 FRU Exchange 5-29



LIC Unit Type 2 Packaging for LIC Type 6 Low-speed

Note: Refer to Vol 4, page YZ077 for PS type 7 addressing switches. Note: LICs type 5 and 6 can be mixed in this board. Figure 5-27. LIC Unit Type 2 Packaging for LIC Type 6 Low-speed

LIC Unit Type 2 Packaging for LIC Type 6 High-speed

E В С D F G Н J Κ А y 80 92 84 88 S M U Х В ΡS type 7 68 72 76 64 S M U X A **]**

BOARD 01M-B1

s,

BOARD 01M-B1

BOARD

01M-B2

BOARD 01M-B2

Figure 5-28. LIC Unit Type 2 Packaging for LIC Type 6 High-speed

\mathbf{O}

LIC Unit type 1 Layout Board B2 (for LIC type 1-4)

BOARD			CA	RD POSI	TION				
	DMUX		•		L	IC		•	
	В	D	E	F	G	н	J	к	L
01P-B2	W = 1 Z = 2	000 001 002 003	004 005 006 007	008 009 010 011	012 013 014 015	016 017 018 019	020 021 022 023	024 025 026 027	028 029 030 031
01M-B2	W = 5 Z = 6	064 065 066 067	068 069 070 071	072 073 074 075	076 077 078 079	080 081 082 083	084 085 086 087	088 089 090 091	092 093 094 095
04D-B2	W = 9 Z = 10	128 129 130 131	132 133 134 135	136 137 138 139	140 141 142 143	144 145 146 147	148 149 150 151	152 153 154 155	156 157 158 159
04G-B2	W = 13 Z = 14	192 193 194 195	196 197 198 199	200 201 202 203	204 205 206 207	208 209 210 211	212 213 214 215	216 217 218 219	220 221 222 223
04B-B2	W = 17 Z = 18	256 257 258 259	260 261 262 263	264 265 266 267	268 269 270 271	272 273 274 275	276 277 278 279	280 281 282 283	284 285 286 287
04E-B2	W = 21 Z = 22	320 321 322 323	324 325 326 327	328 329 330 331	332 333 334 335	336 337 338 339	340 341 342 343	344 345 346 347	348 349 350 351
05D-B2	W = 25 Z = 26	384 385 386 387	388 389 390 391	392 393 394 395	396 397 398 399	400 401 402 403	404 405 406 407	408 409 410 411	412 413 414 415
05G-B2	W = 29 Z = 30	448 449 450 451	452 453 454 455	456 457 458 459	460 461 462 463	464 465 466 467	468 469 470 471	472 473 474 475	476 477 478 479
05B-B2	W = 33 Z = 34	512 513 514 515	516 517 518 519	520 521 522 523	524 525 526 527	528 529 530 531	532 533 534 535	536 537 538 539	540 541 542 543
05E-B2	W = 37 Z = 38	576 577 578 579	580 581 582 583	584 585 586 587	588 589 590 591	592 593 594 595	596 597 598 599	600 601 602 603	604 605 606 607
06D-B2	W = 41 Z = 42	640 641 642 643	644 645 646 647	648 649 650 651	652 653 654 655	656 657 658 659	660 661 662 663	664 665 666 667	668 669 670 671
06G-B2	W = 45 Z = 46	704 705 706 707	708 709 710 711	712 713 714 715	716 717 718 719	720 721 722 723	724 725 726 727	728 729 730 731	732 733 734 735
06B-B2	W = 49 Z = 50	768 769 770 771	772 773 774 775	776 777 778 779	780 781 782 783	784 785 786 787	788 789 790 791	792 793 794 795	796 797 798 799
06E-B2	W = 53 Z = 54	832 833 834 835	836 837 838 839	840 841 842 843	844 845 846 847	848 849 850 851	852 853 854 855	856 857 858 859	860 861 862 863

Figure 5-29. LIC Unit Type 1 Layout Board B2 (for LIC Type 1-4)

LIC Unit Type 1 Layout Board B1 (for LIC Type 1-4)

BOARD	CARD POSITION											
	DMUX				L	I C						
	В	D	E	F	G	H	J	К	L			
01P-B1	W = 3 $Z = 4$	032 033 034 035	036 037 038 039	040 041 042 043	044 045 046 047	048 049 050 051	052 053 054 055	056 057 058 059	060 061 062 063			
01M-B1	W = 7 Z = 8	096 097 098 099	100 101 102 103	104 105 106 107	108 109 110 111	112 113 114 115	116 117 118 119	120 121 122 123	124 125 126 127			
04D-B1	W = 11 Z = 12	160 161 162 163	164 165 166 167	168 169 170 171	172 173 174 175	176 177 178 179	180 181 182 183	184 185 186 187	188 189 190 191			
04G-B1	W = 15 Z = 16	224 225 226 227	228 229 230 231	232 233 234 235	236 237 238 239	240 241 242 243	244 245 246 247	248 249 250 251	252 253 254 255			
04B-B1	W = 19 Z = 20	288 289 290 291	292 293 294 295	296 297 298 299	300 301 302 303	304 305 306 307	308 309 310 311	312 313 314 315	316 317 318 319			
04E-B1	W = 23 Z = 24	352 353 354 355	356 357 358 359	360 361 362 363	364 365 366 367	368 369 370 371	372 373 374 375	376 377 378 379	380 381 382 383			
05D-B1	W = 27 Z = 28	416 417 418 419	420 421 422 423	424 425 426 427	428 429 430 431	432 433 434 435	436 437 438 439	440 441 442 443	444 445 446 447			
05G-B1	W = 31 Z = 32	480 481 482 483	484 485 486 487	488 489 490 491	492 493 494 495	496 497 498 499	500 501 502 503	504 505 506 507	508 509 510 511			
05B-B1	W = 35 Z = 36	544 545 546 547	548 549 550 551	552 553 554 555	556 557 558 559	560 561 562 563	564 565 566 567	568 569 570 571	572 573 574 575			
05E-B1	W = 39 $Z = 40$	608 609 610 611	612 613 614 615	616 617 618 619	620 621 622 623	624 625 626 627	628 629 630 631	632 633 634 635	636 637 638 639			
06D-B1	W = 43 $Z = 44$	672 673 674 675	676 677 678 679	680 681 682 683	684 685 686 687	688 689 690 691	692 693 694 695	696 697 698 699	700 701 702 703			
06G-B1	W = 47 Z = 48	736 737 738 739	740 741 742 743	744 745 746 747	748 749 750 751	752 753 754 755	756 757 758 759	760 761 762 763	764 765 766 767			
06B-B1	W = 51 Z = 52	800 801 802 803	804 805 806 807	808 809 810 811	812 813 814 815	816 817 818 819	820 821 822 823	824 825 826 827	828 829 830 831			
06E-B1	W = 55 Z = 56	864 865 866 867	868 869 870 871	872 873 874 875	876 877 878 879	880 881 882 883	884 885 886 887	888 889 890 891	892 893 894 895			

Figure 5-30. LIC Unit Type 1 Layout Board B1 (for LIC Type 1-4)

LIC Unit Type 2 Layout Board B2 (for LIC Type 5)

Note:

- LICs 5, LICs 6(low-speed), and LICs 6(high-speed) may be intermixed on a given board.
- A pair of LICs may be made up of a LIC 5 and a LIC 6 (low-speed).

BOARD		CARD POSITION											
	SMUX				L	IC							
	В	С	D	E	F	G	Н	J	К				
01M-B2	W = NA	064	066	068	070	072	074	076	078				
	Z = 5	065	067	069	071	073	075	077	079				
04D-B2	W = NA	128	130	132	134	136	138	140	142				
	Z = 9	129	131	133	135	137	139	141	143				
04G-B2	W = NA	192	194	196	198	200	202	204	206				
	Z = 13	194	196	197	199	201	203	205	207				
04B-B2	W = NA	256	258	260	262	264	266	268	270				
	Z = 17	257	259	261	263	265	267	269	271				
04E-B2	W = NA	320	322	324	326	328	330	332	334				
	Z = 21	321	323	325	327	329	331	333	335				
05D-B2	W = NA	384	386	388	390	392	394	396	398				
	Z = 25	385	387	389	391	393	395	397	399				
05G-B2	W = NA	448	350	452	454	456	458	460	462				
	Z = 29	449	351	453	455	457	459	461	463				
05B-B2	W = NA	512	514	516	518	520	522	524	526				
	Z = 33	513	515	517	519	521	523	525	527				
05E-B2	W = NA	576	578	580	582	584	586	588	590				
	Z = 37	577	579	581	583	585	587	589	591				
06D-B2	₩ = NA	640	642	644	646	648	650	652	654				
	Z = 41	641	643	645	647	649	651	653	655				
06G-B2	W = NA	704	706	708	710	712	714	716	718				
	Z = 45	705	707	709	711	713	715	717	719				
06B-B2	W = NA	768	770	772	774	776	778	780	782				
	Z = 49	769	771	773	775	777	779	781	783				
06E-B2	W = NA	832	834	836	838	840	842	844	846				
	Z = 53	50833	835	837	839	841	843	845	847				

Figure 5-31. LIC Unit Type 2 Layout Board B2 (for LIC Type 5)

FRU Locations

LIC Unit Type 2 Layout Board B1 (for LIC Type 5)

Note:

- LICs 5, LICs 6(low-speed), and LICs 6(high-speed) may be intermixed on a given board.
- A pair of LICs may be made up of a LIC 5 and a LIC 6 (low-speed).

BOARD			CA	RD POSI	TION				
	SMUX				L	IC			
	B	C	D	E	F	G	Н	J	к
01M-B1	W = 7	080	082	084	086	088	090	092	094
	Z = NA	081	083	085	087	089	091	093	095
04D-B1	W = 11	144	146	.148	150	152	154	156	158
	Z = NA	145	147	149	151	153	155	157	159
04G-B1	W = 15	208	210	212	214	216	218	220	222
	Z = NA	209	211	213	215	217	219	221	223
04B-B1	W = 19	272	274	276	278	280	282	284	286
	Z = NA	273	275	277	279	281	283	285	287
04E-B1	W = 23	336	338	340	342	344	346	348	350
	Z = NA	337	339	341	343	345	347	349	351
05D-B1	W = 27	400	402	404	406	408	410	412	414
	Z = NA	401	403	405	407	409	411	413	415
05G-B1	W = 31	464	366	468	470	472	474	. 476	478
	Z = NA	465	367	469	471	473	475	477	479
05B-B1	W = 35 -	528	530	532	534	536	538	540	542
	Z = NA	529	531	533	535	537	539	541	543
05E-B1	W = 39	592	594	596	598	600	602	604	606
	Z = NA	593	595	597	599	601	603	605	607
06D-B1	W = 43	656	658	660	662	664	666	668	670
	Z = NA	657	659	661	663	665	667	669	671
06G-B1	W = 47	720	722	724	726	728	730	732	734
	Z = NA	721	723	725	727	729	731	733	735
06B-B1	W = 51	784	786	788	790	792	794	796	798
	Z = NA	785	787	789	791	793	795	797	799
06E-B1	W = 55	848	850	852	854	856	858	860	862
	Z = NA	849	851	853	855	857	859	861	863

Figure 5-32. LIC Unit Type 2 Layout Board B1 (for LIC Type 5)

LIC Unit Type 2 Layout Board B2 (for LIC Type 6 Low-speed)

Note:

- LICs 5, LICs 6(low-speed), and LICs 6(high-speed) may be intermixed on a given board.
- A pair of LICs may be made up of a LIC 5 and a LIC 6 (low-speed).

BOARD			CA	RD POSI	TION						
	SMUX				LIC						
	В	C	D	E	F	G	Н	J	к		
01M-B2	Z=5	064	066	068	070	072	074	076	078		
04D-B2	Z=9	128	130	132	134	136	138	140	142		
04G-B2	Z=13	192	194	196	198	200	202	204	206		
04B-B2	Z=17	256	258	260	262	264	266	268	270		
04E-B2	Z=21	320	322	324	326	328	330	332	334		
05D-B2	Z=25	384	386	388	390	392	394	396	398		
05G-B2	Z=29	448	350	452	454	456	458	460	462		
05B-B2	Z=33	512	514	516	518	520	522	524	526		
05E-B2	Z=37	576	578	580	582	584	586	588	590		
06D-B2	Z=41	640	642	644	646	648	650	652	654		
06G-B2	Z=45	704	706	708	710	712	714	716	718		
06B-B2	Z=49	768	770	772	774	776	778	780	782		
06E-B2	Z=53	832	834	836	838	840	842	844	846		

Figure 5-33. LIC Unit Type 2 Layout Board B2 (for LIC Type 6 Low-speed)

LIC Unit Type 2 Layout Board B1 (for LIC Type 6 Low-speed)

BOARD			CA	RD POSI	TION				
	SMUX				L	IC			
	B	C	D	E	F	G	н	J	ĸ
01M-B1	W=7	080	082	084	086	088	090	092	094
04D-B1	W=11	144	146	148	150	152	154	156	158
04G-B1	W=15	208	210	212	214	216	218	220	222
04B-B1	W=19	272	274	276	278	280	282	284	286
04E-B1	W=23	33 <u>6</u>	338	340	342	344	346	348	350
05D-B1	W=27	400	402	404	406	408	410	412	414
05G-B1	W=31	464	366	468	470	472	474	476	478
05B-B1	W=35	528	510	512	514	516	518	520	522
05E-B1	W=39	592	594	596	598	600	602	604	606
06D-B1	W=43	656	658	660	662	664	666	668	670
06G-B1	W=47	720	722	724	726	728	730	732	734
06B-B1	W=51	784	786	788	790	792	794	796	798
06E-B1	W=55	848	850	852	854	856	858	860	862

Figure 5-34. LIC Unit Type 2 Layout Board B1 (for LIC Type 6 Low-speed)

LIC Unit Type 2 Layout Board B2 (for LIC Type 6 High-speed)

Note:

- Any card plugged in positions C,E,G,J may also be fitted in positions D,F,H,K.
- If there is a LIC 6(high-speed) in one position of a pair, the other position must be left empty.
- LICs 5, LICs 6(low-speed), and LICs 6(high-speed) may be intermixed on a given board.

BOARD			CA	RD POSIT	ION				
	SMUX				L	IC			
	В	C	D	E	F	G	H	J	к
01M-B2	Z=5	064		068		072		076	
04D-B2	Z=9	128		132		136		140	
04G-B2	Z=13	192		196		200		204	
04B-B2	Z=17	256		260		264		268	
04E-B2	Z=21	320		324		328		332	
05D-B2	Z=25	384		388		392		396	
05G-B2	Z=29	448		452		456		460	
05B-B2	Z=33	512		516		520		524	
05E-B2	Z=37	576		580		584		588	
06D-B2	Z=41	640		644		648		652	
06G-B2	Z=45	704		708		712		716	
06B-B2	Z=49	768		772		776		780	
06E-B2	Z=53	832		836		840		844	

Figure 5-35. LIC Unit Type 2 Layout Board B2 (for LIC Ty	ype 6 High-speed)

LIC Unit Type 2 Layout Board B1 (for LIC Type 6 High-speed)

BOARD			CA	RD POSIT	ION				
	SMUX				L	IC			
	В	C	D	E	F	G	Н	J.	К
01M-B1	W=7	080		084		088		092	
04D-B1	W=11	144		148		152		156	
04G-B1	W=15	208		212		216		220	
04B-B1	W=19	272		276		280		284	
04E-B1	W=23	336		340		344		348	
05D-B1	W=27	400		404		408		412	
05G-B1	₩=31	464		468		472	·····	476	
05B-B1	W=35	528		532		536		540	
05E-B1	W=39	592		596		600		604	
06D-B1	W=43	656		660		664		668	
06G-B1	W=47	720		724		728		732	
06B-B1	W=51	784		788		792		796	
06E-B1	W=55	848		852		856		860	

Figure 5-36. LIC Unit Type 2 Layout Board B1 (for LIC Type 6 High-speed)

MUX Number / LIC Number / LINE Address Tables

Frame 01

LOCATION	MUX NUMBER	LIC NU	MBER by LIC	type	LIN	E ADDRESS	by LIC t	ype
		1 - 4	5 or 6 LS	6 H	1 - 4	5	6LS	6HS
01M-B1-B1							1	
01M-B1-C1		N.A	041	041	N.A.	080-081	080	080
01M-B1-D1	for LIC 1-4	025	042	041	096-099	082-083	082	080
01M-B1-E1	Z = 7	026	043	043	100-103	084-085	084	084
01M-B1-F1	W = 8	027	044	043	104-107	086-087	086	084
01M-B1-G1		028	045	045	108-111	088-089	088	088
01M-B1-H1	for LIC 5-6	029	046	045	112-115	090-091	090	088
01M-B1-J1	Z = NA	030	047	047	116-119	092-093	092	092
01M-B1-K1	W = 7	031	048	047	120-123	094-095	094	092
01M-B1-L1		032	N.A	N.A	124-127	N.A.	N.A	N.A
01M-B2-B1								
01M-B2-C1		N.A	033	033	N.A.	064-065	064	064
01M-B2-D1	for LIC 1-4	017	034	033	064-067	066-067	066	064
01M-B2-E1	Z = 5	018	035	035	068-071	068-069	068	068
01M-B2-F1	W = 6	019	036	035	072-075	070-071	070	068
01M-B2-G1		020	037	037	076-079	072-073	072	072
01M-B2-H1	for LIC 5-6	021	038	037	080-083	074-075	074	072
01M-B2-J1	Z = 5	022	039	039	084-087	076-077	076	076
01M-B2-K1	W = NA	023	040	039	088-091	078-079	078	076
01M-B2-L1		024	N.A	Ν.Α	092-095	N.A.	N.A	N.A
01P-B1-B1								
01P-B1-C1		N.A	N.A	N.A	N.A.	N.A	N.A	N.A
01P-B1-D1	for LIC 1-4	009	N.A	N.A	032-035	N.A	N.A	N.A
01P-B1-E1	Z = 3	010	N.A	N.A	036-039	N.A	N.A	N.A
01P-B1-F1	W = 4	011	N.A	N.A	040-043	N.A	N.A	N.A
01P-B1-G1		012	N.A	N.A	044-047	N.A	N.A	N.A
01P-B1-H1	for LIC 5-6	013	N.A	N.A	048-051	N.A	N.A	N.A
01P-B1-J1	Z = NA	014	N.A	N.A	052-055	N.A	N.A	N.A
01P-B1-K1	W = NA	015	N.A	N.A	056-059	N.A	N.A	N.A
01P-B1-L1		016	N.A	N.A	060-063	N.A	N.A	N.A
01P-B2-B1								
01P-B2-C1		N.A	N.A	N.A	N.A.	N.A	N.A	N.A
01P-B2-D1	for LIC 1-4	001	N.A	N.A	000-003	N.A	N.A	N.A
01P-B2-E1	Z = 1	002	N.A	N.A	004-007	N.A	N.A	N.A
01P-B2-F1	W = 2	003	N.A	N.A	008-011	N.A	N.A	N.A
01P-82-G1		004	N.A	N.A	012-015	N.A	N.A	N.A
01P-B2-H1	for LIC 5-6	005	N.A	N.A	016-019	N.A	N.A	N.A
01P-B2-J1	Z = NA	006	N.A	N.A	020-023	N.A	N.A	N.A
01P-B2-K1	W = NA	007	N.A	N.A	024-027	N.A	N.A	N.A
01P-B2-L1		008	N.A	N.A	028-031	N.A	N.A	N.A

Figure 5-37. LIC Number / Line Address Tables for Frame 01

FRU Locations

Frame 04B/D

LOCATION	MUX NUMBER	LIC N	JMBER by LIC	type	LIN	E ADDRESS I	by LIC t	уре
		1 - 4	5 or 6 LS	6 H	1 - 4	5	6LS	6HS
04B-B1-B1								
04B-B1-C1		N.A	137	137	N.A.	272-273	272	272
04B-B1-D1	for LIC 1-4	073	138	137	288-291	274-275	274	272
04B-B1-E1	Z = 19	074	139	139	292-295	276-277	276	276
04B-B1-F1	W = 20	075	140	149	296-299	278-279	278	276
04B-B1-G1		076	141	141	300-303	280-281	280	280
04B-B1-H1	for LIC 5-6	077	142	141	304-307	282-283	282	280
04B-B1-J1	Z = NA	078	143	143	308-311	284-285	284	284
04B-B1-K1	W = 19	079	144 .	143	312-315	286-287	286	284
04B-B1-L1		080	N.A	N.A	316-319	N.A.	N.A	N.A
04B-B2-B1								
04B-B2-C1		N.A	129	129	N.A.	256-257	256	256
04B-B2-D1	for LIC 1-4	065	130	129	256-259	258-259	258	256
04B-B2-E1	Z = 17	066	131	131	260-263	260-261	260	260
04B-B2-F1	W = 18	067	132	131	264-267	262-263	262	260
04B-B2-G1		068	133	133	268-271	264-265	264	264
04B-B2-H1	for LIC 5-6	069	134	133	272-275	266-267	266	264
04B-B2-J1	Z = 17	070	135	135	276-279	268-269	268	268
04B-B2-K1	W = NA	071	136	135	280-283	270-271	270	268
04B-B2-L1		072	N.A	N.A	284-287	N.A.	N.A	N.A
04D-B1-B1								
04D-B1-C1		N.A	073	073	N.A.	144-145	144	144
04D-B1-D1	for LIC 1-4	041	074	073	160-163	146-147	146	144
04D-B1-E1	Z = 11	042	075	075	164-167	148-149	148	148
04D-B1-F1	W = 12	043	076	075	168-171	150-151	150	148
04D-B1-G1		044	077	077	172-175	152-153	152	152
04D-B1-H1	for LIC 5-6	045	078	077	176-179	154-155	154	152
04D-B1-J1	Z = NA	046	079	079	180-183	156-157	156	156
04D-B1-K1	W = 11	047	080	079	184-187	158-159	158	156
04D-B1-L1		048	N.A	N.A	188-191	N.A.	N.A	N.A
04D-B2-B1								
04D-B2-C1		N.A	065	065	N.A.	128-129	128	128
04D-B2-D1	for LIC 1-4	033	066	065	128-131	130-131	130	128
04D-B2-E1	Z = 9	034	067	067	132-135	132-133	132	132
04D-B2-F1	W = 10	035	068	067	136-139	134-135	134	132
04D-B2-G1		036	069	069	140-143	136-137	136	136
04D-B2-H1	for LIC 5-6	037	070	069	144-147	138-139	138	136
04D-B2-J1	Z = 9	038	071	071	148-151	140-141	140	140
04D-B2-K1	W = NA	039	072	071	152-155	142-143	142	140
04D-B2-L1		040	N.A	N.A	156-159	N.A.	N.A	N.A

Figure 5-38. LIC Number / Line Address for Frame 04B/D

FRU Locations

Frame 04E/G

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LOCATION	MUX NUMBER	LIC NU	MBER by LIC	type	LINE ADDRESS by LIC type			
		1 - 4	5 or 6 LS	6 H	1 - 4	5	6LS	6HS
04E-B1-B1								
04E-B1-C1		N.A	169	169	N.A.	336-337	336	336
04E-B1-D1	for LIC 1-4	089	170	169	352-355	338-339	338	336
04E-B1-E1	Z = 23	090	171	171	356-359	340-341	340	340
04E-B1-F1	W = 24	091	172	171	360-363	342-343	342	340
04E-B1-G1		092	173	173	364-367	344-345	344	344
04E-B1-H1	for LIC 5-6	093	174	173	368-371	346-347	346	344
04E-B1-J1	Z = NA	094	175	175	372-375	348-349	348	348
04E-B1-K1	W = 23	095	176	175	376-379	350-351	350	348
04E-B1-L1		096	N.A	N.A	380-383	N.A.	N.A	N.A
04E-B2-B1		· · · · · · · · · · · · · · · · · · ·						
04E-B2-C1		N.A	161	161	N.A.	320-321	320	320
04E-B2-D1	for LIC 1-4	081	162	161	320-323	322-323	322	320
04E-B2-E1	Z = 21	082	163	163	324-327	324-325	324	324
04E-B2-F1	W = 22	083	164	163	328-331	326-327	326	324
04E-B2-G1		084	165	165	332-335	328-329	328	328
04E-B2-H1	for LIC 5-6	085	166	165	336-339	330-331	330	328
04E-B2-J1	Z = 21	086	167	167	340-343	332-333	332	332
04E-B2-K1	W = NA	087	168	167	344-347	334-335	334	332
04E-B2-L1		088	N.A	N.A	348-351	N.A.	N.A	N.A
04G-B1-B1								
04G-B1-C1		N.A	105	105	N.A.	208-209	208	208
04G-B1-D1	for LIC 1-4	057	106	105	224-227	210-211	210	208
04G-B1-E1	Z = 15	058	107	107	228-231	212-213	212	212
04G-B1-F1	W = 16	059	108	107	232-235	214-215	214	212
04G-B1-G1		060	109	109	236-239	216-217	216	216
04G-B1-H1	for LIC 5-6	061	110	109	240-243	218-219	218	216
04G-B1-J1	Z = NA	062	111	111	244-247	220-221	220	220
04G-B1-K1	W = 15	063	112	111	248-251	222-223	222	220
04G-B1-L1		064	N.A	N.A	252-255	N.A.	N.A	N.A
04G-B2-B1								
04G-B2-C1		N.A	097	097	N.A.	192-193	192	192
04G-B2-D1	for LIC 1-4	049	098	097	192-195	194-195	194	192
04G-B2-E1	Z = 13	050	099	099	196-199	196-197	196	196
04G-B2-F1	W = 14	051	100	099	200-203	198-199	198	196
04G-B2-G1	.	052	101	101	204-207	200-201	200	200
04G-B2-H1	for LIC 5-6	053	102	101	208-211	202-203	202	200
04G-B2-J1	Z = 13	054	103	103	212-215	204-205	204	204
04G-B2-K1	W = NA	055	104	103	216-219	206-207	206	204
04G-B2-L1	1	056	N.A	N.A	220-223	N.A.	N.A	N.A

Figure 5-39. LIC Number / Line Address for Frame 04E/G

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Frame 05B/D

LOCATION	MUX NUMBER	LIC NUMBER by LIC type			LINE ADDRESS by LIC type			
		1 - 4	5 or 6 LS	6 H	1 - 4	5	6LS	6HS
05B-B1-B1								
05B-B1-C1		N.A	265	265	N.A.	528-529	528	528
05B-B1-D1	for LIC 1-4	137	266	265	544-547	530-531	530	528
05B-B1-E1	Z = 35	138	267	267	548-551	532-533	532	532
05B-B1-F1	W = 36	139	268	267	552-555	534-535	534	532
05B-B1-G1		140	269	269	556-559	536-537	536	536
05B-B1-H1	for LIC 5-6	141	270	269	560-563	538-539	538	536
05B-B1-J1	Z = NA	142	271	271	564-567	540-541	540	540
05B-B1-K1	W = 35	143	272	271	568-571	542-543	542	540
05B-B1-L1	,	144	N.A	N.A	572-575	N.A.	N.A	N.A
05B-B2-B1								
05B-B2-C1		N.A	257	257	N.A.	512-513	512	512
05B-B2-D1	for LIC 1-4	129	258	257	512-515	514-515	514	512
05B-B2-E1	Z = 33	130	259	259	516-519	516-517	516	516
05B-B2-F1	W = 34	131	260	259	520-523	518-519	518	516
05B-B2-G1		132	261	261	524-527	520-521	520	520
05B-B2-H1	for LIC 5-6	133	262	261	528-531	522-523	522	520
05B-B2-J1	Z = 33	134	263	263	532-535	524-525	524	524
05B-B2-K1	W = NA	135	264	263	536-539	526-427	526	524
05B-B2-L1		136	N.A	Ϋ́.Α	540-543	N.A.	N.A	N.A
05D-B1-B1								
05D-B1-C1		N.A	201	201	N.A.	400-403	400	400
05D-B1-D1	for LIC 1-4	105	202	201	416-419	404-405	402	400
05D-B1-E1	Z = 27	106	203	203	420-423	406-407	404	404
05D-B1-F1	W = 28	107	204	203	424-427	408-409	406	404
05D-B1-G1		108	205	205	428-431	410-411	408	408
05D-B1-H1	for LIC 5-6	109	206	205	432-435	412-413	410	408
05D-B1-J1	Z = NA	110	207	207	436-439	414-415	412	412
05D-B1-K1	W = 27	111	208	207	440-443	416-417	414	412
05D-B1-L1		112	N.A	N.A	444-447	N.A.	N.A	N.A
05D-B2-B1								
05D-B2-C1		N.A	193	193	N.A.	384-385	384	384
05D-B2-D1	for LIC 1-4	097	194	193	384-387	386-387	386	384
05D-B2-E1	Z = 25	098	195	195	388-391	388-389	388	388
05D-B2-F1	W = 26	099	196	195	392-395	390-391	390	388
05D-B2-G1		100	197	197	396-399	392-393	392	392
05D-B2-H1	for LIC 5-6	101	198	197	400-403	394-395	394	392
05D-B2-J1	Z = 25	102	199	199	404-407	396-397	396	396
05D-B2-K1	W = NA	103	200	119	408-411	398-399	398	396
05D-B2-L1	1	104	N.A	N.A	412-415	N.A.	N.A	N.A

Figure 5-40. LIC Number / Line Address for Frame 05B/D

Frame 05E/G

and a second second second second second

LOCATION	MUX NUMBER	LIC NU	MBER by LIC	: type		E ADDRESS I	by LIC t	ype
		1 - 4	5 or 6 LS	6 H	1 - 4	5	6LS	6Н
05E-B1-B1								
05E-B1-C1		N.A	297	297	N.A.	592-593	592	59
05E-B1-D1	for LIC 1-4	153	298	297	608-611	594-595	594	59
05E-B1-E1	Z = 39	154	299	299	612-615	596-597	596	59
05E-B1-F1	W = 40	155	300	299	616-619	598-599	598	59
05E-B1-G1		156	301	301	620-623	600-601	600	60
05E-B1-H1	for LIC 5-6	157	302	301	624-627	602-603	602	60
05E-B1-J1	Z = NA	158	303	303	628-631	604-605	604	60
05E-B1-K1	W = 39	159	304	303	632-635	606-607	606	60
05E-B1-L1	w 35	160	N.A	N.A	636-639	N.A.	N.A	N.
000-01-01		100	,		030-033			
05E-B2-B1								
05E-B2-C1		N.A	289	289	N.A.	576-577	576	57
05E-B2-D1	for LIC 1-4	145	290	289	576-579	578-579	578	57
05E-B2-E1	Z = 37	146	291	291	580-583	580-581	580	58
05E-B2-F1	W = 38	147	292	291	584-587	582-583	582	58
05E-B2-G1		148	293	293	588-591	584-585	584	58
05E-B2-H1	for LIC 5-6	149	294	293	592-595	586-587	586	58
05E-B2-J1	Z = 37	150	295	295	596-599	588-589	588	58
05E-B2-K1	W = NA	151	296	295	600-603	590-591	590	58
05E-B2-L1		152	N.A	N.A	604-607	N.A.	N.A	N.,
05G-B1-B1								
05G-B1-C1		N.A	233	233	N.A.	464-465	464	46
05G-B1-D1	for LIC 1-4	121	234	233	480-483	466-467	466	46
05G-B1-E1	Z = 31	122	235	235	484-487	468-469	468	46
05G-B1-F1	W = 32	123	236	235	488-491	470-471	470	46
05G-B1-G1	w JL	124	237	237	492-495	472-473	472	47
05G-B1-H1	for LIC 5-6	125	238	237	496-499	474-475	472	47
05G-B1-J1	Z = NA	125	230	239	500-503	476-477	476	47
05G-B1-61	W = 31	120	240	239	504-507	478-479	478	47
05G-B1-L1	VV - JI	128	N.A	N.A	508-511	N.A.	N.A	N.
AFC DO D1			· · · · ·					
05G-B2-B1		A1 A	005	005			440	
05G-B2-C1		N.A	225	225	N.A.	448-449	448	44
05G-B2-D1	for LIC 1-4	113	226	225	448-451	450-451	450	44
05G-B2-E1	Z = 29	114	227	227	452-455	452-453	452	45
05G-B2-F1	W = 30	115	228	227	456-459	454-455	454	45
05G-B2-G1		116	229	229	460-463	456-457	456	45
05G-B2-H1	for LIC 5-6	117	230	229	464-467	458-459	458	45
05G-B2-J1	Z = 29	118	231	231	468-471	460-461	460	46
05G-B2-K1	W = NA	119	232	231	472-475	462-463	462	46
05G-B2-L1		120	N.A	N.A	476-479	N.A.	N.A	N.,

Figure 5-41. LIC Number / Line Address for Frame 05E/G

Frame 06B/D

06B-B1-B1 06B-B1-C1			LIC NUMBER by LIC type			LINE ADDRESS by LIC type			
		1 - 4	5 or 6 LS	6 H	1 - 4	5	6LS	6HS	
06B_B1_C1									
000-01-01		N.A	393	393	N.A.	784-785	784	784	
06B-B1-D1	for LIC 1-4	201	394	393	800-803	786-787	786	784	
06B-B1-E1	Z ≈ 51	202	395	395	804-807	788-789	788	788	
06B-B1-F1	W = 52	203	396	395	808-811	790-791	790	788	
06B-B1-G1		204	397	397	812-815	792-793	792	792	
06B-B1-H1	for LIC 5-6	205	398	397	816-819	794-795	794	792	
06B-B1-J1	Z = NA	206	399	399	820-823	796-797	796	796	
06B-B1-K1	W = 51	207	400	399	824-827	798-799	798	796	
06B-B1-L1		208	N.A	N.A	828-831	N.A.	N.A	N.A	
06B-B2-B1									
06B-B2-C1		N.A	385	385	N.A.	768-769	768	768	
06B-B2-D1	for LIC 1-4	193	386	385	768-771	770-771	770	768	
06B-B2-E1	Z = 49	194	387	387	772-775	772-773	772	772	
06B-B2-F1	W = 50	195	388	387	776-779	774-775	774	772	
06B-B2-G1		196	389	389	780-783	776-777	776	776	
06B-B2-H1	for LIC 5-6	197	390	389	784-787	778-779	778	776	
06B-B2-J1	Z = 49	198	391	391	788-791	780-781	780	780	
06B-B2-K1	W = NA	199	392	391	792-795	782-783	782	780	
06B-B2-L1		200	N.A	N.A	796-799	N.A.	N.A.	N.A	
06D-B1-B1									
06D-B1-C1		N.A	329	329	N.A.	656-657	656	656	
06D-B1-D1	for LIC 1-4	169	330	329	672-675	658-659	658	656	
06D-B1-E1	Z = 43	170	331	331	676-679	660-661	660	660	
06D-B1-F1	W = 44	171	332	331	680-683	662-663	662	660	
06D-B1-G1		172	333	333	684-687	664-665	664	664	
06D-B1-H1	for LIC 5-6	173	334	333	688-691	666-667	666	664	
06D-B1-J1	Z = NA	174	335	335	692-695	668-669	668	668	
06D-B1-K1	W = 43	175	336	335	696-699	670-671	670	668	
06D-B1-L1		176	N.A	N.A	700-703	N.A.	N.A	N.A	
06D-B2-B1									
06D-B2-C1		N.A	321	321	N.A.	640-641	640	640	
06D-B2-D1	for LIC 1-4	161	322	321	640-643	642-643	642	640	
06D-B2-E1	Z = 41	162	323	323	644-647	644-645	644	644	
06D-B2-F1	W = 42	163	324	323	648-651	646-647	646	644	
06D-B2-G1		164	325	325	652-655	648-649	648	648	
06D-B2-H1	for LIC 5-6	165	326	325	656-659	650-651	650	648	
06D-B2-J1	Z = 41	166	327	327	660-663	652-653	652	652	
06D-B2-K1	W = NA	167	328	327	664-667	654-655	654	652	
06D-B2-L1		168	N.A	N.A	668-671	N.A.	N.A	N.A	

Figure 5-42. LIC Number / Line Address for Frame 06B/D

FRU Locations

Frame 06E/G

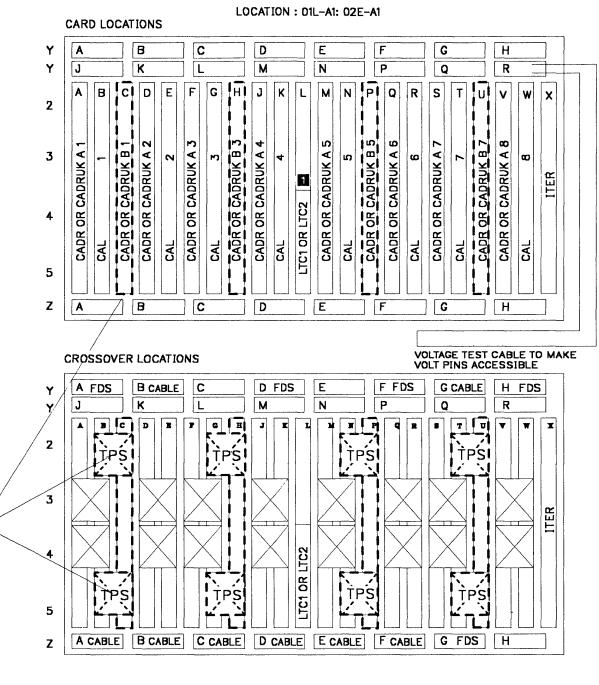
LOCATION	MUX NUMBER	LIC NU	IMBER by LIC	type	LIN	E ADDRESS I	by LIC t	уре
		1 - 4	5 or 6 LS	6 H	1 - 4	5	6LS	6HS
06E-B1-B1								
06E-B1-C1		N.A	425	425	N.A.	848-849	848	848
06E-B1-D1	for LIC 1-4	217	426	425	864-867	850-851	850	848
06E-B1-E1	Z = 55	218	427	427	868-871	852-853	852	852
06E-B1-F1	W = 56	219	428	427	872-875	854-855	854	852
06E-B1-G1		220	429	429	876-879	856-857	856	856
06E-B1-H1	for LIC 5-6	221	430	429	880-883	858-859	858	856
06E-B1-J1	Z = NA	222	431	431	884-887	860-861	860	860
06E-B1-K1	W = 55	223	432	431	888-891	862-863	862	860
06E-B1-L1	N OO	224	N.A	N.A	892-895	N.A.	N.A	N.A
06E-B2-B1								
06E-B2-C1		N.A	417	417	N.A.	832-833	832	832
06E-B2-D1	for LIC 1-4	209	418	417	832-835	834-835	834	832
06E-B2-E1	Z = 53	210	419	419	836-839	836-837	836	836
06E-B2-F1	W = 54	211	420	419	840-843	838-839	838	836
06E-B2-G1	w 31	212	421	421	844-847	840-841	840	840
06E-B2-H1	for LIC 5-6	213	422	421	848-851	842-843	842	840
06E-B2-J1	Z = 53	214	423	423	852-855	844-845	844	844
06E-B2-K1	W = NA	215	424	423	856-859	846-847	846	844
06E-B2-L1	W W	216	N.A	N.A	860-863	N.A.	N.A	N.A
06G-B1-B1								
06G-B1-C1		N.A	361	361	N.A.	720-721	720	720
06G-B1-D1	for LIC 1-4	185	362	361	736-739	722-723	722	720
06G-B1-E1	Z = 47	186	363	363	740-743	724-725	724	724
06G-B1-F1	W = 48	187	364	363	744-747	726-727	726	724
06G-B1-G1		188	365	365	748-751	728-729	728	728
06G-B1-H1	for LIC 5-6	189	366	365	752-755	730-731	730	728
06G-B1-J1	Z = NA	190	367	367	756-759	732-733	732	732
06G-B1-K1	W = 47	191	368	367	760-763	734-735	734	732
06G-B1-L1		192	N.A	N.A	764-767	N.A.	N.A	N.A
06G-B2-B1								
06G-B2-C1		N.A	353	353	N.A.	704-705	704	704
06G-B2-D1	for LIC 1-4	177	354	353	704-707	706-707	706	704
06G-B2-E1	Z = 45	178	355	355	708-711	708-709	708	708
06G-B2-F1	W = 46	179	356	355	712-715	710-711	710	708
06G-B2-G1		180	357	357	716-719	712-713	712	712
06G-B2-H1	for LIC 5-6	181	358	357	720-723	714-715	714	712
06G-B2-J1	Z = 45	182	359	359	724-727	716-717	716	716
06G-B2-K1	W = NA	183	360	359	728-731	718-719	718	716
06G-B2-L1		184	N.A	N.A	732-735	N.A.	N.A	N.A
000-D2-L1		104			1	1		

Figure 5-43. LIC Number / Line Address for Frame 06E/G

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فكالأكاف بإعدار كبر علياتهم ومراجع ومعاريا فالمتكاف

Channel Board and Cards



1

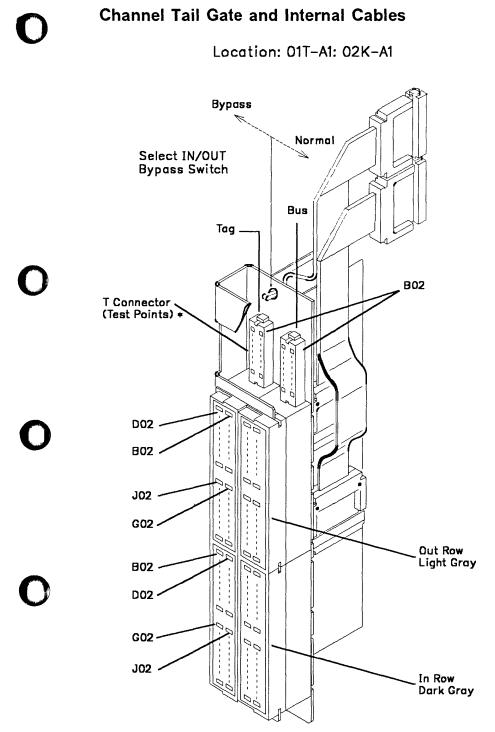
2

- LTC1 is terminator and gives address for CAB1
- LTC2 is terminator and gives address for CAB2

2

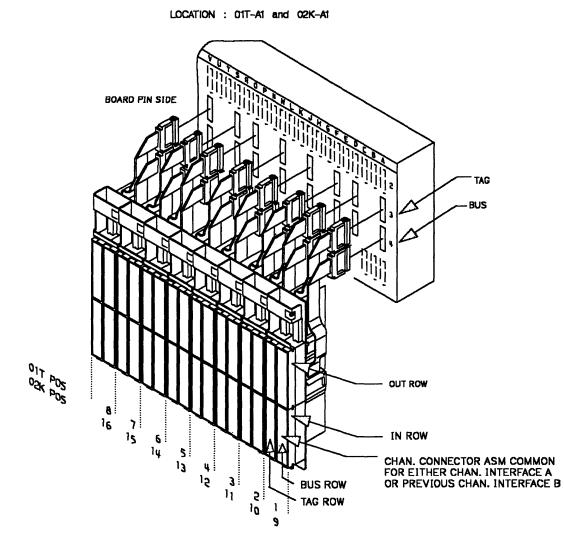
- Cards C,H,P,U and connectors 'TPS' are only present with TPS feature
- When a CA with TPS feature is installed, there is no channel in the associated even position

Figure 5-44. 3745 Channel Board Cards and Connectors



* For details refer to Vol 4; YZ pages.Figure 5-45. 3745 Channel Tail Gate and Standard Interface Test Points

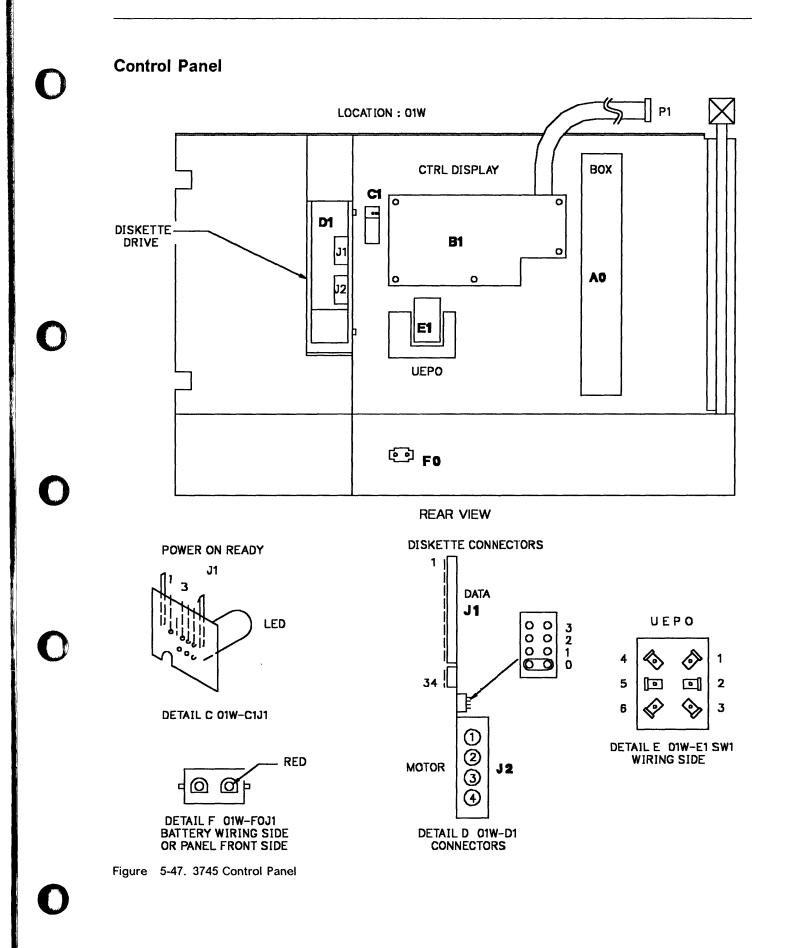
Channel Tail Gate



		CHANNEL INTERFACE A & INTERFACE B (TPS) DISTRIBUTION CHART.								
CA BOARD REAR POS.	TAIL GATE	CA# INTERFACE A INTERFACE B								
A3 A4	1	CA1-A								
D3 D4	2	CA2-A OR CA1-B								
F3 F4	3	САЗ-А								
J3 J4	4	CA4-A OR CA3-B								
M3 M4	5	CA5-A								
Q3 Q4	6	CAS-A OR CAS-B								
53 54	7	CA7-A								
V3 V4	8	CAB-A OR CA7-B								

Figure 5-46. 3745 Channel Tail Gate

	NTERFACE A A	LINTERFACE B (TPS) CHART.
CA BOARD REAR POS.	TAIL GATE	CA# INTERFACE A INTERFACE B
A3 A4	9	CA9-A
D3 D4	10	CA10-A OR CA9-B
F3 F4	11	CA11-A
J3 J4	12	CA12-A OR CA11-B
M3 M4	13	CA13-A
Q3 Q4	14	CA14-A OR CA13-B
S3 S4	15	CA15-A
V3 V4	16	CA16-A OR CA15-B



Primary Power Box LOCATION: OE1 SETTLED BOX PSTY & **◊1E-E1** FRONT PLATE PSTY 6 01E-A1 TFMR (CONV.OUTLET) 2207/1107 2201/2201 CB 1 TB3 LINE CORD CONV. CONV.OUTLET PLATE CB1 PLATE LINE FILTER OE1-B1 01E-

Figure 5-48. 3745 Primary Power Box Components

Table 5-1 (Page 1 of 2). 3745 Power Supply Cross Reference Frame **Power Supply** Location **Area Supplied** Frame 1 Type 2 ID = 01 01V MOSS Type 1 ID = 02 01Q CCU A Type 1 ID = 03 01R CCU B Type 1/1B ID = 02CCU A 01Q Type 1/1B ID = 0301R CCU B CA 01-02 Type 3 ID = 04 01K-A1 Type 3 ID = 05 01K-B1 CA 03-04 Type 3 ID = 06CA 05-06 01K-C1 CA 07-08 Type 3 ID = 07 01K-D1 Type 4 ID = 08 01H-A1 LA 01-02 Type 4 ID = 09 01H-B1 LA 03-04 Type 4 ID = 1001H-C1 LA 05-06 LA 07-08 Type 4 ID = 1101H-D1 Lines 000-063 Type 5 ID = 12 01P-A1 Type 5 or 7 ID = 13 01M-A1 Lines 064-127 P S control Type 6 01F Type 8 01E Fan control Frame 2 Type 3 ID = 14CA 09-10 02D-A1 Type 3 ID = 15CA 11-12 02D-B1 Type 3 ID = 1602D-C1 CA 13-14 Type 3 ID = 1702D-D1 CA 15-16 Type 4 ID = 1802B-A1 LA 09-10 Type 4 ID = 1902B-B1 LA 11-12 Type 4 ID = 2002B-C1 LA 13-14 Type 4 ID = 2102B-D1 LA 15-16 Type 4 ID = 2202G-A1 LA 17-18 Type 4 ID = 23 02G-B1 LA 19-20 02G-C1 LA 21-22 Type 4 ID = 24Type 4 ID = 25 02G-D1 LA 23-24 Frame 3 Type 4 ID = 26 03G-A1 LA 25-26 LA 27-28 Type 4 ID = 27 03G-B1 Type 4 ID = 28 LA 29-30 03G-C1 LA 31-32 Type 4 ID = 29 03G-D1 Frame 4 Lines 128-191 Type 5 or 7 ID = 3004D-A1 Type 5 or 7 ID = 31Lines 192-255 04G-A1 Type 5 or 7 ID = 3204B-A1 Lines 256-319 Type 5 or 7 ID = 33 Lines 320-383 04E-A1

3745 Power Supply Cross Reference

Table 5-1 (F	Page 2 of 2). 3745 Power S	Supply Cross Refe	rence
Frame	Power Supply	Location	Area Supplied
Frame 5	Type 5 or 7 ID = 34	05D-A1	Lines 384-447
	Type 5 or 7 ID = 35	05G-A1	Lines 448-511
	Type 5 or 7 ID = 36	05B-A1	Lines 512-575
	Type 5 or 7 ID = 37	05E-A1	Lines 576-639
Frame 6	Type 5 or 7 ID = 38	06D-A1	Lines 640-703
	Type 5 or 7 ID = 39	06G-A1	Lines 704-767
	Type 5 or 7 ID = 40	06B-A1	Lines 768-831
	Type 5 or 7 ID = 41	06E-A1	Lines 832-895

FRU Exchange Procedures

CADR/CAL Exchange Procedure

Note: There is a special CADR card for the UK.

For physical FRU locations in Frame 01, refer to Figure 5-2 on page 5-6 and Figure 5-44 on page 5-44.

For physical FRU locations in Frame 02, refer to Figure 5-3 on page 5-8 and Figure 5-44 on page 5-44.

IMPORTANT

Check that the 'POWER CONTROL' display is set to local (3) on the control panel. If yes, go to step 4; if not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the power control window.
- 2. Press the 'Validate' key.
- 3. As described in 'Disabling Procedure' the associated channel adapter must be in disconnect status before powering off the PS. (Be sure the two associated channel adapters are disabled).
 - a. Ask the customer to stop activity on the associated channel adapter.
 - b. On the 3745 console, call the CID function
 - c. Enter **D** on the CHANGE E/D REQ field for the interface A (and B if TPS is installed) for the associated channel adapter you are working on.
 - d. Press SEND and wait a few seconds until the **status** change to 'DISABLED'.
 - e. Call menu 3 and type 'CAS' for channel adapter services.
 - f. Press SEND.
 - g. Type '4' for concurrent maintenance commands.
 - h. Press SEND and type the channel adapter number in the CA number = = = > field.

- i. Press SEND.
- 4. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area and press 'SEND'.

You will have the power services menu displayed.

- b. Select the appropriate power services frame and press 'SEND'
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx' where xx = affected power supply id

d. For CADR only, referring to Figure 5-45 on page 5-45 and Figure 5-46 on page 5-46, put the 'Select Out Bypass' switch to the 'BYPASS' position for the channel interface you are working on, and the attached channel interface if the TPS feature is installed for this channel.

5. WARNING: Use the ESD kit and procedures.

- Keeping the correct order, remove the top connectors from the card you have to exchange.
- 7. Exchange the card and re-install the top connectors.
- For CADR only, put the 'Select Out Bypass' switch (or switches) back to the 'NORMAL' position.
- 9. In the 3745 console power services frame, key in '**uxx**' where xx is the PS id. This will turn the PS ON.
- Referring to "How to Run Internal Function Tests" on page 4-29, run the same diagnostics you ran before you exchanged the FRU, then go to "Repair Verification Procedure" on page 5-170.

Control Panel Exchange Procedure

For physical locations, refer to Figure 5-2 on page 5-6

Note: If the nature of the fault does not allow control panel actions, go to step 3f.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Press the 'Service' key on the control panel until (1) is displayed in the service window.
 - b. Press the 'Validate' key.
 - c. Press the 'Function' key on the control panel until the 'MOSS Power OFF' function (B) is displayed.
 - d. Press the 'Validate' key.
 - e. Observe the MOSS Inoperative display on the control panel. At completion of power OFF, it will display the character (**B**).
 - f. Locate the 'Maintenance SW1' on PS type 6. See Figure 5-50 on page 5-53. Lift the lever up and pull it outwards to the 'Test' position. Check that the LED is ON.
 - g. Locate the 'Maintenance SW2'' on PS type 6.
 - h. Switch it to the 'T1' position.

4. WARNING: Use the ESD kit and procedures.

- 5. Open the front cover and the control panel door.
- 6. Exchange the FRU as follows:
 - a. Remove the cable at position 01A-Z0-A6 (control panel FRU comes complete with interconnecting cable). See Figure 5-8 on page 5-13 for cable location.
 - b. Unlatch and swing the control panel gate open.
 - c. Release the cable from its securing points.

d. Remove the 5 screws securing the panel and withdraw the panel complete with cable. 1

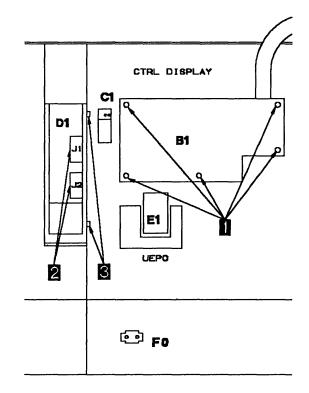


Figure 5-49. Control Panel Removal

- e. To install the control panel, perform this procedure in the reverse order.
- 7. Re-apply power as follows:
 - a. Return the 'Maintenance SW2'' to the 'T2' position.
 - b. Is the control panel displaying 'Power Control' and 'Service Mode' information ? If yes, continue with step 8. If not, the initial checkouts have failed.
 - c. Switch it to the 'T1' position.
 - d. Reseat the PLC card or try another PLC card and return to step 7a.
- Refer to "How to Run the Panel Test" on page 4-21 and run the diagnostic. If the diagnostic runs error free, continue with the next step.
- 9. Push 'Maintenance SW1' back to the 'NORMAL' position.
- 10. Press the 'Function' key on the control panel until (1) is displayed in the function window.

11. Press the 'Validate' key.

Note: This action will power the MOSS ON, run MOSS diagnostics, and complete a MOSS IML. A successful completion will result in a code **F0E,F0F** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14 In the CE leaving procedure you will be instructed to recreate the power configuration, set the time of day clock, and any required scheduled power ON time.

12. Go to "CE Leaving Procedure" on page 5-172.

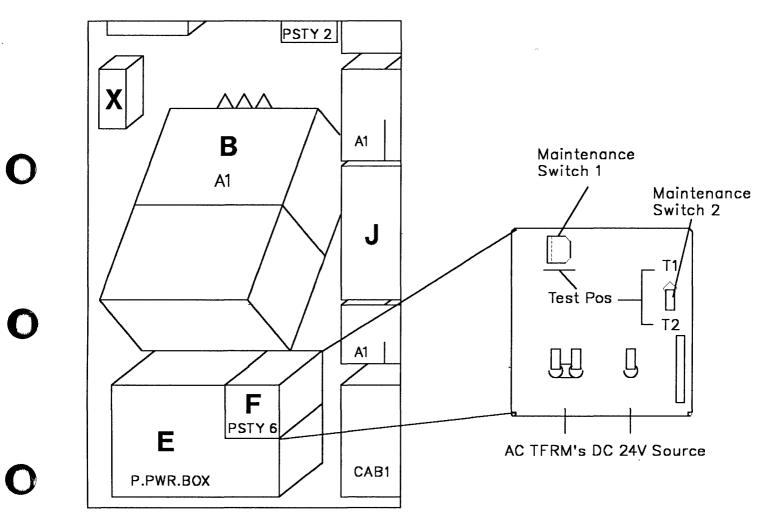


Figure 5-50. PS Type 6 SW1 Actuator

DFA Exchange Procedure

For physical locations, refer to Figure 5-2 on page 5-6 and Figure 5-8 on page 5-13.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Press the 'Service' key until (1) is displayed in the service window.
- 4. Press the 'Validate' key.
- 5. Remove power as follows:
 - a. Press the 'Function' key on the control panel until the 'MOSS Power OFF' function (B) is displayed.
 - b. Press the 'Validate' key.
 - c. Observe the MOSS Inoperative display on the control panel. At completion of power OFF, it will display the character (**B**).).

6. WARNING: Use the ESD kit and procedures.

- 7. Locate the card by referring to Figure 5-8 on page 5-13
- 8. If present, remove the 'shipping springs' that secure the extractor levers by squeezing them together. Refer to Figure 5-57 on page 5-61.
- 9. Remove the card.
- 10. Install the new card.
- 11. Re-install the 'shipping springs' (if present).

Note: In the remaining steps, it is assumed that the microcode is at the same level on both the diskette and the hard disk drive.

- 12. Re-apply power as follows:
 - a. Install the primary backup diskette in the FDD.
 - b. Press the 'Function' key on the control panel until the 'Load from Diskette' function 9 is displayed.
 - c. Press the 'Validate' key.

Note: This action will also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **F0E,F0F** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

- d. If any error is detected, go to "Repair Verification Procedure" on page 5-170.
- 13. If no error is detected :
 - a. Remove the primary backup diskette from the FDD.
 - b. Press the 'Service' key until (0) is displayed in the service window.
 - c. Press the 'Validate' key.
 - d. Press the 'Function' key on the control panel until the 'MOSS IML' function (1) is displayed.
 - e. Press the 'Validate' key.

Note: This action will also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **F0E,F0F** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14.

f. Go to "Repair Verification Procedure" on page 5-170.

FDD Exchange Procedure

For physical locations, refer to Figure 5-2 on page 5-6.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Press the 'Service' key until (1) is displayed in the service window.
- 4. Press the 'Validate' key.
- 5. Before exchanging the FDD, check the voltages as follow:.

Note: The voltages are not permanently applied on the FDD and, to get them available for measurement for approximately 15 minutes, a MOSS IML is required.

- a. Press the 'Function' key on the control panel until the 'MOSS IML' function (1) is displayed.
- b. Press the 'Validate' key.
- c. Using Table 5-2 on page 5-56, measure the voltages on the FDD connector (J2). If the voltages are not within tolerance or are missing, check on the voltage test points of the PS type 2, refer to Figure 5-53 on page 5-56. If that is incorrect, exchange the PS type 2.

Note: If problems are experienced with measuring voltages with the connectors plugged, power the MOSS OFF (function (*B*)), remove connector J2 from the FDD and power the MOSS ON (function 1).

- 6. Remove power as follows:
 - a. Press the 'Function' key on the control panel until the 'MOSS Power OFF' function (**B**) is displayed.
 - b. Press the 'Validate' key.
 - c. Observe the MOSS Inoperative display on the control panel. At completion of

power OFF, this will display the character (**B**).

- 7. WARNING: Use the ESD kit and procedures.
- 8. Open the front cover and the control panel door.
- 9. Replace the FRU as follows:
 - a. Unlatch and swing the control panel gate open.

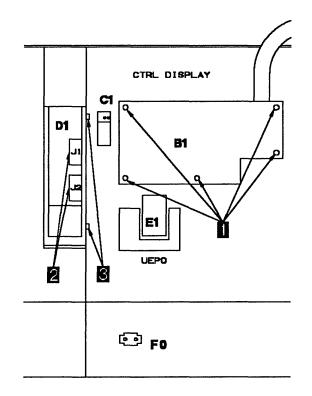
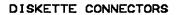
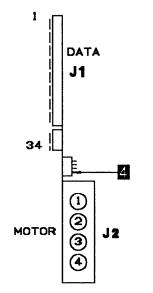


Figure 5-51. FDD Removal

- b. Remove the 2 cables from the drive. 2
- c. Remove the 4 securing screws from the assembly. 3
- d. Slide out the FDD assembly.
- e. Check if the new FDD has a jumper, see Figure 5-52 on page 5-56 for 4. If this is available, ensure that there is a jumper only at position 0.

Exchange Procedure





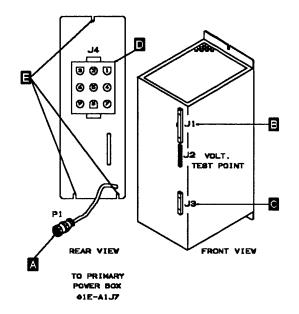


Figure 5-53. PS Type 2

CONNECTORS 01W-D1

Figure 5-52. FDD Jumpering

f. To install the new FDD, perform this procedure in the reverse order.

Note: In the remaining steps, it is assumed that the microcode is at the same level on both the diskette and the hard disk drive.

- 10. Re-apply power as follows:
 - a. Install the primary backup diskette in the FDD.
 - Press the 'Function' key on the control panel until the 'Load from Diskette' function 9 is displayed.
 - c. Press the 'Validate' key.

Note: This action will also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **F0E**,**F0F** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

d. Remove the primary backup diskette from the FDD and go to "Repair Verification Procedure" on page 5-170.

Connector	Pin	Voltage	Max	Min	Ripple
01W-D1-J2 (FDD)	1 2 3 4	+ 12v GND GND + 5v	+ 12.60v + 5.25v	+ 11.60v + 4.85v	.12v peak-to-peak .10v peak-to-peak
PS type 2-J2 Voltage Test Points	2 5 10	+ 12v + 5v GND	+ 12.60v + 5.25v	+ 11.60v + 4.85v	.12v peak-to-peak .10v peak-to-peak

Ο

HDD Exchange Procedure

For physical locations, refer to Figure 5-2 on page 5-6.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Press the 'Service' key until (1) is displayed in the service window.
- 4. Press the 'Validate' key.
- 5. Before exchanging the HDD, check the voltages as follows:

Note: The voltages are not permanently applied to the HDD and, to get them available for measurement for approximately 15 minutes, a MOSS IML is required.

- a. Press the 'Function' key on the control panel until the 'MOSS IML' function (1) is displayed.
- b. Press the 'Validate' key.
 Wait until the control panel displays a hexadecimal code greater than 0A0, it takes approximately 1 minute.
- c. Using Table 5-3 on page 5-58 measure the voltages on the HDD connector (J3). If the voltages are not within tolerance or are missing, check on the voltage test points of the PS type 2; refer to Figure 5-53 on page 5-56. If they are incorrect, exchange the PS type 2.

Note: If problems are experienced with measuring voltages with connectors plugged, power the MOSS OFF (function (*B*)), remove connector P3 from the HDD and power the MOSS ON (function 1).

- 6. Remove power as follows:
 - a. Press the 'Function' key on the control panel until the 'MOSS Power OFF' function (B) is displayed.
 - b. Press the 'Validate' key.
 - c. Observe the MOSS Inoperative display on the control panel. At completion of power OFF, this will display the character (**B**).

7. WARNING: Use the ESD kit and procedures.

- 8. Open the front cover and the control panel door.
- 9. Referring to Figure 5-54, replace the FRU as follows:
 - a. Remove the 3 cables and the ground wire from the drive. **1**
 - b. Remove the 4 securing screws from the assembly. 2

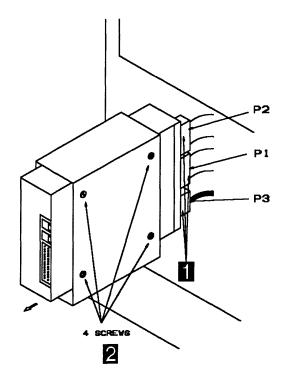


Figure 5-54. HDD Removal

- c. Slide out the HDD assembly.
- d. On the new HDD, remove the rails which are not used in the 3745.
- e. Ensure that there is a jumper in position1. See Figure 5-55.
- f. To install the new HDD, perform this procedure in reverse order.

Exchange Procedure

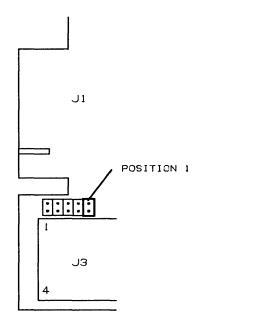


Figure 5-55. HDD Jumpering (Old Model and New Models)

- 10. Re-apply power as follows:
 - a. Install the primary backup diskette in the FDD.
 - b. Press the 'Function' key on the control panel until the 'Load from Diskette' function 9 is displayed.
 - c. Press the 'Validate' key.

Note: This action will also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **FOE**, **FOF** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

- 0 0 0000 J3 J3 0 0 J1 J1 NEW MODELS ::• -position 8 :: :: :: position 1 J2 position 5 J2 position 1
- 11. Refer to "3745 Service Functions, Chapter 11" to initialize and restore the HDD. When previous action is completed, a MOSS IML from the HDD will have been executed.

Note: This action will also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **F0E,F0F** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

- 12. Remove the diskette.
- 13. Go to "Air Filters Exchange Procedure" on page 5-80 and exchange all the filters.

Connector	Pin	Voltage	Max	Min	Ripple
01X-A1-P3 (HDD)	1 2 3 4	+ 12v GND GND + 5v	+ 13.00v + 5.25v	+ 11.00v + 4.85v	.12v peak-to-peak .10v peak-to-peak
PS type 2-J2 Voltage test points	1 5 10	+ 12v + 5v GND	+ 13.00v + 5.25v	+ 11.00v + 4.85v	.12v peak-to-peak .10v peak-to-peak

3

MAC/MAC2 Exchange Procedure

For physical locations, refer to Figure 5-2 on page 5-6 and Figure 5-8 on page 5-13.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Press the 'Service' key until (1) is displayed in the service window.
- 4. Press the 'Validate' key.
- 5. Remove power as follows:
 - a. Press the 'Function' key on the control panel until the 'MOSS Power OFF' function (**B**) is displayed.
 - b. Press the 'Validate' key.
 - c. Observe the MOSS Inoperative display on the control panel. At completion of power OFF, it will display the character (**B**).
- 6. WARNING: Use the ESD kit and procedures.
- 7. The following sequence should always be observed.

- a. Locate the card by referring to Figure 5-8 on page 5-13 and remove the cable attached to the card.
- b. If present, remove the 'shipping springs' that secure the extractor levers by squeezing them together. Refer to Figure 5-56.
- c. Remove the card.
- d. Install the new card.
- Re-install the 'shipping springs' (if present).
- f. Install the cable on the card.
- 8. Re-apply power as follows:
 - a. Press the 'Function' key on the control panel until the 'MOSS IML' function (1) is displayed.
 - b. Press the 'Validate' key.

Note: This action will also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **FOE,FOF** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14.

c. If the MOSS diagnostic was not that which directed you to this FRU, and referring to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1, run the same diagnostics you ran before you exchanged the FRU then go to "Repair Verification Procedure" on page 5-170.

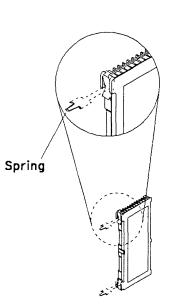




Figure 5-56. Shipping Springs

MPC Exchange Procedure

For physical locations, refer to Figure 5-2 on page 5-6 and Figure 5-8 on page 5-13.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Press the 'Service' key until (1) is displayed in the service window.
- 4. Press the 'Validate' key.
- 5. Remove power as follows:
 - a. Press the 'Function' key on the control panel until the 'MOSS Power OFF' function (**B**) is displayed.
 - b. Press the 'Validate' key.
 - c. Observe the MOSS Inoperative display on the control panel. At completion of power OFF, it will display the character (*B*).
- 6. WARNING: Use the ESD kit and procedures.
- 7. Locate the card by referring to Figure 5-8 on page 5-13

 a. If present, remove the interconnecting cable from the 'PROM' card at position 01A-X0-E4-Z.

Note: The PROM card may not be present on the machine.

- Remove the 'shipping springs' (if present) that secure the extractor levers by squeezing them together. Refer to Figure 5-56 on page 5-59.
- c. Remove the MPC card complete with cable (if present).
- d. Install the new card.
- e. Re-install the 'shipping springs'.
- f. Re-plug the interconnecting cable to the 'PROM' card at position 01A-X0-E4-Z (if present).
- 8. Re-apply power as follows:
 - a. Press the 'Function' key on the control panel until the 'MOSS IML' function (1) is displayed.
 - b. Press the 'Validate' key.

Note: This action will also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **FOE,FOF** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14.

 Go to "Repair Verification Procedure" on page 5-170.

MCA/MSC Exchange Procedure

For physical locations, refer to Figure 5-2 on page 5-6 and Figure 5-8 on page 5-13.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Press the 'Service' key until (1) is displayed in the service window.
- 4. Press the 'Validate' key.
- 5. Remove power as follows:
 - a. Press the 'Function' key on the control panel until the 'MOSS Power OFF' function (**B**) is displayed.
 - b. Press the 'Validate' key.
 - c. Observe the MOSS Inoperative display on the control panel. At completion of power OFF, it will display the character (**B**).

- 6. WARNING: Use the ESD kit and procedures.
- 7. Locate the card by referring to Figure 5-8 on page 5-13
- 8. If present, remove the 'shipping springs' that secure the extractor levers by squeezing them together. Refer to Figure 5-57.
- 9. Remove the card.
- 10. Install the new card.
- 11. Re-install the 'shipping springs' (if present).
- 12. Re-apply power as follows:
 - a. Press the 'Function' key on the control panel until the 'MOSS IML' function (1) is displayed.
 - b. Press the 'Validate' key.

Note: This action will also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **FOE,FOF** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14.

 If the MCA has been exchanged, refer to "How to Run the Console Link Test" on page 4-22 to run this diagnostic, then go to "Repair Verification Procedure" on page 5-170.

Spring

Figure 5-57. Shipping Springs

PAC Exchange Procedure

For physical locations, refer to Figure 5-2 on page 5-6 and Figure 5-8 on page 5-13.

Note: If the nature of the fault does not allow control panel actions, go to step 3f.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Press the 'Service' key on the control panel until (1) is display on the service window.
 - b. Press the 'Validate' key.
 - c. Press the 'Function' key on the control panel until the 'MOSS Power OFF' function (B) is displayed.
 - d. Press the 'Validate' key.
 - e. Observe the MOSS Inoperative display on the control panel. At completion of power OFF, it will display the character (**B**).
 - f. Locate the 'Maintenance SW1' on PS type 6. See Figure 5-50 on page 5-53. Lift the lever up and pull it outwards to the 'Test' position. Check that the LED is ON.
 - g. Locate the 'Maintenance SW2'' on PS type 6.
 - h. Switch it to the 'T1' position.
- 4. WARNING: Use the ESD kit and procedures.
- 5. WARNING: Card damage will result if any other card except PAC is plugged in this position.

- 6. Locate the card by referring to Figure 5-8 on page 5-13
 - a. If present, remove the 'shipping springs' that secure the extractor levers by squeezing them together. Refer to Figure 5-57 on page 5-61.
 - b. Remove the card.
 - c. Install the new card.
 - d. Re-install the 'shipping springs' (if present).
- 7. Re-apply power as follows:
 - a. Return the 'Maintenance SW2'' to 'T2' position.
 - b. Is the control panel displaying 'Power Control' and 'Service Mode' information ? If yes, continue with step 8. If not, the initial checkouts have failed.
 - c. Locate the 'Maintenance SW2' on PS type 6.
 - d. Switch it to the 'T1' position
 - e. Reseat the PLC card or try another PLC card and return to step 7a.
- 8. Refer to "How to Run the Panel Test" on page 4-21 and run the diagnostic.
- 9. Push the 'Maintenance SW1' back to its normal position.
- 10. Press the 'Function' key on the control panel until (1) is displayed in the function window.
- 11. Press the 'Validate' key.

Note: This action will power the MOSS ON, run MOSS diagnostics, and complete a MOSS IML. A successful completion will result in a code **FOE**,**FOF** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14. In the CE leaving procedure you will be instructed to recreate the power configuration, set the time of day clock, and any required scheduled power ON time.

12. Go to "Repair Verification Procedure" on page 5-170.



PLC Exchange Procedure

For physical locations, refer to Figure 5-2 on page 5-6 and Figure 5-8 on page 5-13.

Note: If nature of fault does not allow control panel actions, then go to step 3f

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Press the 'Service' key on the control panel until (1) is display on the service window.
 - b. Press the 'Validate' key.
 - c. Press the 'Function' key on the control panel until the 'MOSS Power OFF' function (B) is displayed.
 - d. Press the 'Validate' key.
 - e. Observe the MOSS Inoperative display on the control panel. At completion of power OFF, it will display the character (*B*).
 - f. Locate the 'Maintenance SW1' on PS type 6. See Figure 5-50 on page 5-53. Lift the lever up and pull it outwards to the 'Test' position. Check that the LED is ON.
 - g. Locate the 'Maintenance SW2' on PS type 6.
 - h. Switch it to the 'T1' position.

4. WARNING: Use the ESD kit and procedures.

- 5. Locate the card by referring to Figure 5-8 on page 5-13
 - a. If present, remove the 'shipping springs' that secure the extractor levers by

squeezing them together. Refer to Figure 5-57 on page 5-61.

- b. Remove the card.
- c. Install the new card.
- d. Re-install the 'shipping springs' (if present).
- 6. Re-apply power as follows:
 - Return the 'Maintenance SW2'' to the 'T2' position.
- Is the control panel displaying 'Power Control' and 'Service Mode' information ? If yes, continue with step 11. If not, the initial checkouts have failed, and continue with step 8.
- 8. Locate the 'Maintenance SW2' on PS type 6.
- 9. Switch it to the 'T1' position.
- 10. Reseat the PLC card or try another PLC card and return to step 6.
- Panel code 008 may appear (depending on the FRU level), do not care.
 Refer to "How to Run the Panel Test" on page 4-21 and run diagnostics.
- 12. Push the 'Maintenance SW1' back to normal position.
- 13. Press the 'Function' key on the control panel until (1) is displayed in the function window.
- 14. Press the 'Validate' key.

Note: This action will power the MOSS ON, run MOSS diagnostics, and complete a MOSS IML. A successful completion will result in a code **F0E**,**F0F** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14. In the CE leaving procedure you will be instructed to recreate the power configuration, set the time of day clock and any required scheduled power ON time.

15. Go to "Repair Verification Procedure" on page 5-170.

PROM Exchange Procedure

For physical locations, refer to Figure 5-2 on page 5-6 and Figure 5-8 on page 5-13.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Press the 'Service' key on the control panel until (1) is displayed on the service window.
- 4. Press the 'Validate' key.
- 5. Remove power as follows:
 - a. Press the 'Function' key on the control panel until the 'MOSS Power OFF' function (B) is displayed.
 - b. Press the 'Validate' key.
 - c. Observe the MOSS Inoperative display on the control panel. At completion of

power OFF, it will display the character (**B**).

6. WARNING: Use the ESD kit and procedures.

- 7. Refer to Figure 5-8 on page 5-13.
- 8. Remove the interconnecting cable from the 'PROM' card at position 01A-X0-E4-Z.
- 9. Exchange the card.
- 10. Re-plug the interconnecting cable to the 'PROM' card at position 01A-X0-E4-Z.
- 11. Re-apply power as follows:
 - a. Press the 'Function' key on the control panel until the 'MOSS IML' function (1) is displayed.
 - b. Press the 'Validate' key.

Note: This action will also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **F0E,F0F** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

12. Go to "Repair Verification Procedure" on page 5-170.

CSP Exchange Procedure

For physical FRU locations in Frame 01, refer to Figure 5-2 on page 5-6 and Figure 5-17 on page 5-22, or Figure 5-19 on page 5-24.

For physical FRU locations in Frame 02, refer to Figure 5-3 on page 5-8 and Figure 5-17 on page 5-22.

For physical FRU locations in Frame 03, refer to Figure 5-4 on page 5-9 and Figure 5-17 on page 5-22.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

Table5-4. Relation Between the CSP Card Location and the Power Services Screen		
CSP or FESL location	Power services screen + ID	
01G-A1-YY	Base Frame ID <i>=′</i> 1′	
02A-A1-YY 02F-A1-YY	Expansion unit A11 ID=′ 2 ′	
03F-A1-YY	Expansion unit A12 ID=' 3 '	

- b. Refer to Table 5-4 ('x' = Power Services Screen ID) and type 'x' to select the appropriate power services frame.
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx' where xx = affected power supply id

4. WARNING: Use the ESD kit and procedures.

- 5. Referring to Figure 5-58 on page 5-66, exchange the CSP card as follows:
 - a. Remove the 3 non-polarized top card connectors from positions W, X and Y.
 - b. Exchange the CSP card.
 - c. Replace the 3 top card connectors.
- 6. Using the MOSS console, turn the affected power supply ON as follows:

On the displayed Power Information screen type '**u**' followed by the number of the affected power supply, to turn it ON.

 Run the same diagnostics you ran before you exchanged the FRU. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1 then go to "Repair Verification Procedure" on page 5-170.

FESL Exchange Procedure

For physical FRU locations in Frame 01, refer to Figure 5-2 on page 5-6 and Figure 5-17 on page 5-22, or Figure 5-19 on page 5-24.

For physical FRU locations in Frame 02, refer to Figure 5-3 on page 5-8 and Figure 5-17 on page 5-22.

For physical FRU locations in Frame 03, refer to Figure 5-4 on page 5-9 and Figure 5-17 on page 5-22.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Refer to Table 5-4 on page 5-65 ('x' = Power Services Screen ID) and type 'x'to select the appropriate power services frame.
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx' where xx = affected power supply id

4. WARNING: Use the ESD kit and procedures.

- 5. Referring to Figure 5-58, exchange the FESL card as follows:
 - a. Remove the 3 non-polarized top card connectors from positions W, X and Y.
 - b. Withdraw the FESL card until the serial link cable (J1) on component side is accessible. Disconnect the cable and fully remove the card.

- Note: Never remove the other end of the SL cable (DMUX or SMUX side) during this maintenance procedure. DMUX or SMUX can be driven by another line adapter and this would lead to the corresponding lines down.
- c. Exchange the FESL card.
- d. Replace the serial link cable and replug the FESL card.
- e. Replace the 3 top card connectors.
- 6. Using the 3745 console, turn the affected power supply ON as follows:

On the displayed power information screen, type 'u' followed by the ID of the affected power supply to turn it ON.

 Run the same diagnostics you ran before you exchanged the FRU. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1 then go to "Repair Verification Procedure" on page 5-170.

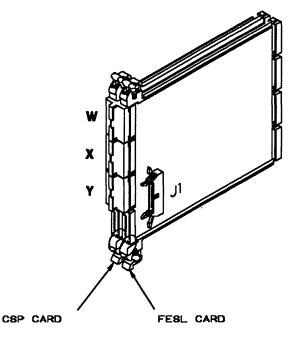


Figure 5-58. CSP and FESL Cards

FESH Exchange Procedure

For physical FRU locations, refer to Figure 5-2 on page 5-6 and Figure 5-17 on page 5-22, or Figure 5-19 on page 5-24.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Type '1' to select the base frame power services.
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx' where xx = affected power supply id

- 4. WARNING: Use the ESD kit and procedures.
- 5. Referring to Figure 5-59, exchange the FESH card as follows:
 - a. Unscrew the plate on the left side of the board and push it up.
 - b. Remove the 3 non-polarized top card connectors from positions W, X and Y.
 - c. Disconnect the 2 cable ground wires from the board.
 - d. Withdraw the FESH card until the 2 line cables (J1, J2) on the component side are accessible. Disconnect the cables (note their position) and remove the card.

- e. Exchange the FESH card (check that the jumper is installed on the new card).
- f. Replace the 2 line cables and replug the FESH card.
- g. Replace the 3 top card connectors.
- h. Reconnect the 2 cable ground wires.
- i. Push the plate on the left side down.

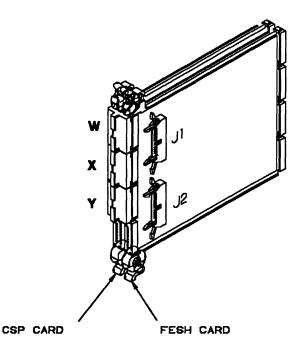


Figure 5-59. FESH Card

6. Using the 3745 console, turn the affected power supply ON as follows:

On the displayed base frame power information screen type ' \mathbf{u} ' followed by the id of the affected power supply to turn it ON.

 Run the same diagnostics you ran before you exchanged the FRU. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1 then go to "Repair Verification Procedure" on page 5-170.

DMUX Exchange Procedure

For physical FRU locations, refer to Figure 5-1 on page 5-5 up to Figure 5-7 on page 5-12 ,and Figure 5-22 on page 5-27.

Since the DMUX is 'hot-pluggable', there is no need to power OFF.

Refer to Figure 5-60 and Figure 5-20 on page 5-25.

- 1. Remove the partial board cover to give access to the DMUX.
- 2. Remove the serial link cable(s) located on top of the DMUX. Note the position(s).

- 3. Unfasten the thumb screw holding the DMUX cassette on the board.
- 4. Exchange the DMUX.
- 5. Fasten the thumb screw holding the DMUX cassette on the board.
- 6. Replace the removed serial link cable(s).
- 7. Replace the partial board cover.
- Run the same diagnostics you ran before you exchanged the DMUX. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1 then go to "Repair Verification Procedure" on page 5-170.

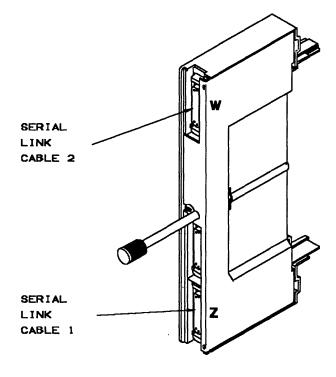


Figure 5-60. DMUX Card

SMUXA/B Exchange Procedure

For physical FRU locations, refer to Figure 5-1 on page 5-5 up to Figure 5-7 on page 5-12 ,and Figure 5-23 on page 5-27.

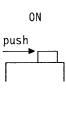
Since the SMUX is 'hot-pluggable', there is no need to power OFF.

Refer to Figure 5-62 on page 5-70 and Figure 5-20 on page 5-25.

- 1. Remove the partial board cover to gain access to the SMUX card.
- 2. Remove the serial link cable(s) located on top or bottom of the SMUX. Note the position(s).
- 3. Disconnect the flat cable between both SMUX A and B.
- 4. Unfasten the thumb screw holding the SMUX cassette on the board.

- 5. Exchange the SMUX.
- 6. Fasten the thumb screw holding the SMUX cassette on the board.
- 7. Replace the removed serial link cable(s).
- 8. Reconnect the flat cable between both SMUX A and B.
- 9. Set the xmit level switches according to the table below.
- 10. Replace the partial board cover.
- Run the same diagnostics you ran before you exchanged the SMUX. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1, then go to "Repair Verification Procedure" on page 5-170.

COUNTRY (leased lines)	XMIT LEVEL (in dBm)	SLIDING SWITCHES			
		1	2	3	4
Canada,Greece,US Ireland,other AP/APG countries	. 0				
	- 1	ON			
	- 2		ON		
	- 3	ON	ON		
	- 4			ON	
	- 5	ON		ON	
Chile,other E.M.E.A countries	- 6		ON	ON	
	- 7	ON	ON	ON	
	- 8			,	ON
Hong-kong	- 9	ON			ON
Denmark,Finland Iceland,Italy,Sweden	-10		ON		ON
	-11	ON	ON		ON
	-12			ON	ON
Australia,UK	-13	ON		ON	ON
	-14		ON	ON	ON
France,Japan	-15	ON	ON	ON	ON



0FF



Figure 5-61. SMUX A/B Switches

Exchange Procedure

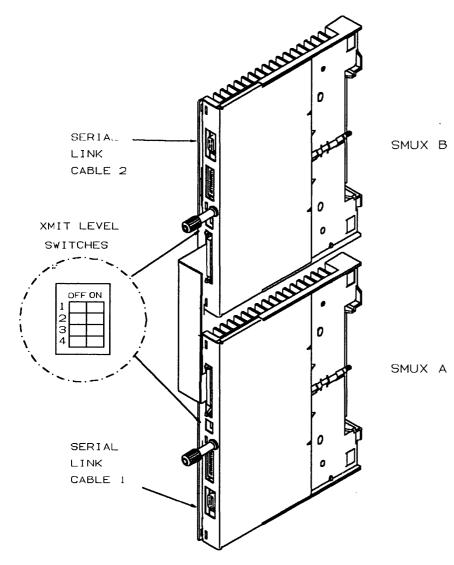


Figure 5-62. SMUX A and SMUX B cards

LIC Type 1-4 Exchange Procedure

For physical FRU locations, refer to Figure 5-1 on page 5-5 up to Figure 5-7 on page 5-12 ,and Figure 5-20 on page 5-25 to 5-29.

Since the LIC is hot-pluggable, there is no need to power OFF.

Refer to Figure 5-63 and Figure 5-20 on page 5-25.

- 1. Remove the line cable(s) from the LIC. Note their positions.
- 2. Unfasten the thumb screw holding the LIC cassette on the board.

- 3. Exchange the LIC.
- 4. Fasten the thumb screw holding the LIC cassette on the board. Finger strength is enough, do not use pliers.
- 5. Replace the line cable(s) removed in step 1.
- Run the same diagnostics you ran before you exchanged the FRU. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1 then go to "Repair Verification Procedure" on page 5-170.

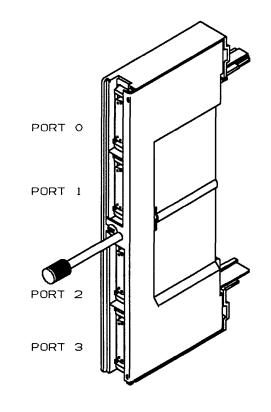


Figure 5-63. LIC Cassette Type 1-4

LIC Type 5 and 6 Exchange Procedure

For physical FRU locations, refer to Figure 5-1 on page 5-5 up to Figure 5-7 on page 5-12 ,and Figure 5-21 on page 5-26 to 5-33.

Since the LIC is hot-pluggable, there is no need to power OFF.

Refer to Figure 5-64 and Figure 5-21 on page 5-26.

- 1. Unplug the line cable(s) at the customer wall frame (to keep the PTT lines loaded).
- 2. Remove the line cable(s) from the LIC. Note their positions.
- 3. Unfasten the thumb screw holding the LIC cassette on the board.
- 4. Exchange the LIC.

- 5. Fasten the thumb screw holding the LIC cassette on the board. Finger strength is enough, do not use pliers.
- 6. If you are exchanging a LIC type 6, locate the speed switch on the right side of the LIC cassette (see Figure 5-64) and set it as it was on the replaced card.
- 7. Ask the customer to select the correct configuration parameters by using the PKD.
- 8. Replace the line cable(s) removed in step 1.
- Run the same diagnostics you ran before you exchanged the FRU. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1 then go to "Repair Verification Procedure" on page 5-170.

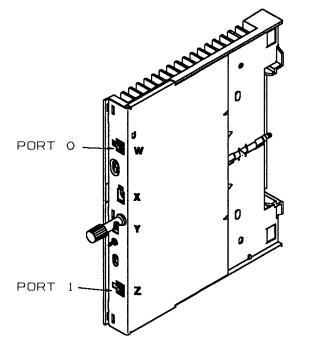
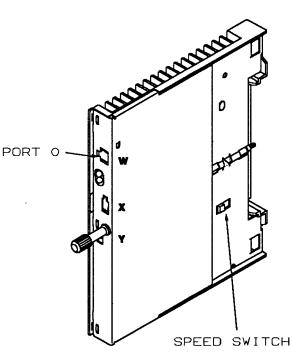


Figure 5-64. LIC Cassette Type 5 and 6



Exchange Procedure

BE SURE TO HAVE NEW FAN READY FOR QUICK EXCHANGE SO 3745 DOESN'T GO DOWN IF REPLACING FAN WHILE 3745 IS IN USE, MARE LIC FAN Exchange Procedure SURE N

Prior to starting the exchange, read the 'Telecommunication Products Safety Handbook', GA33-0126.

WARNING: Power may be present when nothing is displayed on the control panel.

Locations

For LIC fan location 01N : refer to Figure 5-2 on page 5-6.

For LIC fan locations 04C/04F : refer to Figure 5-5 on page 5-10.

For LIC fan locations 05C/05F : refer to Figure 5-6 on page 5-11.

For LIC fan locations 06C/06F : refer to Figure 5-7 on page 5-12.

If the LICs cooled by the LIC fan assembly are type 1,3 or 4 only (powered by PS type 5), go to step 2

If there are LICs type 5 or 6 (powered by PS type 7), continue with the next step.

1. WARNING: Do not forget that the assembly contains 2 fans. You have 2 minutes to replace the assembly. If you exceed 2 minutes the associated power supplies type 7 will automatically be powered OFF.

For this reason:

 Read the following procedure before starting to exchange the assembly.

- Have the assembly to be installed unpacked and close to the location of the failing unit.
- 2. Be sure that the fan blades are running free. Do this by pushing the blades with a thin screwdriver or similar tool.
- 3. Referring to Figure 5-65:
 - a. Unscrew the two screws
 - b. Disconnect the power plug
 - c. Disconnect the AFD plug
 - d. Slide the assembly out of the machine.
 - e. Fit the new assembly into the machine.
 - f. Reconnect the AFD plug B
 - g. Reconnect the power plug A
 - h. Secure the two screws
 - i. Go to "CE Leaving Procedure" on page 5-172.

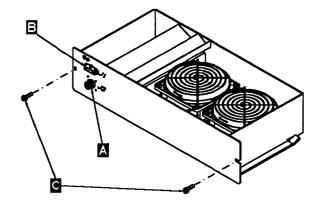


Figure 5-65. Fan Assembly

TRM/TIC Exchange Procedure

For physical FRU locations, refer to Figure 5-2 on page 5-6 and Figure 5-19 on page 5-24.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Type '1' to select the base frame power services.
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx' where xx = affected power supply id

4. WARNING: Use the ESD kit and procedures.

5. If the card you are exchanging is the TIC, do the following, otherwise go to step 6.

Refer to Figure 5-66 on page 5-75 and Figure 5-67 on page 5-75.

- a. Unplug the TIC card and withdraw it until the token-ring cable on the component side is accessible.
- b. Disconnect the token-ring cable.

- c. Fully remove the TIC card.
- d. If the card is a TIC type 1 card, ensure that Jumper A is present and all switches in switch block B are set to ON.
- e. Replug the TIC card in reverse order.
- If you were sent to exchange the TRM, exchange it now. Refer to Figure 5-66 on page 5-75.
- 7. Using the 3745 console, power the affected power supply ON as follows:

On the displayed base frame power services screen type ' \mathbf{u} ' followed by the ID of the affected power supply, to power it ON.

- Although the TRA has been disconnected before exchanging the FRU, you must disconnect again this adapter after power ON and prior to run the diagnostics. Proceed as follows:
 - a. From menu 3 select 'TRSS Services' by entering '**TRS'** into the selection area.
 - b. From the 'TRSS Services' screen choose 'select' by entering '1' in the selection area.
 - c. In the input area enter the number of the suspected adapter.
 - d. Enter '2' in the selection area to choose 'Connect/Disc'.
 - e. On the 'Connect/Disc' screen enter 'DS' to disconnect the TRA.
- Run the same diagnostics you ran before you exchanged the FRU. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1 then go to "Repair Verification Procedure" on page 5-170.

Exchange Procedure

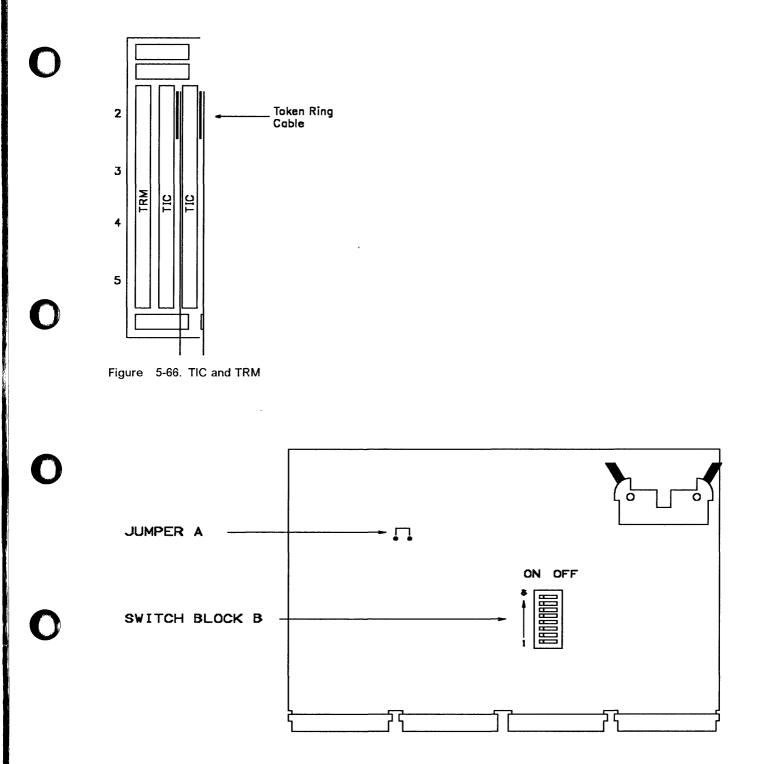


Figure 5-67. Location of Jumper A and Switch Block B on the TIC Card

DTER/ITER Exchange Procedure

For physical FRU locations in frame 01, refer to Figure 5-2 on page 5-6.

For physical FRU locations in frame 02, refer to Figure 5-3 on page 5-8.

For physical FRU locations in frame 03, refer to Figure 5-4 on page 5-9.

WARNING: As each of those cards is common to both CCUs, the whole machine must be available to exchange one of them. Since DTER and ITER are hot-pluggable, there is no need to turn any power OFF.

- 1. Remove the board cover.
- 2. Exchange the card.
- 3. Replace the board cover.
- Run the same diagnostics you ran before exchanging the FRU. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1 then go to "Repair Verification Procedure" on page 5-170.

PTER Exchange Procedure

Refer to the table below for location.

FR01	01M
FR02	02D
	02G
FR03	03G
FR04	04J
	04H
FR05	05J
	05H
FR06	06J
	06H

Figure 5-68. PTER Locations

The 6 power buses on which the power terminator are mounted are located at each frame on the raceway, refer to Figure 5-2 on page 5-8 to figure 5-7 on page 5-12.

Figure 5-68 shows PTER for frame 01.

PTERs are always fitted at the uppermost part of the bus.

The power terminators are hot-pluggable, there is no need to power OFF.

1. Locate the terminator you wish to exchange, as per the above table.

Prior to exchanging the power terminator card, perform the following action:

- 2. Set the Power Control to 'local' as follows:
 - Press the 'Power Control' key until (3) is displayed in the Power Control window.
 - · Press the 'Validate' key.

The procedure is the same as that of the power bus test.

- 3. Set the service mode to 'MAINT 1' as follows:
- 4. Select service (1).

- 5. Press the 'Validate' key.
- 6. Select Function (C).
- 7. Press the 'Validate' key.
- 8. Select the bus on which the failing PTER is fitted (D to H), from power bus test.
- 9. Press the 'Validate' key.
- 10. Locate and remove the power bus terminator card.
- 11. Fit the new power bus terminator card.
- 12. Press the 'Exit' key.
- 13. Press the 'Validate' key.
- 14. Now you have to check that the new terminator card is good, go to "How to Run the Power Control Bus Test" on page 4-24.

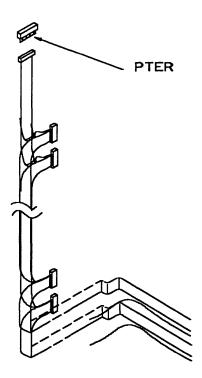


Figure 5-69. Power Terminator (Frame 01 Represented)

STER Exchange Procedure

For physical FRU locations, refer to Figure 5-2 on page 5-6 and Figure 5-9 on page 5-14 for models 210 or 410, or Figure 5-10 on page 5-15 for models 310 or 610.

WARNING: Do not remove more than one card at a time, since the air flow would not be powerful enough to cool the other cards properly.

Since STER is hot pluggable, there is no need to turn the power OFF.

- 1. Remove the board cover by loosening the screws.
- 2. Remove the card as follows:
 - a. Using both hands, release levers A and B simultaneously by moving them upwards and outwards to their fullest extent, refer to Figure 5-70.
 - b. Press catches C and D in gently, draw the card assembly out of the board (catches can be released after initial withdrawal).
- 3. Replace the card as follows:
 - a. Open the card handle by pressing in catches C and D gently and pulling the handle.

- b. Ensure that the levers A and B are still open to their fullest extent.
- c. Insert the card into the slot and allow it to seat under its own weight ensuring that it has reached the end of the slot.

Take care to place the card so that the card label is towards the corresponding board label.

- d. Press catches C and D in and push the handle until it locks in the closed position (catches can be released after initial motion).
- e. Using both hands, release levers A and B simultaneously by moving them down-wards and inwards.
- Note: In order to improve contact, maneuver the card seating levers 3 times.
- 4. Replace the cover above the common area.
- 5. Replace the board cover.
- Run the same diagnostics you ran before exchanging the FRU. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1 then go to "Repair Verification Procedure" on page 5-170.

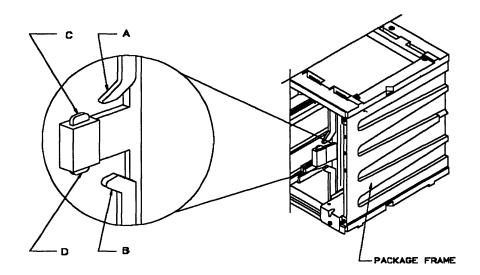


Figure 5-70. Card Clamp Mechanism

Storage and Controls Exchange Procedure

For physical FRU locations, refer to Figure 5-2 on page 5-6 and Figure 5-9 on page 5-14 for models 210 or 410, or Figure 5-10 on page 5-15 for models 310 or 610.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Type '1' to select the base frame power services.
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx' where xx = affectedpower supply id

WARNING: Do not remove more than one card at a time, since the air flow would not be powerful enough to cool the other cards properly.

- 4. WARNING: Use the ESD kit and procedures.
- 5. Remove the board cover by loosening the screws.
- 6. Remove the card as follows:
 - a. Using both hands, release levers A and B simultaneously by moving them upwards and outwards to their fullest extent, refer to Figure 5-70 on page 5-78.
 - b. Press catches C and D in gently, draw the card assembly out of the board (catches can be released after initial withdrawal).

- 7. Replace the card as follows:
 - a. Open the card handle by pressing catches C and D in gently and pulling the handle.
 - b. Ensure that the levers A and B are still open to their fullest extent.
 - c. Insert the card into the slot and allow it to seat under its own weight ensuring that it has reached the end of the slot.

Take care to place the card so that the card label is towards the corresponding board label.

- d. Press catches C and D in and push the handle until it locks in the closed position (catches can be released after initial motion).
- e. Using both hands, release levers A and B simultaneously by moving them downwards and inwards.
- Note: In order to improve contact, maneuver the card seating levers 3 times.
- 8. Replace the board cover.
- 9. Turn the power supply ON by using the power menus as follows:
 - a. Type '**POS**' on any displayed screen selection area. You will have power services menu displayed.
 - b. Type '1' to call the base frame power services.
 - c. Type '**u02**' or '**u03**' depending of the power id you want to turn ON.
- 10. Run the CCU diagnostics for any of the replaced cards, and

Run IOC diagnostics for IOSW card or HPTSS diagnostics for DMSW card. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1), and follow 'How to Run Internal Function Tests' then go to "Repair Verification Procedure" on page 5-170.

Air Filters Exchange Procedure

It is the CE's responsibility to exchange the air filters of the 3745.

(**Note** : We advise you to take advantage of this intervention to check the battery voltage and to exchange it if necessary.)

Gate Filters

No special procedure is needed to exchange the filters located at the bottom of the following gates:

Frame 01 Frame 02 Frame 03

- 1. Open the front cover of the frame.
- 2. Open the internal black cover.
- 3. Exchange the filter, follow the arrow direction.
- 4. Close the covers.

Air Moving Device Filters for Models 210 or 410

The 3745 will automatically send an alert to the operator console when the filters have to be changed.

Perform the following steps to remove the air filter unit:

- 1. Referring to Figure 5-71:
 - Open the left front cover of frame 01.
 - Remove the internal black cover, by unscrewing the 4 screws.
- 2. Referring to Figure 5-72:
 - Locate the air filters for CCU A and CCU B A
- 3. Referring to Figure 5-73 on page 5-81:
 - Unlock the air filter retaining screw A
 - Remove the air filter
 - Put the new air filter in and tighten the screw.
- 4. Close the covers.

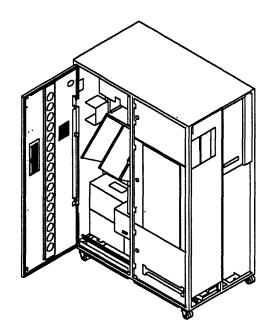


Figure 5-71. Frame 01 Internal Access

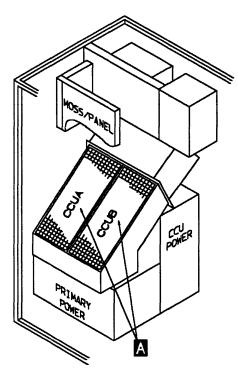


Figure 5-72. AMD Filter Location

5-80 IBM 3745 Communication Controller

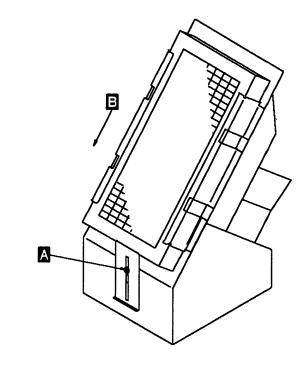


Figure 5-73. Filter Removal

Reporting: Now you have to update the air filters exchange record as follows:

- Using the 3745 console type '**POS**' on any displayed screen selection area.
- You now have the power services menu displayed.

If you have a MOSS console function in process, hit the 'F1' key to terminate it.

Referring to Figure 5-76 on page 5-83 and Figure 5-77 on page 5-83:

- Select option A.
- · Select option F to acknowledge the change.
- Confirm the change (Y/N).

A successful command message will appears.

If you have exchanged the air filters after a HDD replacement, Go to "Repair Verification Procedure" on page 5-170.

If not: Go to "CE Leaving Procedure" on page 5-172.

Air Moving Device Filter for Models 310 and 610

(**Note** : We advise you to take advantage of this intervention to check the battery voltage and to exchange it if necessary.)

The 3745 will automatically send an alert to the operator console when the filter has to be changed.

- 1. Open the left front door of frame 01 (base frame).
- 2. Locate the front air moving device filter, refer to Figure 5-74.
- Loosen the screw which maintains the bracket 1 then push the bracket down. You can now remove the air filter by sliding it down.
- 4. Insert the new air filter. Take care, the arrow on the side of the filter must be **downward**.
- 5. Slide the bracket up then tighten the screw.
- 6. Close the front door.

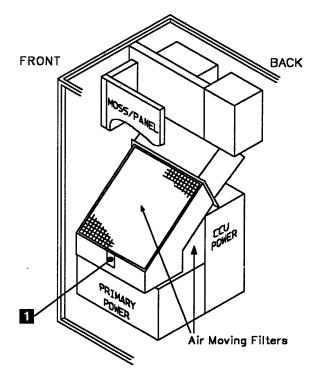


Figure 5-74. Air Filter locations

- 7. Open the back doors of the frame 01 (Base frame).
- 8. Locate the back air moving device filter 2. Refer to Figure 5-74 on page 5-81 and Figure 5-75.
- 9. Loosen the screw wich maintains the bracket
 3 , then remove it. You have to draw gently aside the FDS cables then you can remove the air filter.
- 10. Insert the new air filter. Take care, the arrow on the side of the filter must be **upward**.
- 11. Reinstall the bracket, then tighten the screw.
- 12. Cose the back doors.

BACK

2

Reporting: Now you have to update the air filters exchange record as follows:

- Using the 3745 console type '**POS**' on any displayed screen selection area.
 - 3

Figure 5-75. Back Air Filter location

 You now have the power services menu displayed.

If you have a MOSS console function in process, hit the 'F1' key to terminate it.

Referring to Figure 5-76 on page 5-83 and Figure 5-77 on page 5-83:

• Select option A.

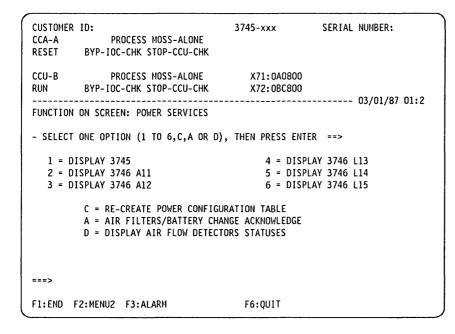
FRONT

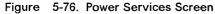
- Select option F to acknowledge the change.
- Confirm the change (Y/N).

A successful command message will appear.

If you have exchanged the air filters after an HDD replacement, go to "Repair Verification Procedure" on page 5-170.

If not: go to "CE Leaving Procedure" on page 5-172.





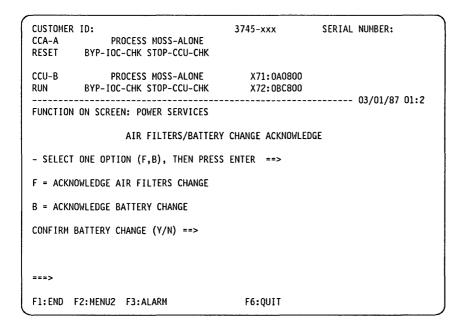


Figure 5-77. Acknowledge Screen

Air Moving Device Exchange Procedure for Models 210 and 410

The following procedures concern the removal and installation of the air moving device (AMD).

This procedure is valid for both CCUs.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Type '1' to select the base frame power services.
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx'

CCU A xx = 02CCU B xx = 03.

Air Moving Device Removal

- 1. Referring to Figure 5-78:
 - Open the left front cover of frame 01.
 - Remove the upper internal black covers by unscrewing the 4 screws.
- 2. Referring to Figure 5-79:
 - Locate the failing AMD given by either the reference code or the FRU list
 - Unplug the power cord **B** of the CCU air moving device.

WARNING: Take care not to switch the nearby CPs OFF.

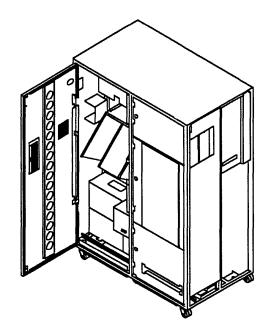


Figure 5-78. Frame 01 Internal Access

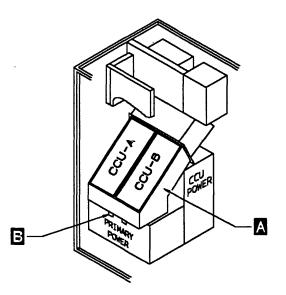


Figure 5-79. Air Moving Devices Location

- 3. Referring to Figure 5-80:
 - Remove the 4 mounting screws A of the air moving device unit.
 - To remove the air moving device, swing out the bottom of the unit and lift out **B**

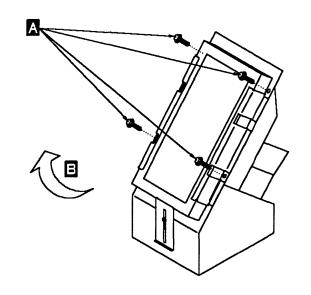


Figure 5-80. Air Moving Devices Removal

Air Moving Device Installation

Note: Inspect the air filter, do not hesitate to exchange it if dirty, also update the exchange record, refer to "Air Filters Exchange Procedure" on page 5-80.

To replace the air moving device assembly, perform the removal procedure in the reverse order.

Then:

- 1. Using the 3745 console, turn the affected power supply ON as follows:
 - Type '**POS**' on any displayed screen selection area.

You now have the power services menu displayed.

- Select option 1.
- Type '**uxx**' to turn the power supply ON. CCU A xx=02CCU B xx=03.
- 2. Go to "Repair Verification Procedure" on page 5-170.

Air Moving Device Exchange Procedure for Models 310 and 610

The following procedure concerns the removal and the installation of the air moving device (AMD).

This procedure is valid for both CCUs.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follow:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Type '1' to select the base frame power services.
- c. On the displayed information screen, check the status of the affected power supply.
 - If it is up, type 'dxx' CCU A xx=02 CCU B xx=03

Air Moving Device Removal

- 1. Open the left front door of frame 01 (base frame).
- 2. Locate the air moving devices, refer to Figure 5-81.

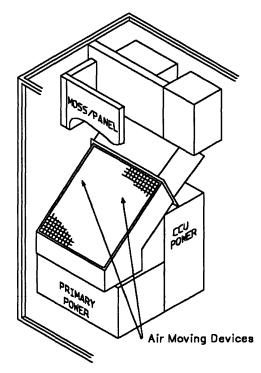


Figure 5-81. Air Moving Devices Location

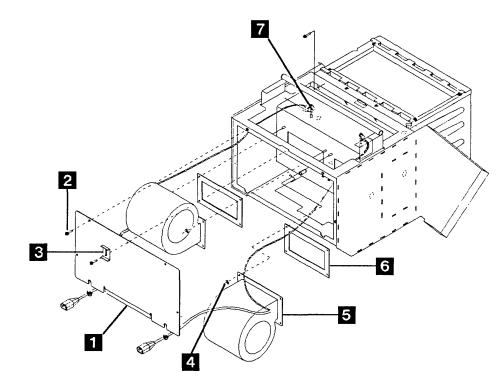


Figure 5-82. Air Moving Devices Removal

- Refer to Figure 5-82. Remove the screw which maintains the bracket 3. You can now remove the upper filter by sliding it down.
- Remove the four screws 2 which maintain the plate 1. Remove the plate.
- Locate the failing air moving device given by either the reference code or the FRU list. The air moving device for CCU A is the left one.
- 6. Disconnect the power plug related to the failing air moving device.
- 7. Disconnect the ground wire related to the failing air moving device **7**.
- Remove the four nuts 4 which maintain the failing air moving device unit. Remove this unit.
- 9. Remove the related pad 6.

Air Moving Device Installation

Note: Inspect the air filter, do not hesitate to exchange it if dirty, also update the exchange record, refer to "Air Moving Device Filter for Models 310 and 610" on page 5-81.

To replace the air moving device unit, perform the removal procedure in the reverse order.(If you do not achieve to reinstall the four nuts which maintain the air moving device, note that it is admitted that three nuts may be considered sufficient).

Then:

- 1. Using the 3745 console, turn the affected power supply ON as follow:
 - a. Type **POS** on any displayed screen selection area.

You now have the services menu displayed.

- b. Select option 1.
- c. Type '**uxx**' to turn the power supply ON. CCU A xx=02CCU B xx=03
- 2. Go to "Repair Verification Procedure" on page 5-170.

Battery Exchange Procedure

It is the CE's responsibility to exchange the battery.

The 3745 will automatically send an alert to the operator console when there is a need to exchange the battery.

Perform the following steps to remove the battery:

- 1. Referring to Figure 5-83:
 - Open the left front cover of frame 01.
 - Locate the battery at the bottom of the control panel

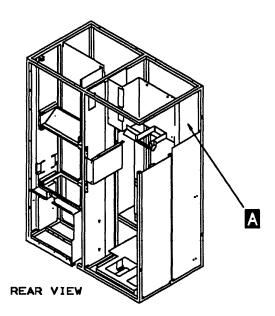


Figure 5-83. Battery Location

- 2. Referring to Figure 5-84:
 - Unclip the battery A
 - Unplug the battery plug B
 - Replace the new battery and reconnect the plug.

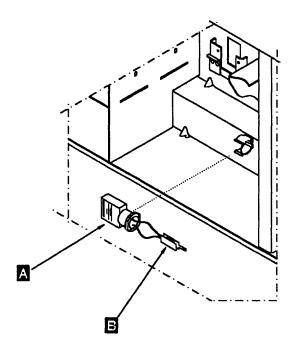


Figure 5-84. Battery Removal

- 3. Close the covers.
- 4. Battery disposal must be performed according to the instructions on the battery case.

Reporting

Now you have to update the battery exchange record as follows:

- Using the 3745 console, type '**POS**' on any displayed screen selection area.
- You now have the power services menu displayed. If you have a MOSS console function in process, hit the 'F1' key to terminate it.

Referring to Figure 5-85 on page 5-89 and Figure 5-86 on page 5-89:

- Select option **A** = air filter/battery.
- Select option **B** = acknowledge battery.
- Confirm the exchange (Y/N).

A successful command message will appears.

Go to "CE Leaving Procedure" on page 5-172.

CUSTOMER ID: CCA-A PROCESS MOSS-ALONE RESET BYP-IOC-CHK STOP-CCU-CHK	3745-xxx	SERIAL NUMBER:
CCU-B PROCESS MOSS-ALONE RUN BYP-IOC-CHK STOP-CCU-CHK	X72:0BC800	03/01/87 01:2
FUNCTION ON SCREEN: POWER SERVICES		03,01,07 0112
- SELECT ONE OPTION (1 TO 6,C,A OR D),	THEN PRESS ENTER	==>
1 = DISPLAY 3745	4 = DISPLA	Y 3746 L13
2 = DISPLAY 3746 A11	5 = DISPLA	Y 3746 L14
3 = DISPLAY 3746 A12	6 = DISPLA	Y 3746 L15
C = RE-CREATE POWER CONFIGUR A = AIR FILTERS/BATTERY CHAN D = DISPLAY AIR FLOW DETECTO	IGE ACKNOWLEDGE	
===>		
F1:END F2:MENU2 F3:ALARM	F6:QUIT	

Figure 5-85. Power Services Screen

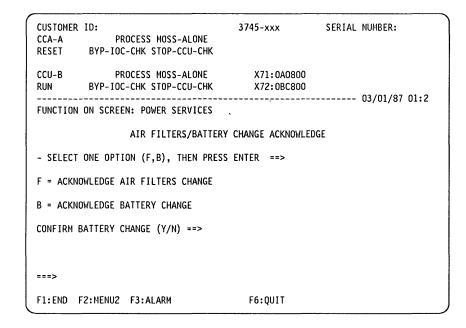


Figure 5-86. Acknowledge Screen

MOSS Blower Exchange Procedure

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the "Validate" key.
- 3. Press the 'Service' key until (1) is displayed.
- 4. Press the "Validate" key.
- 5. Remove power as follows:
 - Press the 'Function' key on the control panel until the 'MOSS Power OFF' function (**B**) is displayed.
 - · Press the 'Validate' key.
 - Observe the MOSS inoperative display on the control panel. At completion of power OFF, it will display the character (**B**).

MOSS Blower Assembly Removal

- 1. Referring to Figure 5-87:
 - Open the left front cover of frame 01.
 - Remove the upper internal black covers by unscrewing the 4 screws.
 - Locate the blower below the MOSS board at 01A-Z0.

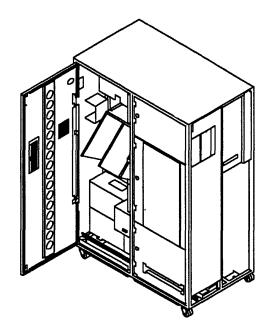


Figure 5-87. Frame 01 Internal Access

- 2. Referring to Figure 5-88:
 - Unplug the connector **A** from the front.
 - Go to the rear side of the 3745 and open the right cover of frame 01.
 - Unplug the connector B 01A-W0C4.
 - Unlock the 2 retaining screws
 - Slide the assembly out of the machine

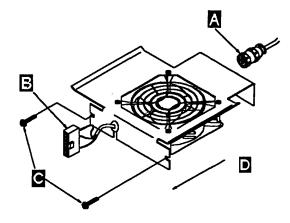


Figure 5-88. Blower Assembly Removal

MOSS Blower Assembly Installation

To replace the MOSS blower assembly, perform this procedure in the reverse order. Then:

- 1. Turn the MOSS ON, proceed as follows:
 - Using the 'Function' key scroll till the value is (1), MOSS IML.
 - Press the 'Validate' key.

Note: This action will also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **FOE,FOF** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

2. Go to "Repair Verification Procedure" on page 5-170.

TCM Exchange Procedure

The following procedures concern the removal and installation of FRUs that pertain to the Thermal Conduction Modules (TCM), and TCM cables.

This procedure is valid for both CCUs.

WARNING: Always be aware that the TCM is susceptible to mechanical shock damage. Carefully observe handling instructions and keep the TCM in its shipping container whenever it is not in the machine.

Tools Required and Preliminary Procedures

Tools Required

The following tools are required to service the TCM area of the CCU.

TCM tool kit P/N 69x7667

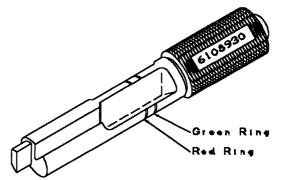
This tool kit contains the following tools:

—	Tool case TCM	P/N 69x7668
—	Label TCM kit, (inside the case)	P/N 69x7669
-	Clip-on TCM cover (COTC) 7331541*	P/N
	TCM handle 7331537*	P/N
	TCM actuation tool	P/N 5665908
	TCM cam gauge	P/N 6108930
	Module pin aligner (2)	P/N 2360424
	Module Pin Template	P/N 4447370
	Hex drive torque tool (red)	P/N 2360092
—	Hex drive torque tool (blue)	P/N 4134750
	1/4 ratchet	P/N 1808111
•	ESD kit	P/N 6428316
•	Signal cable unlatch tool	P/N 2360349
* ^		

* Also shipped in container with each new TCM

TCM Cam Gauge P/N 6108930

The TCM Cam Gauge is provided to check that the TCM is cammed into position correctly after the TCM is installed, using the TCM actuating tool.



TCM Actuation Tool P/N 5665909

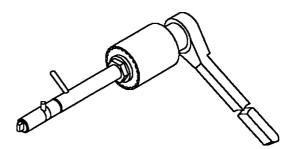
This tool is used to bring the TCM to a cammed position (installation) or to an uncammed position (removal).

The depth indicator ring gives an indication if the tool is properly inserted.

If the tool is fully inserted the ring is no longer visible.

The detent pin must be set to the R position for removal and to the I position to install the TCM.

The indicator pin, points to the 3 o'clock position if the TCM is in the cammed position and to the 7 o'clock position if the TCM is in the uncammed position.



Module Pin Aligner P/N 2360424

Pins may become bent on a module so that it cannot be installed properly without causing severe damage to the system.

To ensure against this potential damage, the pin alignment of a module must be checked before installation.

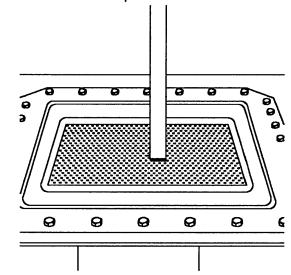
A visual inspection must be made by sighting down the row of pins.

Any pins out of alignment should be checked using the multiple end of the tool to ensure alignment.

The module pin aligner tool should be used only if PINS ARE BENT.

One end of the tool is for straightening a single pin, while the other end is used to verify that a bent pin is straightened correctly, in relation to the surrounding pins.

After bent pins have been straightened, use the Module Pin Template to verify the alignment of all of the module pins.



Module Pin Template P/N 4447370

This tool is provided to check the alignment of the TCM connector pins.

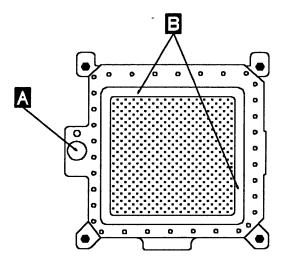
Take the template in both hands with the part number visible.

Align the template so that the large hole in the template coincides with the cam hole in the TCM

Carefully align the gauge with the guide pins on the TCM base plate.

A slight downward pressure on each end of the pin gauge **B** should cause the template to fit easily.

If it does not fit properly use the module pin aligner to straighten the bent pin(s).



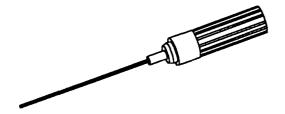
Torque Tool P/N 2360092

This tool is used to operate the screws that hold the TCM module, heat-sink, and module guide.

It is a hand-operated tool with a preset torque setting when turned in a clockwise direction.

Torque control is needed to prevent damage to the screw threads and inserts. When removing screws always ensure that the tip is fully seated in the socket head screw.

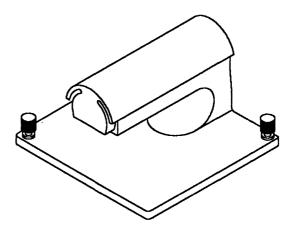
The tool has a positive drive in the counterclockwise direction.



TCM Handle P/N 7331537

This handle is part of the shipping container.

When removing a TCM module, this handle must be mounted right after the heat-sink is removed.



Clip-on TCM Cover (COTC) P/N 7331541

This cover is normally used when the module is returned to the manufacturing plant.

It should also be used if the module is removed for any other reason, to keep the pins from being bent.

Handling ESD-Sensitive TCM FRUs

The 3745 CCUs use parts that are known to be sensitive to electrostatic discharge (ESD).

To prevent damage to ESD-sensitive parts, observe the following procedures.

Perform these procedures in addition to all the usual precautions, such as powering OFF the unit before removing TCMs.

- Keep the ESD-sensitive part in its original shipping container until the part is ready to be installed in the machine.
- Make as few body movements as possible to prevent an increase of static electricity in clothing, carpet, and furniture fabric.
- Before touching the ESD-sensitive part, connect the ESD kit, P/N 6428316 as follows:

Place the wristband around your wrist and attach the wristband to the snap-on clip at the end of the ESD cable

Attach the alligator clip on the other end of the ESD cable to a ground strap on the machine frame.

• Hold the ESD-sensitive part by the edge or the connector shroud (cover); **Do not touch the pins**. If a pluggable module is being removed, use the correct module. • Do not place the ESD-sensitive part on the machine cover or on a metal table; if the ESD-sensitive part must be put down for any reason, first place it in its special protective container.

Machine covers and metal tables are electrical grounds.

They increase the risk of damage because they provide a discharge path from the human body through the ESD-sensitive part.

Large metal objects can provide discharge paths without being grounded.

 Prevent ESD-sensitive parts from being accidentally touched by other customer engineers (CEs) or customers.

Re-install the cover on the machine while the machine is not being serviced, and do not place unprotected ESD-sensitive parts on a table.

- If possible, keep all ESD-sensitive parts in a grounded metal cabinet or case.
- Be especially careful in working with ESD-sensitives parts when cold weather heating is used; low humidity increases static electricity.

Removal and Replacement Procedure

Connect the ESD kit:

- Place the wristband around your wrist and attach the wristband to the snap-on clip at the end of the ESD cable.
- Attach the alligator clip on the other end of the ESD cable to a ground strap on the machine frame, for example grounding strap close to the frame lock.
- Attach the center connector of the ESD cable to the conductive mat.

TCM Removal

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Type '1' to select the base frame power services.
- c. On the displayed information screen, check the status of the affected power supply.
 - If it is up, type 'dxx'
 - CCU A xx = 02
 - CCU B xx = 03.
- 4. Referring to Figure 5-89:
 - Open the left front cover of frame 01.
 - Remove the internal black cover by unscrewing the 4 screws.

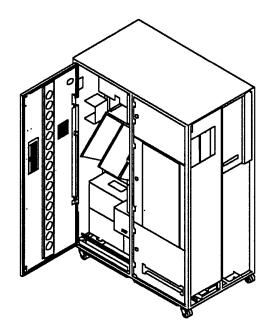


Figure 5-89. Frame 01 Internal Access

- 5. Referring to Figure 5-90:
 - Locate the failing CCU unit given by either the reference code or the FRU list
 A
 - Unplug the power cord of the CCU Air Moving Device B
 - J1 for CCU A, J2 for CCU B.

WARNING: Take care not to switch the nearby CPs OFF.

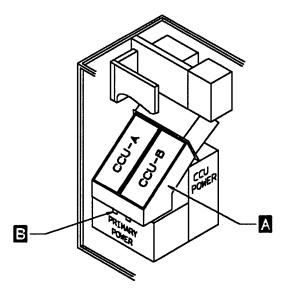


Figure 5-90. AMD Location

- 6. Referring to Figure 5-91 on page 5-97:
 - Remove the 4 mounting screws
 - To remove the Air Moving Device, swing up the bottom of the unit and lift out **B** Move the AMD to a safe place for a later reuse.

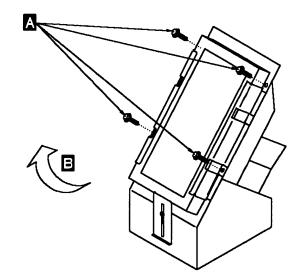


Figure 5-91. Air Moving Device Removal

- 7. Referring to Figure 5-92:
 - Use the torque tool P/N2360092 to loosen the 9 screws which hold the TCM heat sink A
 - Carefully remove the heat-sink B

With care place it in a safe area, resting it with the TCM face uppermost, for a later reuse.

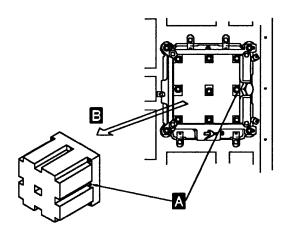


Figure 5-92. Heat Sink Removal

- 8. Referring to Figure 5-93:
 - Attach the TCM handle to the surface of the TCM A
 - Tighten the two thumbscrews securely B

Note: The handle is part of the TCM shipping container. You may have to remove the handle from the new TCM.

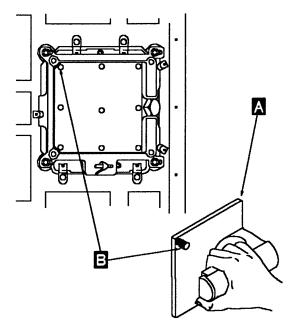


Figure 5-93. TCM Handle Attachment

- 9. Referring to Figure 5-94 on page 5-98:
 - Use the torque tool P/N 2360092 to loosen the four TCM retaining screws completely A

Note: The TCM retaining screws are captive screws; therefore, be certain that they are unscrewed completely and are free of the tapped holes in the board stiffener.

These screws must be loosened completely to allow the cam guard to slide to the left side.

This permits the TCM actuation tool to be inserted to release the TCM.

Exchange Procedure

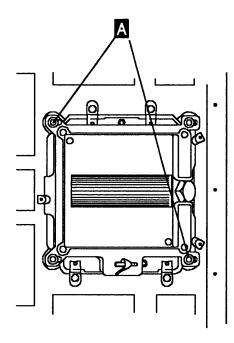


Figure 5-94. TCM Retaining Screws

10. Use the TCM actuation tool P/N5665909 to remove the TCM.

Perform the following steps:

 Before using the TCM actuation tool, be certain that the detent pin in the tool is in the *Removal position* R as shown Figure 5-95.

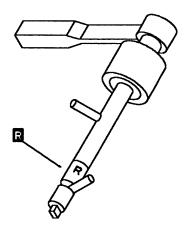


Figure 5-95. Actuation Tool, TCM Removal

• Set the lever on the ratchet handle to drive in a counterclockwise direction.

• On the TCM, slide the cam guard to its left side limit.

Insert the tip of the TCM actuation tool into the module with its indicator pin pointing to the cammed (9 o'clock) position as shown in Figure 5-96.

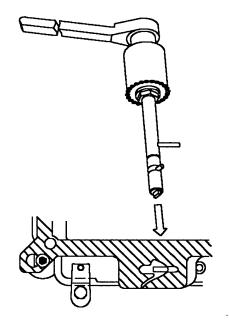


Figure 5-96. Actuation Tool Usage

 Be certain that the TCM actuation tool is fully inserted until the red ring is no longer visible.

WARNING: When turning the TCM actuation tool, avoid exerting any side force on the tool.

If the TCM actuation tool is not fully inserted, turning the actuation tool may damage the cam guard.

 Place both hands on the actuation tool and turn the actuation tool slowly counterclockwise from the cammed position to the uncammed position.

Continue to turn the actuation tool counterclockwise until the slip clutch is activated. This assures that the TCM is uncammed completely as shown Figure 5-97 on page 5-99.

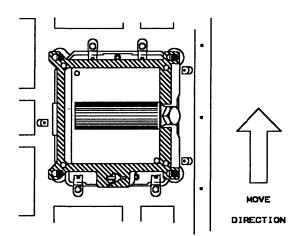


Figure 5-97. TCM Uncammed Position

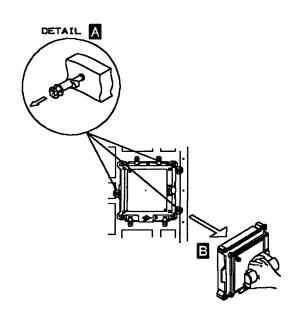
Remove the TCM actuation tool.

WARNING: Be sure to keep one hand firmly on the TCM handle to hold it in position until after the next operation is completed.

- 11. Referring to Figure 5-98:
 - Grasp and unlatch the three spring clip retainers A starting with the one on the left, then the two on the right.

Unlatch them by grasping each clip, lift and rotate the clip approximately 180 degrees see detail

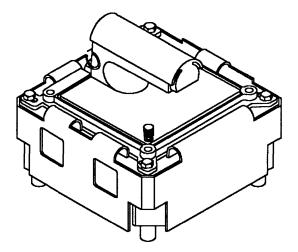
 Hold the TCM handle firmly and carefully remove the TCM from the machine B



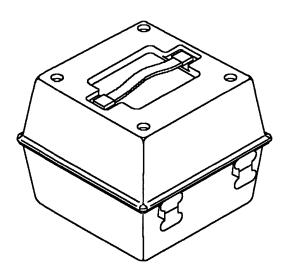
12. Install the clip-on TCM cover (COTC) on the pin side of the TCM, as shown Figure 5-99.

Ensure that the P/N labels are visible through the holes.

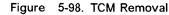
13. Using the ESD mat, place the TCM in a safe place until you can put it in the shipping container, as shown Figure 5-100.











TCM Installation

WARNING: When handling a TCM, be extremely careful not to drop, bump, or jar the assembly.

1. Inspect the TCM board connectors for dirt, dust or lint as shown in Figure 5-101.

Use extreme care, if you have to remove foreign debris so that the connectors are not bent.

If any deformed or damaged connectors are detected, **DO NOT INSTALL THE TCM** and call your next level of support.

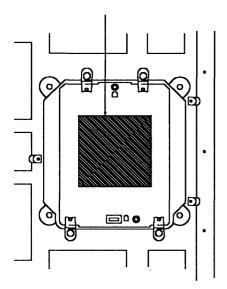


Figure 5-101. TCM Board

2. Grasp the TCM handle and take out the TCM from the shipping container.

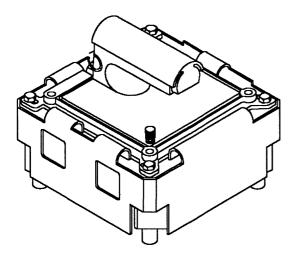


Figure 5-102. TCM Assembly

3. Referring to Figure 5-103:

- Remove the clip-on cover from the TCM. Squeeze at arrows to remove clip-on cover A
- Inspect the TCM for dirt, debris and bent pins B
- Use the module pin template to ensure alignment, refer to "Module Pin Template P/N 4447370" on page 5-93.

If any pin is damaged **DO NOT INSTALL THE TCM**.

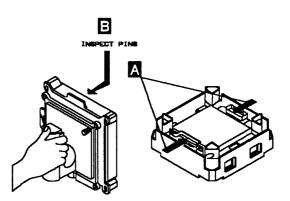


Figure 5-103. TCM Inspection

4. Hold the TCM by the handle, position the cam at the bottom, and carefully insert it into the board as shown in Figure 5-104.

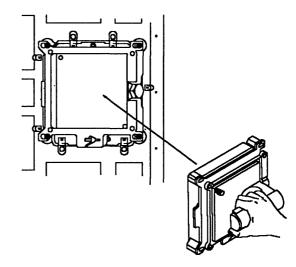


Figure 5-104. TCM Installation

WARNING: Be sure to keep one hand firmly on the module to hold it in position until the next operation is completed.

- Grasp and latch each of the three spring clip retainers by lifting and rotating the clip approximately 180 degrees.
- 6. Then, perform the following steps:

Before using the TCM actuation tool be certain that the detent pin is in the *Installation position* as shown in Figure 5-105 on page 5-101.

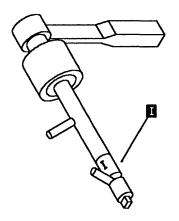


Figure 5-105. Actuation Tool Installation

- Set the lever on the ratchet handle to drive the tool in a clockwise direction.
- Move the cam guard to its left side to insert the TCM actuation tool, see Figure 5-106.

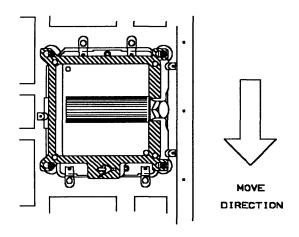


Figure 5-106. TCM Cammed Position

• Insert the tip of the TCM actuation tool into the module with the indicator pin

pointing to the uncammed (9 o'clock) position.

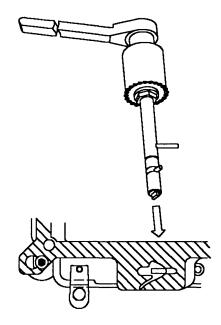


Figure 5-107. Actuation Tool Usage

- Turn the actuation tool clockwise until the slip clutch is activated.
- Remove the TCM actuation tool.
- Use the TCM cam gauge P/N6108930 to check that the TCM is cammed into position correctly.

Insert and turn the gauge, the red ring should disappear, only the green ring should remain.

- Referring to Figure 5-108 on page 5-102:
 - Move the cam guard to its rightmost limit and use the torque tool to tighten the four (4) TCM retaining screws completely
 - Remove the TCM handle by loosening the two thumbscrews B

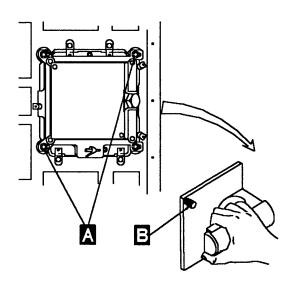


Figure 5-108. TCM Handle Removal

- 7. Referring to Figure 5-109:
 - Carefully install the heat sink A previously removed with the two beveled corners B to the left.
 - Use the torque tool to tighten the nine (9) screws C which hold the heat sink
- 8. Disconnect the ESD kit.

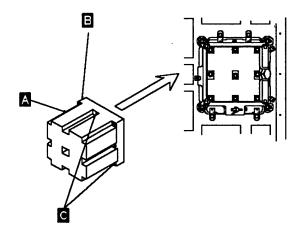
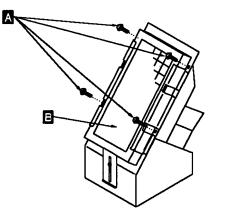


Figure 5-109. Heat Sink Installation

9. Referring to Figure 5-110:

- Install the Air Moving Device unit and tighten the 4 mounting screws A
- Inspect the filter **B** do not hesitate to exchange it if dirty (refer to "Air Filters Exchange Procedure" on page 5-80, if you have exchanged it).



- Figure 5-110. AMD Installation
 - Plug the power cord of the Air Moving Device.
- 10. If previously removed, replace the internal black cover and reconnect the ground strap.
- 11. Close the internal black cover.
- 12. Close the front left cover of frame 01.
- 13. Using the 3745 console, power ON the affected power supply as follows:
 - Type '**POS**' on any displayed screen selection area.

You have the power services menu displayed.

- Select option 1.
- Type 'uxx' to turn the power supply ON.

CCU A xx = 02

CCU B xx = 03.

 Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1, and run diagnostics for the associated area then go to "Repair Verification Procedure" on page 5-170.

PS Type 1 Exchange Procedure for Models 210 and 410

For physical FRU location, refer to Figure 5-2 on page 5-6.

This type of power supply is located at 01Q or 01R.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Type '1' to select the base frame power services.
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx'

$$CCUA xx = 02$$

CCU B xx = 03.

Prior to starting the exchange, read the 'Telecommunication Products Safety Handbook', GA33-0126.

Before exchanging the PS type 1, visually check that there are no opened wires at connector J1.

Power Supply Assembly Removal Procedure

1. Switch OFF the corresponding CP in the primary box:

CCU A PS type 1 id = 02 CP3

CCU B PS type 1 id = 03 CP8.

Refer to Figure 5-111:

2. Disconnect the connector from P1 B

J4 for CCU A J9 for CCU B

3. Take note of SW1's position A :

- 4. Disconnect the connector from J1 C
- 5. Disconnect the connector from J2 D
- Disconnect laminar buses from TB-1 to TB-9 E (mark each laminar for easier replacement).

IMPORTANT This power supply weighs 19 kilos.

 Remove the three mounting screws F and slide the power supply assembly out of the machine using, the handle G

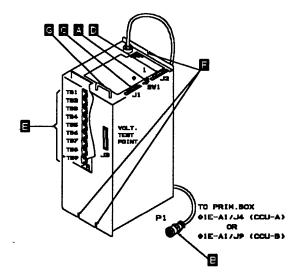


Figure 5-111. PS Type 1

Power Supply Assembly Installation

1. To replace the power supply assembly, perform the removal procedure in the reverse order.

Note: Be sure that SW1 is in the same position as noted in step 2 of the power supply removal. If not, refer to "Volume 4, page YZ071" for the proper setting.

- 2. Using the 3745 console, turn the affected power supply ON as follows:
 - Type '**POS**' on any displayed screen selection area.

You now have the power services menu displayed.

- Select frame 01.
- Type 'uxx' to turn the power supply ON:

 $\begin{array}{c} \text{CCU A} \quad xx = 02 \\ \text{CCU B} \quad xx = 03. \end{array}$

 Run CCU diagnostics, refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1, and follow 'How to Run Internal Function Tests'. then go to "Repair Verification Procedure" on page 5-170.

PS Type 1B Exchange Procedure for Models 310 and 610

For physical FRU location, refer to Figure 5-2 on page 5-6.

This type of power supply is located at 01Q or 01R.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Type '1' to select the base frame power services.
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx'

CCU A xx = 02

CCU B xx = 03.

Prior to starting the exchange, read the 'Telecommunication Products Safety Handbook', GA33-0126.

Before exchanging the PS type 1B, visually check that there are no opened wires at connector J1.

Power Supply Assembly Removal Procedure

1. Switch OFF the corresponding CP in the primary box:

CCU A PS type 1B id = 02 CP3

CCU B PS type 1B id = 03 CP8.

Refer to Figure 5-112:

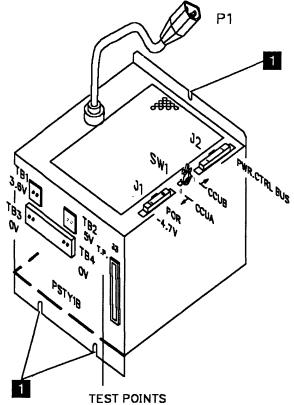
2. Disconnect the P1 connector in the Primary Power Box.

01E-A1J4 for CCU A 01E-A1J9 for CCU B

3. Take note of SW1's position.

- 4. Disconnect the connector from J1.
- 5. Disconnect the connector from J2.
- Disconnect laminar buses from TB-1 to TB-4. (mark each laminar for easier replacement).
- 7. Remove the three mounting screws **1** and slide the power supply assembly out of the machine.

PSTY18	P.P.B
01Q	01E-A1/J4
01R	01E-A1/J9



WRITTEN ON FRONT OF PSTY1B

Figure 5-112. PS Type 1B

Power Supply Assembly Installation

1. To replace the power supply assembly, perform the removal procedure in the reverse order.

Note: Be sure that SW1 is in the same position as noted in step 2 of the power supply removal. If not, refer to "Volume 4, page YZ071" for the proper setting.

- 2. Using the 3745 console, turn the affected power supply ON as follows:
 - Type '**POS**' on any displayed screen selection area.

You now have the power services menu displayed.

- Select frame 01.
- Type 'uxx' to turn the power supply ON:

CCU A xx = 02

CCU B xx = 03.

3. Run CCU diagnostics, refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1, and follow 'How to Run Internal Function Tests'. then go to "Repair Verification Procedure" on page 5-170.

PS Type 2 Exchange Procedure

For physical FRU location, refer to Figure 5-2 on page 5-6.

This type of power supply is located at 01V.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.

Note: Normally, a failure on the MOSS power supply (PS type 2) will automatically turn the power supply OFF. If the MOSS is still available, continue the procedure in sequence. If not, check at the voltage test point (J2) on the power supply that no voltage is distributed; see YZ370 for voltage pin assignment. Then continue with paragraph 'Power Supply Assembly Removal Procedure' for that power supply.

- 3. Remove power as follows:
 - Press the 'Service' key on the control panel until (1) is displayed on the service ' window.
 - · Press the 'Validate' key.
 - Press the 'Function' key on the control panel until the 'MOSS Power OFF' function (B) is displayed.
 - · Press the 'Validate' key.
 - Observe the MOSS inoperative display on the control panel. At completion of power OFF, this will display the character (B).

Prior to starting the exchange, read the 'Telecommunication Products Safety Handbook', GA33-0126.

Power Supply Assembly Removal Procedure

1. Switch CP6 OFF in the primary box.

Referring to Figure 5-113:

2. Disconnect the P1 connector in the primary power box (01E-A1J7)

- 3. Free the ac cable from primary to power supply, from the raceway(s).
- 4. Disconnect the connector from J1 B
- 5. Disconnect the connector from J3 C
- 6. Disconnect the connector from J4 D
- Remove the three mounting screws and slide the power supply assembly out of the machine

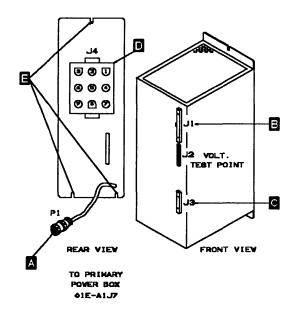


Figure 5-113. PS Type 2

Power Supply Assembly Installation

1. To replace the power supply assembly perform the removal procedure in the reverse order.

When only the MOSS is powered OFF proceed as follows:

- Using the 'Function' key scroll till the value is (1), MOSS IML.
- Press the 'Validate' key.
- Initiates a MOSS power ON.

Note: This action will also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **F0E,F0F** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

2. Go to "Repair Verification Procedure" on page 5-170.

PS Type 3 Exchange Procedure

For PS type 3 locations in frame 01, refer to Figure 5-2 on page 5-6.

This type of power supply is located at 01K.

For PS type 3 locations in frame 02, refer to Figure 5-3 on page 5-8.

This type of power supply is located at 02D.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Type '**x**' to select the appropriate service frame.
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx' where xx = affected power supply id.

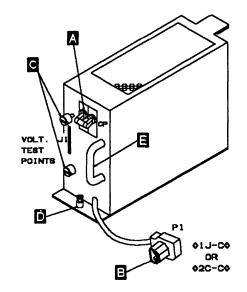
Prior to starting the exchange, read the 'Telecommunication Products Safety Handbook', GA33-0126.

Power Supply Assembly Removal Procedure

Referring to Figure 5-114:

- 1. Switch the CP OFF on the power supply
- 2. Disconnect the ac power plug P1 B
- 3. Unscrew the 2 tab screws until they are free

- 4. Unlock the retaining screw D
- 5. Slide the power supply assembly out of the machine, using the handle





Power Supply Assembly Installation

- 1. To replace the power supply assembly, perform the removal procedure in the reverse order.
- 2. Using the 3745 console, turn the affected power supply ON as follows:
 - Type '**POS**' on any displayed screen selection area.

You now have the power services menu displayed.

- Type '**uxx**' to turn the power supply ON.
- 3. Run diagnostics for the associated area, refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1 and then go to "Repair Verification Procedure" on page 5-170.



PS Type 4 Exchange Procedure

For PS type 4 locations in frame 01, refer to Figure 5-2 on page 5-6.

This type of power supply is located at 01H.

For PS type 4 locations in frame 02, refer to Figure 5-3 on page 5-8.

This type of power supply is located at 02B,02G.

For PS type 4 locations in frame 03, refer to Figure 5-4 on page 5-9.

This type of power supply is located at 03G.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Type 'x' to select the appropriate service frame.
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx' where xx = affected power supply id.

Prior to starting the exchange, read the 'Telecommunication Products Safety Handbook', GA33-0126.

Power Supply Assembly Removal Procedure

Referring to Figure 5-115:

1. Switch the CP OFF on the power supply

- IMPORTANT -

Do not switch OFF more than one CP of PS type 4s in the same power supply board (01H, 02B, 02G, or 03G) at the same time. If you switch OFF two or more CPs at the same time, the remaining supply in that board may go to "NOREPLY" status.

- 2. Disconnect the ac power plug P1 B
- 3. Unscrew the 2 tab screws until they are free C
- 4. Unlock the retaining screw **D** and slide the power supply assembly out of the machine, using the handle **E**

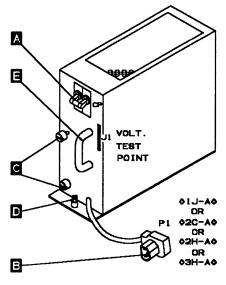


Figure 5-115. PS Type 4

Power Supply Assembly Installation

- 1. To replace the power supply assembly, perform the removal procedure in the reverse order.
- 2. Using the 3745 console, turn the affected power supply ON as follows:
 - Type '**POS**' on any displayed screen selection area.

You now have the power services menu displayed.

- Type 'uxx' to turn the power supply ON.
- If it is successful, continue with step 3.

- If any other status, go to step 4.
- 3. Using the 3745 console, proceed as follows:
 - a. If the power is supplying TSSs or HPTSSs, IML the two line adapters as follows:
 - From menu 3 select TSS services by entering 'TSS' into the selection area.
 - From the TSS services screen, choose 'Select/Release' by entering '1' into the selection area.
 - In the input area enter an 'S' followed by the suspected adapter number.
 - Enter '2' in the selection area to choose Dump/IML.
 - On the Dump/IML screen, enter 'I' to IML the line adapter.
 - Enter '1' in the selection area to choose 'Select/Release'.
 - Enter '**REL**' in the input area to release the disabled line adapter.

- Repeat the preceding steps for the associated adapter.
- b. If this power is supplying TRSSs, you must disconnect again the adapters after power ON and prior to running the diagnostics. Proceed as follows:
 - From menu 3 select 'TRSS Services' by entering 'TRS' into the selection area.
 - From the 'TRSS Services' screen choose 'select' by entering '1' in the selection area.
 - In the input area enter the number of the suspected adapter.
 - Enter '2' in the selection area to choose 'Connect/Disc'.
 - On the 'Connect/Disc' screen enter 'DS' to disconnect the TRA.
 - Repeat the preceding steps for the associated adapter.
- 4. Run diagnostics for the associated area , refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1, then go to "Repair Verification Procedure" on page 5-170.

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PS Type 5 Exchange Procedure

For PS type 5 locations 01M-A1, 01P-A1: refer to Figure 5-2 on page 5-6.

For PS type 5 locations 04B-A1, 04D-A1, 04E-A1, 04G-A1: refer to Figure 5-5 on page 5-10.

For PS type 5 locations 05B-A1, 05D-A1, 05G-A1, 05E-A1: refer to Figure 5-6 on page 5-11.

For PS type 5 locations 06B-A1, 06D-A1, 06G-A1, 06E-A1: refer to Figure 5-7 on page 5-12.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Select the appropriate service frame.
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx' where xx = affected power supply id.

Prior to starting the exchange, read the 'Telecommunication Products Safety Handbook', GA33-0126.

Power Supply Assembly Removal Procedure

In order to access the power supply you have to remove the partial board cover.

Referring to Figure 5-116:

- 1. Switch the CP OFF on the power supply A
- 2. Trace the AC power cord **B** of the PS type 5 back to the AC distribution (01Z or 04A or 05A) and unplug the P1 connector, (see table bellow).
- 3. Disconnect the J3 connector
- 4. Disconnect the J2 connector D
- 5. Disconnect the J4 connector
- 6. Take note of the addressing switches positions
- 7. Unscrew the two mounting screws **G** and slide the power supply assembly out of the machine, using the handle **H**

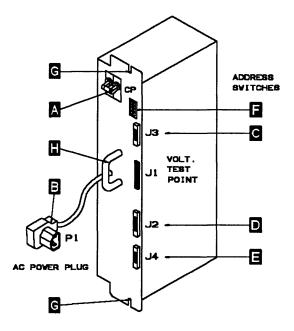


Figure 5-116. PS Type 5

		FRAME 04				FRAME 05				FRAME 06			
PS	ID	30	31	32	33	34	35	36	37	38	39	40	41
POWER	PLUG	J5	J9	J6	J10	J5	J9	J6	J10	J5	J9	J6	J10

Power Supply Assembly Installation

To replace the power supply assembly, perform the removal procedure in the reverse order.

Note: Be sure that the addressing switches are in the same positions as noted in step 6 of the power supply removal.

If not, refer to "Volume 4, page YZ075, Addressing" for the proper setting.

- 1. Using the 3745 console, turn the affected power supply ON as follows:
 - Type '**POS**' on any displayed screen selection area.

You now have the power services menu displayed.

- Type 'uxx' to turn the power supply ON.
- If it is successful, continue with step 2.
- If any other status, go to "Repair Verification Procedure" on page 5-170.
- Run diagnostics for the associated area (refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1),then go to "Repair Verification Procedure" on page 5-170.

PS Type 6 Exchange Procedure

For physical FRU location, refer to Figure 5-2 on page 5-6.

This type of power supply is located at 01F.

Prior to starting the exchange, read the 'Telecommunication Products Safety Handbook', GA33-0126.

Power Supply Assembly Removal Procedure

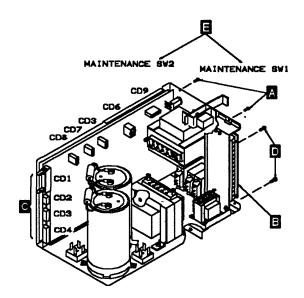


Figure 5-117. PS Type 6

1. Switch CB1 OFF located at frame 01, 01E-B1.

Referring to Figure 5-117:

You have to remove the cover by unscrewing the 2 screws A to access and perform the following steps:

- 2. Disconnect the TB1 wires **B** positions 1, 6, 10, 14, refer to YZ576.
- 3. Go to the rear and disconnect the CD1 CD2 CD4 CD5 connectors
- 4. Unscrew the 2 mounting screws D
- 5. Disconnect the ground strap.

- 6. Remove the power supply assembly out of the machine.
 - Note: Switches 1 and 2 E:

Maintenance Sw1 normally OFF when the machine is operating., Closing the external cover actuates Sw1 to the normal position. Maintenance Sw2 is used for card unplugging.

Power Supply Assembly Installation

1. To replace the power supply assembly, perform the removal procedure in the reverse order.

Note: Check with YZ576 for voltage input.

- 2. Switch CB1 ON, located at frame 01, 01E-B1.
- 3. Re-apply the power as follows by means of the control panel :
 - a. Press the Power Control key until (3) appears in the power control window (Power Control in local).
 - b. Press the 'Validate' key.
 - c. Press the 'Function' key until (1) appears in the function window (function in MOSS IML).
 - d. Press the 'Validate' key.
 - e. Press the 'Service' key until (1) appears in the service window (service in MAINT.1).
 - f. Press the 'Validate' key.
 - g. Press 'power ON Reset' key.

Note: The former actions will power the machine ON and also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **FOE**, **FOF** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

4. Go to "Repair Verification Procedure" on page 5-170.

PS Type 7 Exchange Procedure

For PS Type 7 locations 01M-A1: refer to Figure 5-2 on page 5-6.

For PS Type 7 locations 04B-A1, 04D-A1, 04E-A1, 04G-A1: refer to Figure 5-5 on page 5-10.

For PS Type 7 locations 05B-A1, 05D-A1, 05E-A1, 05G-A1: refer to Figure 5-6 on page 5-11.

For PS Type 7 locations 06B-A1, 06D-A1, 06E-A1, 06G-A1: refer to Figure 5-7 on page 5-12.

IMPORTANT

Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 3.

If not, proceed with step 1.

- 1. Press the 'Power Control' key until (3) is displayed in the power control window.
- 2. Press the 'Validate' key.
- 3. Remove power as follows:
 - a. Type '**POS**' on any displayed screen selection area.

You will have the power services menu displayed.

- b. Select the appropriate service frame.
- c. On the displayed information screen, check the status of the affected power supply.

If it is up, type 'dxx' where xx = affected power supply id.

Prior to starting the exchange, read the 'Telecommunication Products Safety Handbook', GA33-0126.

Power Supply Assembly Removal Procedure

In order to access the power supply you have to remove the partial board cover.

Referring to Figure 5-118:

- 1. Switch the CP OFF on the power supply A
- 2. Trace the AC power cord **B** of the PS type 7 back to the AC distribution (01Z or 04A or 05A or 06A) and unplug the P1 connector, (see table below).
- 3. For easier access to power connectors, remove both SMUXs as follows:
 - a. Remove the cables located on the top of the SMUXs
 - b. Unfasten the thumb screw holding the SMUX cassettes
 - c. Remove the SMUXs
- 4. Disconnect the P2 connector D
- 5. Disconnect the J3 connector C
- 6. Disconnect the J4 connector
- 7. Take note of the addressing switches positions **F**
- 8. Unscrew the four mounting screws **G** and slide the power supply assembly out of the machine, using the handle **H**

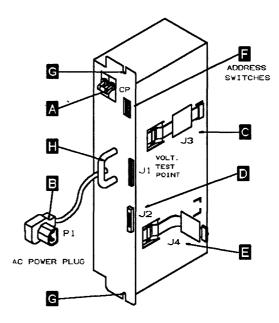


Figure 5-118. PS Type 7

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		FRAME 04					FRAM	E 05		FRAME 06			
PS	ID	30	31	32	33	34	35	36	37	38	39	40	41
POWER	PLUG	J5	J9	J6	J10	J5	J9	J6	J10	J5	J9	J6	J10

Power Supply Assembly Installation

To replace the power supply assembly, perform the removal procedure in the reverse order.

Note: Be sure that the addressing switches are in the same position as noted in step 7 of the power supply removal.

If not, refer to the "Volume 4, page YZ077" for the proper setting.

1. Using the 3745 console, turn the affected power supply ON as follows:

• Type '**POS**' on any displayed screen selection area.

You now have the power services menu displayed.

- Type 'uxx' to turn the power supply ON.
- If it is successful, continue with step 2.
- If any other status, go to "Repair Verification Procedure" on page 5-170.
- 2. Run diagnostics for the associated area , refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1, then go to "Repair Verification Procedure" on page 5-170.

PS Type 8 Exchange Procedure

For physical FRU location, refer to Figure 5-2 on page 5-6.

This type of power supply is located at 01E.

- VERY IMPORTANT -

Before starting maintenance:

- 1. **Imperatively ask** the customer to remove ac power from the 3745.
- 2. **Confirm** that ac power is no longer present.
- 3. Find TB1 in PS type 6, located at 01F.
- 4. Check for power not present at PS type 6 TB1-6, 10, 14, A with a CE meter, using ground as reference, see Figure 5-119.

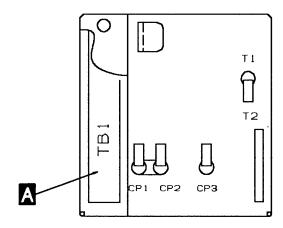


Figure 5-119. Phases

Prior to starting the exchange, read the 'Telecommunication Products Safety Handbook', GA33-0126.

Power Supply Assembly Removal Procedure

- 1. Referring to Figure 5-120:
 - Open the left front cover of frame 01.
 - Open the lower and upper internal black covers.
 - Remove the front plate 01E-A1 to access the PS type 8, refer to Figure 5-48 on page 5-48.
 - Disconnect connectors J1 to J10 and remove the cover.

Note: Do not damage the AMD cables when removing the cover.

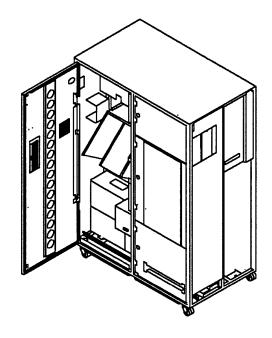


Figure 5-120. Frame 01 Internal Access

- 2. Switch CB1 OFF, location 01E-B1.
- '3. Referring to Figure 5-121:
 - Disconnect the P11 connector A
 - Unscrew the 2 mounting screws B
 - Remove the power supply assembly from the machine.

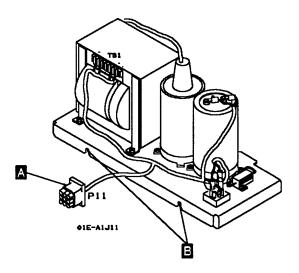


Figure 5-121. PS Type 8

Power Supply Assembly Installation

To replace the power supply assembly, perform the removal procedure in the reverse order.

- 1. Ask the customer to enable the ac power to the 3745.
- 2. Switch CB1 ON, located at frame 01, 01E-B1.
- 3. Re-apply the power as follows by means of the control panel :
 - Press the 'Power Control' key until (3) appears in the Power Control window (Power Control in local).
 - · Press the 'Validate' key.
 - Press the 'Function' key until (1) appears in the function window (function in MOSS IML).

- Press the 'Validate' key.
- Press the 'Service' key until (1) appears in the service window (service in MAINT.1).
- · Press the 'Validate' key.
- Press the 'power ON Reset' key.

Note: The former actions will turn the machine ON and also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **F0E**,**F0**F or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

4. Go to "Repair Verification Procedure" on page 5-170.

PS Fan Exchange Procedure

Prior to starting the exchange, read the 'Telecommunication Products Safety Handbook', GA33-0126.

WARNING: Power may be present when nothing is displayed on the control panel.

Locations

For PS fan locations 01J-B1 ,01J-B2: refer to Figure 5-2 on page 5-6.

For PS fan locations 02C-B1, 02C-B2, 02H-B1, 02H-B2: refer to Figure 5-3 on page 5-8.

For PS fan locations 03H-B1, 03H-B2: refer to Figure 5-4 on page 5-9.

WARNING: Do not forget that the assembly contains 2 fans. You have 2 minutes to replace the assembly. If you exceed 2 minutes the associated power supplies will automatically be powered OFF.

For this reason:

- Read the following procedure before starting to exchange the assembly.
- Have the assembly to be installed unpacked and close to the location of the failing unit.
- Be sure that the fan blades are running free. Do this by pushing the blades with a thin screwdriver or similar tool.

Referring to Figure 5-122:

- 1. Unlock the T-Knobs A
- 2. Disconnect the power plug B
- 3. Disconnect the AFD plug
- 4. Slide the assembly out of the machine.
- 5. Fit the new assembly into the machine.
- 6. Reconnect the AFD plug C
- 7. Reconnect the power plug B
- 8. Lock the T-Knobs A
- Using the 3745 console POS function, verify that all power supplies are in the 'UP' status, refer to "3745 Service Functions, Chapter 12".
- 10. Go to "CE Leaving Procedure" on page 5-172.

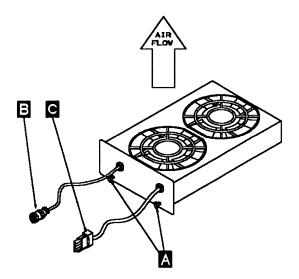


Figure 5-122. Fan Assembly

Channel Tail Gate and Internal Cables Exchange Procedure

- 1. Advise the customer that the 3745 is to be turned OFF and the channel removed from the host configuration. (Channel will be opened).
- 2. Check that the 'Power Control' display is set to local (3) on the control panel. If yes, go to step 5; if not, proceed with step 3.
- 3. Press the 'Power Control' key until (3) is displayed in the Power Control window.
- 4. Press the 'Validate' key.
- 5. Remove power as follows:
- 6. Press 'Power OFF' on the control panel.
- 7. Switch the CB1 OFF. Refer to Figure 5-124 on page 5-120 for the location of CB1.
- Using Figure 5-125 on page 5-121 or Figure 5-126 on page 5-121 locate Tail Gate 01T-A1 containing the channels 1 to 8, or Tail Gate 02K-A1 containing the channels 9 to 16.

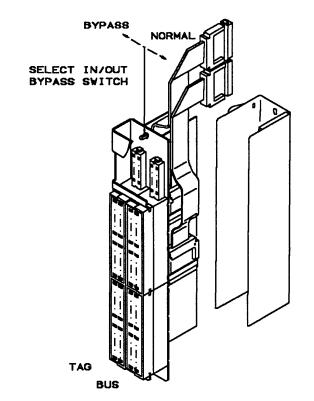


Figure 5-123. Tail Gate Connector

- 9. Remove the tail gate front cover.
- Disconnect the interface cables or terminators from the tail gate for the involved channel interface.
- 11. Remove the cover above the tail gate connectors. (6 screws)
- 12. Remove the two screws retaining the tail gate connector and the screw holding the flat cable retainer on the board.
- 13. Remove the retainer and unplug the flat cable connectors.
- 14. Remove the assembly.
- For re-installation proceed in reverse order.
 Warning: Take care of the springs located at the left side of the assembly.
- 16. Power the 3745 ON and referring to "How to Run the Channel Wrap Test" on page 4-42, run diagnostics on the involved channel interface then go to "Repair Verification Procedure" on page 5-170

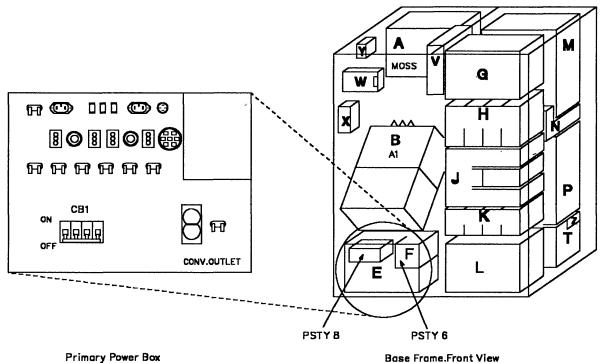
Channel Board Exchange Procedure

Removal Procedure

- 1. Advise the customer that the 3745 is to be turned OFF.
- 2. Press 'Power OFF' on the control panel.
- 3. Switch CB1 OFF. Refer to Figure 5-124 for the location of CB1.
- 4. Locate using Figure 5-125 on page 5-121 channel board 01L-A1 containing channels 1 to 8, or using Figure 5-126 on page 5-121 the

channel board 02E-A1 containing channels 9 to 16.

- 5. For the channel board you are working on, locate the related tail gate using Figure 5-125 on page 5-121 or Figure 5-126 on page 5-121.
- 6. At the tail gate, switch all the channel select in/out bypass switches to the 'BYPASS' position. Refer to Figure 5-127 on page 5-122.
- 7. From the rear of the channel adapter board, note the locations and remove the flat cables coming from the tail gate (2 per channel).
- 8. Open the channel adapter board cover and remove it by lifting it upwards.



Primary Power Box

Figure 5-124. Primary Power Box in Frame 01

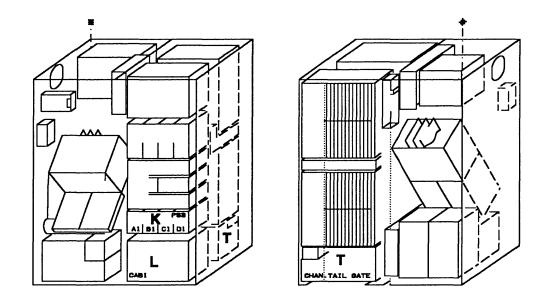


Figure 5-125. Channel Board, Tail Gate and Channel Power in Basic Frame 01

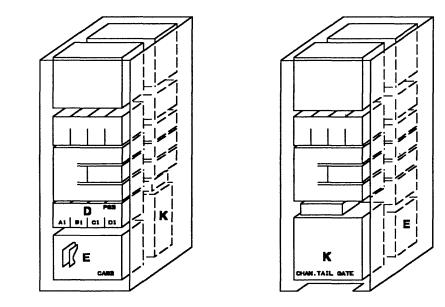


Figure 5-126. Channel Board, Tail Gate and Channel Power in Frame 02

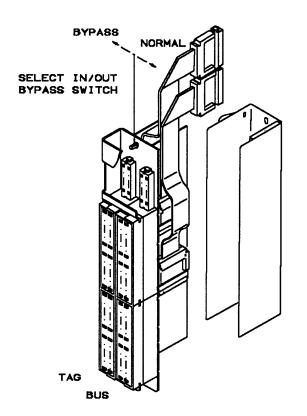


Figure 5-127. Tail Gate

 The power supplies for channel board 01L-A1 are located at 01K. Refer to Figure 5-125 on page 5-121. The power supplies for channel board 02E-A1 are located at 02D. Refer to Figure 5-126 on page 5-121. Using Figure 5-128, remove the power supply(ies) as follows:

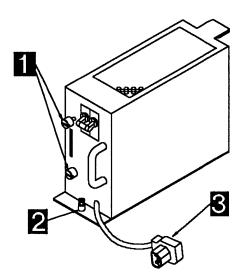


Figure 5-128. Channel Board Power Supply

- a. On each power supply, unscrew the 2 tab screws 1 until they are free and the green band is visible.
- b. Unlock the retaining screw 2.
- c. Disconnect connector **3** and slide the assembly out of the machine.
- 10. Note the locations and remove the top card connectors.
- 11. WARNING: Use the ESD kit and procedures. Check if all the cards are labelled according to their positions, if not, label them. Then remove the cards and store them in a safe place.
- 12. When exchanging channel board 01L-A1 proceed as directed in step 13. When exchanging channel board 02E-A1 proceed as directed in step 14.
- 13. For board 01L-A1
 - a. In positions:

01L-A1X2 01L-A1X3 01L-A1X4 01L-A1X5,

you may find flat cables instead of a terminator card, if so disconnect these cables and remove them from the raceway in the channel board enclosure.

b. Locate cables at:

01A-Y0C1 01A-Y0C2

01B-A1HZ1 01B-A1HZ2 01B-A1NZ4 01B-A1NZ5.

Check that the cables are labelled according to their positions, if not, label them.

Disconnect the cables.

- c. Feed the cables through the frame back to the 01L-A1 board enclosure.
- d. Remove power connectors 01K-J7 and 01K-J8, refer to Figure 5-129 on page 5-124.
- e. At machine frame 01 ground bus remove the FDS ground cable coming from the channel board assembly.
- f. Continue with step 16 on page 5-124.
- 14. For board 02E-A1
 - a. Locate cables at:

01A-Y0E1 01A-Y0E2 01L-A1X2 01L-A1X3 01L-A1X4 01L-A1X5.

Check that the cables are labelled according to their positions, if not, label them. Disconnect the cables.

- b. Remove the cables from the raceway and feed the cables through the frame back to the 02E-A1 board enclosure.
- c. Remove power connectors 02D-J7 and 02D-J8. refer to Figure 5-129 on page 5-124.
- d. At machine frame ground area to the right of the 01L-A1 board, remove the FDS ground cable coming from the channel board assembly.
- 15. Continue with step 16 on page 5-124.

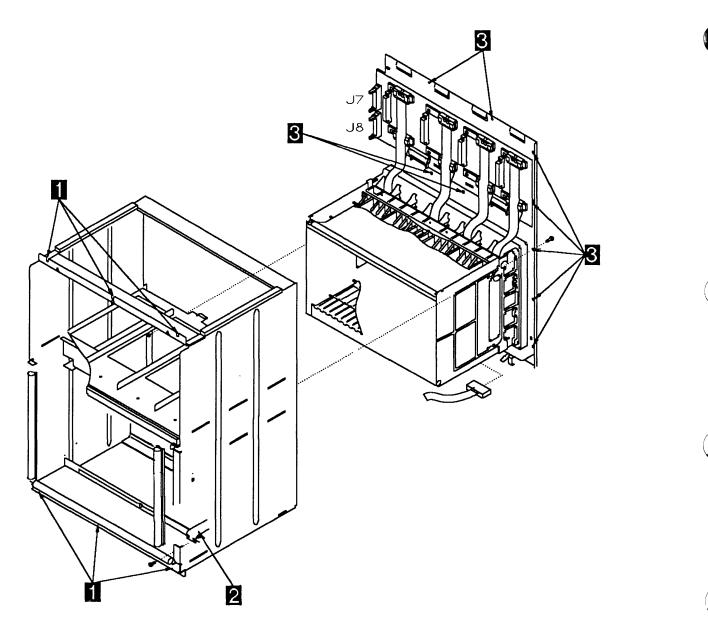


Figure 5-129. Channel Board and Power Enclosure

16. Refer to Figure 5-129.

- Remove the 6 screws 1 which maintain the enclosure on the frame. Then slide the enclosure out of the machine taking care not to damage the power board and connectors on the left side.
- 17. Remove the 2 screws **3** securing the FDS cable.
- 18. Refer to Figure 5-129. Remove the 11 screws 3 holding the enclosure back plate assembly. Remove the back plate assembly and place in an area for further work.

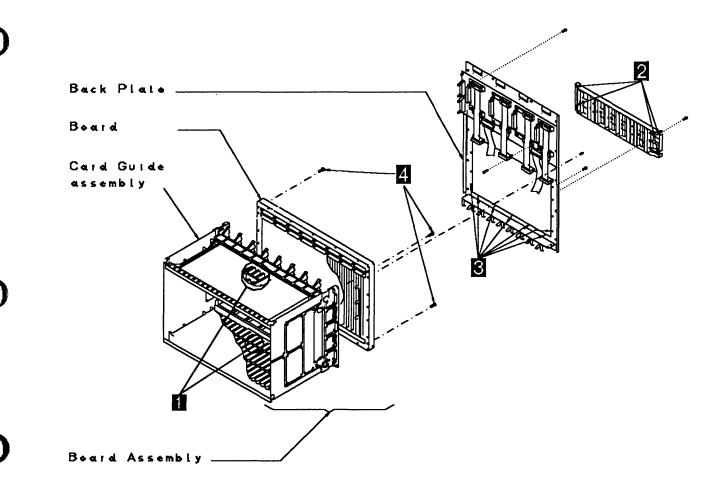


Figure 5-130. Board Assembly

- Refer to Figure 5-130. At the front of the board, loosen the brackets which maintain the flat cables at the top and bottom of the board (rows 'Y' and 'Z'). Remove those cables from the board.
 - a. Refer to Figure 5-130.
 - b. At the back of the channel board, remove the 4 screws 2 which hold the cable retainer to the board assembly.
- c. Remove the 10 screws **3** which maintain the board assembly on the frame. You can now remove the board assembly.
- d. Remove the 4 screws 4 which hold the board to the card guide assembly and remove the board.

Installation Procedure

- Attach the card guide assembly to the new board using the 4 screws
 Refer to Figure 5-130 on page 5-125.
- 2. Install the 10 screws **3** which hold the board assembly to the back panel.
- 3. Refer to Figure 5-130 on page 5-125. Ensure that there are no bent pins on the board. At the back of the channel board, re-install the 4 screws 2 which hold the cable retainer to the board assembly taking care that the retainer is located correctly.
- 4. At the front of the board, re-install the cables at the top and bottom of the board (rows 'Y' and 'Z'). Re-install and tighten the cable retainers for these cables and re-install the cables in the raceway.
- 5. Refer to Figure 5-129 on page 5-124.
 Re-install the 11 screws 2 holding the enclosure back plate assembly to the enclosure.
- 6. Refer to Figure 5-129 on page 5-124.
 Slide the enclosure into the machine taking care not to damage the power board and connectors on the left side. Re-install the 6 screws 1 which maintain the enclosure to the frame.
- 7. When exchanging channel board 01L-A1, proceed as directed in step 9. When exchanging channel board 02E-A1, proceed as directed in step 8.
- 8. For board 02E-A1
 - a. Feed the cables through the frame back to their correct locations.
 - 01A-Y0E1 01A-Y0E2
 - 01L-A1X2 01L-A1X3 01L-A1X4 01L-A1X5

Replug the cables.

- b. Replug power connectors 02D-J7 and 02D-J8.
- c. At machine frame ground area to the right of 01L-A1 board, connect the ground FDS cable coming from the 02E-A1 board assembly.
- d. Continue with step 10.
- 9. For board 01L-A1
 - a. Feed the cables through the frame back to their correct locations.

01A-Y0C1 01A-Y0C2

01B-A1HZ1 01B-A1HZ2 01B-A1NZ4 01B-A1NZ5

Connect the cables.

- b. Re-install power connectors 01K-J7 and 01K-J8.
- c. At machine frame 01 ground bus, re-install the ground FDS cable coming from the channel board assembly.
- d. In the positions
 - 01L-A1X2 01L-A1X3 01L-A1X4 01L-A1X5

if you removed flat cables, re-install those cables.

- 10. WARNING: Use the ESD kit and procedures. Re-install the cards.
- 11. Re-install the top card connectors.
- 12. The power supplies for channel board 01L-A1 are located at 01K. The power supplies for channel board 02E-A1 are located at 02D. Using the Figure 5-128 on page 5-122, re-install the power supply(ies) as follows:
 - a. On each power supply, slide the assembly into the machine.
 - b. Tighten the 2 tab screws 1
 - c. Lock the retaining screw 2
 - d. Re-install connector 3
- At the rear of the channel adapter board, re-install the flat cables coming from the tail gate (2 per channel).
- 14. Re-install the channel adapter board cover.
- 15. Close the internal covers.
- 16. Switch the CB1 ON.
- 17. Close the frame doors.
- power the machine ON using the control panel as follows:
 - a. Press the Power Control key until (3) appears in the Power Control window (Power Control in local).
 - b. Press the 'Validate' key.
 - c. Press the 'Function' key until (1) appears in the function window (function in MOSS IML).

- d. Press the 'Validate' key.
- e. Press the 'Service' key until (1) appears in the service window (service in MAINTENANCE 1).
- f. Press the 'Validate' key.
- g. Press the 'power ON' Reset key.

Note: The former actions will turn the machine ON and also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **FOE**,**FOF** or **000**. If any other code is displayed, an error

was detected. See "Panel Codes" on page 2-14

- 19. Run the diagnostics related to the channel boards you changed.
- At the tail gate, switch all the channel select in/out bypass switches to the 'NORMAL' position. Refer to Figure 5-127 on page 5-122. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1.
- 21. Go to "Repair Verification Procedure" on page 5-170.

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Notes:

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Line Adapter Board Exchange Procedure

Removal Procedure

- 1. Advise the customer that the 3745 is to be turned OFF.
- 2. Press 'Power OFF' on the control panel.
- 3. Switch CB1 OFF. Refer to Figure 5-131 for the location of the CB1.

- 4. Locate the Line Adapter Boards at:
 - 01G-A1 = LAB1 (TSSB or TSST) 02A-A1 = LAB2 (TSSB) 02F-A1 = LAB3 (TSSB)
 - 03F-A1 = LAB4 (TSSB)

For the location of the boards and associated power supplies refer to Figure 5-132 on page 5-130 for line adapters 01 to 08 (LAB1);

Figure 5-133 on page 5-130 for line adapters 09 to 15 (LAB2) and line adapters 15 to 24 (LAB3);

Figure 5-134 on page 5-131 for line adapters 25 to 32 (LAB4).

To identify the board type of LAB1, refer to "Line Adapter Board Type" on page 1-29.

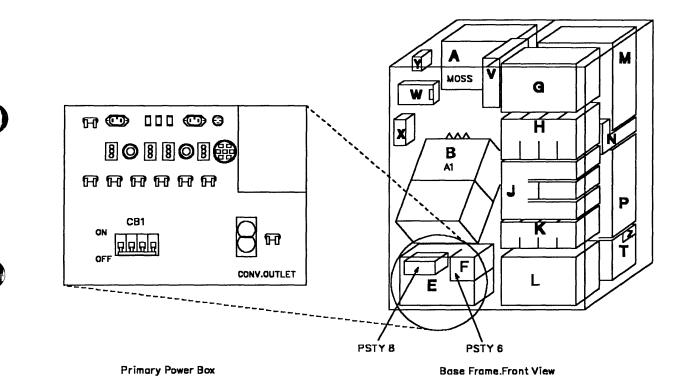


Figure 5-131. Primary Power Box in Frame 01

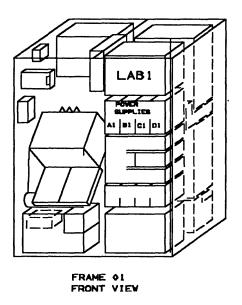
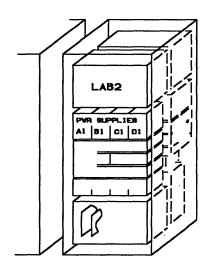
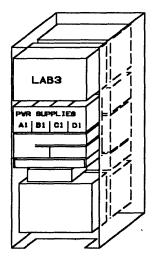


Figure 5-132. LAB1 and the Associated Power Supplies





FRONT VIEW

FRAME 02

REAR VIEW

Figure 5-133. LAB2, LAB3 and the Associated Power Supplies

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- c. Disconnect the connector **3** and slide the power supply assembly out of the machine.
- d. Repeat the previous steps for each of the power supplies in the rack.

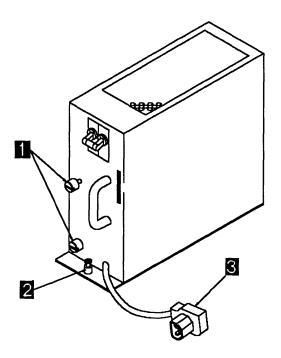
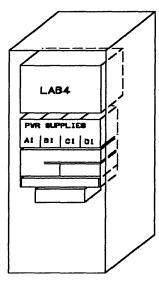


Figure 5-135. Line Adapter Power Supply



FRAME 03 REAR VIEW

Figure 5-134. LAB4 and Associated Power Supplies

- Using Figure 5-135, remove the power supply(ies) (Up to 4 power supplies can be installed) as follows:
 - a. Unscrew the 2 tab screws **1** until they are free and the green band is visible.
 - b. Unlock the retaining screw 2

6. WARNING: Use the ESD kit and procedures.

Refer to Figure 5-136 if dealing with a TSSB Board or to Figure 5-137 on page 5-133 if dealing with a TSST Board.

- a. Note the locations and remove the top card connectors.
- b. Note the locations and remove the serial link cables from the FESL card(s) if any.
- c. Note the locations and remove the token-ring cables from the TRM card(s) if any.

- d. Note the locations and remove the line cables from the FESH card(s) if any.
- e. Check if the cards are labelled according to their positions, if not, label them. Then, remove the cards and store them in a safe place.
- f. If flat cables are present in positions X2, X3, X4, X5, disconnect and remove them from the raceway in the line adapter board enclosure.
- g. Remove the grounding screws of the serial link, token-ring and line cables. Feed these cables out of the enclosure.

LOCATION : 01G-A1.02A-A1.02F-A1.03F-A1 DMA BUS IOC BUS C IOC BUS B (5) GND F G Y A D Ε H (6) N DMA BUS IOC BUS K DMA BUS IOC BUS Ρ Y J L М 0 R (8) (4) (1) В С D G н κ Μ Ν Q R S U A Ε J Ρ W X 2 V.TST TSSB.POS. ADDRESSES 1 2 3 SPARE SPARE 4 FOR 1 ROW FESH FESH FESH FESH FESH FESH FESH FESH 3 3 3 3 DTER ITER Ř в Ю В В g В Ы 5 FESL FESL FESL FESL FESL FESL FESL FESL CSP CSP CSP CSP CSP SSP CSP CSP D GND +5V GND +5V GND +5V 7 GND +5V F G н -B MULTV C MULTV D E MULTV MULTV A в BOARD D1G-A1 LA01 LA02 LA03 LA04 LA05 LA06 LA07 LA08 02A-A1 LA09 LA10 LA11 LA12 LA13 LA14 LA16 LA15 LA17 LA18 LA19 02F-A1 LA20 LA21 LA22 LA23 LA24 03F-A1 LA25 LA26 LA2B LA31 LA27 LA29 LA30 LA32

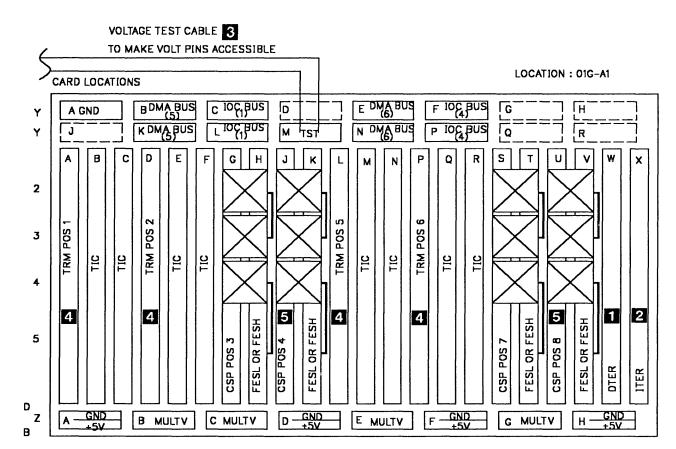
Card present when HPTSS installed

Either Card or flat cables 2

Install bypass CARD BPC1 in missing CSP positions to insure 3 the bus continuity between scanners, except for the case when the first adapter of the group is the last adapter of the bus.

Figure 5-136. Line Adapter Board, Cards and Crossovers (TSSB)

BOARD CARD SIDE





- 1 CARD present when HPTSS installed
- 2 either a CARD or flat cable
- 3 going to voltage test connector located on the left side on board 01G-A1

Install bypass CARD BPC2 in missing TRM positions to insure the bus continuity between scanners

5 install bypass CARD BPC1 in missing CSP positions to insure the bus continuity between scanners, except for the case when the first adapter of the group is the last adapter of the bus.

7. If you are exchanging a LAB1 board, go to step 8.

If you are exchanging a LAB2 board, go to step 9 on page 5-134.

If you are exchanging a LAB3 board, go to step 10 on page 5-134.

If you are exchanging a LAB4 board, go to step 11 on page 5-134.

- 8. For a LAB1 board:
 - a. Refer to Figure 5-11 on page 5-16 and locate cables at:

01B-A1-GZ4 01B-A1-GZ5 01B-A1-HZ4 01B-A1-HZ5 01B-A1-NZ1 01B-A1-NZ2 01B-A1-PZ4 01B-A1-PZ5

 b. Check that the cables are labelled according to their positions. If not, label them, then disconnect the cables from the SACU board.

c. Free these cables from the raceway and feed them through the frame back to LAB1 board enclosure.

- d. Refer to Figure 5-139 on page 5-136 and remove the power connectors 01H-J8 and 01H-J9.
- e. Disconnect the FDS ground cable from the LAB1 board.
- f. Continue with step 12.
- 9. For a LAB2 board:
 - a. Refer to Figure 5-136 on page 5-132 and locate cables at:

01G-A1-X2 01G-A1-X3 01G-A1-X4 01G-A1-X5

- b. Check that the cables are labelled according to their positions. If not, label them, then disconnect the cables.
- c. Free these cables from the raceway and feed them through the frame back to LAB2 board enclosure.
- d. Refer to Figure 5-139 on page 5-136 and remove the power connectors 02B-J8 and 02B-J9.
- e. Disconnect the FDS ground cable from the LAB2 board.
- f. Continue with step 12.
- 10. For a LAB3 board:
 - a. Refer to Figure 5-136 on page 5-132 and locate cables at:

02A-A1-X2 02A-A1-X3 02A-A1-X4 02A-A1-X5.

- b. Check that the cables are labelled according to their positions. If not, label them, then disconnect the cables.
- c. Free these cables from the raceway and feed them through the frame back to LAB3 board enclosure.

- d. Refer to Figure 5-139 on page 5-136 and remove the power connectors 02G-J8 and 02G-J9.
- e. Disconnect the FDS ground cable from the LAB3 board.
- f. Continue with step 12.
- 11. For a LAB4 board:
 - a. Refer to Figure 5-136 on page 5-132 and locate cables at:
 - 02F-A1-X2 02F-A1-X3 02F-A1-X4 02F-A1-X5.
 - b. Check that the cables are labelled according to their positions. If not, label them, then disconnect the cables.
 - c. Free these cables from the raceway and feed them through the frame back to LAB4 board enclosure.
 - d. Refer to Figure 5-139 on page 5-136 and remove the power connectors 03G-J8 and 03G-J9.
 - e. Disconnect the FDS ground cable from the LAB4 board.
- 12. Refer to Figure 5-138 on page 5-135 and Figure 5-139 on page 5-136, and do the following:
 - a. Remove the 6 screws **1** which maintain the enclosure on the frame. Then slide the enclosure out of the machine taking care not to damage the power board and connectors on the left side. Place the enclosure on safe working area front side up.
 - b. Unscrew the 2 screws 2 securing the FDS cable.
 - c. Loosen the spring-loaded cable retainers which hold the cables on rows Y and Z by completely loosening the 2 screws
 6 . Then remove these cables.

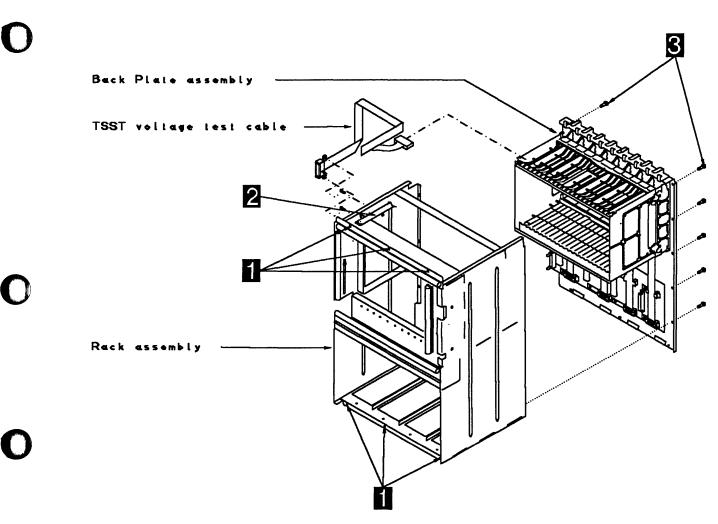


Figure 5-138. Enclosure for the Line Adapter Board

- d. If you are exchanging a TSST Board, remove the 2 screws holding the TSST voltage test cable on the left side of the rack assembly.
- e. Working from the rear side of the enclosure, remove the 11 screws 3 holding the back plate assembly and rack assembly together. Then, remove

back the plate assembly and place it in an area for further work.

- f. Remove the 10 screws 4, which maintain the board assembly on the back plate. Remove the board assembly.
- g. Remove the 4 screws **5** which hold the board to the card guide assembly. You can now remove the line adapter board.

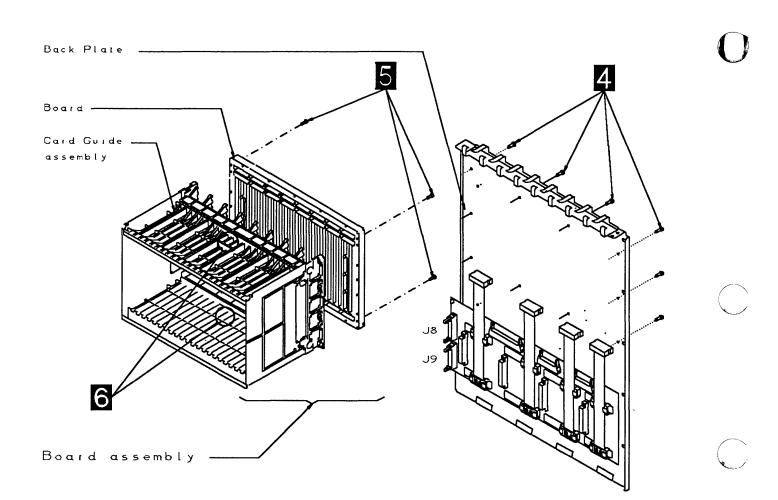


Figure 5-139. Back Plate Assembly

Installation Procedure

- 1. Refer to Figure 5-138 on page 5-135 and Figure 5-139 on page 5-136 and do the following:
 - a. Fasten the new line adapter board on the card guide assembly by means of 4 screws
 - b. Fasten the board assembly on the back plate assembly with 10 screws
 - c. Fasten the back plate assembly on the rack assembly with 11 screws
 - d. Reconnect the flat cables at the top and at the bottom of the board (row 'Y' and 'Z') and tighten the brackets which maintain them with 2 screws
 - e. If you have exchanged a TSST Board, re-install the 2 screws holding the TSST voltage test cable on the left side of the rack assembly.
 - f. Slide the enclosure into the machine, then fasten it on the frame with 6 screws
- 2. Secure the cables with the cable clamps on the enclosure raceway.
- 3. WARNING: Use the ESD kit and procedures.

Refer to Figure 5-136 on page 5-132 (for a TSSB), or to Figure 5-137 on page 5-133 (for a TSST) and do the following:

- a. Re-install all the cards and the top card connectors.
- B. Route the present serial link, token-ring and line cables back to the enclosure and fasten their grounding screws.
 Reconnect them to the FESL, TIC and FESH cards according to their labels.
- c. If no card is present on X2, re-install the flat cables on X2, X3, X4, X5. Secure them on the raceway with cable clamps.
- 4. Refer to Figure 5-135 on page 5-131, re-install the removed power supplies as follows:
 - a. Slide the PS type 4 assembly into the machine.
 - b. Connect the P1 connector 3
 - c. Lock the retaining screw 2
 - d. Tighten the 2 tab screws 3
- 5. If you have exchanged a LAB1 board, go to step 6.

If you have exchanged a LAB2 board, go to step 7.

If you have exchanged a LAB3 board, go to step 8.

If you have exchanged a LAB4 board, go to step 9 on page 5-138.

- 6. For the LAB1 board:
 - a. Feed the cables through the frame back to the SACU board and re-install them in their correct locations:

01B-A1-GZ4 01B-A1-GZ5 01B-A1-HZ4 01B-A1-HZ5 01B-A1-NZ1 01B-A1-NZ2 01B-A1-PZ4 01B-A1-PZ5.

- b. Re-install the power connectors 01H-J8 and 01H-J9.
- c. At machine frame 01 ground bus, reconnect the FDS cable coming from the LAB1 board.
- d. Continue with step 11 on page 5-138.
- 7. For the LAB2 board:
 - a. Feed the cables through the frames back to the LAB1 board enclosure. Reconnect the cables to their correct locations:
 - 01G-A1-X2 01G-A1-X3 01G-A1-X4 01G-A1-X5.
 - b. Re-install the power connectors 02B-J8 and 02B-J9.
 - c. At machine frame 02 ground bus, re-install the FDS cable coming from the LAB2 board.
 - d. Continue with step 11 on page 5-138.
- 8. For the LAB3 board:
 - a. Feed the cables through the frame back to the LAB2 board enclosure. Reconnect the cables to their correct locations:

02A-A1-X2 02A-A1-X3 02A-A1-X4 02A-A1-X5.

- b. Reconnect the power connectors 02G-J8 and 02G-J9.
- c. At machine frame ground bus, reconnect the FDS cable coming from the LAB3 board.
- d. Continue with step 11 on page 5-138.

- 9. For the LAB4 board:
 - a. Feed the cables through the frames back to the LAB3 board enclosure. Reconnect the cables to their correct locations:
 - 02F-A1-X2 02F-A1-X3 02F-A1-X4
 - 02F-A1-X5.
 - b. Reconnect power connectors 03G-J8 and 03G-J9.
 - c. At machine frame 03 ground bus, reconnect the FDS cable coming from the LAB4 board.
- 10. Close the internal covers.
- 11. Switch the CB1 ON.
- 12. Close the frame doors.
- 13. Turn the machine ON using the control panel as follows:
 - a. Press the 'Power Control' key until (3) appears in the Power Control window (Power Control in local).

- b. Press the 'Validate' key.
- c. Press the 'Function' key until (1) appears in the function window (function in MOSS IML).
- d. Press the 'Validate' key.
- e. Press the 'Service' key until (1) appears in the service window (service in MAINTENANCE 1).
- f. Press the 'Validate' key.
- g. Press the 'power ON Reset' key.

Note: The former actions will power the machine ON and also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **FOE,FOF** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

- 14. Run the TSS diagnostics. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1.
- 15. Go to "Repair Verification Procedure" on page 5-170.

LIC Board Type 1 Exchange Procedure

Removal Procedure

- 1. Advise the customer that the 3745 is to be turned OFF.
- 2. Press power OFF on the control panel.
- 3. Switch CB1 OFF. Refer to Figure 5-140.
- 4. Locate the board to exchange. Refer to Figures 5-1 to 5-6.

Refer to Figure 5-141 on page 5-140 and do the following:

- 5. Verify that the LIC cables are labelled according to their positions. If not, label them. Then, remove the LIC cables from the LICs.
- 6. Remove the cover to allow access to the DMUX.
- 7. Verify the serial link cable(s) on the DMUX are labeled according to their positions. If not, label them. Then remove the serial link cable(s).
- 8. Note the types and locations of the LICs. The LIC type is indicated by the color of the thumb screw.

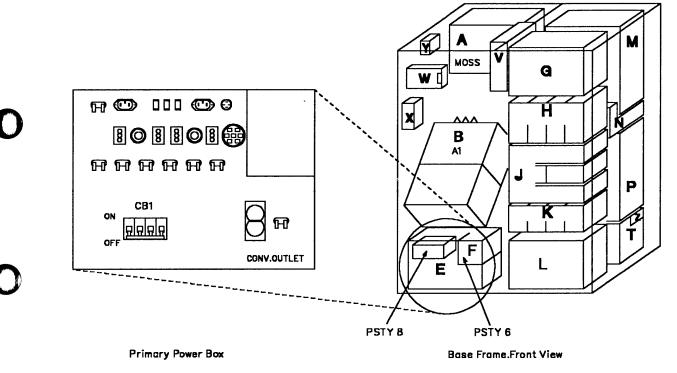


Figure 5-140. Primary Power Box

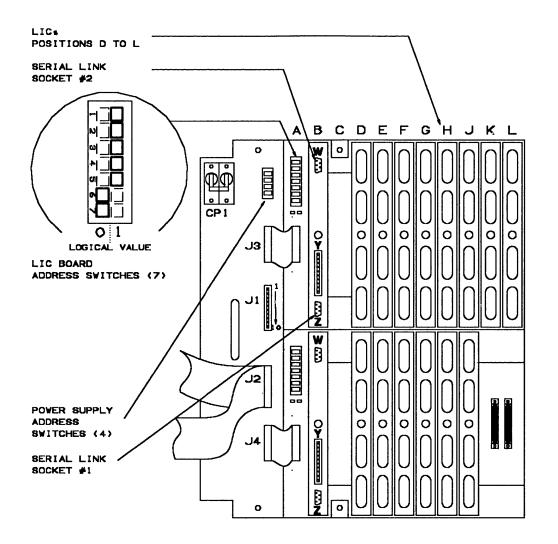


Figure 5-141. LIC Board Type 1 Assembly

1 1 1

LIC Board Type 1 Location	Address Switches 7 to 1	LIC Board Type 1 Location	Address Switches 7 to 1
01M-B1	0000011	05D-B1	0010001
01M-B2	0000010	05D-B2	0010000
01P-B1	0000001	05E-B1	0010111
01P-B2	0000000	05E-B2	0010110
04B-B1	0001101	05G-B1	0010011
04B-B2	0001100	05G-B2	0010010
04D-B1	0001001	06B-B1	0011101
04D-B2	0001000	06B-B2	0011100
04E-B1	0001111	06D-B1	0011001
04E-B2	0001110	06D-B2	0011000
04G-B1	0001011	06E-B1	0011111
04G-B2	0001010	06E-B2	0011110
05B-B1	0010101	06G-B1	0011011
05B-B2	0010100	06G-B2	0011010

FRU Type	Thumb Screw Colors
LIC Type 1	Brown
LIC Type 3	Blue
LIC Type 4A	Green
LIC Type 4B	Green
DMUX	White

9. WARNING: Use the ESD kit and procedures. Remove the LICs and the DMUX by unfastening the thumb screws holding them to the board.

10. Note the board address for later use.

Refer to Figure 5-142 and Figure 5-143 and do the following:

11. Disconnect the flat power cable 1 from the LIC Board.

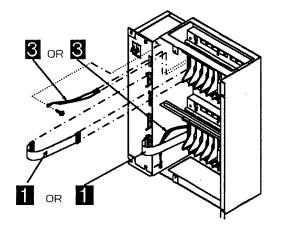


Figure 5-142. LIC Board Type 1 Enclosure Assembly

- 12. If present, disconnect the ground strap from the LIC board 3.
- 13. Remove the 4 screws 2 holding the board assembly to the frame.
- 14. Remove the LIC Board assembly.

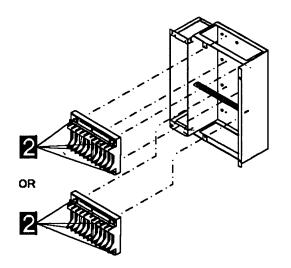


Figure 5-143. LIC Board Type 1 Assemblies

Installation Procedure

- 1. Refer to Figure 5-141 on page 5-140 and set the board address the same way you noted it during board removal.
- Refer to Figure 5-143 on page 5-141. If present, check if there is a place on the new board to install the ground strap and reconnect it; If not, remove the ground strap from the frame. Mount the new board in place and secure it with the four screws 2
- 3. Refer to Figure 5-142 on page 5-141. Reconnect the flat power cable 1
- 4. WARNING: Use the ESD kit and procedures.

Install the LICs and the DMUX in their proper positions and fasten the thumb screws holding them on the board. Finger strength is enough, do not use tools.

- 5. Install the LIC cables on the LICs.
- 6. Note from the serial link cable label(s) the connection information (which line adapter they were connected to). Record this information for later use.
- 7. Install the serial link cable(s) on the DMUX.
- 8. Re-install the DMUX cover.

- 9. Record the Part Number of the new board on the label stuck above the LIC enclosure.
- 10. Switch the CB1 ON, refer to Figure 5-140 on page 5-139.
- 11. Turn the machine ON, using the control panel as follows:
 - a. Press the 'Power Control' key until (3) appears in the Power Control mode window (Power Control in local).
 - b. Press the 'Validate' key.
 - c. Press the 'Function' key until (1) appears in the function window (function MOSS IML).
 - d. Press the 'Validate' key.
 - e. Press the 'Service' key until (1) appears in the service window (service in MAINTENANCE 1).
 - f. Press the 'Validate' key.
 - g. Press the 'power ON' Reset key.

Note: The former actions will power the machine ON and also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **F0E,F0F** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

- 12. Run the TSS diagnostics for the Line Adapters you recorded in step 6 in this procedure. Refer to "How to Run Internal Function Tests" on page 4-29.
- 13. Go to "Repair Verification Procedure" on page 5-170.

LIC Board Type 2 Exchange Procedure

Removal Procedure

- 1. Advise the customer that the 3745 is to be turned OFF.
- 2. Press power OFF on the control panel.
- 3. Switch CB1 OFF. Refer to Figure 5-144
- 4. Locate the board to exchange. Refer to Figures 5-1 to 5-6.

Refer to Figure 5-145 on page 5-144 and do the following:

- 5. Verify that the LIC cables are labeled according to their positions. If not, label them. Then remove the LIC cables from the LICs.
- 6. Remove the cover to allow access to the SMUX.
- 7. Verify that the serial link cable on the SMUXA or SMUXB is labeled according to its position. If not, label them. Then remove the serial link cable.
- 8. Remove the flat cable between SMUXA and SMUXB.
- 9. Note the types and locations of the LICs.

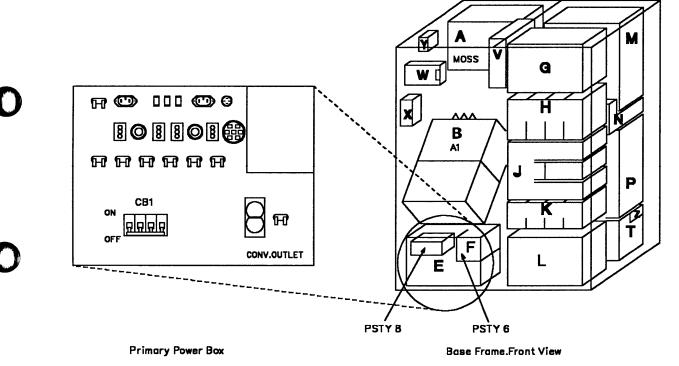
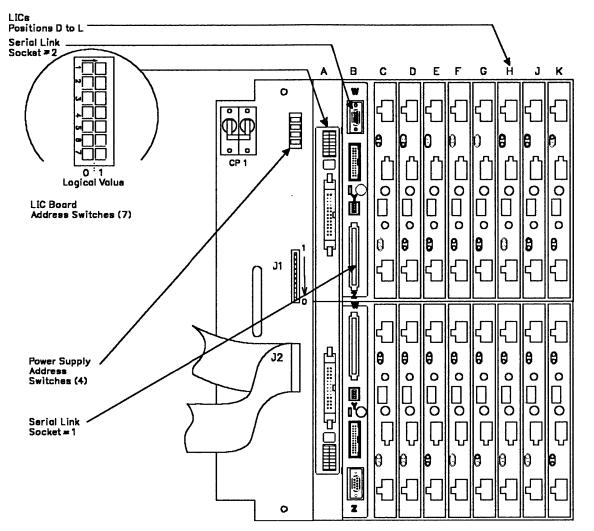


Figure 5-144. Primary Power Box





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Figure 5-145. LIC Board Type 2 Assembly

LIC Board Type 2 Location	Address Switches 7 to 1	LIC Board Type 2 Location	Address Switches 7 to 1
01M-B1	0000011	05D-B1	0010001
01M-B2	0000010	05D-B2	0010000
01P-B1	N.A.	05E-B1	0010111
01P-B2	N.A.	05E-B2	0010110
04B-B1	0001101	05G-B1	0010011
04B-B2	0001100	05G-B2	0010010
04D-B1	0001001	06B-B1	0011101
04D-B2	0001000	06B-B2	0011100
04E-B1	0001111	06D-B1	0011001
04E-B2	0001110	06D-B2	0011000
04G-B1	0001011	06E-B1	0011111
04G-B2	0001010	06E-B2	0011110
05B-B1	0010101	06G-B1	0011011
05B-B2	0010100	06G-B2	0011010

FRU Type

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Thumb Screw Colors

LIC Type 1
LIC Type 3
LIC Type 4A
LIC Type 4B
LIC Type 5
LIC Type 6
DMUX
SDMUXA
SDMUXB

Brown Blue Green Black Black White Black Black

10. WARNING: Use the ESD kit and procedures.

Remove the LICs and the SMUXA or SMUXB by unfastening the thumb screws holding them on the board.

11. Note the board address for later use.

Refer to Figure 5-146 and Figure 5-147 and do the following:

- 12. Disconnect the flat power cable **1** from the LIC board.
- 13. Remove the 4 screws **2** holding the board assembly on the frame.
- 14. Remove the LIC board assembly.

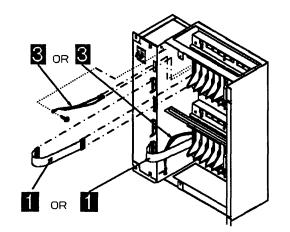


Figure 5-146. LIC Board Type 2 Enclosure Assembly

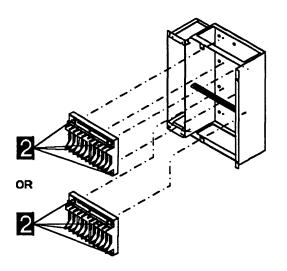


Figure 5-147. LIC Board Type 2 Assemblies

Installation Procedure

- 1. Refer to Figure 5-145 on page 5-144 and set the board address to the same one you noted during board removal.
- Refer to Figure 5-147 on page 5-146. Mount the new board in place and secure it with the four screws
- 3. Refer to Figure 5-146 on page 5-146. Reconnect the flat power cable 1
- 4. WARNING: Use the ESD kit and procedures.
 - Install the LICs and the SMUXA or SMUXB in their proper positions and fasten the thumb⁻ screws holding them on the board. Finger strength is enough, do not use tools.
- 5. Install the LIC cables on the LICs.
- 6. Note from the serial link cable label the connection information (which line adapter they are connected to). Record this information for later use.
- 7. Install the serial link cable on the SMUXA or SMUXB.
- Install the flat cable between SMUXA and SMUXB.
- 9. Re-install the SMUX cover.

- 10. Record the part number of the new board on the label stuck above the LIC enclosure.
- 11. Switch CB1 ON, refer to Figure 5-144 on page 5-143
- 12. Power the machine ON using the control panel as follows:
 - a. Press the 'power control' key until (3) appears in the Power Control mode window (Power Control in local).
 - b. Press the 'Validate' key.
 - c. Press the 'Function' key until (1) appears in the function window (function MOSS IML).
 - d. Press the 'Validate' key.
 - e. Press the 'Service' key until (1) appears in the service window (service in MAINTENANCE 1).
 - f. Press the 'Validate' key.
 - g. Press the 'power ON' Reset key.
 - Note: The former actions will power the machine ON and also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code FOE,FOF or 000. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14
- 13. Run the TSS diagnostics for the Line Adapters you recorded on step 6 in this procedure. Refer to "How to Run Internal Function Tests" on page 4-29.
- 14. Go to "Repair Verification Procedure" on page 5-170.

MOSS Board Exchange Procedure

Removal Procedure

- 1. Advise the customer that the 3745 is to be turned OFF.
- 2. Press 'Power OFF' on the control panel.
- 3. Switch CB1 OFF. Refer to Figure 5-149.
- 4. Refer to Figure 5-148 to locate the MOSS board.
- 5. Refer to Figure 5-150 on page 5-149.
 - a. Disconnect the flat cable 2 from PROM card 01A-X0E1. The disconnection can be done only from the PROM card.
 - b. Disconnect the cable **1** from MAC/MAC2 card 01A-X0H1.

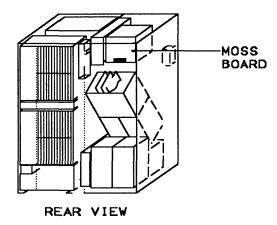


Figure 5-148. Base Frame - Rear View

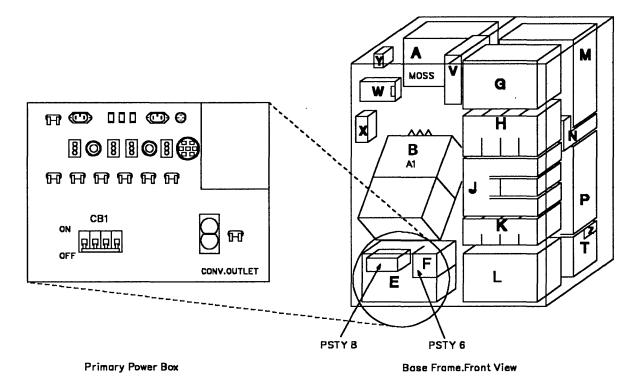


Figure 5-149. Primary Power Box in Frame 01

LOCATION: 01A-

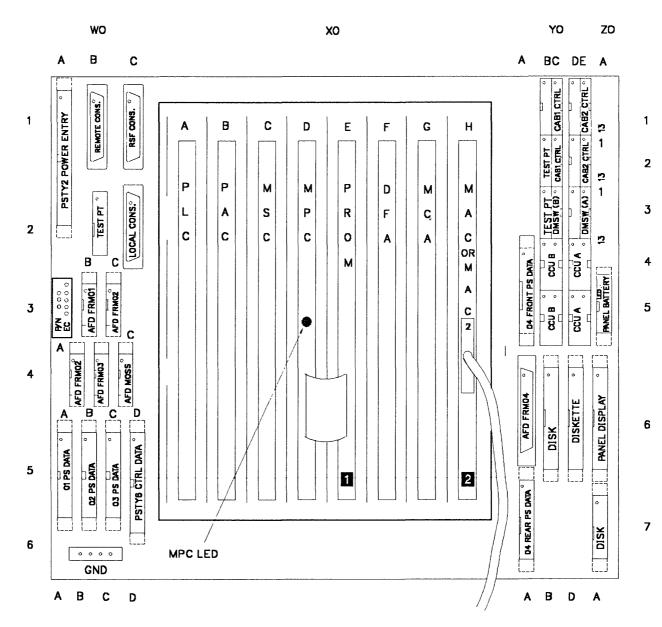


Figure 5-150. Cables and Cards of the MOSS

6. Refer to Figure 5-150.

Verify if the cards are labelled according their locations. If not, label them.

WARNING: Use the ESD kit and procedures.

Remove the cards and put them in a safe place.

7. Refer to Figure 5-150.

Verify that all the cables are labelled according their locations, if not, label them.

Disconnect the cables from the 01A-W0, 01A-Y0 and 01A-Z0 areas.

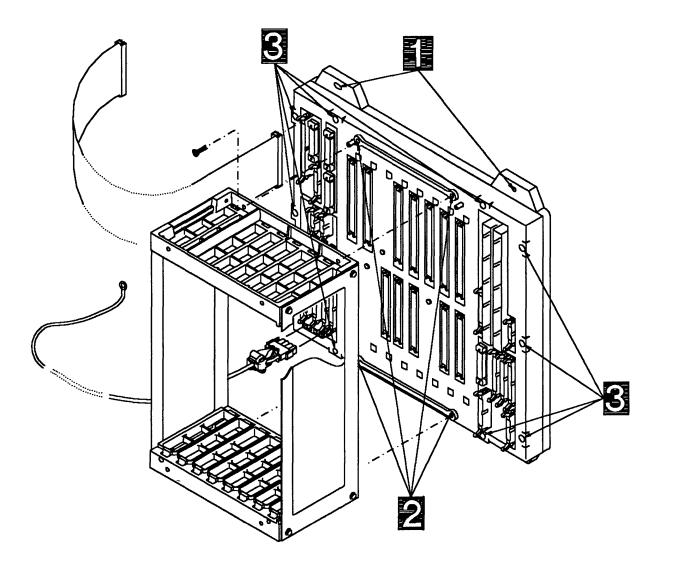


Figure 5-151. MOSS Board and Card Rail Assemblies

- 8. Refer to Figure 5-151.
 - a. Remove the 4 screws **1** holding the MOSS board assembly to the machine frame. Remove the MOSS board assembly. Place the board assembly in a work area for further work.
 - b. Remove the 4 screws **2** holding the rail assembly on the FRU board. Remove

the rail assembly and store it for later use.

c. Remove the 10 screws holding the top stiffener of the MOSS board.
 Carefully remove the top stiffener. Lift the MOSS board out of the bottom stiffener.

Installation Procedure

- 1. Place the new MOSS board in the bottom stiffener.
- 2. Refer to Figure 5-151 on page 5-150.
 - a. Replace the top stiffener and attach it with the 10 screws 3
 - b. Attach the rail assembly to the top stiffener with the 4 screws 2 ,
 - c. Attach the moss board and rail assembly to the base frame with the 4 screws 1,
- 3. Refer to Figure 5-150 on page 5-149.

Install cables at 01A-W0, 01A-Y0 and 01A-Z0 in their correct locations according to their labels.

4. WARNING: Use the ESD kit and procedures.

Install the cards in their correct locations according to their labels, refer to Figure 5-150 on page 5-149.

5. Refer to Figure 5-150 on page 5-149.

Reconnect the flat cable 2 coming from the MPC card 01A-X0D1, to the PROM card 01A-X0E1.

Reconnect the cable **1** to the MAC/MAC2 card 01A-X0H1.

- 6. Close the internal covers.
- 7. Switch CB1 ON.
- 8. Close the doors of the base frame.
- 9. Turn the machine ON, using the control panel as follows :
 - a. Press the 'Power Control' key until (3) appears in the Power Control window (Power Control in local).
 - b. Press the 'Validate' key.
 - c. Press the 'Function' key until (1) appears in the function window (function in MOSS IML).
 - d. Press the 'Validate' key.
 - e. Press the 'Service' key until (1) appears in the service window (service in MAINTENANCE 1).
 - f. Press the 'Validate' key.
 - g. Press the 'power ON Reset' key.

Note: The former actions will turn the machine ON and also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **FOE**,**FOF** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

10. Go to "Repair Verification Procedure" on page 5-170.

Notes:

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SAC Gate Assembly Exchange Procedure for Models 210 and 410

Removal Procedure

- 1. Advise the customer that the 3745 is to be turned OFF.
- 2. Press 'Power OFF' on the control panel.
- 3. Switch CB1 OFF. Refer to Figure 5-152 for the location of the CB1.
- 4. Refer to Figure 5-153 on page 5-154 to locate the SAC boards (SACU & SACL).
- 5. Refer to Figure 5-154 on page 5-155. Working from the rear of the frame 01, do the following:
 - a. Loosen the 4 screws which maintain the internal cover and remove the cover.
 - b. Remove the blanking plate assembly by removing the 4 screws 1
 - c. WARNING: Use the ESD kit and procedures.

Check that the cards are labelled according to their positions, if not, label

them. Refer to Figure 5-156 on page 5-156 and remove the cards as follows:

- Using both hands, release levers A and B simultaneously by moving them upwards and outwards.
- Press catches C and D in gently and pull the card assembly out of the SAC gate assembly.
- d. Note the locations and remove the cables from the Z row of the SACL board.
- e. Remove the cable cover 2 by removing the 2 screws 3
- f. Note the locations and remove the trilead packs from the SACL board.
- g. Note the locations and remove the cables from the Y row of the SACL board.
- h. Make sure that all the removed cables are well clear of the board assembly.

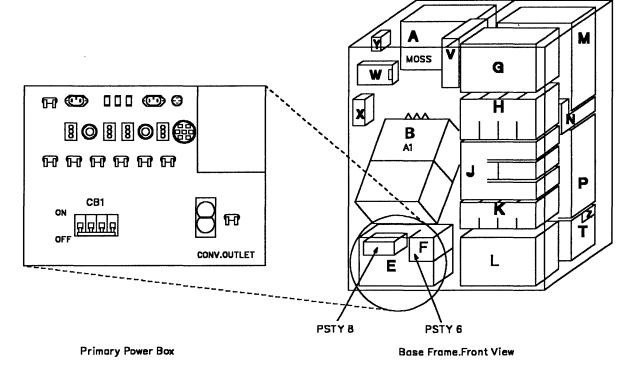


Figure 5-152. Primary Power BOX in Frame 01

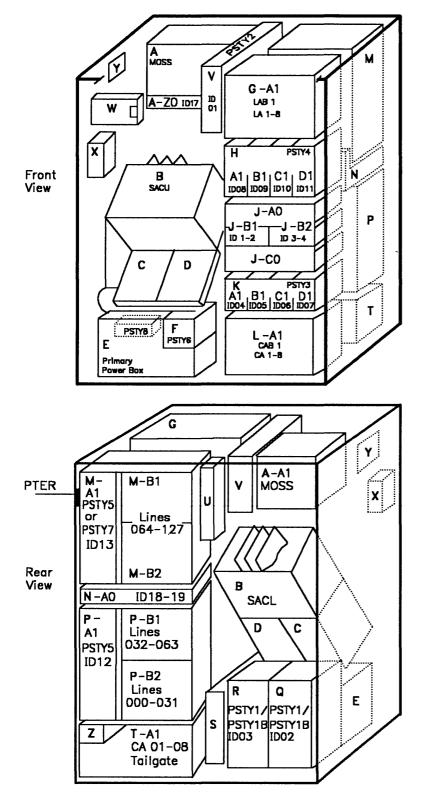


Figure 5-153. Frame 01 Front and Rear View

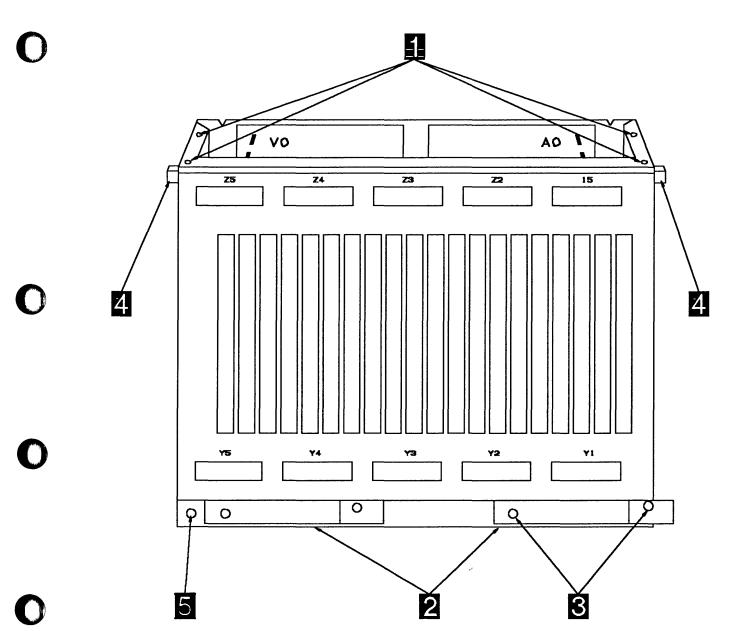


Figure 5-154. Rear View of the SAC Gate Assembly

- 6. Refer to Figure 5-155 on page 5-156. Working from the front of frame 01, do the following:
 - a. Open the internal door.
 - b. Open the control panel door.
 - c. Note the locations and remove the cables from the Z row of the SACU board.

- d. Note the locations and remove the ribbon cables from the SACU board.
- e. Note the locations and remove the cables from the Y row of the SACU board.
- f. Make sure all the removed cables are well clear of the SAC gate assembly.

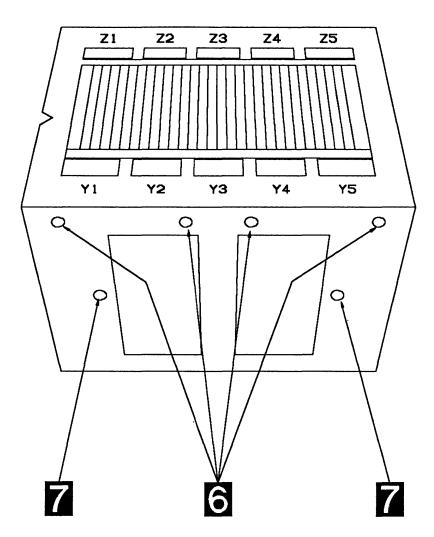


Figure 5-155. Front View of the SAC Gate Assembly

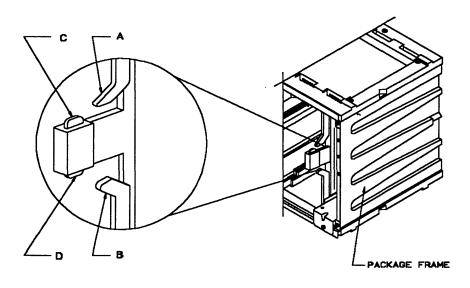


Figure 5-156. Card Clamp Mechanism

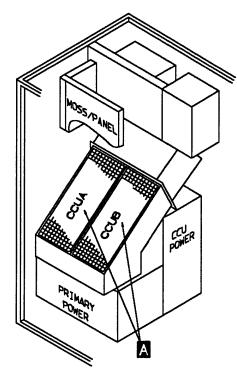


Figure 5-157. SAC Air Moving Device Unit Location

- 7. Refer to Figure 5-157 and to Figure 5-158 and remove the Air Moving Device(s) as follows:
 - a. Unplug the Air Moving Device power cord.
 - b. Remove the 4 mounting screws from the Air Moving Device unit.
 - c. To remove the Air Moving Device, swing the bottom of the unit out and lift the Air Moving Device out.
 - d. Repeat the procedure for the second Air Moving Device if present, otherwise remove the blanking cover by removing the 4 mounting screws.

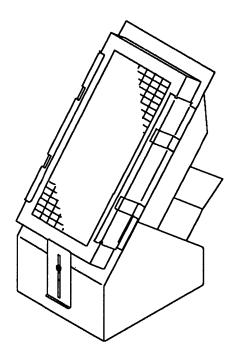


Figure 5-158. SAC Air Moving Device

- Refer to Figure 5-155 on page 5-156. Then remove the 4 screws 6 holding the SAC gate assembly.
- 9. Refer to Figure 5-154 on page 5-155. Working from the rear of frame 01, do the following:
 - a. Open the cable clips 4 and remove the FDS cables.
 - b. Remove the 2 screws **5** holding the gate assembly to the frame.
 - c. Referring to Figure 5-155 on page 5-156 and working through the gate assembly, remove the last 2 screws **7** still holding the gate assembly to the frame.
 - d. WARNING: The SAC gate assembly weighs approximately 10 kg.
 - e. Very carefully remove the SAC gate assembly by lifting it upwards with both hands.

Installation Procedure

1. Install the labels shipped with the new SAC gate assembly using the enclosed instructions.

Refer to Figure 5-154 on page 5-155 and Figure 5-155 on page 5-156

- 2. Working from the rear, do the following:
 - a. Put the new SAC gate assembly in place.
 - b. Fasten the SAC gate assembly to the frame with the 2 center screws 7 and 2 bottom screws 5.
- 3. Working from the front do the following:
 - a. Install the 4 top screws 6. Do not tighten the screws.
 - b. Align the SAC gate assembly with the bottom and sides of the opening and tighten all 8 screws.
 - c. Reconnect the ribbon cables to the SACU board.
 - Reconnect the cables to Z and Y rows of the SACU board, refer to Figure 5-11 on page 5-16.
 - e. Re-install the Air Moving Device(s).
- 4. Working from the rear do the following:
 - a. Feed the FDS cables going to the SACU board from the rear through the cable clips
 4. Close the clips.
 - Reconnect the cables to the Y row of the SACL board, refer to Figure 5-13 on page 5-18.
 - c. Reconnect all the trilead packs on the SACL board.
 - d. Reconnect the cables to the Z row of the SACL board.
 - e. Re-install the cable cover 2 by installing the 2 screws 3 ensuring that no trileads are trapped.
 - f. WARNING: Use the ESD kit and procedures.

g. Re-install the cards.

Note: In order to improve contact, maneuver card seating levers 3 times for every card.

- h. Re-install the blanking plate assembly by installing the 4 screws
- i. Re-install the SAC gate assembly internal cover.
- 5. Close the front internal door and the control panel door.
- 6. Switch the CB1 ON.
- 7. Close the frame doors.
- 8. Turn the machine ON using the control panel as follows:
 - a. Press the 'Power Control' key until (3) appears in the Power Control window (Power Control in Local).
 - b. Press the 'Validate' key.
 - c. Press the 'Function' key until (1) appears in the function window (function in MOSS IML).
 - d. Press the 'Validate' key.
 - e. Press the 'Service' key until (1) appears in the service window (service in MAINTENANCE 1).
 - f. Press the 'Validate' key.
 - g. Press the 'power ON Reset' key.

Note: The former actions will turn the machine ON and also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **F0E,F0F** or **000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14

- Run the CCU and the IOC bus diagnostics. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1.
- 10. Go to "Repair Verification Procedure" on page 5-170.



Notes: . • • . • . •

SAC2 Gate Assembly Exchange Procedure for Models 310 and 610

Removal Procedure

- 1. Advise the customer that the 3745 is to be turned OFF.
- 2. Press 'Power OFF' on the control panel.
- 3. Open the doors of frame 01 (base frame).
- 4. Switch CB1 OFF. Refer to Figure 5-159 for the location of CB1.

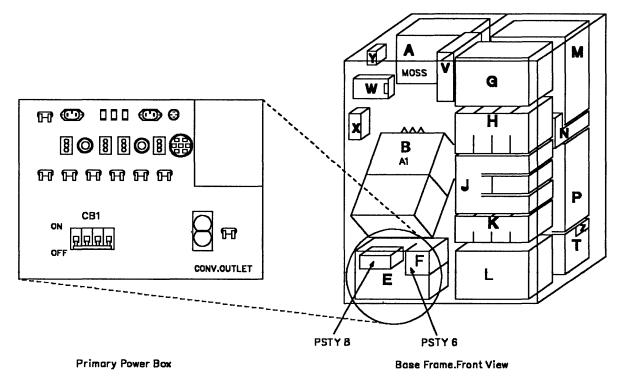


Figure 5-159. Primary Power BOX in Frame 01

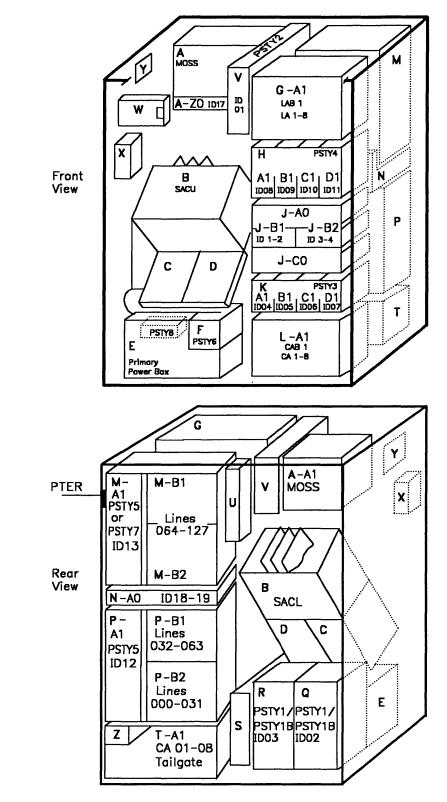


Figure 5-160. Frame 01 Front and Rear View

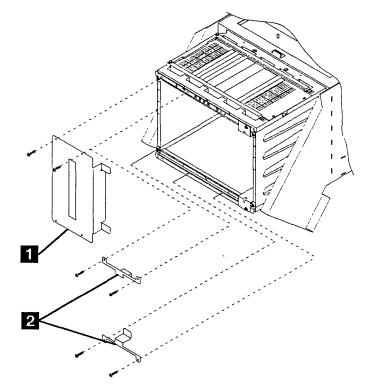


Figure 5-161. SAC Gate Assembly - Brackets

- 5. Refer to Figure 5-160 on page 5-161 to locate the SAC boards (SACU & SACL).
- 6. Refer to Figure 5-161. Working from the rear of frame 01, do the following:
- a. Remove the bracket(s) which maintain(s) the central card(s). One bracket 1 for the 3745 simplex model, two brackets
 2 for the 3745 duplex model. Four screws have to be removed to do that.

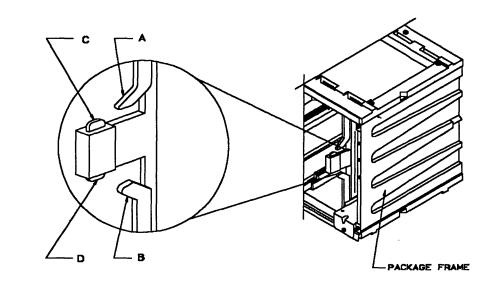


Figure 5-162. Card Clamp Mechanism

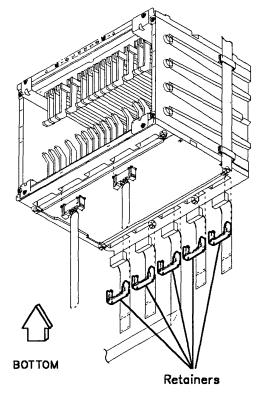
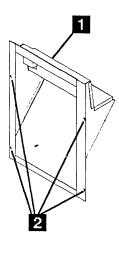
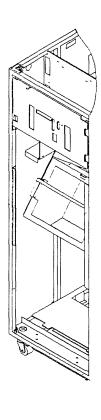


Figure 5-163. Lower view of the SAC Gate Assembly

- b. WARNING: Use the ESD kit and procedures.
- c. Check that the cards are labelled according to their positions, if not, label them. Refer to Figure 5-162 and remove the cards as follows:
 - 1) Using both hands, release levers A and B simultaneously by moving them upwards and outwards.
 - 2) Press catches C and D in gently and pull the card assembly out of the SAC gate assembly.
- d. Refer to Figure 5-163. Check if the cables are labelled according to their positions, if not, label them. Remove the retainers and the cables from the Y and Z rows.





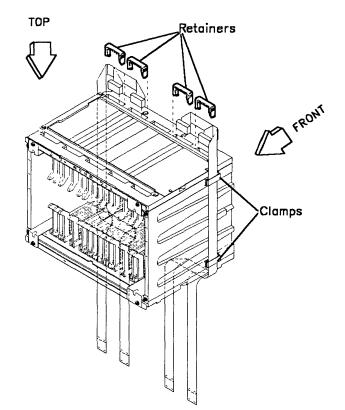


Figure 5-164. Air Duct

- 7. Refer to Figure 5-164. Working from the front side, do the following:
 - a. Loosen the four screws 2 which maintain the air duct 1 on the frame.
 - b. Lift the air duct up and remove it.
- 8. Refer to Figure 5-165. Working from the front of frame 01, do the following:

Figure 5-165. Upper View of the SAC Gate Assembly

- a. Check that the cables are labelled according to their positions, if not, label them.
- b. Remove the ribbon cables from the central area of the SACU board.
- c. Open the clamps, then remove the retainers and the cables from row Y of the SACU board.
- d. Make sure all the removed cables are well clear of the SAC gate assembly.

9. Refer to Figure 5-166 and to Figure 5-167 and remove the air moving device(s) as follows:

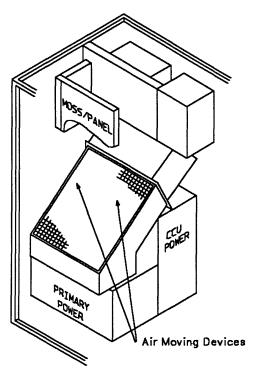


Figure 5-166. SAC Air Moving Devices Unit Location

- a. Unplug the air moving device power cord(s).
- b. Remove the plate **1** and the braket **3** by removing the five screws **2**.
- c. Remove the the upper filter.
- d. Disconnect the ground wire(s) 7.
- e. Remove the two air moving device units **5** (or the left air moving device and the right plate if you work on a 3745 simplex model). To do that, eight nuts **4** have to be removed.
- f. Remove the two pads 6.
- g. You can now access the eight screws 8 wich maintain the SAC gate assembly
 9.
- h. WARNING: The SAC gate assembly weighs approximately 10 kg.
- i. A second person must support at the rear side the SAC gate assembly while you remove the eight screws.
- j. Working from the rear side, very carefully remove the SAC gate assembly by lifting it upwards with both hands.

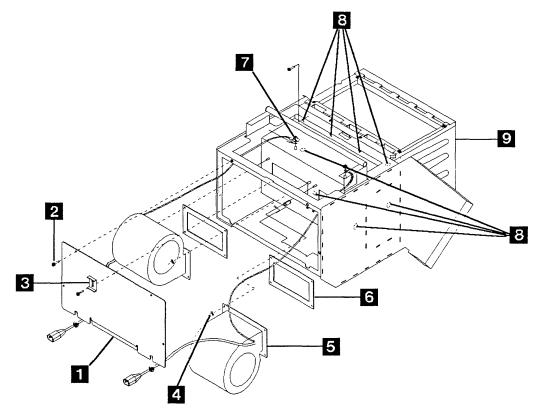


Figure 5-167. Air Moving Device Unit Removal

Installation Procedure

- 1. Install the labels shipped with the new SAC gate assembly using the enclosed instructions.
- 2. Refer to Figure 5-167 on page 5-165 then do the following :
 - a. From the rear side, put the new SAC gate assembly 9 in place.
 - b. While you support the SAC gate assembly, a second person has to install the eight screws 8 at the front side.
 - c. At the front side, install the two pads 6.
 - d. Re-install the two air moving devices unit (or the left air moving device unit and the right plate if you work on a 3745 simplex model). Tighten the eigth nuts
 4 which maintain the air moving device unit(s).
 - e. Reconnect the ground wire(s) 7.
 - f. Re-install the upper filter.
 - g. Re-install the plate 1 and the bracket
 3 using the five screws 2.
 - h. Replug the air moving device power cord(s).
- 3. Refer to Figure 5-165 on page 5-164, then, at the front side, do the following :
 - a. Reconnect the cables to the Y row of the SACU board.
 - b. Re-install the retainers and close the clamps.
 - c. Reconnect the ribbon cables to the central area of the SACU board.
- 4. Refer to Figure 5-163 on page 5-163, then at the rear side, do the following :
 - a. Reconnect the cables to the Y and Z row of the SACL board.
 - b. Re-install the retainers.
- 5. Refer to Figure 5-164 on page 5-164, then at the front side, re-install the air duct as follow :
 - a. Slide down the air duct **1** on the four loosened screws **2**.

- b. Tighten the four srews.
- 6. Refer to Figure 5-161 on page 5-162, then from the rear side, do the following :
 - a. WARNING: Use the ESD kit and procedures.
 - b. Re-install the cards.
 - Note: In order to improve contact, maneuver the card seating levers 3 times for every card.
 - c. Re-install the brackets(s) **1** or **2** which maintain(s) the central cards using the four screws.
- 7. Switch CB1 ON.
- 8. Close the frame doors.
- 9. Turn the machine ON using the control panel as follows:
 - a. Press the 'Power Control' key until (3) appears in the Power Control window (Power Control in Local).
 - b. Press the 'Validate' key.
 - c. Press the 'Function' key until (1) appears in the function window (function in MOSS IML).
 - d. Press the 'Validate' key.
 - e. Press the 'Service' key until (1) appears in the service window (service in MAINTENANCE 1).
 - f. Press the 'Validate' key.
 - g. Press the 'power ON Reset' key.

Note: The former actions will turn the machine ON and also run MOSS diagnostics and complete a MOSS IML. A successful completion will result in a code **F0E**, **F0F** or`**000**. If any other code is displayed, an error was detected. See "Panel Codes" on page 2-14.

- 10. Run the CCU and the IOC bus diagnostics. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1.
- 11. Go to "Repair Verification Procedure" on page 5-170.

TCM Board Exchange Procedure

The following procedures concern the removal and installation of the Thermal Conduction Modules (TCM) board.

This procedure is valid for both CCUs.

WARNING: Keep aware that the TCM is susceptible to mechanical shock damage. Carefully observe handling instructions and keep the TCM in its shipping container whenever it is not in the machine.

Removal and Replacement Procedure

WARNING: Advise the customer that the 3745 is to be turned off.

In order to access the TCM board it is necessary to remove the TCM.

WARNING: Always remove the TCM before exchanging a TCM board. If not, you could damage the TCM.

Refer to "TCM Removal" on page 5-96.

TCM Board Removal

1. Referring to Figure 5-168 on page 5-168:

- Using the torque tool, disconnect the 3 supergroupers A positions B1, A2, A4 located on the TCM board (TCM side).
- Go to the rear of the machine, open the cover.

- Unscrew the FDS retaining screws.
- · Remove the FDS bracket.
- Disconnect the FDS **B** positions C1, A3, C4.
- Disconnect the sense cable C.
- 2. Remove the PS type 1 (except TB-1 disconnect) refer to "PS Type 1 Exchange Procedure for Models 210 and 410" on page 5-103.
- 3. Referring to Figure 5-169 on page 5-169, use the torque tool and, remove the 10 mounting screws.

Note: To access the 2 lower screws, you will have to slide the SAC cage assembly about 15 centimeters. Some but not all the cables must be disconnected to allow the SAC cage to slide back.

- 4. Carefully remove the TCM board from the machine.
- 5. Remove the metallic RFI cover, and save it for later use.

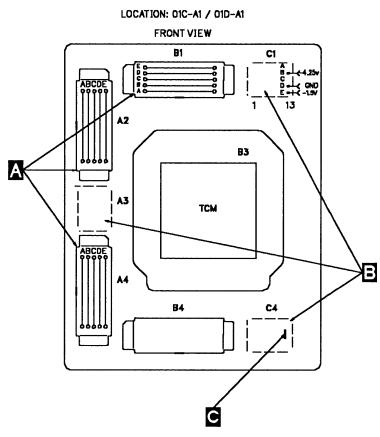


Figure 5-168. TCM Board

TCM Board Installation

WARNING: Before installing the TCM board, inspect it for dirt or damage. *DO NOT INSTALL* the TCM board if damaged, or in doubtful shape.

Proceed as follows:

- 1. Before installing the new board, install the RFI metallic cover over the plastic cover, using the plastic cover screws.
- 2. Carefully install the TCM board into the machine.
- 3. Use the torque tool and fasten the 10 mounting screws.
- 4. Re-install the PS type 1 refer to "PS Type 1 Exchange Procedure for Models 210 and 410" on page 5-103.
- 5. Re-install the TCM using "TCM Installation" on page 5-100.

- 6. Refer to Chapter 4, "How to Run the 3745 Diagnostics" on page 4-1, and run the CCU diagnostics.
- 7. Go to "Repair Verification Procedure" on page 5-170.

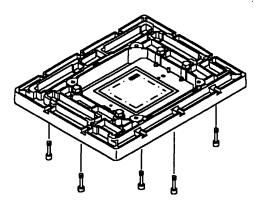


Figure 5-169. Board Screws

Repair Verification Procedure Verification Procedure 0001 011 (continued) 001 Go to "CE Leaving Procedure" on Have you been told to exchange all FRUs for an page 5-172. intermittent problem ? (From step 17. "Action to Take After a Diagnostic Run" on page 4-43). 012 Yes No Did the last run of diagnostics or IML detect an 002 error? Yes No Go to Step 008. 013 003 Go to "CE Leaving Procedure" on Did the diagnostics run error free or power page 5-172. successfully on ? Yes No 014 004 Is the error the same as before ? Yes No You have a problem with the new FRU. Try another one or put the original back in. 015 Go to Chapter 5, "3745 FRU Exchange" on page 5-1. Go to Step 019. 005 016 Have all the FRUs called been exchanged ? As the problem is not solved by changing this Yes No FRU you have to put the original back in. Have all the FRUs called been changed ? 006 Yes No Go to Chapter 5, "3745 FRU Exchange" on page 5-1 for next FRU called. 017 007 Go to "FRU Machine Requirements" on page 2-34 for next FRU called. Go to "CE Leaving Procedure" on page 5-172. 018 800 Go to Step 021 on page 5-171. Was the FRU other than a power supply ? Yes No 019 Check what you have done: 009 Cards, seating Has the power supply successfully Cables powered up ? Crossovers, location and orientation Yes No Switches in correct position. Run diagnostics again, IML or any other 010 action you were asked after FRU exchange. (Step 019 continues) Go to Step 021 on page 5-171. 011 (Step 011 continues)

019 (continued)

Was a failure detected ? Yes No

020

Go to "CE Leaving Procedure" on page 5-172.

021

During your path through the MIP, have you recorded an "Other Action" or "MAP" to use ? Yes No



You may have a defective new FRU, or multiple problems. Try to determine if restarting the full procedure, or if an other symptom may help you.

Suspect also cables, boards and voltages. It could also be necessary to run diagnostics with the 'ALL' option in offline mode. In any case, contact your support structure for further assistance.

023

Go there now.

Chapter 5. 3745 FRU Exchange 5-171

CE Leaving Procedure

The maintenance package has determined that the 3745 is ready to be returned to normal operation. You should use the following list to ensure that the machine is in suitable condition for customer operation and that call information is recorded.

- 1. Replace any cables removed.
- 2. Do all actions that apply in the following list:

If You Have	What You Should Do						
Exchanged all the FRUs called for an intermittent problem or a problem not detected by the diagnostics	Use the manual BER correlation to point out some additional potentially failing FRUs. Proceed as follows:						
(tentative repair which could be unsuccessful).	 Find in the Error Log Display the alarm with the Reference Code you used to exchange the FRUs. 						
	Select the BER range which occurs in the same time frame as the alarm.	1					
	3. In the menu '3' type 'BRC'.						
	Enter the most recent and the oldest BER in the range you have selected then press 'SEND'.						
	 Note the extra FRUs, if any, provided by the BER correlation and advise the HSC/HCS or update the PMH in case of problem reoccurrence. 						
Used the MIP for an installation	Go back to the installation procedure in the Installation Manual.	(
Exchanged the PLC card	 Set the time-of-day clock and recreate the power configuration table, refer to the Service Functions Chapter 12. 						
	 Tell the customer that the "scheduled power ON" services will have to be recreated. 						
Exchanged the HDD	Tell the customer that he will have to :						
	 Refresh the NCP on this disk if he uses HDD to load the control program. 	(
	2. Update the passwords.						
Exchanged a PUC	Return IMMEDIATELY the old PUC to your Branch Office Stores. (Shipment can then occur to the designated plant to permit Failure Analysis)						
Run the wrap diagnostic on the CA or power bus	Ensure that the wrap plug is removed and replaced by the normal cable.						
Run the offline diagnostics	Ensure that you have terminated diagnostics by pressing the 'F1' key., Otherwise, MOSS will remain in 'service' mode.						
Been working on a model 410 or 610 machine (2 CCUs)	Ensure that no CCU is in the 'down' state; if one is in the down state, use the ' REP ' facility in menu 2 to change the failing CCU from the 'down' to the 'ready' state.	(

Been working on the channels area in concurrent maintenance mode with ACF/NCP Version 5 Release 2 or higher

Been working on the TSS or HPTSS adapter area in concurrent maintenance mode Restore the adapters back to NCP, using the channel service screen; refer to "CA Restore Procedure" on page 5-175.

- Remove all wrap plugs installed during this service call.
- Replace all modem and line cables removed during this service call.
- If you altered CDFs during this service call, check CDFs and update if necessary, refer to the "3745 Service Functions, Chapter 9".
- IML the scanners disconnected from the NCP during this call; this can be done by selecting 'IMS' from menu 1. When IML is complete, the adapters will automatically be connected to the NCP.
- Ask the customer to reactivate the lines stopped during the maintenance.
- Connect the TRAs you disconnected during this service call back to the NCP, refer to "TRA Reconnect Procedure" on page 5-175.
- Ask the customer to reactivate the rings stopped during the maintenance.
- 3. IML the MOSS as follows:
- Set service to (0) (normal mode).

Been working with TRSS in

concurrent maintenance mode

- Press the Validate key.
- Set function to (1) (MOSS IML).
- Press the Validate key.
- 4. Set the console in use according to customer requirements.
- 5. Restore the power mode as it was before your intervention.
- 6. Do all actions that apply in the following list:

<u>If You Have</u>	What You Should Do
Disabled a complete CSS	Ask the customer to IPL that CSS and load the NCP. Verify that the IPL completes without errors. If the system is not available to load the NCP into the box, return the console to maintenance mode and IPL step-by-step. At the beginning of phase 4, verify that you do not have the message 'SCANNER(s) not IMLED xxxx' displayed. Continue to end of phase 4.
Had the whole configuration	Ask the customer to IPL and load the NCP into both CCUs. Verify that both IPLs complete without errors. If the system is not available to load the NCP into both CCUs, return the console to maintenance mode and IPL each CCU (which does not have NCP loaded) step-by-step. At the beginning of phase 4, verify that you do not have the message 'SCANNER(s) not IMLED xxxx' displayed. Continue to end of phase 4.

CE leaving procedure

Repaired a CCU unused by the customer (stand-by mode)	Inform the customer that this CCU is ready for IPL.
If you are in fallback mode	Ask the customer to 'switch back' the complete system, and to reactivate the resources.
Disabled some channels	Ask the customer:To re-enable them using the CID screen.

• To put them online from the host.

7. Ensure that all latches holding the internal covers are in the vertical position. This is to prevent the ESD door rubbers from being damaged, and to ensure a proper contact with the machine frame.

8. Replace all covers.

9. Leave the machine in a safe condition.

10. Record the actions taken and the FRUs replaced during the call. If the origin of the intervention was an alarm A5 or AA, report as preventive maintenance (Service Code 08).

11. Update the PMH record for this call.

12. Return parts to the stock room.

CA Restore Procedure

- 1. On the 3745 console, call menu 3 and type 'CAS' in the selection area for channel adapter services.
- 2. Press SEND.
- 3. Type '4' for concurrent maintenance commands.
- 4. Press SEND.
- 5. Type the channel adapter number corresponding to this FRU in the CA number = = = > field.
- 6. Press SEND.
- 7. Type '**RES**' in the command = = = > field.
- 8. Press SEND.
- 9. Re-initiate the same procedure from step 5 for the associated CA if any.

TRA Reconnect Procedure

For this procedure you may wish to refer to Figure 2-23 on page 2-93, Figure 2-25 on page 2-94 and Figure 2-24 on page 2-93.

- 1. Call menu 3 and enter 'TRS' for TRSS services.
- 2. Press SEND.
- 3. Type '1' in the selection area to choose Select.
- 4. Press SEND.
- 5. In the input area enter the TRA number.
- 6. Press SEND.
- 7. In the selection area enter '2' for connect/disc.
- 8. Press SEND.
- 9. In the input area enter 'CT' to connect the selected adapter to the NCP.
- 10. Press SEND.

How to Put MOSS Online

Note: MOSS can be put online only if the NCP is running.

- 1. Using the console, call menu 2.
- 2. If you are working on a 3745-210 or 310 type 'MON' in the selection area.
- 3. Press SEND.
- 4. 'MOSS ONLINE' will be displayed on the screen.
- 5. If you are working on a 3745-410 or 610, from menu 2 select CCU SEL/RELEASE by entering 'CSR'.
- 6. Press SEND.
- 7. On the CCU selection screen, enter '1' to select CCU A.
- 8. Press SEND.
- 9. Type 'MON' in the selection area.
- 10. Press SEND.
- 11. 'MOSS ONLINE' will be displayed on the screen.
- 12. On the CCU selection screen, enter '2' to select CCU B.
- 13. Press SEND.
- 14. Type 'MON' in the selection area.
- 15. Press SEND.
- 16. 'MOSS ONLINE' will be displayed on the screen.



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Appendix A. Control Panel Code Definitions

PANEL CODE	DEFINITION
000	IPL has completed; The MOSS IML was performed from the disk; The control program
	is loaded and MOSS is ONLINE.
001	Moss ROS code unable to get control or unable to execute scheduled processing.
002	Problem detected with the MMIO interface.
003	Moss Re-IML has been initiated.
004	Power bus test successfully completed.
005	Problem detected during the power bus test.
006	AC Input Fault detected
007	Moss battery down
008	Power control not initialised
009	Moss power supply ID 1 error detected - "NO REPLY"
00A	Moss power supply ID 1 error detected - "PROBLEM WITH INTERFACE"
00B	Moss power supply ID 1 error detected - "OVERCURRENT FAULT"
00C	Moss power supply ID 1 error detected - "POWER SUPPLY FAULT"
	(overvoltage or undervoltage).
00D	NOT USED
00E	Problem detected on power supply ID 2
00F	Problem detected on power supply ID 3
010	Problem detected on power supply ID 4
011	Problem detected on power supply ID 5
012	Problem detected on power supply ID 6
013	Problem detected on power supply ID 7
014	Problem detected on power supply ID 8
015	Problem detected on power supply ID 9
016	Problem detected on power supply ID 10
017	Problem detected on power supply ID 11
018	Problem detected on power supply ID 12
019	Problem detected on power supply ID 13
01A	Problem detected on power supply ID 14
01B	Problem detected on power supply ID 15
01C	Problem detected on power supply ID 16
01D	Problem detected on power supply ID 17
01E	Problem detected on power supply ID 18
01F	Problem detected on power supply ID 19
020	Problem detected on power supply ID 20
021	Problem detected on power supply ID 21
022	Problem detected on power supply ID 22
023	Problem detected on power supply ID 23
024	Problem detected on power supply ID 24
025	Problem detected on power supply ID 25
026	Problem detected on power supply ID 26
027	Problem detected on power supply ID 27
028	Problem detected on power supply ID 28
029	Problem detected on power supply ID 29
02A	Problem detected on power supply ID 30
02B	Problem detected on power supply ID 31
02C	Problem detected on power supply ID 32
02D	Problem detected on power supply ID 33
02E	Problem detected on power supply ID 34
02F	Problem detected on power supply ID 35

Table A-1 (Page 1 of 23). MOSS Control Panel Codes

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Table	A-1	(Page	2	of	23).	MOSS	Control	Panel	Codes
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PANEL CODE	DEFINITION	
030	Problem detected with MOSS blower	
031	Problem detected with base frame blower	
032	Problem detected with Expansion Unit A11 blowers - front side	
033	Problem detected with Expansion Unit A11 blowers - rear side	
034 035	Problem detected with Expansion Unit A12 blowers	
035	Cooling problem for the LICs in the Base Frame Cooling problem for the LICs in the Expansion Unit L13	
030	Front side	
037	Cooling problem for the LICs in the Expansion Unit L13 Rear side	
038	Cooling problem for the LICs in the Expansion Unit L14 Front side	
039	Cooling problem for the LICs in the Expansion Unit L14 Rear side	
03A	Cooling problem for the LICs in the Expansion Unit L15 Front side	\bigcap
03B	Cooling problem for the LICs in the Expansion Unit L15 Rear side	
03C		
to	NOT USED	
044 045	CCU A power OFF due to overheating.	
045	CCU B power OFF due to overheating.	
047		
to 04F	NOT USED	_
050	Initial MOSS processor reset state is incorrect.	
051	NOT USED	
052	Initial MOSS processor state OK - diagnostics progression code	
053	Unexpected level 0 interrupt present in IOIRV	
054 055	Unexpected level 1 interrupt present in IOIRV	
055	Unexpected level 2 interrupt present in IOIRV Unexpected level 3 interrupt present in IOIRV	
057	Unexpected level 4 interrupt present in IOIRV	
058	Unexpected level 5 interrupt present in IOIRV	
059	Unexpected level 6 or 7 interrupt present in IOIRV	
05A	Moss processor condition codes is incorrect	\frown
05B	NOT USED	(
05C	Moss processor cache is incorrect	A. S.
05D	Moss processor instruction failure during 1st part of test	
05E	NOT USED	
05F 060	MOSS ROS check sum is incorrect MOSS ROS bad parity location not detected	
061	NOT USED	
062	MOSS EIRV did not report the forced errors	
063		
to	NOT USED	
065		
066	PIO bus test did not run completely	
067	PIO bus test; some error(s) occurred - first IO problem found is read TOD BSTAT not as expected	
068	PIO bus test; some error(s) occurred - first IO problem found is set TOD BSTAT bits 5/6	
069	PIO bus test; some error(s) occurred - first IO problem found is reset TOD BSTAT bits 5/6	A
	An * following a panel code denotes that the code should 'Blink'.	V

Table A-1 (Page 3 of 23). MOSS Control Panel Codes

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PANEL CODE	DEFINITION
06A	PIO bus test; some error(s) occurred - first IO problem found is set TOD BSTAT bit 6
06B	PIO bus test; some error(s) occurred - first IO problem found is read DFA BSTAT not as expected
06C	PIO bus test; some error(s) occurred - first IO problem found is set DFA BSTAT bits 5/6/7
06D	PIO bus test; some error(s) occurred - first IO problem found is reset DFA BSTAT bits 5/6/7
06E	PIO bus test; some error(s) occurred - first IO problem found is read MCCU A STAT0 not as expected
06F	PIO bus test; some error(s) occurred - first IO problem found is set MCCU A STAT0 bits 5/6
070	FIO bus test; some error(s) occurred - first IO problem found is reset MCCU A STAT0 bits 5/6
071	PIO bus test; some error(s) occurred - first IO problem found is read MCCU B STAT0 not as expected
072	PIO bus test; some error(s) occurred - first IO problem found is set MCCU B STAT0 bits 5/6
073	PIO bus test; some error(s) occurred - first IO problem found is reset MCCU A STAT0 bits 5/6
074	PIO bus test; some error(s) occurred - first IO problem found is read MCAD INTP1 not as expected
075	PIO bus test; some error(s) occurred - first IO problem found is set MCAD INTP1 bits 5/6
076	PIO bus test; some error(s) occurred - first IO problem found is reset MCAD INTP1 bits 5/6
077	PIO bus test; some error(s) occurred - first IO problem found is read SWAD BSTAT not as expected
078	PIO bus test; some error(s) occurred - first IO problem found is set SWAD BSTAT bits 5/6
079 07A	PIO bus test; some error(s) occurred - first IO problem found is reset SWAD BSTAT bits 5/6 PIO bus test; some error(s) occurred - first IO problem found is
07B	command read PCA (local port) BSTAT not as expected PIO bus test; some error(s) occurred - first IO problem found is
07C	command set PCA (local port) BSTAT bit 6 PIO bus test; some error(s) occurred - first IO problem found is
07D	command reset PCA (local port) BSTAT bit 6 PIO bus test; some error(s) occurred - first IO problem found is
07E	command read PCA (remote port) BSTAT not as expected PIO bus test; some error(s) occurred - first IO problem found is
07F	command set PCA (remote port) BSTAT bit 6 PIO bus test; some error(s) occurred - first IO problem found is
080	command reset PCA (remote port) BSTAT bit 6 PIO bus test; some error(s) occurred - first IO problem found is
081	command read PCA (RSF port) BSTAT not as expected PIO bus test; some error(s) occurred - first IO problem found is command set PCA (RSF port) RSTAT bit 6
082	command set PCA (RSF port) BSTAT bit 6 PIO bus test; some error(s) occurred - first IO problem found is command reset PCA (RSF port) BSTAT bit 6
083	
to 289	NOT USED
08A	Progression code for PIO tests Part 1 successful without severe errors or problems in PIO test part 2

Table	A-1	(Page	4	of	23).	MOSS	Control	Panel	Codes
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PANEL CODE	DEFINITION	
08B	All PIO bus tests failed	
08C	Only IOs to TOD adaptor were successful during PIO tests	
08D	All IOs to the DFA failed during PIO tests	
08E	All IOs to the MAC failed during PIO tests	
08F	All IOs to the MCCU-A of the MAC failed during PIO tests	
090	All IOs to the MCCU-B of the MAC failed during PIO tests	
091	All IOs to the MCAD of the MAC failed during PIO tests	
092 093	All IOs to the SWAD of the MAC failed during PIO tests	
093 094	All IOs to the MCA failed during PIO tests All IOs to the local PCA of the MCA failed during PIO tests	
095	All IOs to the remote PCA of the MCA failed during PIO tests	
096	All IOs to the RSF PCA of the MCA failed during PIO tests	
097	NOT USED	
098*	Unexpected data during specific pattern test on PIO bus	
099	Progression code for successful completion of PIO pattern test	
09A	C	
to	NOT USED	
09C		
09D	Unexpected error from PLC when request definition was originated	
09E	NOT USED	
09F	Control lost in mainline controller after checking the request	
DA0	Moss storage tests in progress	
DA1*	Unexpected error in MOSS EIRV register	
)A2*	Unexpected error in MOSS EIRV register during memory access	
DA3*	Control panel 'valid' option cannot be disabled	
)A4*	Reconfigure bit 5 in TOD mode register is permanently ON	
)A5*)A6*	No address increment during write/read storage operation	
DA6* DA7*	Data mismatch during write/read storage operation No expected check in EIRV bit 3 during ROS invalid address check	
DA8*	No expected check in EIRV bit 3 after maximum storage exceeded	
DA9*	All memory locations contained errors	
DAA*	Error interrupt in EIRV during memory access to all locations	
DAB		
to	NOT USED	
DAC		
DAD*	Appropriate single bit errors were never corrected during ECC	
DAE*	Single bit errors were badly corrected during ECC	
DAF	NOT USED	
DB0*	ECC mechanism failed during double bit error correction	
)B1*	Different loaded and stored contents of a memory location	
)B2*	Reconfigure bit 5 in TOD mode register cannot be set	~
)B3	NOT USED	,
)B4*	Different loaded and stored contents of a memory location	
)B5*	Double uncorrectable error during spare bit swapping	
)B6*)B7*	Control panel 'valid' option cannot be enabled	
)B7)B8	Unexpected error in EIRV at completion of memory tests	
to	NOT USED	
DBE		
DBF	Moss memory tests complete - progress to next test	
000	Problem found during initialization of ROS mainline controller	
)C1	Control lost after initialization of ROS mainline controller	
)C2	Control lost during PSV swap test	
)C3*	Storage check occurred when accessing register space	
)C4*	Scheduled progression not performed during PSV test	

An * following a panel code denotes that the code should 'Blink'.

4 1 4

CODE	DEFINITION
0C5*	Cache in/cache out operation was not successful
0C6	NOT USED
0C7	PSV swap tests complete - progress to next test
0C8	
to	NOT USED
	NOT USED
OCF	
0D0*	DFA test entry and progression
0D1*	DFA; Unexpected error interrupt in EIRV during reset
0D2*	DFA; Unexpected interrupt in IOIRV during reset
0D3*	DFA; BSTAT bits 0,1 or 6 not in busy or in enable after reset
0D4	NOT USED
0D5*	DFA; BSTAT bits 0,1 not in idle state after reset
0D6*	DFA; Different loaded and stored contents during PIO commands
0D7*	DFA; Register not in reset state after reset command
0D8*	DFA; Invalid command not recognised
0D9*	DFA; Unexpected error interrupt in EIRV during PIO command test
ODA*	DFA; Unexpected interrupt in IOIRV during PIO command test
0DB*	DFA; BSTAT bits 0,1 are not in idle state during initialization
0DC*	DFA; Unexpected error interrupt in EIRV during initialization
0DD*	DFA; Unexpected interrupt in IOIRV during initialization
0DE*	DFA; Unexpected error interrupt in EIRV during transfer initialisation
0DF*	DFA; No interrupt request in IOIRV during transfer initialization
0E0*	DFA; Error occurred during CHIO transfer
0E1*	DFA; BSTAT bits 0,1 and 6 not in idle or enable during diagnostic command test
0E2*	DFA; Data transmission error - HSTAT and BSTAT bits are incorrect during diagnostic
022	command test
0E3*	DFA; Different content between 1st and 2nd part of sector buffer during diagnostic
UL3	command test
05.4*	
0E4*	DFA; Error found in drive status of SSB byte 0 during diagnostic command test
0E5*	DFA; Error found in adaptor status of SSB byte 1 and 2 during
	diagnostic command test
0E6*	DFA;HDD; BSTAT bits 0,1 or 6 not in idle or enable during drive initialization
0E7*	DFA;HDD; No interrupt request in IOIRV during drive initialization
0E8*	DFA;HDD; Unexpected error interrupt in EIRV during drive
	initialization
0E9*	DFA;HDD; Data transmission error - HSTAT bits are incorrect during drive initialization
0EA*	DFA;HDD; BSTAT bits 0,1 or 6 not in idle or enable during seek command before
0271	recalibrate test
0EB*	DFA;HDD; No interrupt request in IOIRV during seek command before recalibrate test
	NOT USED
0ED*	DFA;HDD; BSTAT bits 0,1 or 6 not in idle or enable before recalibrate command
OEE*	DFA;HDD; No interrupt received in IOIRV during recalibrate command
0EF*	DFA;HDD; Unexpected error interrupt in EIRV during recalibrate command
0F0	NOT USED
0F1*	DFA;HDD; Data transmission error - HSTAT and BSTAT bits incorrect during recalibra command
0 F2 *	DFA;HDD; No cylinder zero in SSB byte 0, bit 7 during recalibrate command
0F3*	DFA;HDD; Drive status error in SSB byte 0 during recalibrate command
DF3 DF4*	
	DFA;HDD; Adaptor status error in SSB byte 1 or 2 during recalibrate command
0F5*	DFA;HDD; BSTAT bits 0,1 or 6 not in idle or enable during read ID command
0F6*	DFA;HDD; No interrupt request in IOIRV during read ID command
DF7*	DFA;HDD; Unexpected error interrupt in EIRV during read ID command
0F8*	DFA;HDD; Data transmission error - HSTAT and BSTAT bits incorrect during read ID
	command
0F9*	DFA;HDD; Error on head addressing mechanism during read ID command An * following a panel code denotes that the code should 'Blink'.

Table A-1 (Page 6 of 23). MOSS Control Panel Codes	Table	A-1	(Page	6	of	23).	MOSS	Control	Panel	Codes
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PANEL CODE	DEFINITION
0FA*	DFA;HDD; Drive status error in SSB byte 0 during read ID command
FB*	DFA;HDD; Adaptor status error in SSB byte 1 or 2 during read ID command
FC*	DFA;HDD; BSTAT bits 0,1 or 6 not in idle or enable during recalibrate before seek command
D*	DFA;HDD; No interrupt request in IOIRV during recalibrate before seek command
E	NOT USED
F*	DFA;HDD; BSTAT bits 0,1 or 6 not in idle or enable during seek command
0	NOT USED
)1	Hard disk initial state not ready. Recovery in process.
)2	Hard disk not ready after recovery.
03	NOT USED
0	NOT USED
10 11*	DEA: HDD: No interrupt request in IOIDV, during each command
12*	DFA;HDD; No interrupt request in IOIRV during seek command DFA;HDD; Unexpected error interrupt in EIRV during seek command
12 13*	DFA;HDD; Drexpected error interrupt in EIRV during seek command DFA;HDD; Data transmission error - HSTAT and BSTAT bits incorrect during seek
10	command
14*	DFA;HDD; Different head numbers during seek command
14 15*	DFA;HDD; Drive status error in SSB byte 0 during seek command
16*	DFA;HDD; Adaptor status error in SSB byte 1 or 2 during seek command
17*	DFA;HDD; BSTAT bits 0,1 or 6 not in idle or enable during
•	read/write a sector command
8*	DFA;HDD; No interrupt request in IOIRV during read/write a sector command
9*	DFA;HDD; Unexpected error interrupt in EIRV during read/write a sector command
A*	DFA;HDD; Data transmission error - HSTAT and BSTAT bits incorrect during read /
	write a sector command
B*	DFA;HDD; Different written and read sectors after read/write a sector command
C*	DFA;HDD; Drive status error in SSB byte 0 after read/write a sector command
D*	DFA;HDD; Adaptor status error in SSB byte 1 or 2 after read/ write a sector command
E*	DFA;HDD; BSTAT bits 0,1 or 6 not in idle or enable during read /write a full track command
1F*	DFA;HDD; No interrupt request in IOIRV during read/write a full track command
20*	DFA;HDD; Unexpected error interrupt in EIRV during read/write a full track command
21*	DFA;HDD; Data transmission error - HSTAT and BSTAT bits incorrect during read/write
0 0*	a full track command
22*	DFA;HDD; Different written and read tracks after read/write a full track command
23* 24*	DFA;HDD; Drive status error in SSB byte 0 after read/write a full track command DFA;HDD; Adaptor status error in SSB byte 1 or 2 after read/ write a full track
-7	command
25*	DFA;HDD; BSTAT bits 0,1 or 6 not in idle or enable during read/ write no data
26*	command DFA;HDD; No interrupt request in IOIRV during read/write no data command
20 27*	DFA;HDD; Unexpected error interrupt in EIRV during read/write no data command
28*	DFA;HDD; Data transmission error - HSTAT and BSTAT bits incorrect during read/write
	no data command
29*	DFA;HDD; Different written and read sectors after read/write no data command
:A*	DFA;HDD; Drive status error in SSB byte 0 after read/write no data command
:B*	DFA;HDD; Adaptor status error in SSB byte 1 or 2 after read/ write no data command
2C*	DFA;HDD; BSTAT bits 0,1 or 6 not in idle or enable during read check/write verify
	command
	UFA:HUU: NO INTERPUT REQUEST IN IVIKY - QURING READ CHECK/WRITE VERITY COMMAND
2D*	DFA;HDD; No interrupt request in IOIRV during read check/write verify command DFA:HDD: Unexpected error interrupt in EIRV during read check/ write verify command
2D* 2E* 2F*	DFA;HDD; Unexpected error interrupt in EIRV during read check/ write verify command
2D* 2E*	DFA;HDD; Unexpected error interrupt in EIRV during read check/ write verify command DFA;HDD; Data transmission error - HSTAT and BSTAT bits incorrect during read
D* E*	DFA;HDD; Unexpected error interrupt in EIRV during read check/ write verify command

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PANEL	
CODE	DEFINITION
131*	DFA;HDD; Adaptor status error in SSB byte 1 or 2 after read check /write verify
	command
132*	DFA;HDD; Different written and read sectors after read check/ write verify command
133*	DFA;HDD; BSTAT bits 0,1 or 6 not in idle or enable during ECC
	correction test
134*	DFA;HDD; No interrupt request in IOIRV during ECC correction test
135*	DFA;HDD; Unexpected error interrupt in EIRV during ECC correction test
136*	DFA;HDD; Data transmission error - HSTAT and BSTAT bits incorrect during ECC correction test
137*	DFA;HDD; Error on a selected sector during ECC correction test
138*	DFA;HDD; Expected error in SSB byte 1, bit 1 did not occur during burst length 16 EC correction test
139*	DFA;HDD; Expected correction did not occur during ECC correction test
13A*	DFA;HDD; Expected error in SSB byte 1, bit 1 did not occur during burst length 17 EC correction test
13B*	DFA;HDD; Unexpected correction occurred during ECC correction test
13D 13C*	DFA;HDD; Drive status error in SSB byte 0 after ECC correction test
13C 13D*	DFA;HDD; Adaptor status error in SSB byte 1 or 2 after ECC correction test
13E*	DFA;HDD; Different written and read sector contents during ECC correction test
13F*	DFA;FDD; Diskette change information is not present in SSB byte 0, bit 4
140*	DFA;FDD; BSTAT bits 0,1 or 6 not in idle or enable during drive initialization
140	DFA;FDD; No interrupt request in IOIRV during drive initialization
141	
142	DFA;FDD; Unexpected error interrupt in EIRV during drive initialization
143*	DFA;FDD; Data transmission error - HSTAT bits are incorrect during drive initialization
144*	DFA;FDD; BSTAT bits 0,1 or 6 not in idle or enable during seek command before recalibrate test
145*	DFA;FDD; No interrupt request in IOIRV during seek command before recalibrate tes
146	NOT USED
147*	DFA;FDD; BSTAT bits 0,1 or 6 not in idle or enable before recalibrate command
148*	DFA;FDD; No interrupt received in IOIRV during recalibrate command
149*	DFA;FDD; Unexpected error interrupt in EIRV during recalibrate command
14A*	DFA;FDD; Data transmission error - HSTAT and BSTAT bits incorrect during recalibra command
14B*	DFA;FDD; No cylinder zero in SSB byte 0, bit 7 during recalibrate command
14C*	DFA;FDD; Drive status error in SSB byte 0 during recalibrate command
14D*	DFA;FDD; Adaptor status error in SSB byte 1 or 2 during recalibrate command
14E*	DFA;FDD; BSTAT bits 0,1 or 6 not in idle or enable during read ID command
14F*	DFA;FDD; No interrupt request in IOIRV during read ID command
150*	DFA;FDD; Unexpected error interrupt in EIRV during read ID command
151*	DFA;FDD; Data transmission error - HSTAT and BSTAT bits incorrect during read ID command command
152*	DFA;FDD; Error on head addressing mechanism during read ID command
153*	DFA;FDD; Drive status error in SSB byte 0 during read ID command
154*	DFA;FDD; Adaptor status error in SSB byte 1 or 2 during read ID command
155*	DFA;FDD; BSTAT bits 0,1 or 6 not in idle or enable during recalibrate before seek command
156*	DFA;FDD; No interrupt request in IOIRV during recalibrate before seek command
150	NOT USED
157	DFA;FDD; BSTAT bits 0,1 or 6 not in idle or enable during seek command
158 159*	
	DFA;FDD; No interrupt request in IOIRV during seek command
15A*	DFA;FDD; Unexpected error interrupt in EIRV during seek command
15B*	DFA;FDD; Data transmission error - HSTAT and BSTAT bits incorrect during seek command

Table A-1 (Page 7 of 23), MOSS Control Panel Codes

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Table A-1	(Page 8 of 23). MOSS Control Panel Codes
PANEL	
CODE	DEFINITION
15C*	DFA;FDD; Different head numbers during seek command
15D*	DFA;FDD; Drive status error in SSB byte 0 during seek command
15E*	DFA;FDD; Adaptor status error in SSB byte 1 or 2 during seek command
15F	Completion of DFA diagnostics
160	
to	NOT USED
16F	
170	Ros code had control for a Re-IML but the Re-IML reset sequence was not performed
171	Re-IML sequence was performed but an error occurred in the MOSS reset test
172	
to	NOT USED
177	
178	Control was lost during the processing of the 'Moss diags by-pass option' request
	(origin default parms set)
179	
to	NOT USED
17A	
17B	Control was lost during the processing of the 'Moss diags by-pass option' request
17C	NOT USED
17D	Storage access problem - dump request cannot be processed
17E	NOT USED
17F	Completion of ROS part of MOSS Diagnostics
180	Entry into RAM part of MOSS Diagnostics
181*	Level 6 program level interrupt not as expected
182	Progression code indicating RAM Diagnostic has full control
183	
to 187	NOT USED
188	Control lost during MOCC instruction test Dort 0
189*	Control lost during MOSS instruction test Part 2 Error occurred during 2nd part of MOSS instruction execution
18A	Successful completion of MOSS instruction test Part 2
18B	NOT USED
18C	Control lost during TOD tests
18D	TOD tests complete - progress to next test
18E	TOD tests complete - progress to next test
to	NOT USED
18F	NOT USED
190	Start of MCA tests
191*	PCA1; Hardwired conditions do not allow access to PCA1
192*	PCA1; Error during PCA1 asynchronous test
193*	PCA1; Unexpected level 0 interrupt during PCA1 test
194*	PCA1; Error during PCA1 internal wrap asynchronous test
195*	PCA1; Unexpected level 0 interrupt during PCA1 wrap test
196*	PCA2; Hardwired conditions do not allow access to PCA2
197*	PCA2; Error during PCA2 asynchronous test
198*	PCA2; Unexpected level 0 interrupt during PCA2 test
199*	PCA2; Error during PCA2 internal wrap asynchronous test
19A*	PCA2; Unexpected level 0 interrupt during PCA2 wrap test
19B*	PCA3; Hardwired conditions do not allow access to PCA3
19C*	PCA3; Error during PCA3 asynchronous test
19D*	PCA3; Unexpected level 0 interrupt during PCA3 test
19E*	PCA3; Error during PCA3 internal wrap asynchronous test
19F*	PCA3; Unexpected level 0 interrupt during PCA3 wrap test
1A0	Local link test; wrap block does not appear to be installed on local console
	cable/connector
	An * following a panel code denotes that the code should 'Blink'.

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Table A-1 (Page 8 of 23). MOSS Control Panel Codes

PANEL CODE	DEFINITION
1A1	Local link test; Local console cable is at fault
1A2	Local link test; Local console PCA1 is at fault
1A3	Remote/Alternate link test; wrap block does not appear to be installed on
IAJ	
	remote/alternate console cable/connector
1A4	Remote/Alternate link test; Remote/Alternate console cable is at fault
1A5	Remote/Alternate link test; Remote/Alternate console PCA2 is at fault
1A6	RSF link test; wrap block does not appear to be installed on RSF console cable/connector
1A7	RSF link test; RSF console cable is at fault
1A8	RSF link test; RSF console PCA3 is at fault
1A9	
to	NOT USED
1AF	
1B0	Completion of MCA tests
1B1	Start of Local Console link test
1B2	Completion of Local Console link test
1B3	Start of Remote / Alternate Console link test
1B4	Completion of Remote / Alternate Console link test
1B5	Start of RSF Console link test
1B6	Completion of RSF Console link test
1B7	
to	NOT USED
1CF	
1D0	MAC; Start of MAC tests
1D1	NOT USED
1D2*	MAC; Solid error detected in one of the MCAD registers (2nd pass)
1D3*	MAC; 100 milli second timer in MCAD is not operational
1D4*	MAC; Permanent interrupt request level 1 in IOIRV during MCCU tests
1D5*	MAC; Permanent interrupt request level 4 in IOIRV during MCAD tests
1D6*	MAC; Interrupt request level 1 of MCAD was not reported to Solo
1D7*	MAC; MCCU A reset line did not activate 'Moss inop bit'
1D8*	
1D8 1D9*	MAC; MCCU B reset line did not activate 'Moss inop bit'
	MAC; Permanent interrupt request level 0 in IOIRV during MCCU tests
1DA*	MAC; Solid error detected in one of the MCCU A registers (1st pass)
1DB*	MAC; Solid error detected in one of the MCCU A registers (2nd pass)
1DC*	MAC; Solid error detected in one of the MCCU B registers (1st pass)
1DD*	MAC; Solid error detected in one of the MCCU B registers (2nd pass)
1DE*	MAC; Permanent interrupt request level 0 in IOIRV during SWAD tests
1DF*	MAC; 'Switch MOSS Inop'- bit 0 in SWAD disconnect register was not reset during tes
1E0*	MAC; Internal clock check occurred - bit 4 in SWAD disconnect register
1E1*	MAC; Solid error detected in one of the SWAD registers (1st pass)
1E2*	MAC; Solid error detected in one of the SWAD registers (2nd pass)
1E3*	MAC; Unable to set MOSS Inop bit in MCCU A
1E4*	MAC; Unable to set MOSS Inop bit in MCCU B
1E5*	MAC; TCM A power off information is not available in MCCU A
1E6*	MAC; TCM B power off information is not available in MCCU B
1E7*	MAC, No interrupt reporting possible in MCCU A
1E8*	MAC; No interrupt reporting possible in MCCU B
1E9	
to	NOT USED
1EE	
1EF	MAC; Completion of MAC tests
1F0	WAC, COMPLETION OF WAC LESIS
to IFD	NOT USED

Table	A-1	(Page	10	of	23)	MOSS Control Panel Codes
10010		1 ugo		U .	m oj.	

PANEL CODE	DEFINITION
1FE*	Control lost during return to RAM IML processor
1FF	Completion of RAM MOSS diagnostics
00	
0	NOT USED
FF	
00*	Moss level 0 error detection; MCCU A or MCCU B or SWAD Adaptor is 'down'; Excess spurious errors
.01*	Moss level 0 error detection; PCA1; Adaptor is 'down'
.02*	Moss level 0 error detection; PCA1; PIO Bus Check; Inbound parity
.03*	Moss level 0 error detection; PCA1; PIO Bus Check; Adaptor not detected
.04*	Moss level 0 error detection; PCA1; PIO Timeout; Outbound; Address parity check
.05*	Moss level 0 error detection; PCA1; PIO Timeout; Outbound; Command/data parity check
.06*	Moss level 0 error detection; PCA2; Adaptor is 'down'
.07*	Moss level 0 error detection; PCA2; PIO Bus Check; Inbound parity
.08*	Moss level 0 error detection; PCA2; PIO Bus Check; Adaptor not detected
.09*	Moss level 0 error detection; PCA2; PIO Timeout; Outbound; Address parity check
0A*	Moss level 0 error detection; PCA2; PIO Timeout; Outbound; Command/data parity check
\0B*	Moss level 0 error detection; PCA3; Adaptor is 'down'
0C*	Moss level 0 error detection; PCA3; PIO Bus Check; Inbound parity
0D*	Moss level 0 error detection; PCA3; PIO Bus Check; Adaptor not detected
0E*	Moss level 0 error detection; PCA3; PIO Timeout; Outbound; Address parity check
0F*	Moss level 0 error detection; PCA3; PIO Timeout; Outbound; Command/data parity check
10*	Moss level 0 error detection; MCCU A; Adaptor is 'down'
11*	Moss level 0 error detection; MCCU A; Adaptor is 'down'; Excess spurious errors
.12*	Moss level 0 error detection; MCCU A; Adaptor check; 1 usec counter parity
13*	Moss level 0 error detection; MCCU A; Adaptor check; MIOC/CCU timeout parity
14*	Moss level 0 error detection; MCCU A; CHIO Bus check
15*	Moss level 0 error detection; MCCU A; CHIO Timeout
16*	Moss level 0 error detection; MCCU A; CHIO; Storage ECC error; Register space parity during main store.
\17 *	Moss level 0 error detection; MCCU A; CHIO; Storage ECC error; Multiple bits in DIV Register
\18 *	Moss level 0 error detection; MCCU A; CHIO; Storage ECC error; No bits active in DIV Register
419*	Moss level 0 error detection; MCCU A; CHIO; Exception; Address exception on main store data access
A1A*	Moss level 0 error detection; MCCU A; CHIO; Exception; Operation exception; CHCV Reg invalid
∖1B *	Moss level 0 error detection; MCCU A; CHIO; Exception; Register precision; CHP Reg bits 0-7 are not zero
\1C*	Moss level 0 error detection; MCCU A; CHIO; Exception; Specification exception with invalid address on main store data access
\1D*	Moss level 0 error detection; MCCU A; CHIO; Exception; Multiple bits in DIV Register
1E*	Moss level 0 error detection; MCCU A; CHIO; Exception; No bits active in DIV Register
1F*	Moss level 0 error detection; MCCU A; CHIO; Internal check; Cache parity check
20*	Moss level 0 error detection; MCCU A; CHIO; Internal check; Invalid address on CHP Reg access
\21 *	Moss level 0 error detection; MCCU A; CHIO; Internal check; Multiple bits in DIV Register
A22*	Moss level 0 error detection; MCCU A; CHIO; Adaptor check; Step counter parity
	An * following a panel code denotes that the code should 'Blink'.

Table A-1 (Page 11 of 23). MOSS Control Panel Codes

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PANEL CODE	DEFINITION
A23*	Moss level 0 error detection; MCCU A; CHIO; Adaptor check; Half word/burst counter parity
A24*	Moss level 0 error detection; MCCU A; CHIO; Adaptor check; CCU busy; Timeout
A25*	Moss level 0 error detection; MCCU A; CHIO; Adaptor check; MIOC timeout
A26*	Moss level 0 error detection; MCCU A; CHIO; Adaptor check; MIOC parity check - in
A27*	Moss level 0 error detection; MCCU A; CHIO; Adaptor check; MIOC parity check - in Moss level 0 error detection; MCCU A; CHIO; Adaptor check; MIOC parity check - out
A28*	Moss level 0 error detection; MCCU A; CHIO; Adaptor check; MiOC parity check - out Moss level 0 error detection; MCCU A; CHIO; Adaptor check; Adaptor failure
A20 A29*	Moss level 0 error detection; MCCU A; CHIO; Adaptor check; Multiple bits detected in
	Stat reg
A2A*	Moss level 0 error detection; MCCU A; CHIO; Adaptor check; No CHIO in progress in Adaptor Control Block
A2B*	Moss level 0 error detection; MCCU A; CHIO; Multiple bits detected in EIRV reg
A2C*	Moss level 0 error detection; MCCU A; CHIO; No CHIO in progress in Adaptor Contro Block
A2D*	Moss level 0 error detection; MCCU A; Device; Adaptor check; Step counter parity
A2E*	Moss level 0 error detection; MCCU A; Device; Adaptor check; MIOC timeout
A2F*	Moss level 0 error detection; MCCU A; Device; Adaptor check; MIOC parity check - in
A30*	Moss level 0 error detection; MCCU A; Device; Adaptor check; MIOC parity check - o
A31*	Moss level 0 error detection; MCCU A; Device; Adaptor check; Adaptor failure
A32*	Moss level 0 error detection; MCCU A; Device; Adaptor check; Multiple bits detected Stat reg
A33*	Moss level 0 error detection; MCCU A; Device; Adaptor check; No Common Adaptor Code running
A34*	Moss level 0 error detection; MCCU A; PIO; Bus check; Inbound parity
A35*	Moss level 0 error detection; MCCU A; PIO; Bus check; Adaptor failure
A36*	Moss level 0 error detection; MCCU A; PIO; Bus check; Adaptor not detected
A37*	Moss level 0 error detection; MCCU A; PIO; Timeout; Invalid command
438*	Moss level 0 error detection; MCCU A; PIO; Timeout; Outbound address parity check
439*	Moss level 0 error detection; MCCU A; PIO; Timeout; Adaptor not detected
A3A*	Moss level 0 error detection; MCCU A; PIO; Timeout; Adaptor failure
A3B*	Moss level 0 error detection; MCCU A; PIO; Timeout; Multiple bits detected in Stat re
A3C*	Moss level 0 error detection; MCCU B; Adaptor is 'down'
A3D*	Moss level 0 error detection; MCCU B; Adaptor is 'down'; Excess
	spurious errors
A3E*	
	Moss level 0 error detection; MCCU B; Adaptor check; 1 usec counter parity
A3F*	Moss level 0 error detection; MCCU B; Adaptor check; MIOC/CCU timeout parity
A40*	Moss level 0 error detection; MCCU B; CHIO Bus check
A41*	Moss level 0 error detection; MCCU B; CHIO Timeout
A42*	Moss level 0 error detection; MCCU B; CHIO; Storage ECC error;
	Register space parity during main store.
4 43*	Moss level 0 error detection; MCCU B; CHIO; Storage ECC error; Multiple bits in DIV Register
4 44*	Moss level 0 error detection; MCCU B; CHIO; Storage ECC error; No bits active in DIN Register
445*	Moss level 0 error detection; MCCU B; CHIO; Exception; Address exception on main store data access
\46 *	Moss level 0 error detection; MCCU B; CHIO; Exception; Operation exception; CHCV Reg invalid
A47*	Moss level 0 error detection; MCCU B; CHIO; Exception; Register precision; CHP Reg bits 0-7 are not zero
\48 *	Moss level 0 error detection; MCCU B; CHIO; Exception; Specification exception with invalid address on main store data access
۹49*	Moss level 0 error detection; MCCU B; CHIO; Exception; Multiple bits in DIV Register
44A*	Moss level 0 error detection; MCCU B; CHIO; Exception; No bits active in DIV Register
44B*	Moss level 0 error detection; MCCU B; CHIO; Exception; No bits detive in bit register Moss level 0 error detection; MCCU B; CHIO; Internal check; Cache parity check
446	

PANEL CODE	DEFINITION
44C*	Moss level 0 error detection; MCCU B; CHIO; Internal check; Invalid address on CHP Reg access
\4D*	Moss level 0 error detection; MCCU B; CHIO; Internal check; Multiple bits in DIV
\4E*	Register Moss level 0 error detection; MCCU B; CHIO; Adaptor check; Step counter parity
4E 4F*	Moss level 0 error detection; MCCU B; CHIO; Adaptor check; Step counter parity Moss level 0 error detection; MCCU B; CHIO; Adaptor check; Half word/burst counter
	parity
\50*	Moss level 0 error detection; MCCU B; CHIO; Adaptor check; CCU busy; Timeout
.51*	Moss level 0 error detection; MCCU B; CHIO; Adaptor check; MIOC timeout
.52*	Moss level 0 error detection; MCCU B; CHIO; Adaptor check; MIOC parity check - in
.53*	Moss level 0 error detection; MCCU B; CHIO; Adaptor check; MIOC parity check - out
.54*	Moss level 0 error detection; MCCU B; CHIO; Adaptor check; Adaptor failure
.55*	Moss level 0 error detection; MCCU B; CHIO; Adaptor check; Multiple bits detected in
	Stat reg
.56*	Moss level 0 error detection; MCCU B; CHIO; Adaptor check; No CHIO in progress in
.57*	Adaptor Control Block Moss level 0 error detection; MCCU B; CHIO; Multiple bits detected in EIRV reg
.57* .58*	Moss level 0 error detection; MCCU B; CHIO; Multiple bits detected in EIRV reg Moss level 0 error detection; MCCU B; CHIO; No CHIO in progress in Adaptor Control
50	Block
59*	Moss level 0 error detection; MCCU B; Device; Adaptor check; Step counter parity
5A*	Moss level 0 error detection; MCCU B; Device; Adaptor check; MIOC timeout
5B*	Moss level 0 error detection; MCCU B; Device; Adaptor check; MIOC parity check - in
5C*	Moss level 0 error detection; MCCU B; Device; Adaptor check; MIOC parity check - out
5D*	Moss level 0 error detection; MCCU B; Device; Adaptor check; Adaptor failure
5E*	Moss level 0 error detection; MCCU B; Device; Adaptor check; Multiple bits detected in
	Stat reg
\5F*	Moss level 0 error detection; MCCU B; Device; Adaptor check; No Common Adaptor
	Code running
.60*	Moss level 0 error detection; MCCU B; PIO; Bus check; Inbound parity
.61*	Moss level 0 error detection; MCCU B; PIO; Bus check; Adaptor failure
62*	Moss level 0 error detection; MCCU B; PIO; Bus check; Adaptor not detected
.63* .64*	Moss level 0 error detection; MCCU B; PIO; Timeout; Invalid command Moss level 0 error detection; MCCU B; PIO; Timeout; Outbound address parity check
.65*	Moss level 0 error detection; MCCU B; PIO; Timeout; Adaptor not detected
.66*	Moss level 0 error detection; MCCU B; PIO; Timeout; Adaptor hot detected
.67*	Moss level 0 error detection; MCCU B; PIO; Timeout; Multiple bits detected in Stat reg
68*	Moss level 0 error detection; SWAD; Adaptor is 'down'
69*	Moss level 0 error detection; SWAD; Adaptor is 'down'; Excess spurious errors
6A*	Moss level 0 error detection; SWAD; Adaptor check; Internal clock check 1
6B*	Moss level 0 error detection; SWAD; Adaptor check; Internal clock check 2
6C*	Moss level 0 error detection; SWAD; Adaptor check; Multiple bits detected in
	Disconnect reg
6D*	Moss level 0 error detection; SWAD; Device; Adaptor check; State counter parity
.6E*	Moss level 0 error detection; SWAD; Device; Adaptor check; Shift pulse counter parity
.6F*	Moss level 0 error detection; SWAD; Device; Adaptor check; Ground fault detected on
	driver line
70*	Moss level 0 error detection; SWAD; Device; Adaptor check; Interface check
71*	Moss level 0 error detection; SWAD; Device; Adaptor check; Interface timeout
72*	Moss level 0 error detection; SWAD; Device; Adaptor check; Interface parity check
73*	Moss level 0 error detection; SWAD; Device; Adaptor check; Multiple bits detected in EB Stat reg
74*	Moss level 0 error detection; SWAD; Device; Adaptor check; Switch interface error
.75*	Moss level 0 error detection; SWAD; Device; Adaptor check; Switch driver fault
76*	Moss level 0 error detection; SWAD; Device; Adaptor check; Switch serial link parity
\77*	Moss level 0 error detection; SWAD; Device; Adaptor check; Switch invalid command

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Table A-1 (Page 13 of 23). MOSS Control Panel Codes

PANEL CODE	DEFINITION
A78*	Moss level 0 error detection; SWAD; Device; Adaptor check; Multiple bits detected in
A 70*	Device stat reg
A79*	Moss level 0 error detection; SWAD; Device; Adaptor check; Adaptor failure
A7A*	Moss level 0 error detection; SWAD; Device; Adaptor check; No Common Adaptor Code running
A7B*	Moss level 0 error detection; SWAD; PIO; Bus check; Inbound parity
A7C*	Moss level 0 error detection; SWAD; PIO; Bus check; Adaptor failure
A7D*	Moss level 0 error detection; SWAD; PIO; Bus check; Adaptor not detected
A7E*	Moss level 0 error detection; SWAD; PIO; Timeout; Invalid command
A7F*	Moss level 0 error detection; SWAD; PIO; Timeout; Outbound address parity check
A80*	Moss level 0 error detection; SWAD; PIO; Timeout; Overrun
A81*	Moss level 0 error detection; SWAD; PIO; Timeout; Adaptor not detected
A82*	Moss level 0 error detection; SWAD; PIO; Timeout; Adaptor failure
A83*	Moss level 0 error detection; SWAD; PIO; Timeout; Multiple bits detected in Stat reg
A84*	Moss level 0 error detection; MCAD; Adaptor is 'down'
A85*	Moss level 0 error detection; MCAD; PIO; Bus check; Inbound parity
A86*	Moss level 0 error detection; MCAD; PIO; Bus check; Adaptor failure
A87*	Moss level 0 error detection; MCAD; PIO; Bus check; Adaptor not detected
A88*	Moss level 0 error detection; MCAD; PIO; Timeout; Invalid command
A89*	Moss level 0 error detection; MCAD; PIO; Timeout; Outbound parity check
A8A*	Moss level 0 error detection; MCAD; PIO; Timeout; Adaptor not detected
A8B*	Moss level 0 error detection; MCAD; PIO; Timeout; Adaptor failure
A8C*	Moss level 0 error detection; MCAD; PIO; Timeout; Multiple bits detected in Stat reg
A8D*	Moss level 0 error detection; DFA; Adaptor is 'down'
A8E*	Moss level 0 error detection; DFA; CHIO Bus check
A8F*	Moss level 0 error detection; DFA; CHIO Timeout
A90*	Moss level 0 error detection; DFA; CHIO; Storage ECC error; Register space parity
/100	during main store.
A91*	Moss level 0 error detection; DFA; CHIO; Storage ECC error; Multiple bits in DIV Register
A92*	Moss level 0 error detection; DFA; CHIO; Storage ECC error; No bits active in DIV Register
A93*	Moss level 0 error detection; DFA; CHIO; Exception; Operation exception; CHCV Reg invalid
A94*	Moss level 0 error detection; DFA; CHIO; Exception; Register precision; CHP Reg bits 0-7 are not zero
A95*	Moss level 0 error detection; DFA; CHIO; Exception; Specification exception with invalid
A33	address on main store data access
A96*	Moss level 0 error detection; DFA; CHIO; Exception; Address exception on main store data access
A97*	Moss level 0 error detection; DFA; CHIO; Exception; Multiple bits in DIV Register
A98*	Moss level 0 error detection; DFA; CHIO; Exception; No bits active in DIV Register
A99*	Moss level 0 error detection; DFA; CHIO; Internal check; Cache parity check
A9A*	Moss level 0 error detection; DFA; CHIO; Internal check; Invalid address on CHP Reg access
A9B*	Moss level 0 error detection; DFA; CHIO; Internal check; Multiple bits in DIV Register
A9C*	Moss level 0 error detection; DFA; CHIO; Multiple bits detected in EIRV reg
A9D*	Moss level 0 error detection; DFA; CHIO; No CHIO in progress in Adaptor Control Block
A9E*	Moss level 0 error detection; DFA; PIO; Bus check; Inbound parity
A9F*	Moss level 0 error detection; DFA; PIO; Bus check; Adaptor failure
AA0*	Moss level 0 error detection; DFA; PIO; Bus check; Adaptor not detected
AA1*	Moss level 0 error detection; DFA; PIO; Timeout; Invalid command
AA2*	Moss level 0 error detection; DFA; PIO; Timeout; Outbound address parity check
AA3*	Moss level 0 error detection; DFA; PIO; Timeout; Outbound command/data parity check
AA4*	Moss level 0 error detection; DFA; PIO; Timeout; Adaptor failure
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Table A-1 (Page 14 of 23). MOSS Control Panel Codes

 Moss level 0 error detection; TOD; Adaptor is 'down' Moss level 0 error detection; TOD; PIO; Bus check; Inbound parity Moss level 0 error detection; TOD; PIO; Bus check; Inbound parity Moss level 0 error detection; TOD; PIO; Bus check; Inbound parity check Moss level 0 error detection; TOD; PIO; Timeout; Outbound address parity check Moss level 0 error detection; TOD; PIO; Timeout; Outbound address parity check Moss level 0 error detection; PLC; Adaptor is 'down' NOT USED Moss level 0 error detection; PLC; MMIO Interface error OR Invalid address during main store data access (ON level 2) Moss level 0 error detection; PLC; MMIO Parity error OR Memory storage; Storage ECC; Data parity (ON level 2) NOT USED Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; Storage ECC; Data parity Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Data parity Moss level 0 error detection; Loop; Excessive MOSS ML loop is detected via a TOD interrupt Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery 	PANEL CODE	DEFINITION
 Moss level 0 error detection; TOD; PIO; Bus check: Adaptor not detected Moss level 0 error detection; TOD; PIO; Bus check: Adaptor not detected Moss level 0 error detection; TOD; PIO; Timeout; Outbound command/data parity check Moss level 0 error detection; TOD; PIO; Timeout; Outbound command/data parity check Moss level 0 error detection; TDC; PIO; Timeout; Outbound command/data parity check Moss level 0 error detection; PLC; MMIO Interface error OR Invalid address during main store data access (ON level 2) Moss level 0 error detection; PLC; MMIO Parity error OR Memory storage; Storage ECC; Data parity (ON level 2) NOT USED MOS level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; CHO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Excessive MOSS ML loop is detected via a TOD interrupt Moss level 0 error detection; Excessive MOSS ML loop is detected via a TOD interrupt Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Re	AA5*	Moss level 0 error detection; DFA; PIO; Timeout; Multiple bits detected in Stat reg
 Moss level 0 error detection; TOD; PIO; Bus check: Adaptor not detected Moss level 0 error detection; TOD; PIO; Timeout; Outbound address parity check Moss level 0 error detection; PLC; Adaptor is 'down' NOT USED Moss level 0 error detection; PLC; MMIO Interface error OR Invalid address during main store data access (ON level 2) Moss level 0 error detection; PLC; MMIO Interface error OR Memory storage; Storage ECC; Data parity (IN level 2) NOT USED Moss level 0 error detection; PLC; MMIO Parity error OR Memory storage; Storage ECC; Data parity (IN level 2) NOT USED Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; CHO Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Row processor is in an unexpected state<td>AA6*</td><td>Moss level 0 error detection; TOD; Adaptor is 'down'</td>	AA6*	Moss level 0 error detection; TOD; Adaptor is 'down'
 Moss level 0 error detection; TOD; PIO; Timeout; Outbound address parity check Moss level 0 error detection; TDD; PIO; Timeout; Outbound command/data parity check Moss level 0 error detection; PLC; Adaptor is 'down' NOT USED Moss level 0 error detection; PLC; MMIO Interface error OR Invalid address during main store data access (ON level 2) Moss level 0 error detection; PLC; MMIO Parity error OR Memory storage; Storage ECC; Data parity (ON level 2) Moss level 0 error detection; PLC; MMIO Parity error OR Memory storage; Storage ECC; Data parity (ON level 2) Moss level 0 error detection; QLC Bus; Bus is 'down' Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Check during PSV swap Moss level 0 error detection; Register Storage; CHO Storage ECC; Check during PSV swap Moss level 0 error detection; Register Storage; Storage ECC; Check during PSV swap Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Return address stack table is enply Moss level 0 error detection; Level 0 code; Program error; Return address stack table is enply	AA7*	Moss level 0 error detection; TOD; PIO; Bus check; Inbound parity
 Moss level 0 error detection; TOD; PIO; Timeout; Outbound command/data parity check Moss level 0 error detection; PLC; Adaptor is 'down' NOT USED Moss level 0 error detection; PLC; MMIO Interface error OR Invalid address during main store data access (ON level 2) Moss level 0 error detection; PLC; MMIO Parity error OR Memory storage; Storage ECC; Data parity (ON level 2) NOT USED Moss level 0 error detection; UC Bus; Bus is 'down' Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; CHO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Memory Storage; CHO Storage ECC; Data parity Wilst accessing MSC Moss level 0 error detection; Memory Storage; CHO Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Instruction fetch parity Moss level 0 error detection; Croneous MOSS code; Program error; IO address is not authorized Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Row processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Reurn address stack table is module CHGHDPGM - is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Row processor is in an unexpected state Moss level 0 error detection; Level 0 code; Pr	AA8*	
 Moss level 0 error detection; PLC; Adaptor is 'down' NOT USED NOT USED Moss level 0 error detection; PLC; MMIO Interface error OR Invalid address during main store data access (ON level 2) Moss level 0 error detection; PLC; MMIO Parity error OR Memory storage; Storage EC; Data parity (ON level 2) NOT USED Moss level 0 error detection; PLC; MMIO Parity error OR Memory storage; Storage EC; Data parity (ON level 2) Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present ir module CHGH0PGM - is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full Moss level 0 error detection; Lev	4A9*	Moss level 0 error detection; TOD; PIO; Timeout; Outbound address parity check
 NOT USED Moss level 0 error detection; PLC; MMIO Interface error OR Invalid address during main store data access (ON level 2) Moss level 0 error detection; PLC; MMIO Parity error OR Memory storage; Storage ECC; Data parity (ON level 2) NOT USED Moss level 0 error detection; CE us; Bus is 'down' Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Check during PSV swap Moss level 0 error detection; Register Storage; CHO Storage ECC; Check during PSV swap Moss level 0 error detection; Register Storage; Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; CHO Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Intruction fetch parity Moss level 0 error detection; Core, Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Rog processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state Moss level 0 error detection; Le	AA *	Moss level 0 error detection; TOD; PIO; Timeout; Outbound command/data parity check
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 Moss level 0 error detection; PLC; MMIO Interface error OR Invalid address during main store data access (ON level 2) Moss level 0 error detection; PLC; MMIO Parity error OR Memory storage; Storage ECC; Data parity (ON level 2) MOSS level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; CHO Storage ECC; Data parity Moss level 0 error detection; Memory Storage; CHO Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Prostponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Prostponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Prostponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in module CHGH0BUS Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Mos	AAC	
 Moss level 0 error detection; PLC; MMIO Interface error OR Invalid address during main store data access (ON level 2) Moss level 0 error detection; PLC; MMIO Parity error OR Memory storage; Storage ECC; Data parity (ON level 2) MOS level 0 error detection; UC Bus; Bus is 'down' Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Memory Storage; CHOI Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Capp: Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full Moss level 0 error detection; Level	to	NOT USED
 main store data access (ON level 2) Moss level 0 error detection; PLC; MMIO Parity error. OR Memory storage; Storage ECC; Data parity (ON level 2) NOT USED Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; Cli Ostorage ECC; Data parity whilst accessing MSC error detection; Register Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Erroneous MOSS code; Program error; IO address is not authorized Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Prasparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Return address stack table is empty Moss level 0 error detection; Level 0 c	٩AD	
 ECC: Data parity (ON level 2) NOT USED NOT USED Moss level 0 error detection; UC Bus; Bus is 'down' Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Unresolved problem Moss level 0 error detection; Register Storage; PIO Storage ECC; Unresolved problem Moss level 0 error detection; Register Storage; Storage ECC; Unresolved problem Moss level 0 error detection; Memory Storage; Storage ECC; Data parity Moss level 0 error detection; Memory Storage; Storage ECC; Instruction fetch parity Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Eroneous MOSS code; Program error; IO address is not authorized Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Prostponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present ir module CHGHOPGM is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine 	AAE*	main store data access (ON level 2)
 Moss level 0 error detection; UC Bus; Bus is 'down' Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Unresolved problem Moss level 0 error detection; Register Storage; PIO Storage ECC; Unresolved problem Moss level 0 error detection; Register Storage; Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; Storage ECC; Data parity Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Instruction fetch parity Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Erroneous MOSS code; Program error; IO address is not authorized Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full M	AAF*	ECC; Data parity (ON level 2)
 Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC bevel 0 error detection; Register Storage; Storage ECC; Data parity Woss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Instruction fetch parity Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Diag code; Program error; IO address is not authorized Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in module CHGH0PGM - is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor		
 accessing MPC Moss level 0 error detection; Register Storage; PIO Storage ECC; Data parity whilst accessing MSC Moss level 0 error detection; Register Storage; Storage ECC; Unresolved problem Moss level 0 error detection; Remory Storage; CHIO Storage ECC; Data parity Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Instruction fetch parity Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Erroneous MOSS code; Program error; IO address is not authorized Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present ir module CHGH0PGM - is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection;	AB1 AB2*	
 accessing MSC Moss level 0 error detection; Register Storage; PIO Storage ECC; Unresolved problem Moss level 0 error detection; Register Storage; Storage ECC; Check during PSV swap Moss level 0 error detection; Memory Storage; Storage ECC; Data parity Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Diag code; Program error; IO address is not authorized Moss level 0 error detection; Level 0 code; Program error; Io address is not authorized Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in module CHGH0BUS Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code;		accessing MPC
 Moss level 0 error detection; Register Storage; Storage ECC; Check during PSV swap Moss level 0 error detection; Memory Storage; CHIO Storage ECC; Data parity Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Instruction fetch parity Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Loop; Excessive MOSS code; Program error; IO address is not authorized Moss level 0 error detection; Diag code; Program error; Power on reset / start; Unresolved Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present ir module CHGH0BUS Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table is empty Moss level 0 error detection; Level 0 code; Program error; Return address stack table is enpty Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Level 0 co	AB3*	accessing MSC
 Moss level 0 error detection; Memory Storage; CHIO Storage ECC; Data parity Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Instruction fetch parity Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Erroneous MOSS code; Program error; IO address is not authorized Moss level 0 error detection; Diag code; Program error; Power on reset / start; Unresolved Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Prostponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Program request dispatcher - module CHGH0PGM - is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present ir module CHGH0BUS Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table Moss level 0 error detection; Level 0 code; Program error; Noss already IML'd routine before the IML routine Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine 	4B4*	
 Moss level 0 error detection; Memory Storage; Storage ECC; Data parity (NOT ON level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Instruction fetch parity Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Erroneous MOSS code; Program error; IO address is not authorized Moss level 0 error detection; Level 0 code; Program error; Nower on reset / start; Unresolved Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in module CHGH0PGM - is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Level 0 code; Program error; Noss already IML'd routine before the IML routine 	\B 5*	
 level 2) Moss level 0 error detection; Memory Storage; Storage ECC; Instruction fetch parity Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Erroneous MOSS code; Program error; IO address is not authorized Moss level 0 error detection; Diag code; Program error; Power on reset / start; Unresolved Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in module CHGH0PGM - is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table moss level 0 error detection; Level 0 code; Program error; Return address stack table moss level 0 error detection; Level 0 code; Program error; Return address stack table moss level 0 error detection; Level 0 code; Program error; Return address stack table moss level 0 error detection; Level 0 code; Program error; Return address stack table moss level 0 error detection; Level 0 code; Program error; Return address stack table moss level 0	AB6*	
 Moss level 0 error detection; Loop; Excessive MOSS IML loop is detected via a TOD interrupt Moss level 0 error detection; Erroneous MOSS code; Program error; IO address is not authorized Moss level 0 error detection; Diag code; Program error; Power on reset / start; Unresolved Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present ir module CHGH0PGM - is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present ir module CHGH0BUS Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table moss level 0 error detection; Level 0 code; Program error; Return address stack table moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Level 0 code; Pr	AB7*	
 interrupt Moss level 0 error detection; Erroneous MOSS code; Program error; IO address is not authorized Moss level 0 error detection; Diag code; Program error; Power on reset / start; Unresolved Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Program request dispatcher - module CHGH0PGM - is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in module CHGH0BUS Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine 	AB8*	
 authorized B8* Moss level 0 error detection; Diag code; Program error; Power on reset / start; Unresolved 3C* Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery 3D* Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery 3E* Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery 3F* Moss level 0 error detection; Level 0 code; Program error; Program request dispatcher - module CHGH0PGM - is in an unexpected state C0* Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in module CHGH0BUS C1* Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state C2* Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state C3* Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state C3* Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full C4* Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full C5* Moss level 0 error detection; Level 0 code; Program error; The type of BER created does not exist in the BER table C6* Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine C7* Moss level 0 error detection; Unexpected spurious interrupt; CHIO error detected 	4B9*	
 Unresolved AC* Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Checkpoint Retry Recovery BD* Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery BE* Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery BF* Moss level 0 error detection; Level 0 code; Program error; Program request dispatcher - module CHGH0PGM - is in an unexpected state C0* Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in module CHGH0BUS C1* Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state C2* Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state C3* Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full C4* Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full C5* Moss level 0 error detection; Level 0 code; Program error; The type of BER created does not exist in the BER table C6* Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine C7* Moss level 0 error detection; Unexpected spurious interrupt; CHIO error detected 	ABA*	
 Checkpoint Retry Recovery BD* Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery BE* Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery BF* Moss level 0 error detection; Level 0 code; Program error; Program request dispatcher - module CHGH0PGM - is in an unexpected state C0* Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in module CHGH0BUS C1* Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state C2* Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state C3* Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full C4* Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full C4* Moss level 0 error detection; Level 0 code; Program error; Return address stack table C5* Moss level 0 error detection; Level 0 code; Program error; The type of BER created does not exist in the BER table C6* Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine C7* Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine 	ABB*	
 Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Postponed Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Program request dispatcher - module CHGH0PGM - is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present ir module CHGH0BUS Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table Moss level 0 error detection; Level 0 code; Program error; The type of BER created does not exist in the BER table Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine 	ABC*	
 Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during Transparent Retry Recovery Moss level 0 error detection; Level 0 code; Program error; Program request dispatcher - module CHGH0PGM - is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in module CHGH0BUS Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full Moss level 0 error detection; Level 0 code; Program error; The type of BER created does not exist in the BER table Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine 	ABD*	Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during
 Moss level 0 error detection; Level 0 code; Program error; Program request dispatcher - module CHGH0PGM - is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in module CHGH0BUS Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table is full Moss level 0 error detection; Level 0 code; Program error; The type of BER created does not exist in the BER table Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Unexpected spurious interrupt; CHIO error detected 	ABE*	Moss level 0 error detection; Level 0 code; Program error; Invalid BER set during
 Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in module CHGH0BUS Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table is empty Moss level 0 error detection; Level 0 code; Program error; The type of BER created does not exist in the BER table Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Unexpected spurious interrupt; CHIO error detected 	ABF*	Moss level 0 error detection; Level 0 code; Program error; Program request dispatcher
 Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table is empty Moss level 0 error detection; Level 0 code; Program error; The type of BER created does not exist in the BER table Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Unexpected spurious interrupt; CHIO error detected 	AC0*	Moss level 0 error detection; Level 0 code; Program error; Invalid adaptor ID present in
 Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an unexpected state Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table is empty Moss level 0 error detection; Level 0 code; Program error; The type of BER created does not exist in the BER table Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Unexpected spurious interrupt; CHIO error detected 	AC1*	Moss level 0 error detection; Level 0 code; Program error; Ram processor is in an
 Moss level 0 error detection; Level 0 code; Program error; Call address stack table is full Moss level 0 error detection; Level 0 code; Program error; Return address stack table is empty Moss level 0 error detection; Level 0 code; Program error; The type of BER created does not exist in the BER table Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Unexpected spurious interrupt; CHIO error detected 	AC2*	Moss level 0 error detection; Level 0 code; Program error; Ros processor is in an
 Moss level 0 error detection; Level 0 code; Program error; Return address stack table is empty Moss level 0 error detection; Level 0 code; Program error; The type of BER created does not exist in the BER table Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Unexpected spurious interrupt; CHIO error detected 	AC3*	Moss level 0 error detection; Level 0 code; Program error; Call address stack table is
 Moss level 0 error detection; Level 0 code; Program error; The type of BER created does not exist in the BER table Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Unexpected spurious interrupt; CHIO error detected 	AC4*	Moss level 0 error detection; Level 0 code; Program error; Return address stack table
 Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine before the IML routine Moss level 0 error detection; Unexpected spurious interrupt; CHIO error detected 	AC5*	Moss level 0 error detection; Level 0 code; Program error; The type of BER created
Moss level 0 error detection; Unexpected spurious interrupt; CHIO error detected	AC6*	Moss level 0 error detection; Level 0 code; Program error; Moss already IML'd routine
An * following a panel code denotes that the code should 'Blink'.	AC7*	
		An * following a panel code denotes that the code should 'Blink'.

Table A-1 (Page 15 of 23). MOSS Control Panel Codes

PANEL CODE	DEFINITION
AC8*	Moss level 0 error detection; Unexpected spurious interrupt; Level 0 interrupt detecte
AC9*	Moss level 0 error detection; Unexpected spurious interrupt; Level 0 interrupt in IOIRV detected
ACA*	Moss level 0 error detection; Unexpected spurious interrupt; PIO Bus check; No adaptor found with Last Priority Level
ACB*	Moss level 0 error detection; Unexpected spurious interrupt; PIO Bus check; Instructic was not an IO type
ACC*	Moss level 0 error detection; Unexpected spurious interrupt; PIO Bus check; Detected on level 2
ACD*	Moss level 0 error detection; Unexpected spurious interrupt; PIO Bus check; Detected on level 6
ACE*	Moss level 0 error detection; Unexpected spurious interrupt; PIO Timeout; No adaptor found with Last Priority Level
ACF*	Moss level 0 error detection; Unexpected spurious interrupt; PIO Timeout; Instruction was not an IO type
4D0*	Moss level 0 error detection; Unexpected spurious interrupt; PIO Timeout; Detected or level 2
4D1*	Moss level 0 error detection; Unexpected spurious interrupt; PIO Timeout; Detected of level 6
4D2*	Moss level 0 error detection; Unexpected spurious interrupt; Program request detecte in PIRV
\D3*	Moss level 0 error detection; Unresolved Exception error; Addressing exception durin Instruction fetch
\D4*	Moss level 0 error detection; Unresolved Exception error; Addressing exception durin Main store data access
\D5*	Moss level 0 error detection; Unresolved Exception error; Fixed point overflow exception
\D6*	Moss level 0 error detection; Unresolved Exception error; Invalid address exception during non main store access
AD7*	Moss level 0 error detection; Unresolved Exception error; Multiple bits detected in DIV
\D8*	Moss level 0 error detection; Unresolved Exception error; Multiple bits detected in EIF
\D9*	Moss level 0 error detection; Unresolved Exception error; Operation exception; Invalic opcode detected
ADA*	Moss level 0 error detection; Unresolved Exception error; Register precision exceptio
ADB*	Moss level 0 error detection; Unresolved Exception error; Specification exception; Invalid address during Instruction fetch
ADC*	Moss level 0 error detection; Unresolved Exception error; Specification exception; Invalid address during Main store data access (NOT ON level 2)
ADD*	Moss level 0 error detection; Unresolved Exception error; Specification exception; Invalid address during non GPR access
\DE*	Moss level 0 error detection; Unresolved Exception error; Specification exception; Invalid execution of KI instruction
NDF*	Moss level 0 error detection; Unresolved Exception error; Specification exception; PSV bits (40-44-47) are not zero
\E0*	Moss level 0 error detection; Unresolved Internal Check; Cache register parity check
E1*	Moss level 0 error detection; Unresolved Internal Check; Invalid address during GPR access
\E2*	Moss level 0 error detection; Unresolved Internal Check; Invalid address during PSV swap
AE3 *	Moss level 0 error detection; Unresolved Internal Check; Multiple bits detected in DIV
AE4* AE5*	Moss level 0 error detection; Unresolved Internal Check; Multiple bits detected in EIR Moss level 0 error detection; Unresolved Storage/ECC Check; Multiple bits detected in DIV

AE6* Moss level 0 error detection; Unresolved Storage/ECC Check; Multiple bits detected in EIRV AE7* Moss level 0 error detection; Unresolved Storage/ECC Check; No bits detected in DIV AE8 NOT USED BFE BFF* Moss level 0 Incoherence; Problem within the level 0 code C00 to NOT USED C03 C04* Moss level 0 error detection; MOSS ABEND; Supervisor; Invalid SVTTRC C05* Moss level 0 error detection; MOSS ABEND; Supervisor; More than one request
AE8 to NOT USED BFE BFF* Moss level 0 Incoherence; Problem within the level 0 code C00 to NOT USED C03 C04* Moss level 0 error detection; MOSS ABEND; Supervisor; Invalid SVTTRC C05* Moss level 0 error detection; MOSS ABEND; Supervisor; More than one request
to NOT USED BFE BFF* Moss level 0 Incoherence; Problem within the level 0 code C00 to NOT USED C03 C04* Moss level 0 error detection; MOSS ABEND; Supervisor; Invalid SVTTRC C05* Moss level 0 error detection; MOSS ABEND; Supervisor; More than one request
BFF* Moss level 0 Incoherence; Problem within the level 0 code C00 to to NOT USED C03 C04* Moss level 0 error detection; MOSS ABEND; Supervisor; Invalid SVTTRC C05* Moss level 0 error detection; MOSS ABEND; Supervisor; More than one request
toNOT USEDC03C04*C05*Moss level 0 error detection; MOSS ABEND; Supervisor; Invalid SVTTRCC05*Moss level 0 error detection; MOSS ABEND; Supervisor; More than one request
C03C04*Moss level 0 error detection; MOSS ABEND; Supervisor; Invalid SVTTRCC05*Moss level 0 error detection; MOSS ABEND; Supervisor; More than one request
C05* Moss level 0 error detection; MOSS ABEND; Supervisor; More than one request
C06* Moss level 0 error detection; MOSS ABEND; Supervisor; Invalid SVTDRC
C07* Moss level 0 error detection; MOSS ABEND; Supervisor; Invalid TCB ID
C08* Moss level 0 error detection; MOSS ABEND; Supervisor; Invalid Adaptor ID
C09* Moss level 0 error detection; MOSS ABEND; Supervisor; Invalid Timer request
COA* Moss level 0 error detection; MOSS ABEND; Supervisor; Lost BER counter is full
COB* Moss level 0 error detection; MOSS ABEND; Supervisor; BER length null
COC* Moss level 0 error detection; MOSS ABEND; Supervisor; Invalid macro ID in CHGSUBEM
C0D* Moss level 0 error detection; MOSS ABEND; Supervisor; Invalid adaptor ID in CHGSUBEA
C0E* Moss level 0 error detection; MOSS ABEND; Keyboard/Display Support; Invalid function request
C0F* Moss level 0 error detection; MOSS ABEND; Keyboard/Display Support; End I/O without FRB
C10* Moss level 0 error detection; MOSS ABEND; Keyboard/Display Support; Program interrupt without FRB
C11* Moss level 0 error detection; MOSS ABEND; Keyboard/Display Support; Invalid interrupt
C12* Moss level 0 error detection; MOSS ABEND; Disk/Diskette Support; Invalid function request
C13 NOT USED
C14* Moss level 0 error detection; MOSS ABEND; Disk/Diskette Support; Invalid header label C15
to NOT USED C16
C17* Moss level 0 error detection; MOSS ABEND; Disk/Diskette Support; Invalid LM elements
C18 NOT USED C19* Moss level 0 error detection; MOSS ABEND; Disk/Diskette Support; Invalid completion
status with preemptive request
C1A NOT USED C1B* Moss level 0 error detection; MOSS ABEND; Disk/Diskette Support; Control record found
C1C* Moss level 0 error detection; MOSS ABEND; Disk/Diskette Support; Invalid completion status with exception detected
C1D* Moss level 0 error detection; MOSS ABEND; Disk/Diskette Support; Program problem detected by CAC
C1E* Moss level 0 error detection; MOSS ABEND; Disk/Diskette Support; Invalid completion status with error detected
C1F* Moss level 0 error detection; MOSS ABEND; Disk/Diskette Support; Invalid completion status with complete but with neither exception nor error detected
C20* Moss level 0 error detection; MOSS ABEND; Disk/Diskette Support; Unexpected completion status or interrupt
An * following a panel code denotes that the code should 'Blink'.

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Table A-1 (Page 16 of 23). MOSS Control Panel Codes

Table	A-1	(Page	17	of	23)	MOSS	Control	Panel	Codes
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PANEL CODE	DEFINITION
C21*	Moss level 0 error detection; MOSS ABEND; Disk/Diskette Support; Bad disk IOCS initialize
C22*	Moss level 0 error detection; MOSS ABEND; Disk/Diskette Support; Threshold exceeded on unexpected interrupt
C23*	Moss level 0 error detection; MOSS ABEND; CCU Support; No action for Scanner AC hit
C24	NOT USED
C25*	Moss level 0 error detection; MOSS ABEND; CCU Support; Undefined interrupt
C26*	Moss level 0 error detection; MOSS ABEND; CCU Support; Unexpected Mailbox IN rejected
C27*	Moss level 0 error detection; MOSS ABEND; CCU Support; Invalid ID from scanner selected
C28*	Moss level 0 error detection; MOSS ABEND; CCU Support; Invalid adaptor address
C29*	Moss level 0 error detection; MOSS ABEND; CCU Support; Undefined CHIO request
C2A*	Moss level 0 error detection; MOSS ABEND; CCU Support; Switch adaptor CAC requests an ABEND
C2B	
to C2D	NOT USED
C2E* C2F	Moss level 0 error detection; MOSS ABEND; CCU Support; Invalid PCW command
to C30	NOT USED
C31*	Moss level 0 error detection; MOSS ABEND; Operator Control; Load module not foun
232*	Moss level 0 error detection; MOSS ABEND; Operator Control; Logical Disk error
C33*	Moss level 0 error detection; MOSS ABEND; Operator Control; Invalid cancel request
234*	Moss level 0 error detection; MOSS ABEND; Operator Control; Moss IML request by operator
C35*	Moss level 0 error detection; MOSS ABEND; Operator Control; Data stream out is greater than 1024 bytes
C36*	Moss level 0 error detection; MOSS ABEND; CCU Functions; End of DCF application
C37*	Moss level 0 error detection; MOSS ABEND; CCU Functions; Incorrect load module identified
C38*	Moss level 0 error detection; MOSS ABEND; CCU Functions; Logical disk error
C39*	Moss level 0 error detection; MOSS ABEND; CCU Functions; Unknown operator contr return code
C3A*	Moss level 0 error detection; MOSS ABEND; Transient Tasks; Load module not found
C3B* C3C*	Moss level 0 error detection; MOSS ABEND; Transient Tasks; Logical disk error Moss level 0 error detection; MOSS ABEND; Transient Tasks; Unknown operator
	control return code
C3D*	Moss level 0 error detection; MOSS ABEND; Transient Tasks; Conflicting dump file information
C3E*	Moss level 0 error detection; MOSS ABEND; Transient Tasks; Scanner not installed o SCB not flagged "auto dump"
C3F*	Moss level 0 error detection; MOSS ABEND; Transient Tasks; Control program invalid answer
C40*	Moss level 0 error detection; MOSS ABEND; Transient Tasks; Disconnect not allowed
C41*	Moss level 0 error detection; MOSS ABEND; Transient Tasks; Buffer limit reached
242*	Moss level 0 error detection; MOSS ABEND; Box Error Logging; Invalid BER stack
C43*	Moss level 0 error detection; MOSS ABEND; Mail Box Support; Load module not foun
C44*	Moss level 0 error detection; MOSS ABEND; Mail Box Support; Mail box request rejected
C45*	Moss level 0 error detection; MOSS ABEND; Mail Box Support; Unsolicited call
C46*	Unsolicited call

Appendix A. Control Panel Code Definitions A-17

Table A-1 (Page 18 of 23). MOSS Control Panel Codes

PANEL CODE	DEFINITION
C47*	Moss level 0 error detection; MOSS ABEND; Macro Invocation; Started bit in request
C48*	Moss level 0 error detection; MOSS ABEND; System IPL; Start IPL refused
C49*	Moss level 0 error detection; MOSS ABEND; Disk Functions; Disk unusable
C4A*	Moss level 0 error detection; MOSS ABEND; Disk Functions; Unable to load CHGDFINT
C4B*	Moss level 0 error detection; MOSS ABEND; Power Functions; Incorrect access to PCST
C4C*	Moss level 0 error detection; MOSS ABEND; Power Functions; Invalid data - threshold
C4D*	Moss level 0 error detection; MOSS ABEND; Power Functions; Next request received before RP
C4E*	Moss level 0 error detection; MOSS ABEND; Level 1; Permanent HLIR - kill MOSS
C4F*	Moss level 0 error detection; MOSS ABEND; Level 1; Excess amount of spurious errors
C50*	Moss level 0 error detection; MOSS ABEND; Level 1; Soft checker - snap shot
C51*	Moss level 0 error detection; MOSS ABEND; MSD; Invalid frame number
C52*	Moss level 0 error detection; MOSS ABEND; IMIN2; No timer IMIN2
C53*	Moss level 0 error detection; MOSS ABEND; TRSS; NCP pointer not found
C54*	Moss level 0 error detection; MOSS ABEND; TRSS; Invalid field format received
C55*	Moss level 0 error detection; MOSS ABEND; TRSS; Invalid TIC storage
C56*	Moss level 0 error detection; MOSS ABEND; TRSS; TRA/TIC not installed or ASB not flagged "Auto TIC Dump"
C57	
to	NOT USED
D00	Mana Javal O amon data tian. Diale among devila a 1841 (D among A daratas have a 1)
D01*	Moss level 0 error detection; Disk errors during IML/Dump; Adaptor busy - attn
D02* D03	Moss level 0 error detection; Disk errors during IML/Dump; FRB busy
to	NOT USED
D04	
D05*	Moss level 0 error detection; Disk errors during IML/Dump; Adapter busy - CHIO
D06*	Moss level 0 error detection; Disk errors during IML/Dump; Adapter busy - reset
D07	NOT USED
D08*	Moss level 0 error detection; Disk errors during IML/Dump; SCA 1 not open
D09*	Moss level 0 error detection; Disk errors during IML/Dump; SCA 2 not open
DOA*	Moss level 0 error detection; Disk errors during IML/Dump; Adapter not open
D0B*	Moss level 0 error detection; Disk errors during IML/Dump; Pre-emptive request complete
D0C*	Moss level 0 error detection; Disk errors during IML/Dump;
	Pre-emptive request rejected
DOD*	Moss level 0 error detection; Disk errors during IML/Dump; SCA 1 already open
D0E* D0F	Moss level 0 error detection; Disk errors during IML/Dump; SCA 2 already open
to	NOT USED
D10	
D11*	Moss level 0 error detection; Disk errors during IML/Dump; FRB Program check
D12*	Moss level 0 error detection; Disk errors during IML/Dump; BCL Program check
D13*	Moss level 0 error detection; Disk errors during IML/Dump; Invalid PIO command (hardware & equipment checks)
D14	
to	NOT USED
D1F	
D20*	Moss level 0 error detection; Disk errors during IML/Dump; Indeterminate equipment check (hardware error in adapt.)
D21	NOT USED
D22*	Moss level 0 error detection; Disk errors during IML/Dump; Device (SCA) ready

	DEFINITION
D23	
to	NOT USED
D27	
D28*	Moss level 0 error detection; Disk errors during IML/Dump; Seek check (DATA
020	
D 0 0	transmission problems)
D29	
to	NOT USED
D2F	
D30*	Moss level 0 error detection; Disk errors during IML/Dump; Device (SCA) not ready (r
	error)
D31*	Moss level 0 error detection; Disk errors during IML/Dump; Control record found (error
	/ not successful class, sequence errors)
D32*	Moss level 0 error detection; Disk errors during IML/Dump; Sector Buffer Parity error
D33*	Moss level 0 error detection; Disk errors during IML/Dump;
033	Termination error with no specific error
D34*	Moss level 0 error detection; Disk errors during IML/Dump; Cylinder overrun
D35*	Moss level 0 error detection; Disk errors during IML/Dump; Write/Protect fault with FE
D36*	Moss level 0 error detection; Disk errors during IML/Dump; Write fault with HDD
D37*	Moss level 0 error detection; Disk errors during IML/Dump; Halt during a CHIO
	operation
D38*	Moss level 0 error detection; Disk errors during IML/Dump; I/O bus parity error
D39*	Moss level 0 error detection; Disk errors during IML/Dump; CCB with no active CSB
D3A*	Moss level 0 error detection; Disk errors during IML/Dump; Invalid command in CCB
	SSB
D3B*	Moss level 0 error detection; Disk errors during IML/Dump; ERP invoked by DFA
D3C*	Moss level 0 error detection; Disk errors during IML/Dump; Internal parity error
D3D*	Moss level 0 error detection; Disk errors during IML/Dump; Data error (SSB byte 1)
D3E*	
DSE	Moss level 0 error detection; Disk errors during IML/Dump; Record not found
Dar	(L/operator intervention required)
D3F	NOT USED
D40*	Moss level 0 error detection; Disk errors during IML/Dump; CRC/ECC error on ID
D41*	Moss level 0 error detection; Disk errors during IML/Dump; CRC/ECC error on data
D42*	Moss level 0 error detection; Disk errors during IML/Dump; Bad track detected
D43*	Moss level 0 error detection; Disk errors during IML/Dump; Format error detected
D44*	Moss level 0 error detection; Disk errors during IML/Dump; Unable to find ID
D45*	Moss level 0 error detection; Diskette errors during IML/Dump; Format error detected
D46	
to	NOT USED
D4F	
D50*	Moss level 0 error detection; Disk errors during IML/Dump; Disk change information
D51	moss level o error delection, bisk errors during met bump, bisk change mormation
	NOT USED
to	NOT USED
D75	
D76*	Moss level 0 error detection; Disk errors during IML/Dump; PIO MCK (non-recursive)
D77	
to	NOT USED
DF5	
DF6*	Moss level 0 error detection; Disk errors during IML/Dump; PIO MCK (recursive) -
	(preemptive request class.)
DF7	NOT USED
DF8*	Moss level 0 error detection; Device errors during IML/Dump; Dump directory entry n
	found
DF9*	
	Moss level 0 error detection; Device errors during IML/Dump; Hard Disk not initialised
DFA*	Moss level 0 error detection; Device errors during IML/Dump; Hard Disk not formatted
DFB*	Moss level 0 error detection; Device errors during IML/Dump; Invalid IML request

Table A-1 (Page 19 of 23). MOSS Control Panel Codes

PANEL CODE	DEFINITION
DFC*	Moss level 0 error detection; Device errors during IML/Dump; Volume IML check
DFD*	Moss level 0 error detection; Device errors during IML/Dump; Data compare check
DFE*	Moss level 0 error detection; Device errors during IML/Dump; Disk time out
DFF*	Moss level 0 error detection; Device errors during IML/Dump; Diskette time out
E00	
to	NOT USED
EFF	
F00	Status / Progression step; Start of MOSS Dump
F01	Status / Progression step; Moss Dump has been completed without error
F02	Status / Progression steps which occur during the IML sequence; IML Initialisation
F03	Status/Progression steps which occur during the IML sequence; Open adaptor
F04	Status/Progression steps which occur during the IML sequence; Open SCA (either disk
	or diskette)
F05	Status/Progression steps which occur during the IML sequence; Check disk or diskette ID
F06	
to	NOT USED
F07	
F08	Status/Progression steps which occur during the IML sequence; Find directory entry
F09	Status/Progression steps which occur during the IML sequence; IML end - go to MOSS
	loader
FOA	Status/Progression steps which occur during the IML sequence; Ram entry (Start of
	MOSS Init step 1)
FOB	Status/Progression steps which occur during the IML sequence; End of MOSS Init step
	1
FOC	Status/Progression steps which occur during the IML sequence; Start of MOSS Init step
	2 (Moss level 7)
FOD	Status/Progression steps which occur during the IML sequence; IML complete with
	errors detected during MOSS Diagnostics.
FOE	Status/Progression steps which occur during the IML sequence; IML complete - MOSS
	ALONE
FOF	Status/Progression steps which occur during the IML sequence; IML Complete - CCU
	connected - MOSS OFFLINE
	or MOSS Offline command successful
-10	Errors detected during the IPL sequence; Solid error during MIOC
.	operation
=11	Errors detected during the IPL sequence; CCU hardcheck during a CCU IPL in progress
F12	Errors detected during the IPL sequence; Host IPL request during CCU IPL in progress
F13	Errors detected during the IPL sequence; Unidentified IPL selection
-14	Errors detected during the IPL sequence; CDS not correctly built by the CDF
F15	NOT USED
F16	Errors detected during the IPL sequence; CCU memory test failed
F17	Errors detected during the IPL sequence; CCU test failed
F18	Errors detected during the IPL sequence; IOC BUS test failed
F19	Errors detected during the IPL sequence; IPL port table has been incorrectly built via
	the CDF
-1A	Errors detected during the IPL sequence; CLDP not accessible
F1B	Errors detected during the IPL sequence; CLDP/SALT abend. (output 70)
F1C	Errors detected during the IPL sequence; CLDP/MOSS interface error
F1D	Errors detected during the IPL sequence; NCP/EP init abend
F1E	Errors detected during the IPL sequence; CLDP time out on 'IN MAILBOX'
	acknowledgement
F1F	Errors detected during the IPL sequence; MOSS time out on waiting NCP/EP init MB
	out

An * following a panel code denotes that the code should 'Blink'.

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Table A-1 (Page 20 of 23). MOSS Control Panel Codes

PANEL CODE	DEFINITION
F20	Errors detected during the IPL sequence; MOSS time out on waiting NCP/EP init MB
F21	acknowledgement Errors detected during the IPL sequence; NCP/EP INIT/MOSS interface error
F22	acknowledgement
to	NOT USED
F23	NOT USED
F24	Errors detected during the IPL sequence; No scanner IMLed after scanner IML routin
F25	(phase 3) Errors detected during the IPL sequence; No valid scanner in the CDS
F26	Errors detected during the IPL sequence; LSSD residual count > 7
F27	Errors detected during the IPL sequence; LSSD string select error during a read or write LSSD
F28	Errors detected during the IPL sequence; IPL phase 1A load module not accessible
F29	Errors detected during the IPL sequence; IPL phase 1B load module not accessible
F2A	Errors detected during the IPL sequence; IPL phase 2 load module not accessible
F2B	Errors detected during the IPL sequence; IPL phase 3 load module not accessible
F2C	Errors detected during the IPL sequence; IPL phase 4 load module not accessible
F2D	Errors detected during the IPL sequence; Too many CCU RE-IPL (PGM abend or hardcheck)
F2E	Errors detected during the IPL sequence; Wrong CCU LSSD initialization
F2F	Errors detected during the IPL sequence; No IPL port is available (Neither the Link no Channel) and no load module on the Disk is available
F30	Errors detected during the IPL sequence; CPIT error:
F31	 CPIT length different from CHGCONCP Some CPIT fields not initialized Errors detected during the IPL sequence; IPL phase 1C load module not accessible
F32 F33 F34	Errors detected during the IPL sequence; CCU check occured during Phase 1C Errors detected during the IPL sequence; SALT not accessible
to F47	NOT USED
F48	Errors detected during the IPL sequence; CCU and CACHE checkout failed SCTL checkout failed
F4A	Errors detected during the IPL sequence; SCTL initialization failed
F4B	Errors detected during the IPL sequence; Switch checkout failed
F4C	Errors detected during the IPL sequence; IOC bus problem.
F4D	Errors detected during the Fallback/Switchback sequence; Channel monitoring failure in normal monitor mode during Fallback or Switch back
F4E	Errors detected during the Fallback/Switchback sequence; Reset adaptors can not be performed during Fallback or Switchback
F4F	Errors detected during the Fallback/Switchback sequence; Problem detected by the CDF
F50	Errors detected during the Fallback/Switchback sequence; The control program cannot be set ONLINE by the Fallback or Switchback
F51	Errors detected during the IPL Fallback/Switchback sequence; Switch operation failed
F52 F53	Errors detected during the IPL sequence; Problem detected with the MCAD interface Errors detected during the Fallback/Switchback sequence; Fall back function not
F54	supported Errors detected during the Fallback/Switchback sequence; No buffer available for NC
F55	during fallback Errors detected during the Fallback/Switchback sequence; NCP / MOSS fallback
F56	interface error Errors detected during the Fallback/Switchback sequence; Interface problem detected between Fallback / Switchback and Channel Monitoring

Table A-1 (Page 21 of 23). MOSS Control Panel Codes

Table A-1 (Page 22 of 23). MOSS Control Panel Codes

PANEL CODE	DEFINITION
F57	Errors detected during the IPL sequence; CCU power has dropped during the IPL
F58	Error detected during Switchback sequence; Error found in Switchback protocol
F59	Error detected during MOSS IML Diagnostics; IPL can not be performed on the selected CCU
F60	Error detected during MOSS IML Diagnostics; IPL can not be performed on all CCUs
F61	Errors detected during the IPL sequence; Load module not accessible after a 'suspend procedure
F62	Errors detected during the IPL sequence; IPL cancelled after stop in phase 1 diags.
F63	Errors detected during the IPL sequence; IPL cancelled after stop in phase 1 diags. CCU unknown.
F64	
to	NOT USED
FCF	
FD0	Status/Progression steps which occur during a configuration sequence; Fall back complete
FD1	Status/Progression steps which occur during a configuration sequence; Fall back complete but with errors
FD2	Status/Progression steps which occur during a configuration sequence; Switch back complete
FD3	Status/Progression steps which occur during a configuration sequence; Switch back complete but with errors
FD4	Status/Progression steps which occur during a configuration sequence; Fall back in progress
FD5	Status/Progression steps which occur during a configuration sequence; Switch back in progress
FD6	Status/Progression steps which occur during the IPL sequence; The control program loading is started from the Disk
FD7	Status/Progression step; Dump Control Program onto MOSS disk in progress
FD8	Status / Progression step; Save Control Program on MOSS disk in progress
FD9	Status / Progression step; Phase 1C test in progress on the standby CCU
FDA FDB	Status / Progression step; Phase 1C test cancelled on the standby CCU
to	NOT USED
FE0	
FE1	Errors detected during IML sequence; Disk initialisation failure
FE2	Errors detected during IML sequence; Disk load operation failure
FE3	Errors detected during IML sequence; Power error A - Get end of IML data
FE4	Errors detected during IML sequence; Power error B - Get stacked error
FE5	Errors detected during IML sequence; Panel error
FE6	Errors detected during IML sequence; MIOC error with CCU A operation
FE7	Errors detected during IML sequence; MIOC error with CCU B operation
FE8	Errors detected during IML sequence; Disk error when reading CDF
FE9	Errors detected during IML sequence; CDF not created
FEA	Errors detected during IML sequence; CDF access function(s) error
FEB	Errors detected during IML sequence; NCP timeout on mailbox to CCU A
FEC	Errors detected during IML sequence; NCP timeout on mailbox to CCU B
FED	NOT USED
FEE	Errors detected during IML sequence; MOSS data saving error
FEF	Errors detected during IML sequence; Disk error when reading Port Swap file
FFO	Status/Progression steps which occur during the IPL sequence; IPL entered
FF1	Status/Progression steps which occur during the IPL sequence; IPL phase 1 started
FF2	Status/Progression steps which occur during the IPL sequence; IPL phase 1 started Status/Progression steps which occur during the IPL sequence; IPL phase 2 started
FF2 FF3	Status/Progression steps which occur during the IPL sequence; IPL phase 2 statted Status/Progression steps which occur during the IPL sequence; IPL phase 3 entered
FF4	Status/Progression steps which occur during the IPL sequence; IPL phase 3 entered Status/Progression steps which occur during the IPL sequence; IPL phase 4 entered

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	Table	A-1	(Page	23	of	23).	MOSS Control Panel Codes
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PANEL CODE	DEFINITION
FF5	Status/Progression steps which occur during the IPL sequence; The control program Load / Dump is started on a channel attached 3745
FF6	Status/Progression steps which occur during the IPL sequence; The control program Load / Dump is started on a Link attached 3745
FF7	Status/Progression steps which occur during the IPL sequence; control program is loaded and initialization has started
FF8	NOT USED
FF9	Status / Progression steps which occur during a configuration sequence; Switchback was cancelled by the 3745 operator.
FFA	Status / Progression steps which occur during the IPL sequence; IPL has completed but has detected a PCA1 adapter error; Local console may not be accessible
FFB	Status / Progression steps which occur during the IPL sequence; IPL was cancelled by the 3745 Console Operator
FFC	Status / Progression steps which occur during a configuration sequence; Fallback was cancelled by the 3745 Console Operator
FFD	Status / Progression steps which occur during the IPL sequence; IPL has completed; The MOSS IML was performed from the diskette; control program is loaded and MOSS is operational
FFE	Status / Progression steps which occur during the IPL sequence; IPL has been completed but has detected some error during the sequence.
FFF	IPL canceled after error detection.
	An * following a panel code denotes that the code should 'Blink'.

Appendix A. Control Panel Code Definitions A-23

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A-24 IBM 3745 Communication Controller

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Appendix B. Maintenance Aids

PKD Maintenance Aids

Configuration

On a LIC type 5 or 6, the configuration parameters are set from the PKD, refer to the "3745 Connection and Integration Guide" for detailed procedure.

On a LIC type 5, the following configuration parameters are "service representative only": MODE (native or CCITT), CD SENSIT (normal or low) and L XMIT LEVEL. They must be set by using the '**B**' command as follows:

- 1. Enter the B 300 at the PKD.
- 2. Press GO several times to get the desired option message.
- 3. Press ERASE and enter the new value if applicable.
- 4. Press GO to validate the new value.

B Commands (Only for LIC Type 5)

The following other **B** commands can be used by the CE for miscellaneous actions:

- B 100 Reload default configuration.
- B 555 Address a remote modem (using the modem serial number) to change some parameters.
- B 666 Increase the timeout from 30 seconds to 10 minutes.
- B 703/704/705 CO/CS functions, allows remote commands.
- B 730 Send a 1004 HZ tone on telephone line.

Manual Tests

The following manual test can be executed on a LIC type 5:

- Local self-test
- · Remote self-test
- · Local status report
- · Remote status report
- · Analog test (line analysis)
- Digital test (transmit/receive test)
- Manual loopback

The following manual test can be executed on a LIC type 6:

- · Local self-test
- Digital test (transmit/receive test)
- Manual loopback

Refer to the "3745 Connection and Integration Guide" Part 3 for detailed procedure.

Contacting Support

You may wish to record your support structure telephone number here.

You may be directed to call support for various reasons. When support is called you may be asked to perform specific tasks. In the following pages you will find information about why you call support and references to where you will find information about the tasks you may have to perform.

- "Control Program Maintenance Aids" on page B-4.
- "MOSS Microcode Maintenance Aids" on page B-6.
- "Scanner Microcode Maintenance Aids" on page B-8.
- "Channel Microcode Maintenance Aids" on page B-10.



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Notes:

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Control Program Maintenance Aids

The following list gives some possible causes of control program errors.

- A hardware configuration change has been performed and there is a difference between the hardware configuration and the control program generation.
- The customer has made some software changes.
- A PTF has been incorrectly applied.
- A PTF exists for the problem but has not been applied.

The following table shows where to find useful information in case of a suspected control program error.

Information	Where to find it
Customer procedures for diagnosis	"ACF/SSP Diagnosis Reference, LY30-3060"
How to perform control program procedures	"Advanced Operation Guide, Chapter 3"
How to execute NCP functions	"Advanced Operation Guide, Chapter 26"
Line Interface Display (LID)	"Advanced Operation Guide, Chapter 12"
Token-ring Interface Display (TID)	"Advanced Operation Guide, Chapter 23"
Port Swap	"Advanced Operation Guide, Chapter 17"
LIC Swap	"Advanced Operation Guide, Chapter 17"
Access method traces	"Maintenance Information Reference Manual, Chapter 13"
Scanner Interface Trace (SIT)	"Maintenance Information Reference Manual, Chapter 13"
Stand-Alone Link Test (SALT)	"Advanced Operation Guide, Chapter 20"
Catalogued Procedures (CP1 to CP6)	"Advanced Operation Guide, Chapter 3"
LIC internal wrap test	"3745 Problem Determination Guide, Chapter 10"
LIC wrap test with wrap plugs	"Advanced Operation Guide, Chapter 24"
NETVIEW* alerts	NETVIEW Bibliography.



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MOSS Microcode Maintenance Aids

The following table shows where to find useful information in case of a suspected microcode error.

Information	Where to find it
How to apply MCF	"3745 Service Functions, Chapter 7"
How to display, delete a MOSS dump.	"3745 Service Functions, Chapter 6"
Theory of MOSS and MOSS adapters	"Maintenance Information Reference Manual, Chapter 8"
How to perform traces and dumps	"Maintenance Information Reference Manual, Chapter 13"
Save, restore, format the MOSS hard disk drive.	"3745 Service Functions, Chapter 11".
How to dump MOSS	"Control Panel Use" on page 1-33



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Scanner Microcode Maintenance Aids

The following table shows where to find useful information in case of a suspected scanner microcode error.

Information	Where to find it
MCF	"3745 Service Functions, Chapter 7"
Patches	"3745 Service Functions, Chapter 8"



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Channel Microcode Maintenance Aids

The following table shows where to find useful information in case of a suspected channel microcode error.

Information	Where to find it
Channel Adapter Description	"Maintenance Information Reference Manual, Chapter 7"

List of Abbreviations

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A	ampere	BRC	BER correlation
abend	abnormal end of task	BSC	binary synchronous communication
AC	1) alternating current	вт	branch trace
	2) abandon call 3) address compare	ВТАМ	Basic Telecommunications Access Method
ACB	adapter control block	BTAM-ES	BTAM extended support
ACF	Advanced Communications Function	BZL	branch on Z latch (instruction)
ACK	affirmative acknowledgment (BSC)	С	(1) Celsius
ACR	 add character register (instruction) abandon call request 	СА	(2) control (X.21 signal) channel adapter
ACU	automatic calling unit	САВ	channel adapter board
AE	address exception	CAC	common adapter code
AEK	address exception key	CACM	channel adapter concurrent
AFD	airflow detector		maintenance
AGC	automatic gain control (signal)	CAL	channel adapter logic card
AHR	add halfword register (instruction)	CADR	channel adapter driver receiver card
AIO AIT	adapter-initiated operation algorithm interface table	CADRUK	channel adapter driver receiver type UK card
ALC	Airlines Line Control	CATPS	channel adapter with two-processor switch
ALU	arithmetic and logic unit	СВ	circuit breaker
AMD ANSI	air moving device American National Standards Institute	ссітт	Comite Consultatif International Telegraphique et Telephonique
AR	add register (instruction)	CCMD	current command (storage)
ARI	add register immediate (instruction)	CCN	communications controller node
AS	autoselection chain	CCR	compare character register
ASCII	American National Standard Code for	0011	(instruction)
	Information Interchange	CCU	central control unit
AXB	adapter expansion block	CCW	channel command word
B BAL	branch (instruction)	CD	1) carrier detector (signal) 2) connector
BAL	branch and link (instruction)	CDF	configuration data file
BB	branch and link register (instruction) branch on bit (instruction)	CDG	concurrent diagnostic
BCC	block check character (BSC)	CDS	configuration data set (NCP/EP)
BCCW	bit clock control word	CE	customer engineer
BCD	binary-coded decimal notation	CEPT	Comite Europeen des Postes et Telecommunications
BCL	branch on C latch (instruction)	снсw	channel control word
ВСТ	branch on count (instruction)	CHPID	channel path identification
BER	box event record	CHR	compare halfword register (instruction)
B/M	bill of material	CI	calling indicator (signal)
BPC1	bus propagation card to replace the	CID	channel interface display
	CAL card	CLDP	controller load/dump program
BPC2	bus propagation card to replace the TRM card	CMOS	complementary metal oxide
bps	bits per second	A 111	semiconductor
BR	bus request	CNM	communication network management

CNIMI	communication notwork monogoment	DFI	defect free installation	
CNMI	communication network management interface	DFI	defect-free installation data in	
CNSL	console	DIFF	differentiator	U
CO/CS	contact operate/contact sense	DLE	data link escape character	
CONFSW	configuration switch	DLO	data line occupied (signal)	
СР	1) communication processor, control	DMA	direct memory access	
	program 2) circuit protector	DMSW	direct memory access switch card	
CPIT	control program information table	DMUX	double multiplex card for board on LIC	
СРМ	connection point manager	Dillon	unit 1	
CPT	checkpoint trace	DO	data out	
CR	(1) compare register (instruction)	DOI	duration of interrupt	
	(2) call request (signal)	DP	digit present (signal)	
CRC	cyclic redundancy check character	DPR	digit present request	
CRI	compare register immediate	DRA	duration of repair action	
	(instruction)	DRS	data rate select	\bigcap
CRP	check record pool	DRV	driver	
CRQ	call request	DS	data streaming	
CRU	customer replaceable unit	DSC	distant station connected	
CS	(1) cycle steal (2) communication scanner	DSR	data set ready (signal)	
CSA	common subassembly	DSRS	data signaling rate selection (signal)	
cscw	cycle steal control word	DSU	data service unit (DCE-like for high-speed communication lines)	
CSG	cycle steal grant	DTE	data terminal equipment	
CSGH	cycle steal grant high	DTER	DMA bús terminator	<u> </u>
CSGL	cycle steal grant low	DTR	data terminal ready (signal)	the states
CSP	communication scanner processor	DVB	device block	
CSR	cycle steal request	DX	duplex	
CSRH	cycle steal request high	EBCDIC	extended binary-coded decimal	
CSRL	cycle steal request low		interchange code	
CSS	control subsystem	EC	engineering change	
CSU	1) customer setup 2) customer service unit (DCE-like for	ECC	error checking and correction	
	high-speed communication lines)	EDE	elementary data exchange	(
CSW	channel status word	ED/FI	error detection/fault isolation	× .
стѕ	clear to send (signal)	EIA	Electronic Industries Association	
CW	control word	EIB	error intermediate block	
CZ	carry/zero (latch)	ELCS	extended line communication status	
DAF	destination address field (SNA)	EMEA	Europe, Middle East, Africa	
DB	data byte	ENQ	enquiry (BSC)	
DC	1) direct current	EOT	end of transmission (BSC)	
5.05	2) data chaining (channel status)	EP	emulation program	
DCE	data circuit-terminating equipment	EPO	emergency power-off	
DCF	diagnostic control function	ERC	error reference code	
DCM DCRLSD	diagnostic control monitor data channel receive line signal	EREP	environmental recording, editing, and printing (program)	
	detector (same as CD)	ERP	error recovery procedure	
DE	device end (channel status)	ESC	emulation subchannel (address)	
DFA	disk file adapter card	ESCH	emulation subchannel high (address)	

ESCL	emulation subchannel low (address)	IC	insert character (instruction)
ESD	electrostatic discharge	ICA	integrated communication adapter
ETB	end-of-transmission block character	ICB	interface control block (storage)
LID	(BSC)	ICE	internal clock function
ETX	end-of-text character (BSC)	ICT	insert character and count (instruction)
EXP	expected	ICW	interface control word
FAC	flag address control (SDLC frame)		
FCC	Federal Communications Commission	ID	identifier
FCPS	final call progress signals (X.21)	IEEE	Institute of Electrical and Electronics Engineers
FCS	frame check sequence	IFT	internal function test
FDD	flexible disk drive	ІМВ	in mailbox (MOSS)
FDS	flat distribution system	IML	initial microcode load
FDX	full-duplex (synonym for duplex)	in.	inch
FE	field engineering	IN	input (instruction)
FEIS	field engineering information system	INN	intermediate network node
FERR	FESA error register	INOP	inoperative (line, modem, or terminal)
FES	front-end scanner	INS	information network system
FESA	front-end scanner adapter	100	input/output control
FESH	front-end scanner (high-speed)	1/0	input/output
FESL	front-end scanner (low-speed)	IOCB	input/output control bus
FID4	format identification 4	IOCS	input/output control system
FM	frequency modulation	ЮН	input/output halfword (instruction)
FPS	FES parameter/status	ЮНІ	input/output halfword immediate
FRU	field-replaceable unit		(instruction)
ft	foot	IOIRR	input/output interrupt request register
GPR	general purpose register	IOSW	input/output switch (card)
GPT	generalized PIU trace	IPF	instruction pre-fetch
GTF	generalized trace facility	IPL	initial program load
HCS	Hardware Central Service	IPR	isolated pacing response (SNA)
HDD	hard disk drive	IR	interrupt request
HDX	half-duplex	IRR	interrupt request removed
hex	hexadecimal	ISDN	integrated service digital network
hh	hexadecimal value hh	ISL	inbound serial link
HLIR	high-level interrupt request	ISO	International Organization for Standardization
HLU	highest logical unit (largest CPU in an establishment)	ITB	intermediate text block (BSC)
HPTSS	high-performance transmission	ITER	IOC bus terminator
111 100	subsystem	IVT	isolation verification tests
HSB	high-speed buffer	К	1024 (bytes or words)
HSC	high-speed channel	КВ	kilobyte (1024 bytes)
HSS	high-speed scanner	KBD	keyboard
HW	hardware	kbps	kilobits per second
Hz	Hertz	kg	kilogram
I.	indication (signal)	kHz	kilohertz
IACK	interrupt acknowledgement	ko	not ok
IAR	instruction address register	L	load (instruction)
IBE	internal box error		

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LA	1) load address (instruction)	LSI	large scale integration	
	2) line adapter	LSR	local storage register (CSP)	
LAB	line adapter board	LSK	low-speed scanner	
LAN	local area network	LSSD	level-sensitive scan design	
LAP	line adapter processor	LT	local test	
LAR	lagging address register	LTC1	line terminator card for CAB1	
LCB	line control block (storage)	2.01	addressing	
LCD	line control definer (storage)	LTC2	line terminator card for CAB2	
LCOR	load character with offset register (instruction)	LU	addressing logical unit	
LCR	load character register (instruction)	m	meter	
LCS	line communication status (storage)	mA	milliampere	
LDF	line description file	MAC	MOSS adapter card	
LED	light-emitting diode	MAP	maintenance analysis-procedure	
LERR	line error register/driver check	MB	megabyte; 1 048 576 bytes	\frown
LH	load halfword (instruction)	MCA	MOSS console adapter card	
LHOR	load halfword with offset register	МСРС	machine check/program check	
	(instruction)	МСС	MOSS control card	
LHR	load halfword register (instruction)	MCF	microcode fix	
LIB	1) line interface buffer 2) LIC board	МСТ	machine configuration table	
LIB1	LIC board type 1 for LICs type 1, 3, and	MDOR	MOSS data operand register	
	4	MDR	miscellaneous data record	
LIB2	LIC board type 2 for LICs type 5 and 6	MERR	MUX error	\frown
LIC	line interface coupler card	MES	miscellaneous equipment specification	la s
LIC1	line interface coupler type 1 (card)	MFM	modified frequency modulation	
LIC3	line interface coupler type 3 (card)	MHz	megahertz	
LIC4	line interface coupler type 4 (card)	MICB	MOSS interface control block	
LIC5	line interface coupler type 5 (card)	MIM	Maintenance Information Manual	
LIC6	line interface coupler type 6 (card)	min	minute	
LID	line interface display	MIO	MOSS input/output	
LIU	line interface coupler unit	MIOC	MOSS I/O control bus	$\langle \cdot \rangle$
LIU1	LIC unit 1 for LICs type 1, 3, and 4	MIOH	MOSS input/output halfword	(main the second
LIU2	LIC unit 2 for LICs type 5, and 6	міоні	MOSS input/output halfword immediate	
LLAP	LIC line analysis procedure	MIP	Maintenance Information Procedures	
LLB	local loopback	MIR	Maintenance Information Reference	
LLIR	low-level interrupt request	MIT	MOSS interface table	
LL2	link level 2 test	MLC	machine level control	
LNVT	line vector table	MLT	machine load table	
LOR	load with offset register (instruction)	mm	millimeter	
LPDA	Link Problem Determination Aid	MMIO	memory mapped input/output	
LR	load register (instruction)	MOD	modifier	
LRC	longitudinal redundancy check	MOSS	maintenance and operator subsystem	
LRI	load register immediate (instruction) local storage	MPC	MOSS processor card	
LRU	least-recently used	MPS	multiple port sharing	
LS	local storage	ms	millisecond	$(1,1) \in \mathbb{R}^{n}$
LSAR	-	MSA	machine status area	$\mathbf{\tilde{\mathbf{v}}}$
LJAK	local storage address register			

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MSAU	multistation access unit	OLTT	online terminal test
MSC	MOSS storage card	OMB	out mailbox
MSD	machine status display	OP	operation decode
MUX	multiplex function	OR	OR register (instruction)
mV	millivolt	ORI	OR register immediate (instruction)
MVS	Multi Virtual Storage	os	Operating System
NA	not applicable	OSL	outbound serial link
NAK	negative acknowledgment character (BSC)	Ουτ	output (instruction)
NCCF	Network Communications Control Facility	ov PAC	overvoltage power analog card
NCP	Network Control Program	ΡΑΡ	previous adapter present
NCR	AND character register (instruction)	PAR	problem analysis and repair
NCTE	network communication terminal	PC	personal computer
NOTE	equipment	РСВ	power control bus
NHR	AND halfword register (instruction)	PCF	primary control field (storage)
NLDM	Network Logical Data Manager	PCI	program-controlled interrupt
NMPF	network management program facilities	PCR	power check reset
ΝΜντ	network management vector transport	PCSS	power control subsystem
NO-OP	no-operation instruction	PCW	processor control word
NOSP	network operation support program (VTAM) <d> Use storage</d>	PCWC	power control wrap card
NPDA	Network Problem Determination	PD	problem determination
NF DA	Application	PDAID	problem determination aids
NPM	NetView performance monitor	PDB	power distribution board
NPSI	network packet switching interface	PDF	parallel data field (storage)
NR	AND register (instruction)	PE	Product Engineering
NRI	AND register immediate (instruction)	PEP	partitioned emulation program
NRZI	see NRZ-1	PF	programmable function
NRZ-1	non return-to-zero change on ones	PFAR	prefetch address register
	recording	PI	power indication (signal)
NS	new sync (signal)	PIO	program-initiated operation
ns	nanosecond	PIRR	program interrupt request register
NSC	native subchannel (address)	PIU	pass information unit
NTO	Network Terminal Option	PKD	portable keypad display
NTT	Nippon Telegraph and Telephone	PLC	power logic card
	(Japanese PTT)	PN	part number
0C	overcurrent	PND	present next digit (signal)
OCR	OR character register	POPR	prefetch operation register
ODG	offline diagnostic	POR	power-ON reset
OEM	original equipment manufacturer	POS	power ON services
ΟΕΜΙ	original equipment manufacturer's interface	PROM	programable read-only memory
OHR	OR halfword register	PS	power supply
OLT	online test	PSA	program status area
OLTEP	online test executive program	PSS	power subsystem
OLTSEP	online test stand-alone execution	PSTCE	product support trained CE
	(program)	PSTY	power supply type
OLTS	online test system	PSV	program status vector

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PSW	program status word	RTM	retry timer (X.21)
PSx	power supply type x	RTS	request to send (signal)
PTCE	product-trained CE	RU	request/response unit (SNA)
PTER	power bus terminator	RVI	reverse interrupt (BSC)
PTF	program temporary fix	R/W	read/write
PTT	Post, Telephone and Telegraph (agency)	S	second
РТХ	phototransistor	SAC	storage and control board assembly
PU	physical unit	SACL	storage and control lower assembly
PV	parity valid (signal)	SACU	storage and control upper assembly
QAM	quadrature amplitude modulation	SALT	stand-alone link test
RA	repair action	SAR	storage address register
RAC	repair action code	SCB	scanner control block (storage)
RAS	reliability, availability, and	SCF	secondary control field (storage)
	serviceability	SCP	signal converter product (or DCE)
RC	receive clock	SCR	(1) subtract character register (instruction)
RCDB	reference code data base		(2) serial clock receive (signal)
RCV	receive	SCT	serial clock transmit (signal)
RD	receive data (signal)	SCTL	storage control card
RDB	reference code data base	SD	send data (signal)
RECFMS	record formatted maintenance statistics	SDF	serial data field (storage)
RECMS	record maintenance statistics	SDLC	Synchronous Data Link Control
REQMS	request for maintenance statistics	SE	system engineer
RETAIN	Remote Technical Assistance	SES	secondary status (storage)
RFS	Information Network	SET	signal elément timing (signal)
KF3	ready for sending (signal) (or clear to send CTS)	SHM	short hold mode
RH	request/response header	SHR	subtract halfword register (instruction)
RI	1) register to immediate operand	SI	select in
	(instruction) 2) ring indicator (same as CI)	SIDI	serial in data in
RIM	request initialization mode (SDLC)	SIM	set initialization mode (SDLC)
RLSD	receive line signal detector	SIO	start input/output
RNIO	OS/VS VTAM IO trace	SIT	scanner internal trace
ROK	read-only key	SKA	storage key address
ROS	read-only storage	SKDR	storage-protect key data register
ROSAR	read-only storage address register	SL	serial link
rpm	revolutions per minute	SMPS	switching module power supply
RPO	1) remote power-off 2) request power-off	SMUXA	single multiplex card for lower board on LIC 2
RPQ	request for price quotation	SMUXB	single multiplex card for upper board on LIC 2
RR	register-to-register (instruction)	SNA	Systems Network Architecture
RS	register-to-storage (instruction)	SNRM	set normal response mode (SDLC)
RSA	register-to-storage with addition	SO	select out
	(instruction)	SODO	serial out data out
RSET	receive signal element timing (same as	SOH	start of heading (BSC)
DCE	RC)	SP	storage protect
RSF	remote support facility	SPAE	storage protect/ address exception
RTC	retry count (X.21)		- · ·

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SPK	storage protect key	TICB	trace interface control block
SR	subtract register (instruction)	τιο	test I/O
SRI	subtract register immediate (instruction)	TLNVT	trace line vector table
SRL		TOD	time of day
	shift register latch	TPS	two-processor switch
SS	start-stop	TPSA	trace parameter status area
SSB	system status block	TRA	token-ring adapter
SSCP	system services control point	TRM	1) token-ring multiplexer card that
SSP	system support programs		controls up to two TICs 2) test register under mask (instruction)
ST	store (instruction)	TRSS	token-ring subsystem
STC	store character (instruction)	TRU	trace record unit
STCT	store character and count (instruction)	TSET	transmitter signal element timing
STER	switch terminator		(signal, same as TC)
STH	store halfword (instruction)	TSS	transmission subsystem
STG	storage	TSSB	FRU name for LA board (basic) with no
STO	storage (card)		TRA adapters
STX	start of text (BSC)	TSST	FRU name for LA board (basic) with TRA adapters
SVC SW	supervisor call switch	TTA	translate table area
SWER	switch error register	TTD	temporary text delay (BSC)
SYN	synchronous idle (BSC)	T1	US service for very high speed transmissions at 1.5 million bps
SYSGEN	system generation	UA	unnumbered acknowledgment (SDLC)
Т	transmit (signal)	UC	universal controller
ТА	tag address	UCW	unit control word
ΤΑΡ	trace analysis program	UE	unit exception (channel status)
TAR	temporary address register	UEPO	unit emergency power-off
тв	terminator block	υκ	United Kingdom
тс	transmit clock	UKA	user key address
TCAM	Telecommunications Access Method	UKP	user key program
тсв	task control block	UKDR	user key data register
тсс	trace correlation counter (storage)	UKL	user key level interrupt
тсм	1) thermally-controlled module	URSF	universal remote support facility
TOD	2) treillis coded modulation	USASCII	(see ASC//)
TCP	test connector pin	μS	microsecond
TCS	two-channel switch	uv	undervoltage
TCTR	transient error counter	v	volt
TD	1) tag data 2) transmitted data (signal)	VB	valid byte (signal)
TERM	terminator	VAC	volts, alternating current
TG	transmission group	VCNA	VTAM node control application
тн	transmission header	VDC	volts, direct current
TI	test indicator (signal)	VFO	variable frequency oscillator
TIC	token-ring interface coupler	VH	valid halfword (signal)
TIC1	token-ring interface coupler type 1	VPD	vital product data
	(card)	VRC	vertical redundancy check
TIC2	token-ring interface coupler type 2	vs	virtual storage
	(card)	VSE	Virtual Storage Extended
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VTAM	Virtual Telecommunications Access Method
V.24	CCITT V.24 recommendation
V.25	CCITT V.25 recommendation
V.28	CCITT V.28 recommendation
V.35	CCITT V.35 recommendation
W	watt
WACK	wait before transmit positive acknowledgment (BSC)
WB	wrapback (signal)
WKR	work register
WSDR	wide storage data register
XI	X.25 SNA interconnection
XID	exchange identification
XCR	exclusive OR character register (instruction)
XHR	exclusive OR halfword register (instruction)
XOR	exclusive OR
XR	exclusive OR register (instruction)
XREG	external registers
XRI	exclusive OR register immediate (instruction)
X.21	CCITT X.21 recommendation
X.25	CCITT X.25 recommendation
YZxxx	wiring diagram
ZI	zero insert
ZREG	Z register

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Glossary

This glossary defines all new terms used in this manual. It also includes terms and definitions from the *IBM Dictionary of Computing*, GC20-1699.

adapter-initiated operation (AIO). A transfer of up to 256 bytes between an adapter (CA or LA) and the CCU storage. The transfer is initiated by an IOH/IOHI instruction, and is performed in cycle stealing via the IOC bus.

addressing. A technique where the control station selects, among the DTEs that share a transmission line, the DTE to which it is going to send a message.

alarm. A message sent to the MOSS console. In case of an error a reference code identifies the nature of the error.

alert. A message sent to the host console. In case of an error a reference code identifies the nature of the error.

asynchronous transmission. Transmission in which each character is individually synchronized, usually by the use of start and stop elements. The start-stop link protocol, for example, uses asynchronous transmission. Contrast with *synchronous transmission*.

auto-answer. A machine feature that allows a DCE to respond automatically to a call that it receives over a switched line.

auto-call. A machine feature that allows a DCE to initiate a call automatically over a switched line.

autoBER. A program to automatically analyse a BER file.

automaint. A function that uses autoBER to isolate failing FRUs.

availability. The degree to which a system or resource is ready when needed to process data.

Bell 212A. Bell recommendations on transmission interface

binary synchronous communication (BSC). A uniform procedure, using standardized set of control characters and character sequences, for synchronous transmission of binary-coded data between stations.

box event record (BER). Information about an event detected by the controller. It is recorded on the disk/diskette and can be displayed on the operator console for event analysis.

block multiplexer channel. A multiplexer channel that interleaves blocks of data. See also *byte multiplexer channel*. Contrast with *selector channel*.

byte multiplexer channel. A multiplexer channel that interleaves bytes of data. See also block multiplexer channel. Contrast with selector channel.

cache. A high-speed buffer storage that contains frequently accessed instructions and data; it is used to reduce access time.

central control unit (CCU). In the 3745, the controller hardware unit that contains the circuits and data flow paths needed to execute instructions and to control its storage and the attached adapters.

channel. A one-way path between a host and the controller.

channel adapter (CA). A communication controller hardware unit used to attach the controller to a host processor.

channel interface. The interface between the controller and the host processors.

clear channel. Mode of data transmission where the data passes through the DCE and network, and arrives at the receiving communication controller (for example, the IBM 3745) unchanged from the data transmitted. The DCE or network can modify the data during transmission because of certain network restrictions, but must ensure the received data stream is the same as the transmitted data stream.

command list. In NetView, a sequential list of commands and control statements that is assigned a name. When the name is invoked (as a command) the commands in the list are executed.

communication common carrier. In the USA and Canada, a public data transmission service that provides the general public with transmission service facilities. For example, a telephone or telegraph company (see also *Post Telephone and Telegraph* for countries outside the USA and Canada).

communication controller. A communication control unit that is controlled by one or more programs stored and executed in the unit. Examples are the IBM 3705, IBM 3725/3726, IBM 3720, and IBM 3745.

communication network management (CNM) application program. An ACF/VTAM application program authorized to issue formatted management services request units containing physical-unit-related requests and to receive formatted management services request units containing information from physical units.

communication scanner. See scanner.

communication scanner processor (CSP). The processor of a scanner.

communication subsystem. The part of the controller that controls the data transfers over the transmission interface.

configuration data file (CDF). A MOSS file that contains a description of all the hardware features (presence, type, address, and characteristics).

control panel. A panel that contains switches and indicators for the use of the customer's operator and service personnel.

control program. A computer program designed to schedule and to supervise the execution of programs of the controller.

control subsystem (CSS). The part of the controller that stores and executes the control program, and monitors the data transfers over the channel and transmission interfaces.

customer engineer (CE). See *IBM service* representative

cyclic redundancy check. A system of error checking performed at both the sending and receiving station after a block check character has been accumulated.

cyclic redundancy check character (CRC). A character used in a modified cyclic code for error detection and correction.

data circuit-terminating equipment (DCE). The equipment installed at the user's premises that provides all the functions required to establish, maintain, and terminate a connection, and the signal conversion and coding between the data terminal equipment (DTE) and the line. For example, a modem is a DCE (see *modem*.)

Note: The DCE may be separate equipment or an integral part of other equipment.

data communication channel. See channel.

data host. A host running application programs only.

data terminal equipment (DTE). That part of a data station that serves as a data source, data sink, or both, and provides for the data communication control function according to protocols.

DIN. Technology of connector contacts.

direct attachment. The attachment of a DTE to another DTE without a DCE.

direct-current interlock (DCI). A mode of data transfer over an I/O interface to enable communication between data processing systems through a channel.

diskette. A thin, flexible magnetic disk, and its protective jacket, that records diagnostics, microcode, and 3745 files.

diskette drive. A mechanism that reads and writes diskettes.

DOS/VS. Disk Operating System/Virtual Storage.

duplex transmission. Data transmission in both directions at the same time. Contrast with *half-duplex*.

Emulation Program (EP). An IBM licensed program that allows a channel-attached communication controller to emulate the functions of an IBM 2701 Data Adapter Unit, an IBM 2702 Transmission Control, or an IBM 2703 Transmission Control.

error recovery procedure (ERP). A procedure designed to help isolate and, where possible, to recover from errors in equipment. The procedures are often used in conjunction with programs that record the information on machine malfunctions.

fallback. In twin-backup mode, a state where the traffic of the failing CCU has been redirected to the second one.

In standby mode, a state where the traffic of the failing CCU has been redirected to the standby CCU after it is IPLed.

front-end scanner (FES). A circuit that scans the transmission lines, serializes and deserializes the transmitted characters, and manages the line services. It is part of the scanner.

half-duplex. Data transmission in either direction, one direction at a time. Contrast with *duplex*.

high-performance transmission subsystem (HPTSS). The part of the controller that controls the data transfers over the high-speed transmission interface (speed up to 2 million bps).

The HPTSS consists of up to eight high-speed scanners (HSSs).

high-speed scanner. Line adapter for lines up to 2 million bps, composed of a communication scanner processor (CSP) and a front-end high-speed scanner (FESH).

high-speed transfer. A mode of high-speed data transmission over an I/O interface to enable communication between data processing systems through a channel.

hit. In cache operation, indicates that the information is in the cache storage.

host processor. (1) A processor that controls all or part of a user application network. (2) In a network, the processing unit in which the access method for the network resides. (3) In an SNA network, the processing unit that contains a system services control point (SSCP). (4) A processing unit that executes the access method for attached communication controllers. Also called *host*.

IBM service representative. An individual in IBM who performs maintenance services for IBM products or systems.

initial microcode load (IML). The process of loading the microcode into a scanner or into MOSS.

initial program load (IPL). The initialization procedure that causes 3745 control program to commence operation.

input/output control (IOC). The circuit that controls the input/output from/to the channel adapters and scanners via the IOC bus.

internal clock function. A LIC function that provides a transmit clock for sending data, and retrieves a receive clock from received data, when the modem does not provide those timing signals. When the terminal is connected in direct-attach mode (without modem) the ICF also provides the transmit and receive clocks to the terminal, via the LIC card.

internal function test (IFT). A set of diagnostic programs designed and organized to detect and isolate a malfunction.

LIC module. A group of four adjacent LICs.

LIC unit. A line interface coupler unit (LIU) consisting of:

- One power supply (PS) associated with
- Two LIC boards (LIEs), housing
- Multiplex cards (DMUX, SMUXA, or SMUXB), and
- Line interface coupler cards (LICs)

line. See transmission line.

line adapter (LA). The part of the TSS, HPTSS, or TRSS that scans and controls the transmission lines. Also called *scanner*.

For the TSS the line adapters are low-speed scanners (LSSs).

For the HPTSS the line adapters are high-speed scanners (HSSs).

For the TRSS the line adapters are token-ring adapters (TRAs).

line interface coupler (LIC). A circuit that attaches up to four transmission cables to the controller.

Link Problem Determination Aid (LPDA). A set of test facilities resident in the IBM 386X/586X modems and activated from the control program in the controller and from host.

link protocol. The set of rules by which a logical data link is established, maintained, and terminated, and by which data is transferred across the link.

Logrec. Error logging program managed via the operating system.

longitudinal redundancy check (LRC). A system of error checking performed at the receiving station after a block check character has been accumulated.

low-speed scanner. Line adapter for lines up to 256 kbps, composed of a communication scanner processor (CSP) and a front-end low-speed scanner (FESL).

maintenance and operator subsystem (MOSS). The part of the controller that provides operating and

servicing facilities to the customer's operator and the IBM service representative.

microcode. A program, that is loaded in a processor (for example, the MOSS processor) to replace a hardware function. The microcode is not accessible to the customer.

miss. In cache operation, indicates that the information is not in the cache storage.

modem (modulator-demodulator). A functional unit that transforms logical signals from a DTE into analog signals suitable for transmission over telephone lines (modulation), and conversely (demodulation). A modem is a DCE. It may be integrated in the DTE.

MOSS input/output control (MIOC). The circuit that controls the input/output from/to the MOSS.

multiplexer channel. A channel designed to operate with a number of I/O devices simultaneously. Several I/O devices can transfer records at the same time by interleaving items of data. See also byte multiplexer, block multiplexer.

multiplexing. In data transmission, a function that permits two or more data sources to share a common transmission medium so that each data source has its own channel.

multipoint connection. A connection established for data transmission among more than two data stations. The connection may include switching facilities.

NetView. An IBM licensed program used to monitor a network, manage it, and diagnose its problems.

network. See user application network.

Network Control Program (NCP). An IBM licensed program that provides communication controller support for single-domain, multiple-domain, and interconnected network capability.

nonswitched line. A connection between systems or devices that does not have to be made by dialing. The connection can be point-to-point or multipoint. The line can be leased or private. Contrast with switched line.

online tests. Testing of a remote data station concurrently with the execution of the user's programs (that is, with only minimal effect on the user's normal operation).

Operating System/Virtual Storage (OS/VS). A family of operating systems that control IBM System/360 and System/370 computing systems. OS/VS includes VS1, VS2, MVS/370, and MVS/XA:

operator console. The IBM Operator Console that is used to operate and service the 3745 through the MOSS. A local console must be located within 7 m of the 3745. Optionally an alternate console may be installed up to 120 m from the 3745, or a remote console may be connected to the 3745 through the switched network. owning host. A host which can IPL a 3745 and also run application programs.

partitioned emulation programming (PEP) extension. A function of a network control program that enables a communication controller to operate some telecommunication lines in network control mode while simultaneously operating others in emulation mode.

phototransistor. An electronic part used to sense the light of a light-emitting diode.

point-to-point connection. A connection established between two data stations for data transmission. The connection may include switching facilities.

polling. The process whereby remote stations are invited, one at a time, to transmit.

post telephone and telegraph (PTT). A generic term for the government-operated common carriers in countries other than the USA and Canada. Examples of the PTT are British Telecom in the United Kingdom, Deutsche Bundespost in Germany, and Nippon Telephone and Telegraph Public Corporation in Japan.

program-initiated operation (PIO). A transfer of four bytes between a general register in the CCU and an adapter (channel or scanner). The transfer is initiated by IOH/IOHI instruction and is executed via the IOC bus.

reliability. The ability of a functional unit to perform a required function under stated conditions, for a stated period of time.

scanner. A device that scans and controls the transmission lines. Also called *line adapter*.

selector channel. An I/O channel designed to operate with only one I/O device at a time. Once the I/O device is selected, a complete record is transferred one byte at a time. Contrast with *block multiplexer* channel, multiplexer channel.

services. A set of functions designed to facilitate the maintenance of a device or system.

serviceability. The capability to perform effective problem determination, diagnosis, and repair on a data processing system.

single. Configuration with one CCU

start-stop. A data transmission system in which each character is preceded by a start signal and is followed by a stop signal.

switchback. Operation to reset a twin-backup configuration from fallback to initial state.

switched line. A transmission line with which the connections are established by dialing, only when data transmission is needed. The connection is point-to-point and uses a different transmission line each time it is established. Contrast with nonswitched line.

Synchronous Data Link Control (SDLC). A discipline conforming to subsets of the Advanced Data Communication Control Procedures (ADCCP) of the American National Standards Institute (ANSI) and High-level Data Link Control of the International Organization for Standardization, for managing synchronous, code-transparent, serial-by-bit information transfer over a link connection. Transmission exchanges may be duplex or half-duplex over switched or nonswitched links. The configuration of the link connection may be point-to-point, multipoint, or loop.

synchronous transmission. Data transmission in which the sending and receiving instruments are operating continuously at substantially the same frequency and are maintained, by means of correction, in a desired phase relationship. Contrast with asynchronous transmission.

Systems Network Architecture (SNA). The description of the logical structure, formats, protocols, and operational sequences for transmitting information through a user application network. The structure of SNA allows the users to be independent of specific telecommunication facilities.

time out. The time interval allotted for certain operations to occur.

token-ring subsystem (TRSS). The part of the controller that controls the data transfers over an IBM Token-Ring Network.

The TRSS consists of up to four token-ring adapters (TRAs).

token-ring adapter (TRA). Line adapter for an IBM Token-Ring Network, composed of one token-ring multiplexer card (TRM), and two token-ring interface couplers (TICs).

The TRSS consists of up to four token-ring adapters (TRAs).

transmission interface. The interface between the controller and the user application network.

transmission line. The physical means for connecting two or more DTEs (via DCEs). It can be nonswitched or switched. Also called *line*.

transmission subsystem (TSS). The part of the controller that controls the data transfers over lowand medium-speed, switched and non switched transmission interfaces.

The TSS consists of:

- Up to 32 low-speed scanners (LSSs) associated with
- LIC units (LIUs), through
- Serial links (SLs).

TSST board. line adapter board for token-ring adapters

twin. Configuration with two CCUs.

twin-dual. Mode of operation with two CCUs operating simultaneously in two distinct subareas.

twin-backup. Mode of operation identical to twin-dual with fallback capability.

twin-standby. Mode of operation with one CCU active and the other in standby, ready to take over.

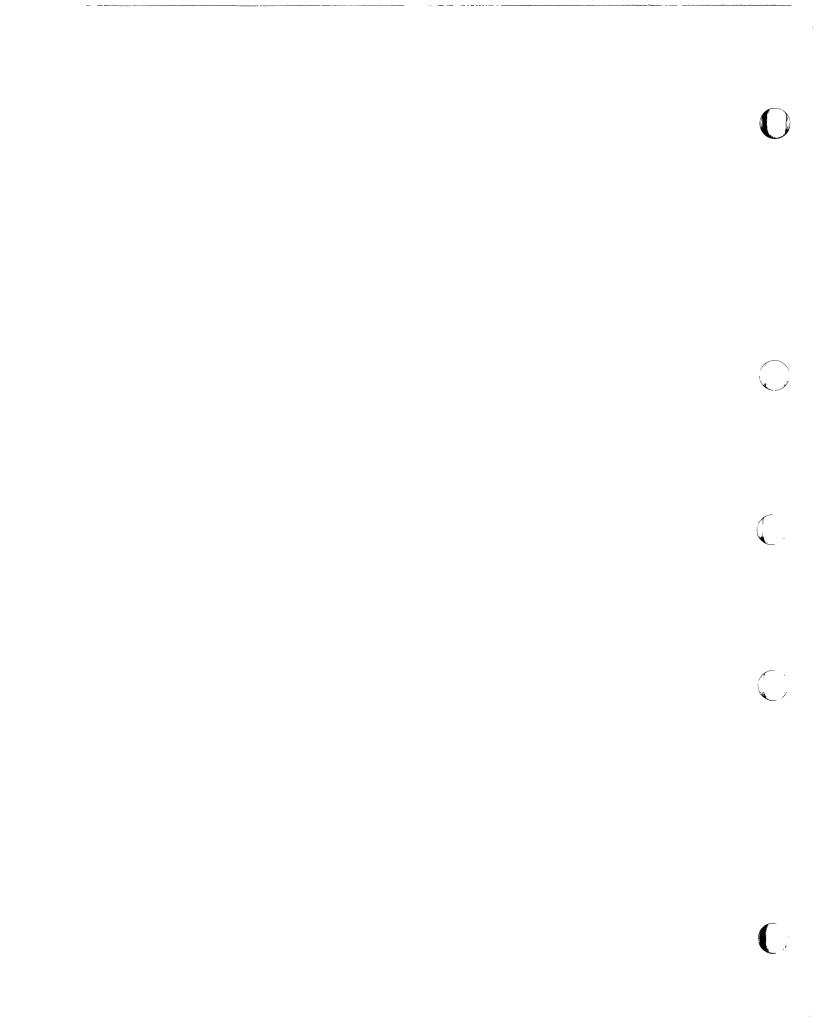
two-processor switch (TPS). A feature of the channel adapter that connects a second channel to the same adapter.

user application network. A configuration of data processing products, such as processors, controllers, and terminals, for the purpose of data processing and information exchange. This configuration may use circuit-switched, packet-switched, and leased-circuit services provided by carriers or the PTT. Also called *user network*.

vertical redundancy check (VRC). An odd parity check performed on each character of a block as the block is received.

V.24,25,35. EIA/CCITT recommendations on transmission interfaces

X.20 bis, 21, 21 bis, 21 native, 25. CCITT recommendations on transmission interfaces



1 L IBM 3745 Communication Controller Models 210, 310, 410, and 610 Maintenance Information Procedures (MIP) Part 2 Order No. SY33-2054-6 READER'S COMMENT FORM

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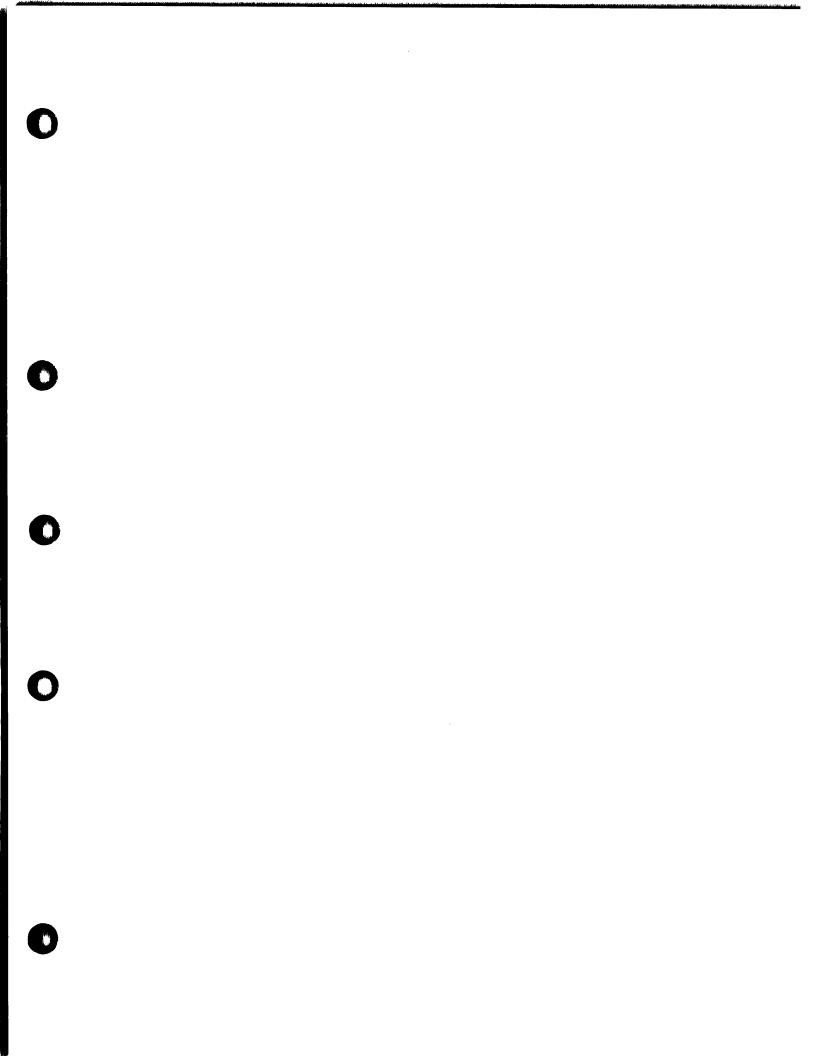
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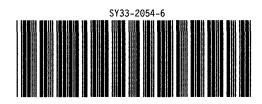


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